# XC4000E and XC4000X Series Field Programmable Gate Arrays

# XILINX®

## XC4000E and XC4000X Series Field Programmable Gate Arrays

## XC4000E and XC4000X Series Features

**Note:** XC4000 Series devices described in this data sheet include the XC4000E family and XC4000X Series. XC4000X Series devices described in this data sheet include the XC4000EX and XC4000XL families. This information does not apply to the older Xilinx families: XC4000, XC4000A, XC4000D, XC4000H, or XC4000L. For information on these devices, see the Xilinx WEBLINX at http://www.xilinx.com.

- System featured Field-Programmable Gate Arrays
  - Select-RAM™ memory: on-chip ultra-fast RAM with
    - synchronous write option
    - dual-port RAM option
  - Fully PCI compliant (speed grades -2 and faster)
  - Abundant flip-flops
  - Flexible function generators
  - Dedicated high-speed carry logic
  - Wide edge decoders on each edge
  - Hierarchy of interconnect lines
  - Internal 3-state bus capability
  - 8 global low-skew clock or signal distribution networks
- System Performance beyond 80 MHz
- Flexible Array Architecture
- Low Power Segmented Routing Architecture
- Systems-Oriented Features
  - IEEE 1149.1-compatible boundary scan logic support
  - Individually programmable output slew rate
  - Programmable input pull-up or pull-down resistors
  - 12-mA sink current per XC4000E output
- Configured by Loading Binary File
  - Unlimited reprogrammability
- Readback Capability
  - Program verification
  - Internal node observability
- Backward Compatible with XC4000 Devices
- XACT*step* Development System runs on most common computer platforms
  - Interfaces to popular design environments
  - Fully automatic mapping, placement and routing
  - Interactive design editor for design optimization

## Low-Voltage Versions Available

- Low-Voltage Devices Function at 3.0 - 3.6 Volts
- XC4000XL: High Performance Low-Voltage Versions of XC4000EX devices

## Additional XC4000X Series Features

- Highest Performance — 3.3 V XC4000XL
- Highest Capacity — Over 180,000 Usable Gates
- 5V tolerant I/Os on XC4000XL
- 0.35μ SRAM process for XC4000XL
- Additional Routing Over XC4000E
  - almost twice the routing capacity for high-density designs
- Buffered Interconnect for Maximum Speed
- New Latch Capability in Configurable Logic Blocks
- Improved VersaRing™ I/O Interconnect for Better Fixed Pinout Flexibility
- 12-mA Sink Current Per XC4000X Output
- Flexible New High-Speed Clock Network
  - 8 additional Early Buffers for shorter clock delays
  - Virtually unlimited number of clock signals
- Optional Multiplexer or 2-input Function Generator on Device Outputs
- 4 Additional Address Bits in Master Parallel Configuration Mode

## Introduction

XC4000 Series high-performance, high-capacity Field Programmable Gate Arrays (FPGAs) provide the benefits of custom CMOS VLSI, while avoiding the initial cost, long development cycle, and inherent risk of a conventional masked gate array.

The result of thirteen years of FPGA design experience and feedback from thousands of customers, these FPGAs combine architectural versatility, on-chip Select-RAM memory with edge-triggered and dual-port modes, increased speed, abundant routing resources, and new, sophisticated software to achieve fully automated implementation of complex, high-density, high-performance designs.

The XC4000E and XC4000X Series currently have 20 members, as shown in Table 2.

**Note:** *All functionality in low-voltage families is the same as in the corresponding 5-Volt family, except where numerical references are made to timing or power.*

**Table 2: XC4000E and XC4000X Series Field Programmable Gate Arrays**

| Device | Logic Cells | Max Logic Gates (No RAM) | Max. RAM Bits (No Logic) | Typical Gate Range (Logic and RAM)* | CLB Matrix | Total CLBs | Number of Flip-Flops | Max. User I/O |
|---|---|---|---|---|---|---|---|---|
| XC4003E | 238 | 3,000 | 3,200 | 2,000 - 5,000 | 10 x 10 | 100 | 360 | 80 |
| XC4005E/XL | 466 | 5,000 | 6,272 | 3,000 - 9,000 | 14 x 14 | 196 | 616 | 112 |
| XC4006E | 608 | 6,000 | 8,192 | 4,000 - 12,000 | 16 x 16 | 256 | 768 | 128 |
| XC4008E | 770 | 8,000 | 10,368 | 6,000 - 15,000 | 18 x 18 | 324 | 936 | 144 |
| XC4010E/XL | 950 | 10,000 | 12,800 | 7,000 - 20,000 | 20 x 20 | 400 | 1,120 | 160 |
| XC4013E/XL | 1368 | 13,000 | 18,432 | 10,000 - 30,000 | 24 x 24 | 576 | 1,536 | 192 |
| XC4020E/XL | 1862 | 20,000 | 25,088 | 13,000 - 40,000 | 28 x 28 | 784 | 2,016 | 224 |
| XC4025E | 2432 | 25,000 | 32,768 | 15,000 - 45,000 | 32 x 32 | 1,024 | 2,560 | 256 |
| XC4028EX/XL | 2432 | 28,000 | 32,768 | 18,000 - 50,000 | 32 x 32 | 1,024 | 2,560 | 256 |
| XC4036EX/XL | 3078 | 36,000 | 41,472 | 22,000 - 65,000 | 36 x 36 | 1,296 | 3,168 | 288 |
| XC4044XL | 3800 | 44,000 | 51,200 | 27,000 - 80,000 | 40 x 40 | 1,600 | 3,840 | 320 |
| XC4052XL | 4598 | 52,000 | 61,952 | 33,000 - 100,000 | 44 x 44 | 1,936 | 4,576 | 352 |
| XC4062XL | 5472 | 62,000 | 73,728 | 40,000 - 130,000 | 48 x 48 | 2,304 | 5,376 | 384 |
| XC4085XL | 7448 | 85,000 | 100,352 | 55,000 - 180,000 | 56 x 56 | 3,136 | 7,168 | 448 |

\* Max values of Typical Gate Range include 20-30% of CLBs used as RAM.

## Description

XC4000 Series devices are implemented with a regular, flexible, programmable architecture of Configurable Logic Blocks (CLBs), interconnected by a powerful hierarchy of versatile routing resources, and surrounded by a perimeter of programmable Input/Output Blocks (IOBs). They have generous routing resources to accommodate the most complex interconnect patterns.

The devices are customized by loading configuration data into internal memory cells. The FPGA can either actively read its configuration data from an external serial or byte-parallel PROM (master modes), or the configuration data can be written into the FPGA from an external device (slave and peripheral modes).

XC4000 Series FPGAs are supported by powerful and sophisticated software, covering every aspect of design from schematic or behavioral entry, floorplanning, simulation, automatic block placement and routing of interconnects, to the creation, downloading, and readback of the configuration bit stream.

Because Xilinx FPGAs can be reprogrammed an unlimited number of times, they can be used in innovative designs where hardware is changed dynamically, or where hardware must be adapted to different user applications.

FPGAs are ideal for shortening design and development cycles, and also offer a cost-effective solution for production rates well beyond 5,000 systems per month. For lowest high-volume unit cost, a design can first be implemented in the XC4000E or XC4000X, then migrated to one of Xilinx' compatible HardWire mask-programmed devices.

## Taking Advantage of Reconfiguration

FPGA devices can be reconfigured to change logic function while resident in the system. This capability gives the system designer a new degree of freedom not available with any other type of logic.

Hardware can be changed as easily as software. Design updates or modifications are easy, and can be made to products already in the field. An FPGA can even be reconfigured dynamically to perform different functions at different times.

Reconfigurable logic can be used to implement system self-diagnostics, create systems capable of being reconfigured for different environments or operations, or implement multi-purpose hardware for a given application. As an added benefit, using reconfigurable FPGA devices simplifies hardware design and debugging and shortens product time-to-market.

# XC4000E and XC4000X Series Compared to the XC4000

For readers already familiar with the XC4000 family of Xilinx Field Programmable Gate Arrays, the major new features in the XC4000 Series devices are listed in this section. The biggest advantages of XC4000E and XC4000X devices are significantly increased system speed, greater capacity, and new architectural features, particularly Select-RAM memory. The XC4000X devices also offer many new routing features, including special high-speed clock buffers that can be used to capture input data with minimal delay.

Any XC4000E device is pinout- and bitstream-compatible with the corresponding XC4000 device. An existing XC4000 bitstream can be used to program an XC4000E device. However, since the XC4000E includes many new features, an XC4000E bitstream cannot be loaded into an XC4000 device.

XC4000X Series devices are not bitstream-compatible with equivalent array size devices in the XC4000 or XC4000E families. However, equivalent array size devices, such as the XC4025, XC4025E, XC4028EX, and XC4028XL, are pinout-compatible.

## Improvements in XC4000E and XC4000X

### Increased System Speed

XC4000E and XC4000X devices can run at synchronous system clock rates of up to 80 MHz, and internal performance can exceed 150 MHz. This increase in performance over the previous families stems from improvements in both device processing and system architecture. XC4000 Series devices use a sub-micron multi-layer metal process. In addition, many architectural improvements have been made, as described below.

The XC4000XL family is a high performance 3.3V family based on 0.35µ SRAM technology and supports system speeds to 80 MHz.

### PCI Compliance

XC4000 Series -2 and faster speed grades are fully PCI compliant. XC4000E and XC4000X devices can be used to implement a one-chip PCI solution.

### Carry Logic

The speed of the carry logic chain has increased dramatically. Some parameters, such as the delay on the carry chain through a single CLB (TBYP), have improved by as

much as 50% from XC4000 values. See "Fast Carry Logic" on page 4-18 for more information.

### Select-RAM Memory: Edge-Triggered, Synchronous RAM Modes

The RAM in any CLB can be configured for synchronous, edge-triggered, write operation. The read operation is not affected by this change to an edge-triggered write.

### Dual-Port RAM

A separate option converts the 16x2 RAM in any CLB into a 16x1 dual-port RAM with simultaneous Read/Write.

The function generators in each CLB can be configured as either level-sensitive (asynchronous) single-port RAM, edge-triggered (synchronous) single-port RAM, edge-triggered (synchronous) dual-port RAM, or as combinatorial logic.

### Configurable RAM Content

The RAM content can now be loaded at configuration time, so that the RAM starts up with user-defined data.

### H Function Generator

In current XC4000 Series devices, the H function generator is more versatile than in the original XC4000. Its inputs can come not only from the F and G function generators but also from up to three of the four control input lines. The H function generator can thus be totally or partially independent of the other two function generators, increasing the maximum capacity of the device.

### IOB Clock Enable

The two flip-flops in each IOB have a common clock enable input, which through configuration can be activated individually for the input or output flip-flop or both. This clock enable operates exactly like the EC pin on the XC4000 CLB. This new feature makes the IOBs more versatile, and avoids the need for clock gating.

### Output Drivers

The output pull-up structure defaults to a TTL-like totem-pole. This driver is an n-channel pull-up transistor, pulling to a voltage one transistor threshold below Vcc, just like the XC4000 family outputs. Alternatively, XC4000 Series devices can be globally configured with CMOS outputs, with p-channel pull-up transistors pulling to Vcc. Also, the configurable pull-up resistor in the XC4000 Series is a p-channel transistor that pulls to Vcc, whereas in the original XC4000 family it is an n-channel transistor that pulls to a voltage one transistor threshold below Vcc.

## Input Thresholds

The input thresholds of 5V devices can be globally configured for either TTL (1.2 V threshold) or CMOS (2.5 V threshold), just like XC2000 and XC3000 inputs. The two global adjustments of input threshold and output level are independent of each other. The XC4000XL family has an input threshold of 1.6V, compatible with both 3.3V CMOS and TTL levels.

## Global Signal Access to Logic

There is additional access from global clocks to the F and G function generator inputs.

## Configuration Pin Pull-Up Resistors

During configuration, the three mode pins, M0, M1, and M2, have weak pull-up resistors. For the most popular configuration mode, Slave Serial, the mode pins can thus be left unconnected.

The three mode inputs can be individually configured with or without weak pull-up or pull-down resistors after configuration.

The PROGRAM input pin has a permanent weak pull-up.

## Soft Start-up

Like the XC3000A, XC4000 Series devices have "Soft Start-up." When the configuration process is finished and the device starts up, the first activation of the outputs is automatically slew-rate limited. This feature avoids potential ground bounce when all outputs are turned on simultaneously. Immediately after start-up, the slew rate of the individual outputs is, as in the XC4000 family, determined by the individual configuration option.

## XC4000 and XC4000A Compatibility

Existing XC4000 bitstreams can be used to configure an XC4000E device. XC4000A bitstreams must be recompiled for use with the XC4000E due to improved routing resources, although the devices are pin-for-pin compatible.

# Additional Improvements in XC4000X Only

## Increased Routing

New interconnect in the XC4000X includes twenty-two additional vertical lines in each column of CLBs and twelve new horizontal lines in each row of CLBs. The twelve "Quad Lines" in each CLB row and column include optional repowering buffers for maximum speed. Additional high-performance routing near the IOBs enhances pin flexibility.

## Faster Input and Output

A fast, dedicated early clock sourced by global clock buffers is available for the IOBs. To ensure synchronization with the regular global clocks, a Fast Capture latch driven by the early clock is available. The input data can be initially loaded into the Fast Capture latch with the early clock, then transferred to the input flip-flop or latch with the low-skew global clock. A programmable delay on the input can be used to avoid hold-time requirements. See "IOB Input Signals" on page 4-21 for more information.

## Latch Capability in CLBs

Storage elements in the XC4000X CLB can be configured as either flip-flops or latches. This capability makes the FPGA highly synthesis-compatible.

## IOB Output MUX From Output Clock

A multiplexer in the IOB allows the output clock to select either the output data or the IOB clock enable as the output to the pad. Thus, two different data signals can share a single output pad, effectively doubling the number of device outputs without requiring a larger, more expensive package. This multiplexer can also be configured as an AND-gate to implement a very fast pin-to-pin path. See "IOB Output Signals" on page 4-24 for more information.

## Additional Address Bits

Larger devices require more bits of configuration data. A daisy chain of several large XC4000X devices may require a PROM that cannot be addressed by the eighteen address bits supported in the XC4000E. The XC4000X Series therefore extends the addressing in Master Parallel configuration mode to 22 bits.

# Detailed Functional Description

XC4000 Series devices achieve high speed through advanced semiconductor technology and improved architecture. The XC4000E and XC4000X support system clock rates of up to 80 MHz and internal performance in excess of 150 MHz. Compared to older Xilinx FPGA families, XC4000 Series devices are more powerful. They offer on-chip edge-triggered and dual-port RAM, clock enables on I/O flip-flops, and wide-input decoders. They are more versatile in many applications, especially those involving RAM. Design cycles are faster due to a combination of increased routing resources and more sophisticated software.

## Basic Building Blocks

Xilinx user-programmable gate arrays include two major configurable elements: configurable logic blocks (CLBs) and input/output blocks (IOBs).

- CLBs provide the functional elements for constructing the user's logic.
- IOBs provide the interface between the package pins and internal signal lines.

Three other types of circuits are also available:

- 3-State buffers (TBUFs) driving horizontal longlines are associated with each CLB.
- Wide edge decoders are available around the periphery of each device.
- An on-chip oscillator is provided.

Programmable interconnect resources provide routing paths to connect the inputs and outputs of these configurable elements to the appropriate networks.

The functionality of each circuit block is customized during configuration by programming internal static memory cells. The values stored in these memory cells determine the logic functions and interconnections implemented in the FPGA. Each of these available circuits is described in this section.

## Configurable Logic Blocks (CLBs)

Configurable Logic Blocks implement most of the logic in an FPGA. The principal CLB elements are shown in Figure 2. Two 4-input function generators (F and G) offer unrestricted versatility. Most combinatorial logic functions need four or fewer inputs. However, a third function generator (H) is provided. The H function generator has three inputs. Either zero, one, or two of these inputs can be the outputs of F and G; the other input(s) are from outside the CLB. The CLB can, therefore, implement certain functions of up to nine variables, like parity check or expandable-identity comparison of two sets of four inputs.

Each CLB contains two storage elements that can be used to store the function generator outputs. However, the storage elements and function generators can also be used independently. These storage elements can be configured as flip-flops in both XC4000E and XC4000X devices; in the XC4000X they can optionally be configured as latches. DIN can be used as a direct input to either of the two storage elements. H1 can drive the other through the H function generator. Function generator outputs can also drive two outputs independent of the storage element outputs. This versatility increases logic capacity and simplifies routing.

Thirteen CLB inputs and four CLB outputs provide access to the function generators and storage elements. These inputs and outputs connect to the programmable interconnect resources outside the block.

### Function Generators

Four independent inputs are provided to each of two function generators (F1 - F4 and G1 - G4). These function generators, with outputs labeled F' and G', are each capable of implementing any arbitrarily defined Boolean function of four inputs. The function generators are implemented as memory look-up tables. The propagation delay is therefore independent of the function implemented.

A third function generator, labeled H', can implement any Boolean function of its three inputs. Two of these inputs can optionally be the F' and G' functional generator outputs. Alternatively, one or both of these inputs can come from outside the CLB (H2, H0). The third input must come from outside the block (H1).

Signals from the function generators can exit the CLB on two outputs. F' or H' can be connected to the X output. G' or H' can be connected to the Y output.

A CLB can be used to implement any of the following functions:

- any function of up to four variables, plus any second function of up to four unrelated variables, plus any third function of up to three unrelated variables[1]
- any single function of five variables
- any function of four variables together with some functions of six variables
- some functions of up to nine variables.

Implementing wide functions in a single block reduces both the number of blocks required and the delay in the signal path, achieving both increased capacity and speed.

The versatility of the CLB function generators significantly improves system speed. In addition, the design-software tools can deal with each function generator independently. This flexibility improves cell usage.

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1. When three separate functions are generated, one of the function outputs must be captured in a flip-flop internal to the CLB. Only two unregistered function generator outputs are available from the CLB.
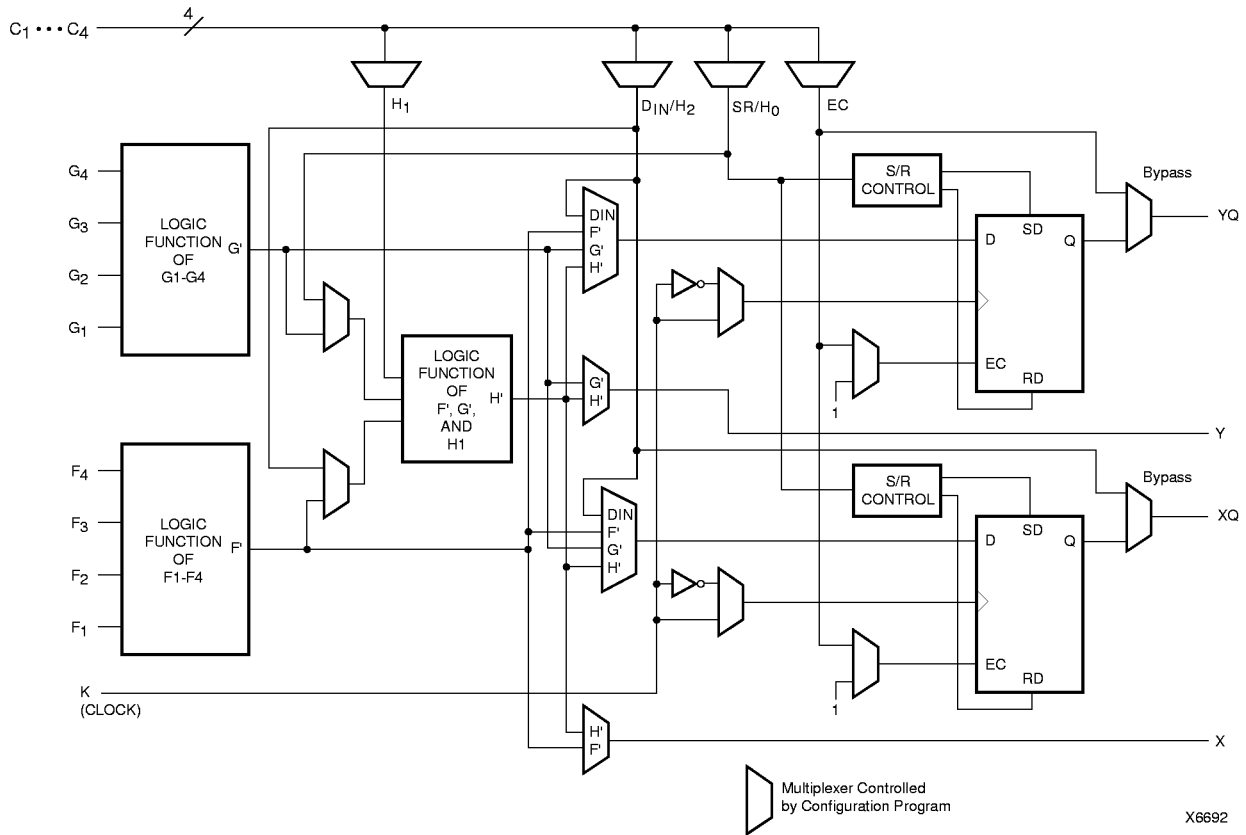
**Figure 2: Simplified Block Diagram of XC4000 Series CLB (RAM and Carry Logic functions not shown)**

## Flip-Flops

The CLB can pass the combinatorial output(s) to the inter-connect network, but can also store the combinatorial results or other incoming data in one or two flip-flops, and connect their outputs to the interconnect network as well.

The two edge-triggered D-type flip-flops have common clock (K) and clock enable (EC) inputs. Either or both clock inputs can also be permanently enabled. Storage element functionality is described in Table 3.

## Latches (XC4000X only)

The CLB storage elements can also be configured as latches. The two latches have common clock (K) and clock enable (EC) inputs. Storage element functionality is described in Table 3.

## Clock Input

Each flip-flop can be triggered on either the rising or falling clock edge. The clock pin is shared by both storage elements. However, the clock is individually invertible for each storage element. Any inverter placed on the clock input is automatically absorbed into the CLB.

## Clock Enable

The clock enable signal (EC) is active High. The EC pin is shared by both storage elements. If left unconnected for either, the clock enable for that storage element defaults to the active state. EC is not invertible within the CLB.

**Table 3: CLB Storage Element Functionality (active rising edge is shown)**

| Mode | K | EC | SR | D | Q |
|---|---|---|---|---|---|
| Power-Up or GSR | X | X | X | X | SR |
| Flip-Flop | X | X | 1 | X | SR |
| | $\_\_\!/\overline{\phantom{a}}$ | 1* | 0* | D | D |
| | 0 | X | 0* | X | Q |
| Latch | 1 | 1* | 0* | X | Q |
| | 0 | 1* | 0* | D | D |
| Both | X | 0 | 0* | X | Q |

Legend:
| | |
|---|---|
| X | Don't care |
| $\_\_\!/\overline{\phantom{a}}$ | Rising edge |
| SR | Set or Reset value. Reset is default. |
| 0* | Input is Low or unconnected (default value) |
| 1* | Input is High or unconnected (default value) |

## Set/Reset

An asynchronous storage element input (SR) can be con-figured as either set or reset. This configuration option determines the state in which each flip-flop becomes oper-ational after configuration. It also determines the effect of a Global Set/Reset pulse during normal operation, and the effect of a pulse on the SR pin of the CLB. All three set/reset functions for any single flip-flop are controlled by the same configuration data bit.

The set/reset state can be independently specified for each flip-flop. This input can also be independently disabled for either flip-flop.

The set/reset state is specified by using the INIT attribute, or by placing the appropriate set or reset flip-flop library symbol.

SR is active High. It is not invertible within the CLB.

## Global Set/Reset

A separate Global Set/Reset line (not shown in Figure 2) sets or clears each storage element during power-up, reconfiguration, or when a dedicated Reset net is driven active. This global net (GSR) does not compete with other routing resources; it uses a dedicated distribution network.

Each flip-flop is configured as either globally set or reset in the same way that the local set/reset (SR) is specified. Therefore, if a flip-flop is set by SR, it is also set by GSR. Similarly, a reset flip-flop is reset by both SR and GSR.



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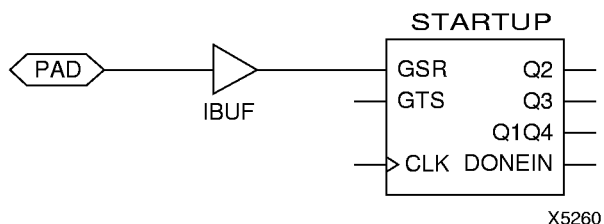
**Figure 3: Schematic Symbols for Global Set/Reset**

GSR can be driven from any user-programmable pin as a global reset input. To use this global net, place an input pad and input buffer in the schematic or HDL code, driving the GSR pin of the STARTUP symbol. (See Figure 3.) A spe-cific pin location can be assigned to this input using a LOC attribute or property, just as with any other user-program-mable pad. An inverter can optionally be inserted after the input buffer to invert the sense of the Global Set/Reset sig-nal.

Alternatively, GSR can be driven from any internal node.

## Data Inputs and Outputs

The source of a storage element data input is programma-ble. It is driven by any of the functions F', G', and H', or by the Direct In (DIN) block input. The flip-flops or latches drive the XQ and YQ CLB outputs.

Two fast feed-through paths are available, as shown in Figure 2. A two-to-one multiplexer on each of the XQ and YQ outputs selects between a storage element output and any of the control inputs. This bypass is sometimes used by the automated router to repower internal signals.

## Control Signals

Multiplexers in the CLB map the four control inputs (C1 - C4 in Figure 2) into the four internal control signals (H1, DIN/H2, SR/H0, and EC). Any of these inputs can drive any of the four internal control signals.

When the logic function is enabled, the four inputs are:

- EC — Enable Clock
- SR/H0 — Asynchronous Set/Reset or H function generator Input 0
- DIN/H2 — Direct In or H function generator Input 2
- H1 — H function generator Input 1.

When the memory function is enabled, the four inputs are:

- EC — Enable Clock
- WE — Write Enable
- D0 — Data Input to F and/or G function generator
- D1 — Data input to G function generator (16x1 and 16x2 modes) or 5th Address bit (32x1 mode).

## Using FPGA Flip-Flops and Latches

The abundance of flip-flops in the XC4000 Series invites pipelined designs. This is a powerful way of increasing per-formance by breaking the function into smaller subfunc-tions and executing them in parallel, passing on the results through pipeline flip-flops. This method should be seriously considered wherever throughput is more important than latency.

To include a CLB flip-flop, place the appropriate library symbol. For example, FDCE is a D-type flip-flop with clock enable and asynchronous clear. The corresponding latch symbol (for the XC4000X only) is called LDCE.

In XC4000 Series devices, the flip flops can be used as reg-isters or shift registers without blocking the function gener-ators from performing a different, perhaps unrelated task. This ability increases the functional capacity of the devices.

The CLB setup time is specified between the function gen-erator inputs and the clock input K. Therefore, the specified CLB flip-flop setup time includes the delay through the function generator.

## Using Function Generators as RAM

Optional modes for each CLB make the memory look-up tables in the F' and G' function generators usable as an array of Read/Write memory cells. Available modes are level-sensitive (similar to the XC4000/A/H families), edge-triggered, and dual-port edge-triggered. Depending on the selected mode, a single CLB can be configured as either a 16x2, 32x1, or 16x1 bit array.

Supported CLB memory configurations and timing modes for single- and dual-port modes are shown in Table 4.

XC4000 Series devices are the first programmable logic devices with edge-triggered (synchronous) and dual-port RAM accessible to the user. Edge-triggered RAM simplifies system timing. Dual-port RAM doubles the effective throughput of FIFO applications. These features can be individually programmed in any XC4000 Series CLB.

### Advantages of On-Chip and Edge-Triggered RAM

The on-chip RAM is extremely fast. The read access time is the same as the logic delay. The write access time is slightly slower. Both access times are much faster than any off-chip solution, because they avoid I/O delays.

Edge-triggered RAM, also called synchronous RAM, is a feature never before available in a Field Programmable Gate Array. The simplicity of designing with edge-triggered RAM, and the markedly higher achievable performance, add up to a significant improvement over existing devices with on-chip RAM.

Three application notes are available from Xilinx that discuss edge-triggered RAM: "*XC4000E Edge-Triggered and Dual-Port RAM Capability,*" "*Implementing FIFOs in XC4000E RAM,*" and "*Synchronous and Asynchronous FIFO Designs.*" All three application notes apply to both XC4000E and XC4000X RAM.

### Table 4: Supported RAM Modes

|  | 16 x 1 | 16 x 2 | 32 x 1 | Edge-Triggered Timing | Level-Sensitive Timing |
|---|---|---|---|---|---|
| Single-Port | √ | √ | √ | √ | √ |
| Dual-Port | √ | | | √ | |

### RAM Configuration Options

The function generators in any CLB can be configured as RAM arrays in the following sizes:

- Two 16x1 RAMs: two data inputs and two data outputs with identical or, if preferred, different addressing for each RAM
- One 32x1 RAM: one data input and one data output.

One F or G function generator can be configured as a 16x1 RAM while the other function generators are used to implement any function of up to 5 inputs.

Additionally, the XC4000 Series RAM may have either of two timing modes:

- Edge-Triggered (Synchronous): data written by the designated edge of the CLB clock. WE acts as a true clock enable.
- Level-Sensitive (Asynchronous): an external WE signal acts as the write strobe.

The selected timing mode applies to both function generators within a CLB when both are configured as RAM.

The number of read ports is also programmable:

- Single Port: each function generator has a common read and write port
- Dual Port: both function generators are configured together as a single 16x1 dual-port RAM with one write port and two read ports. Simultaneous read and write operations to the same or different addresses are supported.

RAM configuration options are selected by placing the appropriate library symbol.

### Choosing a RAM Configuration Mode

The appropriate choice of RAM mode for a given design should be based on timing and resource requirements, desired functionality, and the simplicity of the design process. Recommended usage is shown in Table 5.

The difference between level-sensitive, edge-triggered, and dual-port RAM is only in the write operation. Read operation and timing is identical for all modes of operation.

### Table 5: RAM Mode Selection

|  | Level-Sensitive | Edge-Triggered | Dual-Port Edge-Triggered |
|---|---|---|---|
| Use for New Designs? | No | Yes | Yes |
| Size (16x1, Registered) | 1/2 CLB | 1/2 CLB | 1 CLB |
| Simultaneous Read/Write | No | No | Yes |
| Relative Performance | X | 2X | 2X (4X effective) |

### RAM Inputs and Outputs

The F1-F4 and G1-G4 inputs to the function generators act as address lines, selecting a particular memory cell in each look-up table.

The functionality of the CLB control signals changes when the function generators are configured as RAM. The DIN/H2, H1, and SR/H0 lines become the two data inputs (D0, D1) and the Write Enable (WE) input for the 16x2 memory. When the 32x1 configuration is selected, D1 acts as the fifth address bit and D0 is the data input.

The contents of the memory cell(s) being addressed are available at the F' and G' function-generator outputs. They can exit the CLB through its X and Y outputs, or can be captured in the CLB flip-flop(s).

Configuring the CLB function generators as Read/Write memory does not affect the functionality of the other por-

tions of the CLB, with the exception of the redefinition of the control signals. In 16x2 and 16x1 modes, the H' function generator can be used to implement Boolean functions of F', G', and D1, and the D flip-flops can latch the F', G', H', or D0 signals.

## Single-Port Edge-Triggered Mode

Edge-triggered (synchronous) RAM simplifies timing requirements. XC4000 Series edge-triggered RAM timing operates like writing to a data register. Data and address are presented. The register is enabled for writing by a logic High on the write enable input, WE. Then a rising or falling clock edge loads the data into the register, as shown in Figure 4.
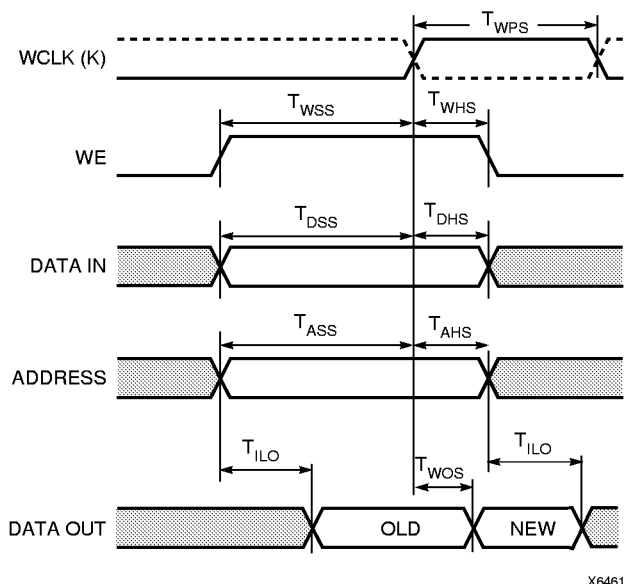


**Figure 4: Edge-Triggered RAM Write Timing**

Complex timing relationships between address, data, and write enable signals are not required, and the external write enable pulse becomes a simple clock enable. The active edge of WCLK latches the address, input data, and WE sig-

nals. An internal write pulse is generated that performs the write. See Figure 5 and Figure 6 for block diagrams of a CLB configured as 16x2 and 32x1 edge-triggered, single-port RAM.

The relationships between CLB pins and RAM inputs and outputs for single-port, edge-triggered mode are shown in Table 6.

The Write Clock input (WCLK) can be configured as active on either the rising edge (default) or the falling edge. It uses the same CLB pin (K) used to clock the CLB flip-flops, but it can be independently inverted. Consequently, the RAM output can optionally be registered within the same CLB either by the same clock edge as the RAM, or by the opposite edge of this clock. The sense of WCLK applies to both function generators in the CLB when both are configured as RAM.

The WE pin is active-High and is not invertible within the CLB.

**Note:** The pulse following the active edge of WCLK ($T_{WPS}$ in Figure 4) must be less than one millisecond wide. For most applications, this requirement is not overly restrictive; however, it must not be forgotten. Stopping WCLK at this point in the write cycle could result in excessive current and even damage to the larger devices if many CLBs are configured as edge-triggered RAM.

**Table 6: Single-Port Edge-Triggered RAM Signals**

| RAM Signal | CLB Pin | Function |
|---|---|---|
| D | D0 or D1 (16x2, 16x1), D0 (32x1) | Data In |
| A[3:0] | F1-F4 or G1-G4 | Address |
| A[4] | D1 (32x1) | Address |
| WE | WE | Write Enable |
| WCLK | K | Clock |
| SPO (Data Out) | F' or G' | Single Port Out (Data Out) |
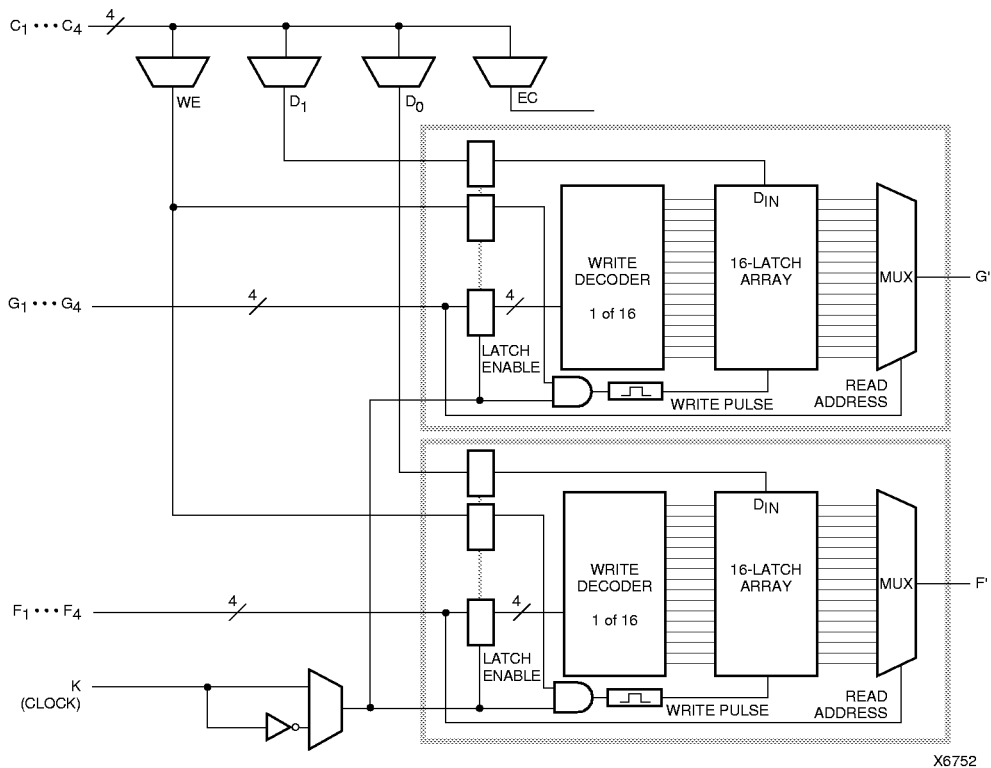
**Figure 5: 16x2 (or 16x1) Edge-Triggered Single-Port RAM**
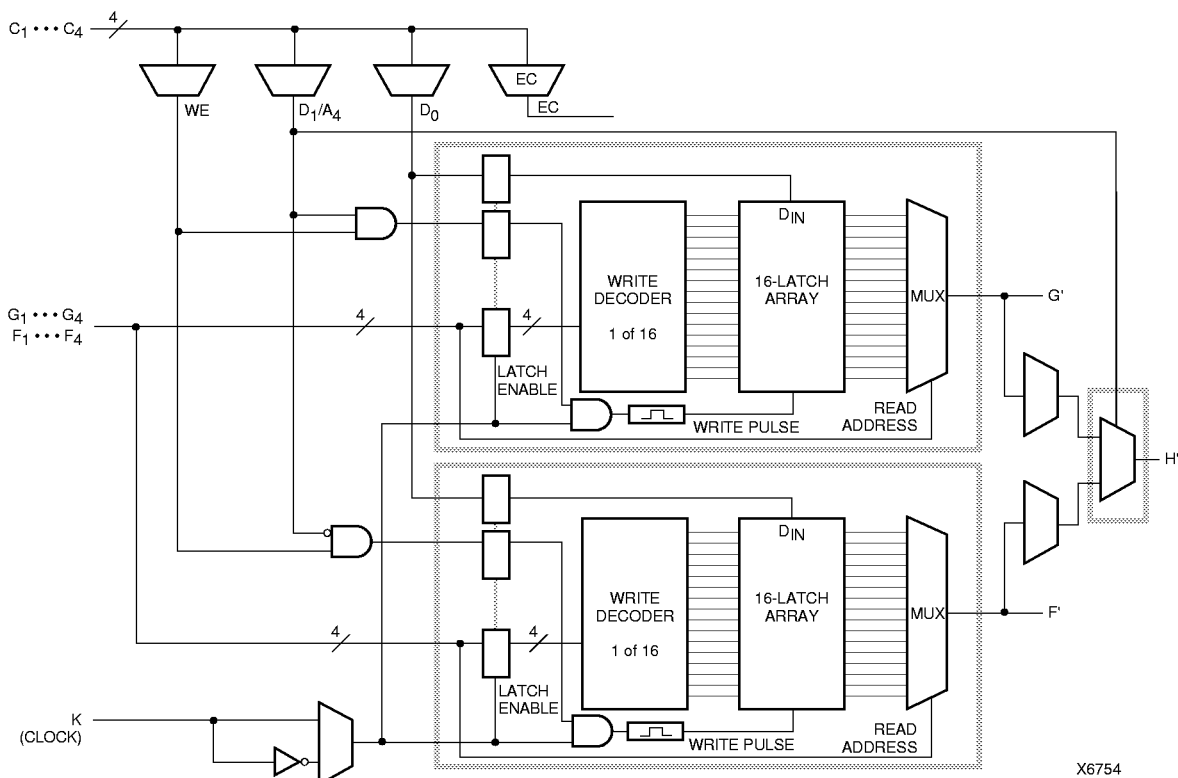


**Figure 6: 32x1 Edge-Triggered Single-Port RAM (F and G addresses are identical)**

## Dual-Port Edge-Triggered Mode

In dual-port mode, both the F and G function generators are used to create a single 16x1 RAM array with one write port and two read ports. The resulting RAM array can be read and written simultaneously at two independent addresses. Simultaneous read and write operations at the same address are also supported.

Dual-port mode always has edge-triggered write timing, as shown in Figure 4.

Figure 7 shows a simple model of an XC4000 Series CLB configured as dual-port RAM. One address port, labeled A[3:0], supplies both the read and write address for the F function generator. This function generator behaves the same as a 16x1 single-port edge-triggered RAM array. The RAM output, Single Port Out (SPO), appears at the F function generator output. SPO, therefore, reflects the data at address A[3:0].

The other address port, labeled DPRA[3:0] for Dual Port Read Address, supplies the read address for the G function generator. The write address for the G function generator, however, comes from the address A[3:0]. The output from this 16x1 RAM array, Dual Port Out (DPO), appears at the G function generator output. DPO, therefore, reflects the data at address DPRA[3:0].

Therefore, by using A[3:0] for the write address and DPRA[3:0] for the read address, and reading only the DPO output, a FIFO that can read and write simultaneously is easily generated. Simultaneous access doubles the effective throughput of the FIFO.

The relationships between CLB pins and RAM inputs and outputs for dual-port, edge-triggered mode are shown in Table 7. See Figure 8 on page 4-16 for a block diagram of a CLB configured in this mode.
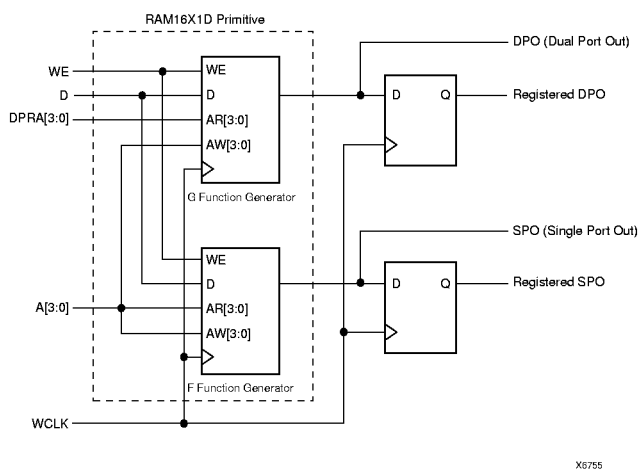


**Figure 7:   XC4000 Series Dual-Port RAM, Simple Model**

**Table 7: Dual-Port Edge-Triggered RAM Signals**

| RAM Signal | CLB Pin | Function |
|------------|---------|----------|
| D | D0 | Data In |
| A[3:0] | F1-F4 | Read Address for F, Write Address for F and G |
| DPRA[3:0] | G1-G4 | Read Address for G |
| WE | WE | Write Enable |
| WCLK | K | Clock |
| SPO | F' | Single Port Out (addressed by A[3:0]) |
| DPO | G' | Dual Port Out (addressed by DPRA[3:0]) |

**Note:** The pulse following the active edge of WCLK ($T_{WPS}$ in Figure 4) must be less than one millisecond wide. For most applications, this requirement is not overly restrictive; however, it must not be forgotten. Stopping WCLK at this point in the write cycle could result in excessive current and even damage to the larger devices if many CLBs are configured as edge-triggered RAM.

### Single-Port Level-Sensitive Timing Mode

**Note:** Edge-triggered mode is recommended for all new designs. Level-sensitive mode, also called asynchronous mode, is still supported for XC4000 Series backward-compatibility with the XC4000 family.

Level-sensitive RAM timing is simple in concept but can be complicated in execution. Data and address signals are presented, then a positive pulse on the write enable pin (WE) performs a write into the RAM at the designated address. As indicated by the "level-sensitive" label, this RAM acts like a latch. During the WE High pulse, changing the data lines results in new data written to the old address. Changing the address lines while WE is High results in spurious data written to the new address—and possibly at other addresses as well, as the address lines inevitably do not all change simultaneously.

The user must generate a carefully timed WE signal. The delay on the WE signal and the address lines must be carefully verified to ensure that WE does not become active until after the address lines have settled, and that WE goes inactive before the address lines change again. The data must be stable before and after the falling edge of WE.

In practical terms, WE is usually generated by a 2X clock. If a 2X clock is not available, the falling edge of the system clock can be used. However, there are inherent risks in this approach, since the WE pulse must be guaranteed inactive before the next rising edge of the system clock. Several older application notes are available from Xilinx that discuss the design of level-sensitive RAMs. These application notes include XAPP031, "*Using the XC4000 RAM Capability*," and XAPP042, "*High-Speed RAM Design in XC4000*." However, the edge-triggered RAM available in the XC4000 Series is superior to level-sensitive RAM for almost every application.
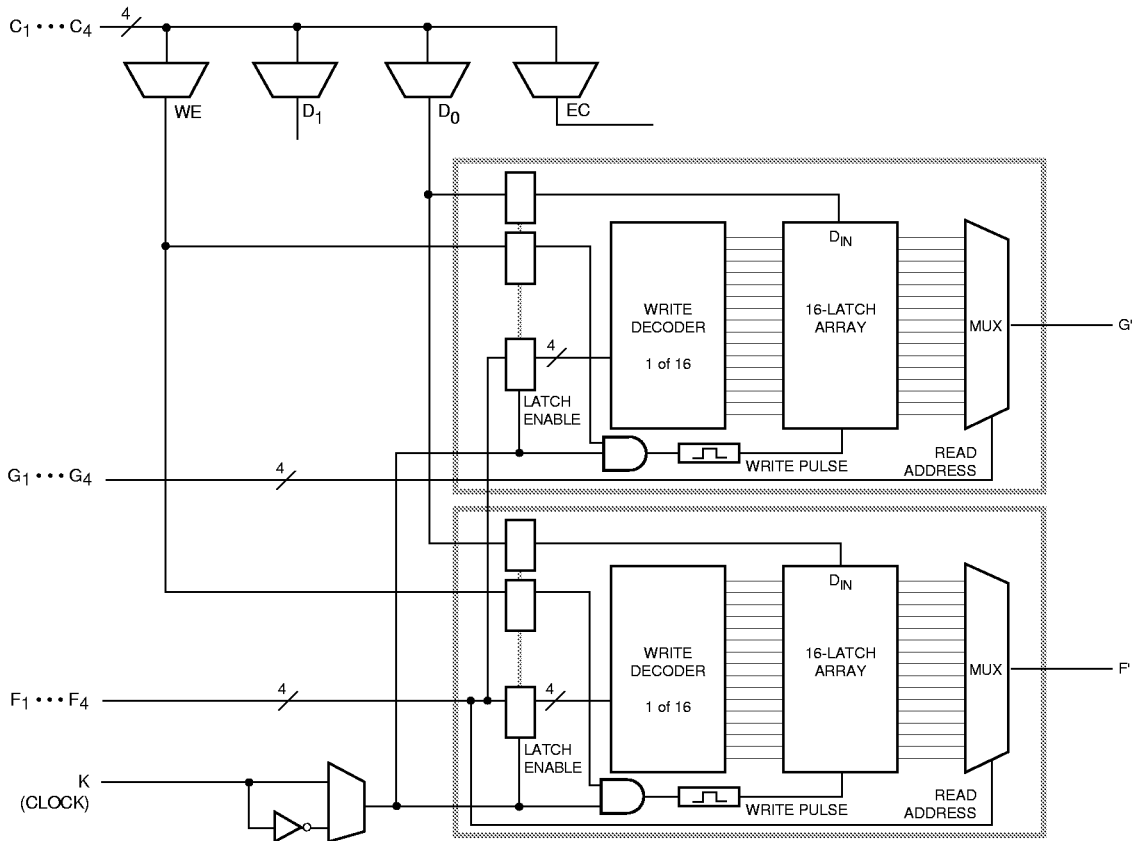
X6748

**Figure 8: 16x1 Edge-Triggered Dual-Port RAM**

Figure 9 shows the write timing for level-sensitive, single-port RAM.

The relationships between CLB pins and RAM inputs and outputs for single-port level-sensitive mode are shown in Table 8.

Figure 10 and Figure 11 show block diagrams of a CLB configured as 16x2 and 32x1 level-sensitive, single-port RAM.

**Initializing RAM at Configuration**

Both RAM and ROM implementations of the XC4000 Series devices are initialized during configuration. The initial contents are defined via an INIT attribute or property attached to the RAM or ROM symbol, as described in the schematic library guide. If not defined, all RAM contents are initialized to all zeros, by default.

RAM initialization occurs only during configuration. The RAM content is not affected by Global Set/Reset.

**Table 8: Single-Port Level-Sensitive RAM Signals**

| RAM Signal | CLB Pin | Function |
|---|---|---|
| D | D0 or D1 | Data In |
| A[3:0] | F1-F4 or G1-G4 | Address |
| WE | WE | Write Enable |
| O | F' or G' | Data Out |
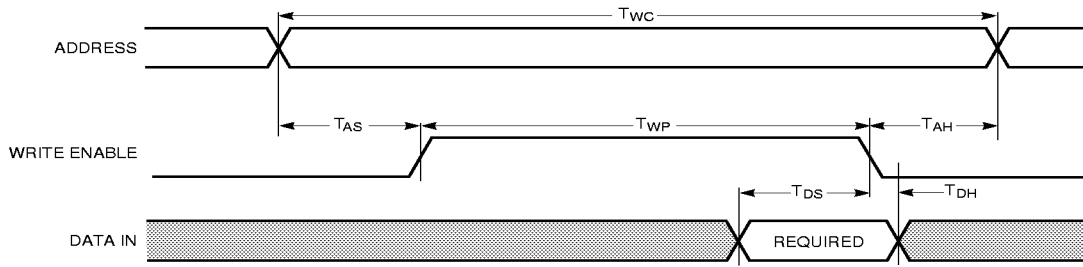
Figure 9: Level-Sensitive RAM Write Timing
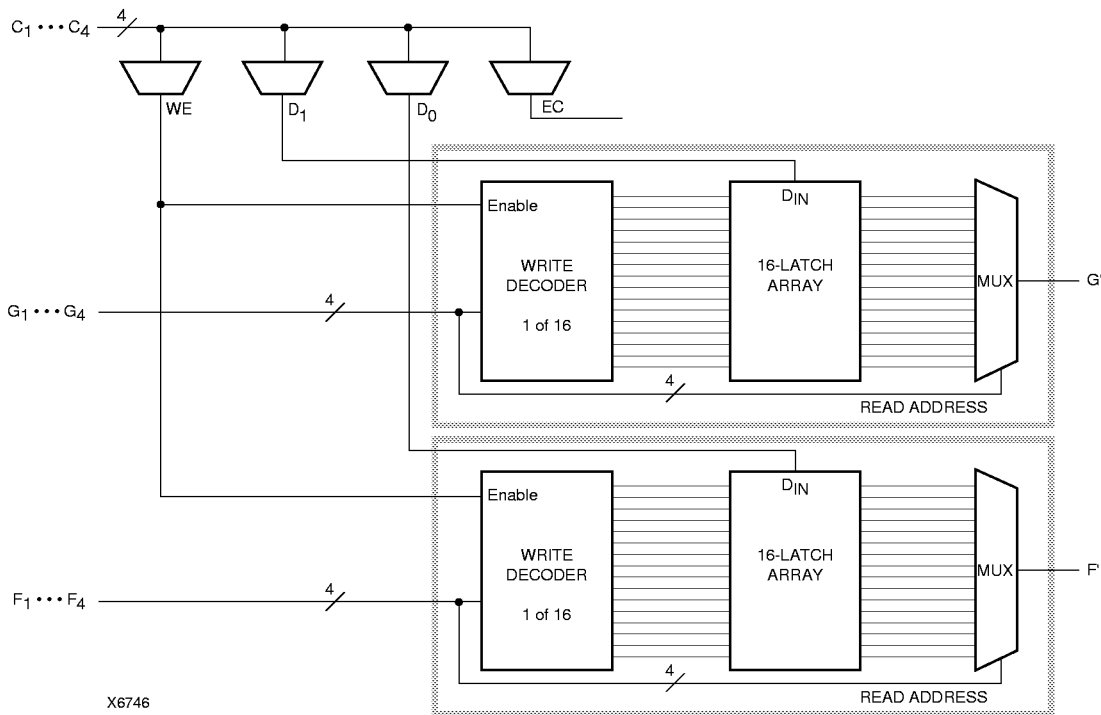


Figure 10: 16x2 (or 16x1) Level-Sensitive Single-Port RAM
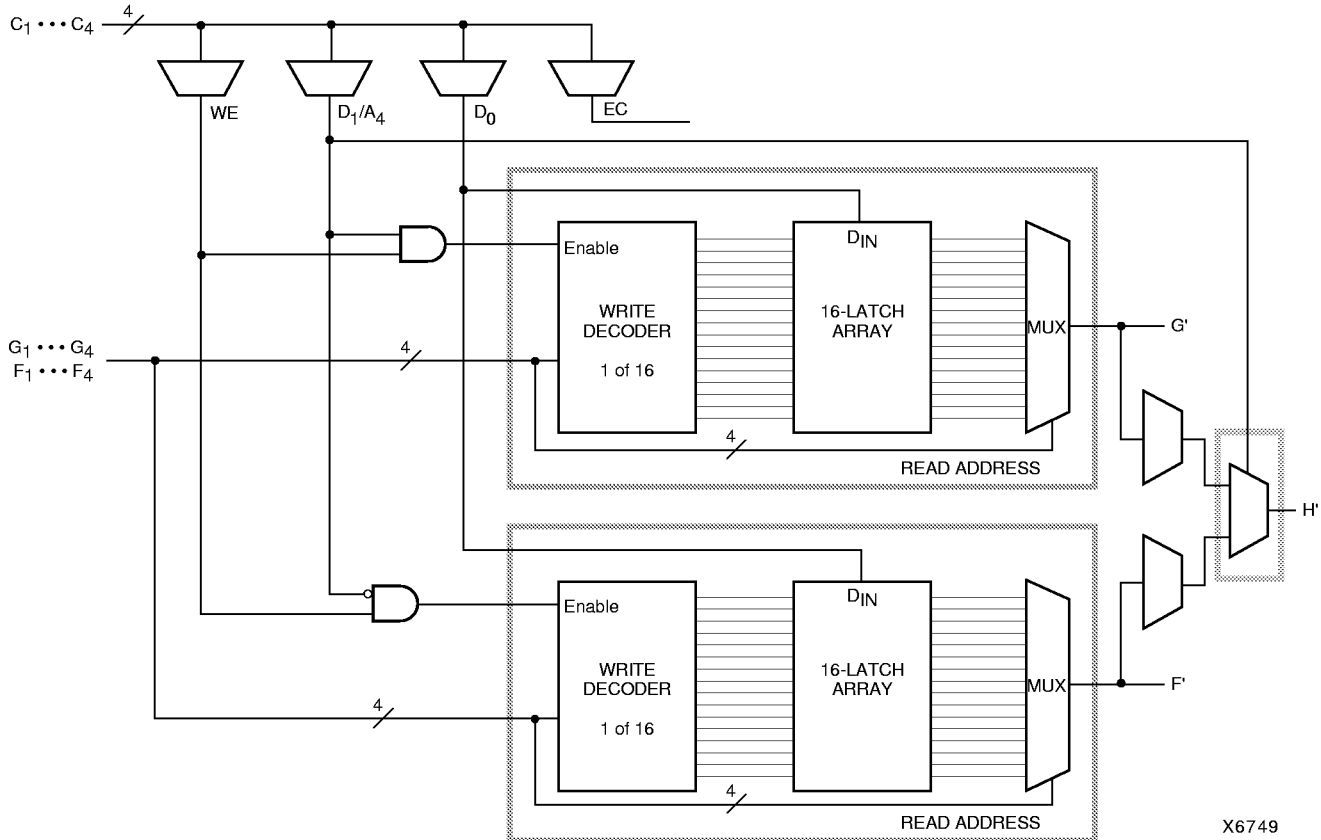
**Figure 11: 32x1 Level-Sensitive Single-Port RAM (F and G addresses are identical)**

## Fast Carry Logic

Each CLB F and G function generator contains dedicated arithmetic logic for the fast generation of carry and borrow signals. This extra output is passed on to the function generator in the adjacent CLB. The carry chain is independent of normal routing resources.

Dedicated fast carry logic greatly increases the efficiency and performance of adders, subtractors, accumulators, comparators and counters. It also opens the door to many new applications involving arithmetic operation, where the previous generations of FPGAs were not fast enough or too inefficient. High-speed address offset calculations in microprocessor or graphics systems, and high-speed addition in digital signal processing are two typical applications.

The two 4-input function generators can be configured as a 2-bit adder with built-in hidden carry that can be expanded to any length. This dedicated carry circuitry is so fast and efficient that conventional speed-up methods like carry generate/propagate are meaningless even at the 16-bit level, and of marginal benefit at the 32-bit level.

This fast carry logic is one of the more significant features of the XC4000 Series, speeding up arithmetic and counting into the 70 MHz range.

The carry chain in XC4000E devices can run either up or down. At the top and bottom of the columns where there are no CLBs above and below, the carry is propagated to the right. (See Figure 12.) In order to improve speed in the high-capacity XC4000X devices, which can potentially have very long carry chains, the carry chain travels upward only, as shown in Figure 13. Additionally, standard interconnect can be used to route a carry signal in the downward direction.

Figure 14 on page 4-20 shows an XC4000E CLB with dedicated fast carry logic. The carry logic in the XC4000X is similar, except that COUT exits at the top only, and the signal CINDOWN does not exist. As shown in Figure 14, the carry logic shares operand and control inputs with the function generators. The carry outputs connect to the function generators, where they are combined with the operands to form the sums.

Figure 15 on page 4-21 shows the details of the carry logic for the XC4000E. This diagram shows the contents of the box labeled "CARRY LOGIC" in Figure 14. The XC4000X carry logic is very similar, but a multiplexer on the pass-through carry chain has been eliminated to reduce delay. Additionally, in the XC4000X the multiplexer on the G4 path has a memory-programmable 0 input, which permits G4 to

directly connect to COUT. G4 thus becomes an additional high-speed initialization path for carry-in.

The dedicated carry logic is discussed in detail in Xilinx document XAPP 013: "*Using the Dedicated Carry Logic in XC4000.*" This discussion also applies to XC4000E devices, and to XC4000X devices when the minor logic changes are taken into account.

The fast carry logic can be accessed by placing special library symbols, or by using Xilinx Relationally Placed Macros (RPMs) that already include these symbols.
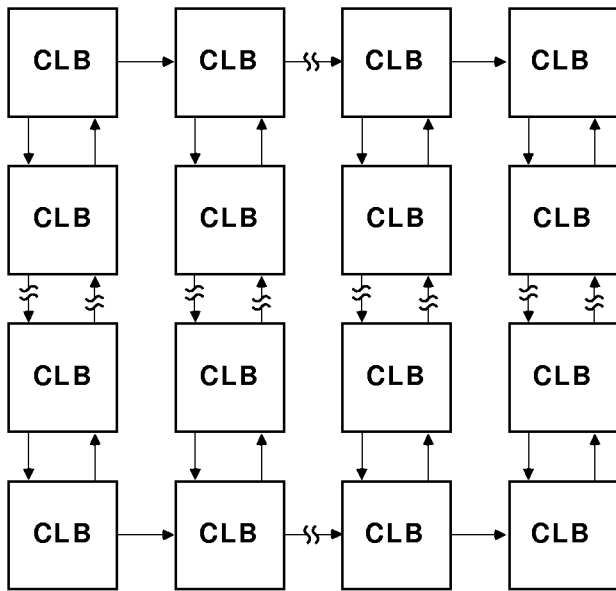


X6687

**Figure 12: Available XC4000E Carry Propagation Paths**
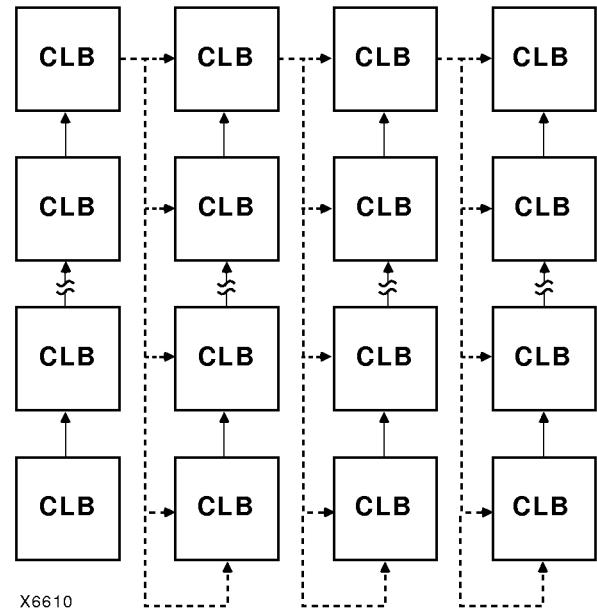


X6610

**Figure 13: Available XC4000X Carry Propagation Paths (dotted lines use general interconnect)**
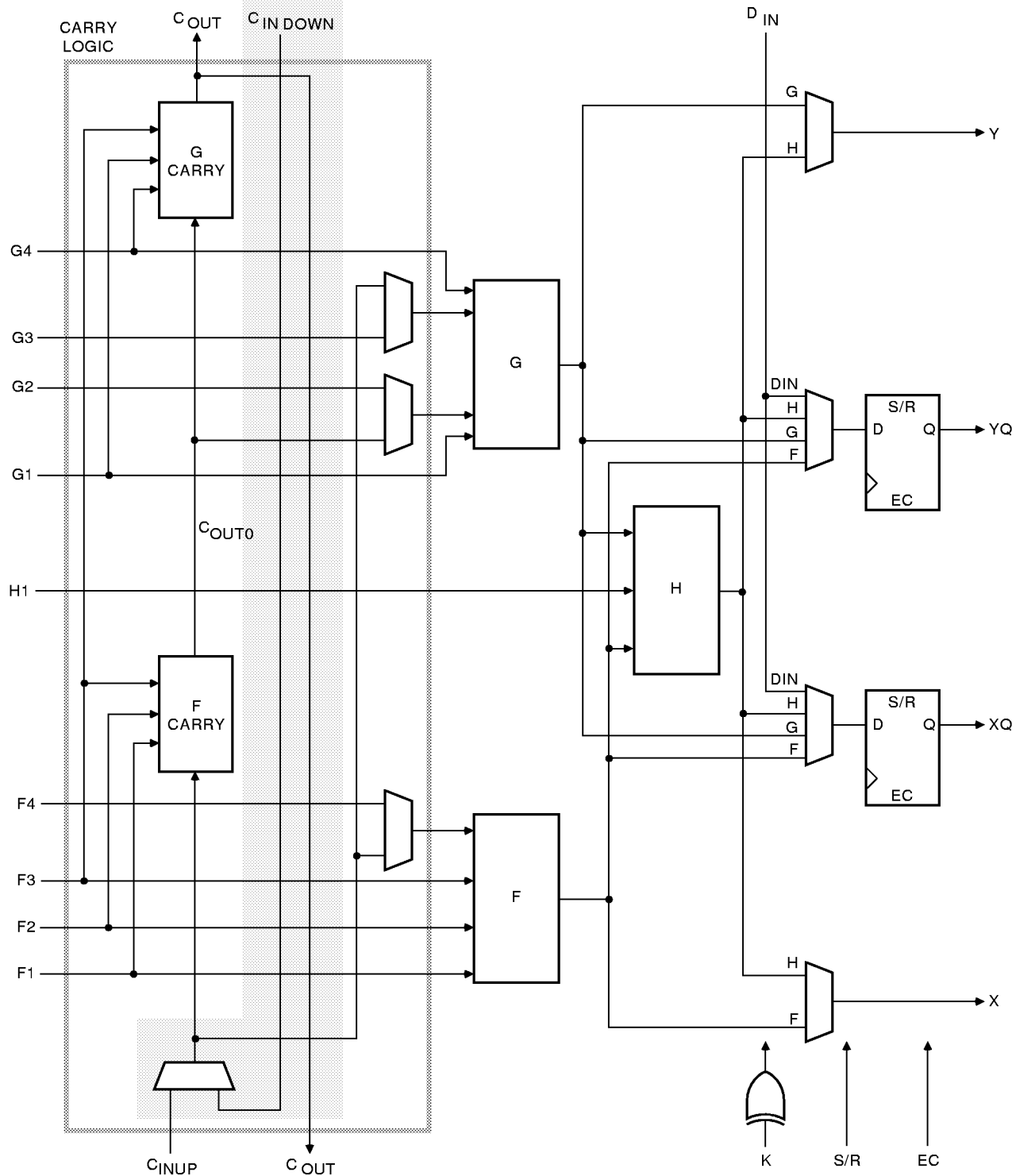
X6699

**Figure 14:   Fast Carry Logic in XC4000E CLB (shaded area not present in XC4000X)**

X2000
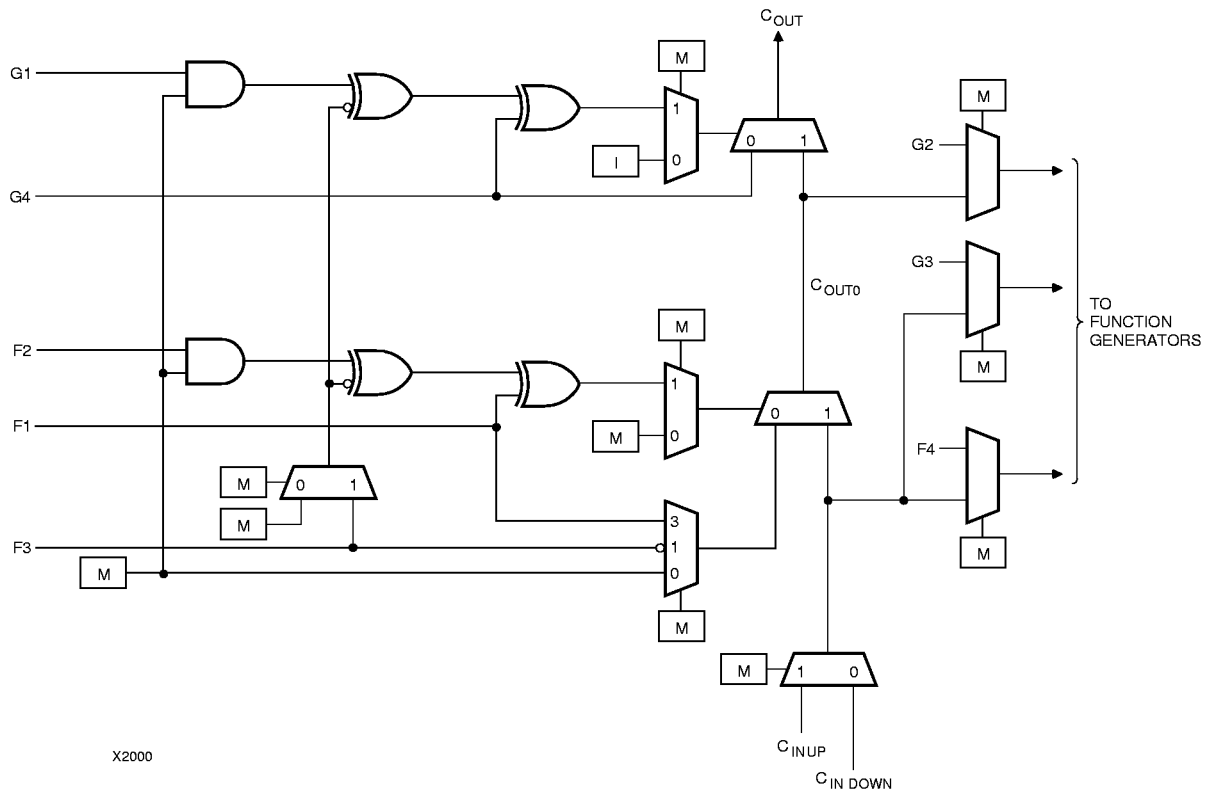
**Figure 15:  Detail of XC4000E Dedicated Carry Logic**

## Input/Output Blocks (IOBs)

User-configurable input/output blocks (IOBs) provide the interface between external package pins and the internal logic. Each IOB controls one package pin and can be configured for input, output, or bidirectional signals.

Figure 16 shows a simplified block diagram of the XC4000E IOB. A more complete diagram which includes the boundary scan logic of the XC4000E IOB can be found in Figure 41 on page 4-44, in the "Boundary Scan" section.

The XC4000X IOB contains some special features not included in the XC4000E IOB. These features are highlighted in a simplified block diagram found in Figure 17, and discussed throughout this section. When XC4000X special features are discussed, they are clearly identified in the text. Any feature not so identified is present in both XC4000E and XC4000X devices.

### IOB Input Signals

Two paths, labeled I1 and I2 in Figure 16 and Figure 17, bring input signals into the array. Inputs also connect to an input register that can be programmed as either an edge-triggered flip-flop or a level-sensitive latch.

The choice is made by placing the appropriate library symbol. For example, IFD is the basic input flip-flop (rising edge triggered), and ILD is the basic input latch (transparent-High). Variations with inverted clocks are available, and some combinations of latches and flip-flops can be implemented in a single IOB, as described in the *XACT Libraries Guide*.

The XC4000E inputs can be globally configured for either TTL (1.2V) or 5.0 volt CMOS thresholds, using an option in the bitstream generation software. There is a slight input hysteresis of about 300mV. The XC4000E output levels are also configurable; the two global adjustments of input threshold and output level are independent.

Inputs on the XC4000XL are TTL compatible and 3.3V CMOS compatible. Outputs on the XC4000XL are pulled to the 3.3V positive supply.

The inputs of XC4000 Series 5-Volt devices can be driven by the outputs of any 3.3-Volt device, if the 5-Volt inputs are in TTL mode.

Supported sources for XC4000 Series device inputs are shown in Table 9.
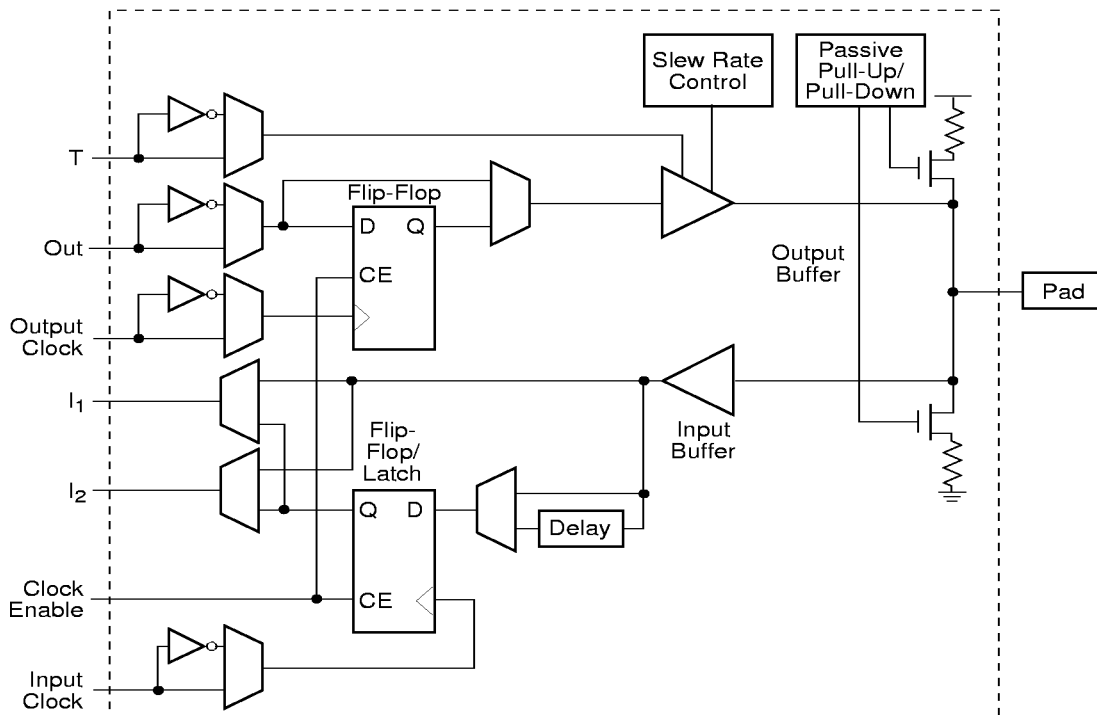
**Figure 16: Simplified Block Diagram of XC4000E IOB**
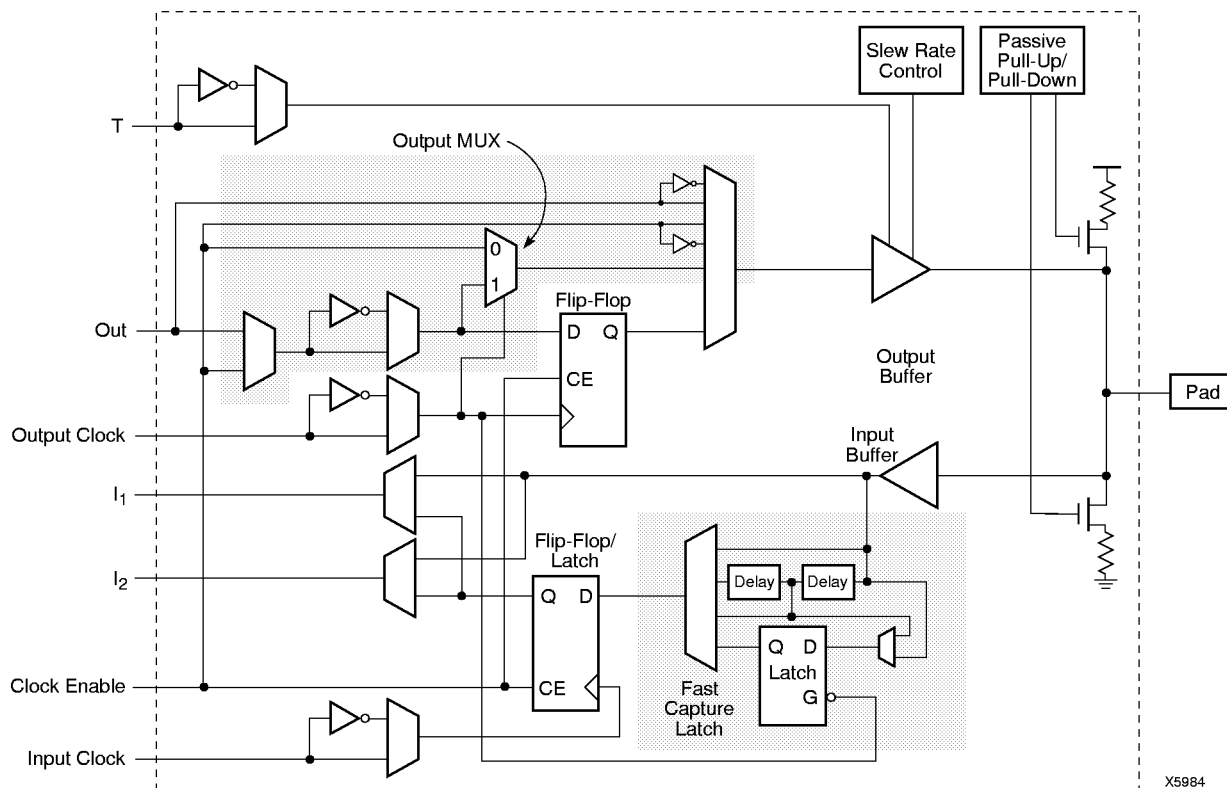


**Figure 17: Simplified Block Diagram of XC4000X IOB (shaded areas indicate differences from XC4000E)**

## Table 9: Supported Sources for XC4000 Series Device Inputs

| Source | XC4000E/EX Series Inputs | | XC4000XL Series Inputs |
|---|---|---|---|
| | 5 V, TTL | 5 V, CMOS | 3.3 V CMOS |
| Any device, Vcc = 3.3 V, CMOS outputs | √ | Unreli -able Data | √ |
| XC4000 Series, Vcc = 5 V, TTL outputs | √ | | √ |
| Any device, Vcc = 5 V, TTL outputs (Voh ≤ 3.7 V) | √ | | √ |
| Any device, Vcc = 5 V, CMOS outputs | √ | √ | √ |

### XC4000XL 5-Volt Tolerant I/Os

The I/Os on the XC4000XL are fully 5-volt tolerant even though the $V_{CC}$ is 3.3 volts. This allows 5 V signals to directly connect to the XC4000XL inputs without damage, as shown in Table 9. In addition, the 3.3 volt $V_{CC}$ can be applied before or after 5 volt signals are applied to the I/Os. This makes the XC4000XL immune to power supply sequencing problems.

### Registered Inputs

The I1 and I2 signals that exit the block can each carry either the direct or registered input signal.

The input and output storage elements in each IOB have a common clock enable input, which, through configuration, can be activated individually for the input or output flip-flop, or both. This clock enable operates exactly like the EC pin on the XC4000 Series CLB. It cannot be inverted within the IOB.

The storage element behavior is shown in Table 10.

### Table 10: Input Register Functionality (active rising edge is shown)

| Mode | Clock | Clock Enable | D | Q |
|---|---|---|---|---|
| Power-Up or GSR | X | X | X | SR |
| Flip-Flop | __/ | 1* | D | D |
| | 0 | X | X | Q |
| Latch | 1 | 1* | X | Q |
| | 0 | 1* | D | D |
| Both | X | 0 | X | Q |

Legend:
X __ Don't care
__/ Rising edge
SR Set or Reset value. Reset is default.
0* Input is Low or unconnected (default value)
1* Input is High or unconnected (default value)

### Optional Delay Guarantees Zero Hold Time

The data input to the register can optionally be delayed by several nanoseconds. With the delay enabled, the setup time of the input flip-flop is increased so that normal clock routing does not result in a positive hold-time requirement. A positive hold time requirement can lead to unreliable, temperature- or processing-dependent operation.

The input flip-flop setup time is defined between the data measured at the device I/O pin and the clock input at the IOB (not at the clock pin). Any routing delay from the device clock pin to the clock input of the IOB must, therefore, be subtracted from this setup time to arrive at the real setup time requirement relative to the device pins. A short specified setup time might, therefore, result in a negative setup time at the device pins, i.e., a positive hold-time requirement.

When a delay is inserted on the data line, more clock delay can be tolerated without causing a positive hold-time requirement. Sufficient delay eliminates the possibility of a data hold-time requirement at the external pin. The maximum delay is therefore inserted as the default.

The XC4000E IOB has a one-tap delay element: either the delay is inserted (default), or it is not. The delay guarantees a zero hold time with respect to clocks routed through any of the XC4000E global clock buffers. (See "Global Nets and Buffers (XC4000E only)" on page 4-36 for a description of the global clock buffers in the XC4000E.) For a shorter input register setup time, with non-zero hold, attach a NODELAY attribute or property to the flip-flop.

The XC4000X IOB has a two-tap delay element, with choices of a full delay, a partial delay, or no delay. The attributes or properties used to select the desired delay are shown in Table 11. The choices are no added attribute, MEDDELAY, and NODELAY. The default setting, with no added attribute, ensures no hold time with respect to any of the XC4000X clock buffers, including the Global Low-Skew buffers. MEDDELAY ensures no hold time with respect to the Global Early buffers. Inputs with NODELAY may have a positive hold time with respect to all clock buffers. For a description of each of these buffers, see "Global Nets and Buffers (XC4000X only)" on page 4-38.

### Table 11: XC4000X IOB Input Delay Element

| Value | When to Use |
|---|---|
| full delay (default, no attribute added) | Zero Hold with respect to Global Low-Skew Buffer, Global Early Buffer |
| MEDDELAY | Zero Hold with respect to Global Early Buffer |
| NODELAY | Short Setup, positive Hold time |

## Additional Input Latch for Fast Capture (XC4000X only)

The XC4000X IOB has an additional optional latch on the input. This latch, as shown in Figure 17, is clocked by the output clock — the clock used for the output flip-flop — rather than the input clock. Therefore, two different clocks can be used to clock the two input storage elements. This additional latch allows the very fast capture of input data, which is then synchronized to the internal clock by the IOB flip-flop or latch.

To use this Fast Capture technique, drive the output clock pin (the Fast Capture latching signal) from the output of one of the Global Early buffers supplied in the XC4000X. The second storage element should be clocked by a Global Low-Skew buffer, to synchronize the incoming data to the internal logic. (See Figure 18.) These special buffers are described in "Global Nets and Buffers (XC4000X only)" on page 4-38.

The Fast Capture latch (FCL) is designed primarily for use with a Global Early buffer. For Fast Capture, a single clock signal is routed through both a Global Early buffer and a Global Low-Skew buffer. (The two buffers share an input pad.) The Fast Capture latch is clocked by the Global Early buffer, and the standard IOB flip-flop or latch is clocked by the Global Low-Skew buffer. This mode is the safest way to use the Fast Capture latch, because the clock buffers on both storage elements are driven by the same pad. There is no external skew between clock pads to create potential problems.

To place the Fast Capture latch in a design, use one of the special library symbols, ILFFX or ILFLX. ILFFX is a transparent-Low Fast Capture latch followed by an active-High input flip-flop. ILFLX is a transparent-Low Fast Capture latch followed by a transparent-High input latch. Any of the clock inputs can be inverted before driving the library element, and the inverter is absorbed into the IOB. If a single BUFG output is used to drive both clock inputs, the software automatically runs the clock through both a Global Low-Skew buffer and a Global Early buffer, and clocks the Fast Capture latch appropriately.

Figure 17 on page 4-22 also shows a two-tap delay on the input. By default, if the Fast Capture latch is used, the Xilinx software assumes a Global Early buffer is driving the clock, and selects MEDDELAY to ensure a zero hold time. Select
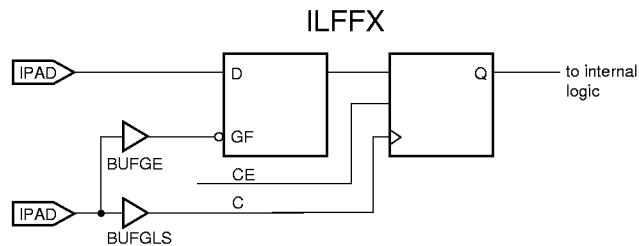
the desired delay based on the discussion in the previous subsection.

## IOB Output Signals

Output signals can be optionally inverted within the IOB, and can pass directly to the pad or be stored in an edge-triggered flip-flop. The functionality of this flip-flop is shown in Table 12.

An active-High 3-state signal can be used to place the output buffer in a high-impedance state, implementing 3-state outputs or bidirectional I/O. Under configuration control, the output (OUT) and output 3-state (T) signals can be inverted. The polarity of these signals is independently configured for each IOB.

The 4-mA maximum output current specification of many FPGAs often forces the user to add external buffers, which are especially cumbersome on bidirectional I/O lines. The XC4000E and XC4000EX/XL devices solve many of these problems by providing a guaranteed output sink current of 12 mA. Two adjacent outputs can be interconnected externally to sink up to 24 mA. The XC4000E and XC4000EX/XL FPGAs can thus directly drive buses on a printed circuit board.

By default, the output pull-up structure is configured as a TTL-like totem-pole. The High driver is an n-channel pull-up transistor, pulling to a voltage one transistor threshold below Vcc. Alternatively, the outputs can be globally configured as CMOS drivers, with p-channel pull-up transistors pulling to Vcc. This option, applied using the bitstream generation software, applies to all outputs on the device. It is not individually programmable. In the XC4000XL, all outputs are pulled to the positive supply rail.

**Table 12: Output Flip-Flop Functionality (active rising edge is shown)**

| Mode | Clock | Clock Enable | T | D | Q |
|------|-------|--------------|---|---|---|
| Power-Up or GSR | X | X | 0* | X | SR |
| Flip-Flop | X | 0 | 0* | X | Q |
| | _/¯ | 1* | 0* | D | D |
| | X | X | 1 | X | Z |
| | 0 | X | 0* | X | Q |

Legend:
X       Don't care
_/¯     Rising edge
SR      Set or Reset value. Reset is default.
0*      Input is Low or unconnected (default value)
1*      Input is High or unconnected (default value)
Z       3-state

ILFFX



X9013

**Figure 18:   Examples Using XC4000X FCL**

Any XC4000 Series 5-Volt device with its outputs configured in TTL mode can drive the inputs of any typical 3.3-Volt device. (For a detailed discussion of how to interface between 5 V and 3.3 V devices, see the 3V Products section of *The Programmable Logic Data Book*.)

Supported destinations for XC4000 Series device outputs are shown in Table 13.

An output can be configured as open-drain (open-collector) by placing an OBUFT symbol in a schematic or HDL code, then tying the 3-state pin (T) to the output signal, and the input pin (I) to Ground. (See Figure 19.)

**Table 13: Supported Destinations for XC4000 Series Outputs**

| Destination | XC4000 Series Outputs | | |
|---|---|---|---|
| | 3.3 V, CMOS | 5 V, TTL | 5 V, CMOS |
| Any typical device, Vcc = 3.3 V, CMOS-threshold inputs | √ | √ | some[1] |
| Any device, Vcc = 5 V, TTL-threshold inputs | √ | √ | √ |
| Any device, Vcc = 5 V, CMOS-threshold inputs | Unreliable Data | | √ |

1. Only if destination device has 5-V tolerant inputs
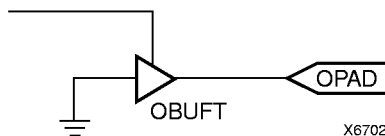


**Figure 19: Open-Drain Output**

### Output Slew Rate

The slew rate of each output buffer is, by default, reduced, to minimize power bus transients when switching non-critical signals. For critical signals, attach a FAST attribute or property to the output buffer or flip-flop.

For XC4000E devices, maximum total capacitive load for simultaneous fast mode switching in the same direction is 200 pF for all package pins between each Power/Ground pin pair. For XC4000X devices, additional internal Power/Ground pin pairs are connected to special Power and Ground planes within the packages, to reduce ground bounce. Therefore, the maximum total capacitive load is 300 pF between each external Power/Ground pin pair. Maximum loading may vary for the low-voltage devices.

For slew-rate limited outputs this total is two times larger for each device type: 400 pF for XC4000E devices and 600 pF for XC4000X devices. This maximum capacitive load should not be exceeded, as it can result in ground bounce of greater than 1.5 V amplitude and more than 5 ns duration. This level of ground bounce may cause undesired transient behavior on an output, or in the internal logic. This restriction is common to all high-speed digital ICs, and is not particular to Xilinx or the XC4000 Series.

XC4000 Series devices have a feature called "Soft Startup," designed to reduce ground bounce when all outputs are turned on simultaneously at the end of configuration. When the configuration process is finished and the device starts up, the first activation of the outputs is automatically slew-rate limited. Immediately following the initial activation of the I/O, the slew rate of the individual outputs is determined by the individual configuration option for each IOB.

### Global Three-State

A separate Global 3-State line (not shown in Figure 16 or Figure 17) forces all FPGA outputs to the high-impedance state, unless boundary scan is enabled and is executing an EXTEST instruction. This global net (GTS) does not compete with other routing resources; it uses a dedicated distribution network.

GTS can be driven from any user-programmable pin as a global 3-state input. To use this global net, place an input pad and input buffer in the schematic or HDL code, driving the GTS pin of the STARTUP symbol. A specific pin location can be assigned to this input using a LOC attribute or property, just as with any other user-programmable pad. An inverter can optionally be inserted after the input buffer to invert the sense of the Global 3-State signal. Using GTS is similar to GSR. See Figure 3 on page 4-11 for details.

Alternatively, GTS can be driven from any internal node.

## Output Multiplexer/2-Input Function Generator (XC4000X only)

As shown in Figure 17 on page 4-22, the output path in the XC4000X IOB contains an additional multiplexer not available in the XC4000E IOB. The multiplexer can also be configured as a 2-input function generator, implementing a pass-gate, AND-gate, OR-gate, or XOR-gate, with 0, 1, or 2 inverted inputs. The logic used to implement these functions is shown in the upper gray area of Figure 17.

When configured as a multiplexer, this feature allows two output signals to time-share the same output pad; effectively doubling the number of device outputs without requiring a larger, more expensive package.

When the MUX is configured as a 2-input function generator, logic can be implemented within the IOB itself. Combined with a Global Early buffer, this arrangement allows very high-speed gating of a single signal. For example, a wide decoder can be implemented in CLBs, and its output gated with a Read or Write Strobe Driven by a BUFGE buffer, as shown in Figure 20. The critical-path pin-to-pin delay of this circuit is less than 6 nanoseconds.

As shown in Figure 17, the IOB input pins Out, Output Clock, and Clock Enable have different delays and different flexibilities regarding polarity. Additionally, Output Clock sources are more limited than the other inputs. Therefore, the Xilinx software does not move logic into the IOB function generators unless explicitly directed to do so.

The user can specify that the IOB function generator be used, by placing special library symbols beginning with the letter "O." For example, a 2-input AND-gate in the IOB function generator is called OAND2. Use the symbol input pin labelled "F" for the signal on the critical path. This signal is placed on the OK pin — the IOB input with the shortest delay to the function generator. Two examples are shown in Figure 21.



X9019
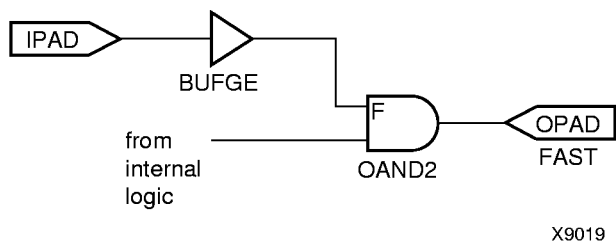
**Figure 20: Fast Pin-to-Pin Path in XC4000X**



**Figure 21: AND & MUX Symbols in XC4000X IOB**

## Other IOB Options

There are a number of other programmable options in the XC4000 Series IOB.

### Pull-up and Pull-down Resistors

Programmable pull-up and pull-down resistors are useful for tying unused pins to Vcc or Ground to minimize power consumption and reduce noise sensitivity. The configurable pull-up resistor is a p-channel transistor that pulls to Vcc. The configurable pull-down resistor is an n-channel transistor that pulls to Ground.

The value of these resistors is 50 k$\Omega$ – 100 k$\Omega$. This high value makes them unsuitable as wired-AND pull-up resistors.

The pull-up resistors for most user-programmable IOBs are active during the configuration process. See Table 23 on page 4-58 for a list of pins with pull-ups active before and during configuration.

After configuration, voltage levels of unused pads, bonded or unbonded, must be valid logic levels, to reduce noise sensitivity and avoid excess current. Therefore, by default, unused pads are configured with the internal pull-up resistor active. Alternatively, they can be individually configured with the pull-down resistor, or as a driven output, or to be driven by an external source. To activate the internal pull-up, attach the PULLUP library component to the net attached to the pad. To activate the internal pull-down, attach the PULLDOWN library component to the net attached to the pad.

### Independent Clocks

Separate clock signals are provided for the input and output flip-flops. The clock can be independently inverted for each flip-flop within the IOB, generating either falling-edge or rising-edge triggered flip-flops. The clock inputs for each IOB are independent, except that in the XC4000X, the Fast Capture latch shares an IOB input with the output clock pin.

### Early Clock for IOBs (XC4000X only)

Special early clocks are available for IOBs. These clocks are sourced by the same sources as the Global Low-Skew buffers, but are separately buffered. They have fewer loads and therefore less delay. The early clock can drive either the IOB output clock or the IOB input clock, or both. The early clock allows fast capture of input data, and fast clock-to-output on output data. The Global Early buffers that drive these clocks are described in "Global Nets and Buffers (XC4000X only)" on page 4-38.

### Global Set/Reset

As with the CLB registers, the Global Set/Reset signal (GSR) can be used to set or clear the input and output registers, depending on the value of the INIT attribute or property. The two flip-flops can be individually configured to set

or clear on reset and after configuration. Other than the global GSR net, no user-controlled set/reset signal is available to the I/O flip-flops. The choice of set or clear applies to both the initial state of the flip-flop and the response to the Global Set/Reset pulse. See "Global Set/Reset" on page 4-11 for a description of how to use GSR.

### JTAG Support

Embedded logic attached to the IOBs contains test structures compatible with IEEE Standard 1149.1 for boundary scan testing, permitting easy chip and board-level testing. More information is provided in "Boundary Scan" on page 4-43.

## Three-State Buffers

A pair of 3-state buffers is associated with each CLB in the array. (See Figure 28 on page 4-31.) These 3-state buffers can be used to drive signals onto the nearest horizontal longlines above and below the CLB. They can therefore be used to implement multiplexed or bidirectional buses on the horizontal longlines, saving logic resources. Programmable pull-up resistors attached to these longlines help to implement a wide wired-AND function.

The buffer enable is an active-High 3-state (i.e. an active-Low enable), as shown in Table 14.

Another 3-state buffer with similar access is located near each I/O block along the right and left edges of the array. (See Figure 34 on page 4-35.)

The horizontal longlines driven by the 3-state buffers have a weak keeper at each end. This circuit prevents undefined floating levels. However, it is overridden by any driver, even a pull-up resistor.

Special longlines running along the perimeter of the array can be used to wire-AND signals coming from nearby IOBs or from internal longlines. These longlines form the wide edge decoders discussed in "Wide Edge Decoders" on page 4-28.

### Three-State Buffer Modes

The 3-state buffers can be configured in three modes:

- Standard 3-state buffer
- Wired-AND with input on the I pin
- Wired OR-AND

### Standard 3-State Buffer

All three pins are used. Place the library element BUFT. Connect the input to the I pin and the output to the O pin. The T pin is an active-High 3-state (i.e. an active-Low enable). Tie the T pin to Ground to implement a standard buffer.

### Wired-AND with Input on the I Pin

The buffer can be used as a Wired-AND. Use the WAND1 library symbol, which is essentially an open-drain buffer. WAND4, WAND8, and WAND16 are also available. See the *XACT Libraries Guide* for further information.

The T pin is internally tied to the I pin. Connect the input to the I pin and the output to the O pin. Connect the outputs of all the WAND1s together and attach a PULLUP symbol.

### Wired OR-AND

The buffer can be configured as a Wired OR-AND. A High level on either input turns off the output. Use the WOR2AND library symbol, which is essentially an open-drain 2-input OR gate. The two input pins are functionally equivalent. Attach the two inputs to the I0 and I1 pins and tie the output to the O pin. Tie the outputs of all the WOR2ANDs together and attach a PULLUP symbol.

### *Three-State Buffer Examples*

Figure 22 shows how to use the 3-state buffers to implement a wired-AND function. When all the buffer inputs are High, the pull-up resistor(s) provide the High output.

Figure 23 shows how to use the 3-state buffers to implement a multiplexer. The selection is accomplished by the buffer 3-state signal.

Pay particular attention to the polarity of the T pin when using these buffers in a design. Active-High 3-state (T) is identical to an active-Low output enable, as shown in Table 14.

**Table 14: Three-State Buffer Functionality**

| IN | T | OUT |
| --- | --- | --- |
| X | 1 | Z |
| IN | 0 | IN |

$$Z = D_A \cdot D_B \cdot (D_C + D_D) \cdot (D_E + D_F)$$
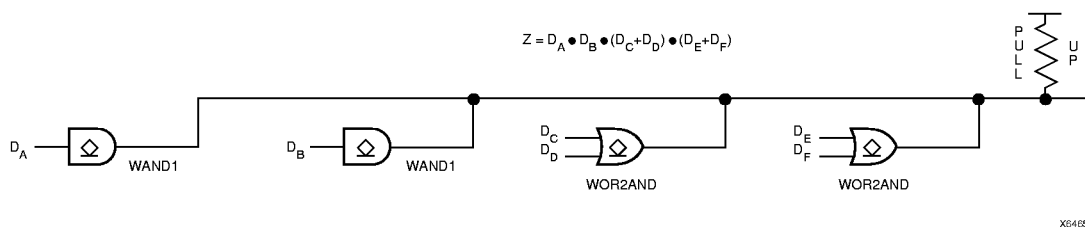
**Figure 22:   Open-Drain Buffers Implement a Wired-AND Function**

$$Z = D_A \cdot \overline{A} + D_B \cdot \overline{B} + D_C \cdot \overline{C} + D_N \cdot \overline{N}$$
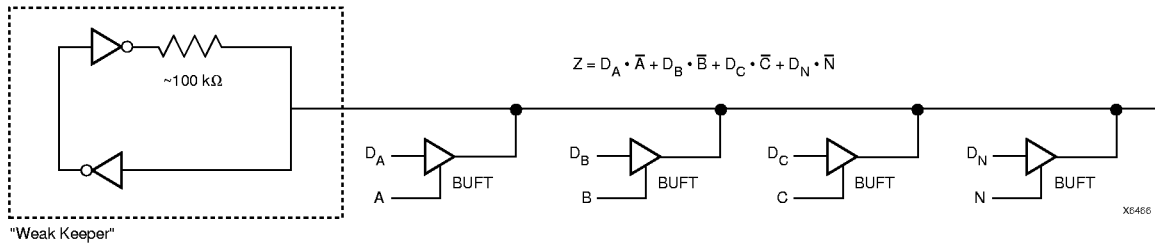
**Figure 23: 3-State Buffers Implement a Multiplexer**

## Wide Edge Decoders

Dedicated decoder circuitry boosts the performance of wide decoding functions. When the address or data field is wider than the function generator inputs, FPGAs need multi-level decoding and are thus slower than PALs. XC4000 Series CLBs have nine inputs. Any decoder of up to nine inputs is, therefore, compact and fast. However, there is also a need for much wider decoders, especially for address decoding in large microprocessor systems.

An XC4000 Series FPGA has four programmable decoders located on each edge of the device. The inputs to each decoder are any of the IOB I1 signals on that edge plus one local interconnect per CLB row or column. Each row or column of CLBs provides up to three variables or their compliments., as shown in Figure 24. Each decoder generates a High output (resistor pull-up) when the AND condition of the selected inputs, or their complements, is true. This is analogous to a product term in typical PAL devices.

Each of these wired-AND gates is capable of accepting up to 42 inputs on the XC4005E and 72 on the XC4013E. There are up to 96 inputs for each decoder on the XC4028X and 132 on the XC4052X. The decoders may also be split in two when a larger number of narrower decoders are required, for a maximum of 32 decoders per device.

The decoder outputs can drive CLB inputs, so they can be combined with other logic to form a PAL-like AND/OR structure. The decoder outputs can also be routed directly to the chip outputs. For fastest speed, the output should be on the same chip edge as the decoder. Very large PALs can be emulated by ORing the decoder outputs in a CLB. This decoding feature covers what has long been considered a weakness of older FPGAs. Users often resorted to external PALs for simple but fast decoding functions. Now, the dedicated decoders in the XC4000 Series device can implement these functions fast and efficiently.

To use the wide edge decoders, place one or more of the WAND library symbols (WAND1, WAND4, WAND8, WAND16). Attach a DECODE attribute or property to each WAND symbol. Tie the outputs together and attach a PUL-

LUP symbol. Location attributes or properties such as L (left edge) or TR (right half of top edge) should also be used to ensure the correct placement of the decoder inputs.
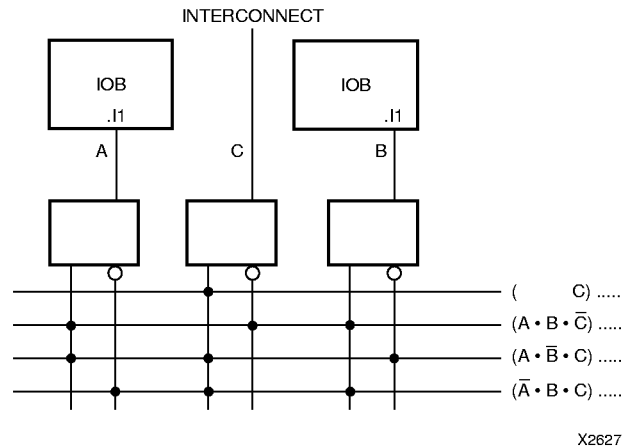


**Figure 24: XC4000 Series Edge Decoding Example**
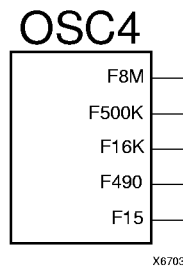


**Figure 25: XC4000 Series Oscillator Symbol**

## On-Chip Oscillator

XC4000 Series devices include an internal oscillator. This oscillator is used to clock the power-on time-out, for configuration memory clearing, and as the source of CCLK in Master configuration modes. The oscillator runs at a nominal 8 MHz frequency that varies with process, Vcc, and temperature. The output frequency falls between 4 and 10 MHz.

The oscillator output is optionally available after configuration. Any two of four resynchronized taps of a built-in divider are also available. These taps are at the fourth, ninth, fourteenth and nineteenth bits of the divider. Therefore, if the primary oscillator output is running at the nominal 8 MHz, the user has access to an 8 MHz clock, plus any two of 500 kHz, 16kHz, 490Hz and 15Hz (up to 10% lower for low-voltage devices). These frequencies can vary by as much as -50% or +25%.

These signals can be accessed by placing the OSC4 library element in a schematic or in HDL code (see Figure 25).

The oscillator is automatically disabled after configuration if the OSC4 symbol is not used in the design.

## Programmable Interconnect

All internal connections are composed of metal segments with programmable switching points and switching matrices to implement the desired routing. A structured, hierarchical matrix of routing resources is provided to achieve efficient automated routing.

The XC4000E and XC4000X share a basic interconnect structure. XC4000X devices, however, have additional routing not available in the XC4000E. The extra routing resources allow high utilization in high-capacity devices. All XC4000X-specific routing resources are clearly identified throughout this section. Any resources not identified as XC4000X-specific are present in all XC4000 Series devices.

This section describes the varied routing resources available in XC4000 Series devices. The implementation software automatically assigns the appropriate resources based on the density and timing requirements of the design.

### Interconnect Overview

There are several types of interconnect.

- CLB routing is associated with each row and column of the CLB array.
- IOB routing forms a ring (called a VersaRing) around the outside of the CLB array. It connects the I/O with the internal logic blocks.

- Global routing consists of dedicated networks primarily designed to distribute clocks throughout the device with minimum delay and skew. Global routing can also be used for other high-fanout signals.

Five interconnect types are distinguished by the relative length of their segments: single-length lines, double-length lines, quad and octal lines (XC4000X only), and longlines. In the XC4000X, direct connects allow fast data flow between adjacent CLBs, and between IOBs and CLBs.

Extra routing is included in the IOB pad ring. The XC4000X also includes a ring of octal interconnect lines near the IOBs to improve pin-swapping and routing to locked pins.

XC4000E/X devices include two types of global buffers. These global buffers have different properties, and are intended for different purposes. They are discussed in detail later in this section.

### CLB Routing Connections

A high-level diagram of the routing resources associated with one CLB is shown in Figure 26. The shaded arrows represent routing present only in XC4000X devices.

Table 15 shows how much routing of each type is available in XC4000E and XC4000X CLB arrays. Clearly, very large designs, or designs with a great deal of interconnect, will route more easily in the XC4000X. Smaller XC4000E designs, typically requiring significantly less interconnect, do not require the additional routing.

Figure 28 on page 4-31 is a detailed diagram of both the XC4000E and the XC4000X CLB, with associated routing. The shaded square is the programmable switch matrix, present in both the XC4000E and the XC4000X. The L-shaped shaded area is present only in XC4000X devices. As shown in the figure, the XC4000X block is essentially an XC4000E block with additional routing.

CLB inputs and outputs are distributed on all four sides, providing maximum routing flexibility. In general, the entire architecture is symmetrical and regular. It is well suited to established placement and routing algorithms. Inputs, outputs, and function generators can freely swap positions within a CLB to avoid routing congestion during the placement and routing operation.
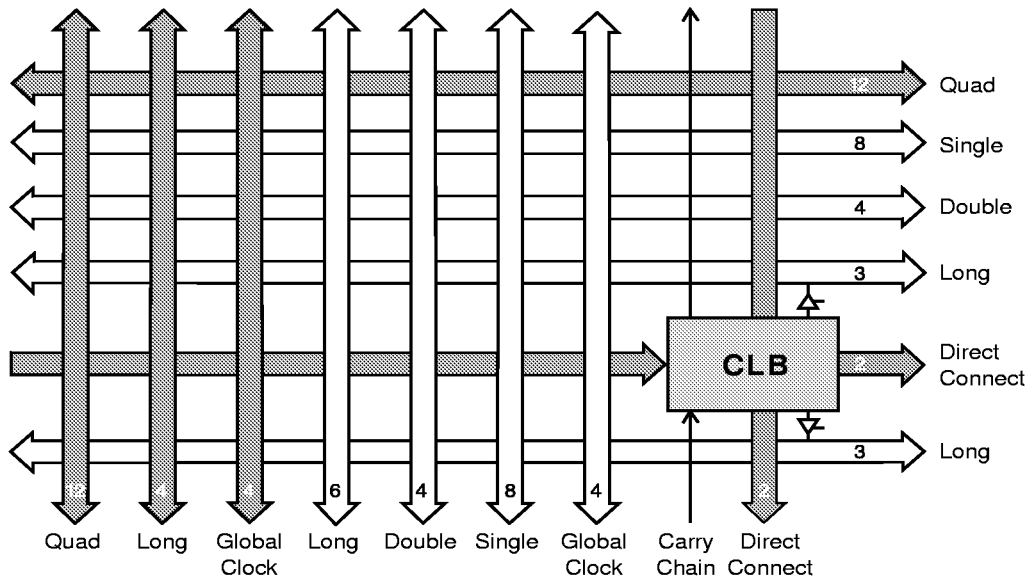
x5994

**Figure 26:   High-Level Routing Diagram of XC4000 Series CLB (shaded arrows indicate XC4000X only)**

**Table 15: Routing per CLB in XC4000 Series Devices**

|  | XC4000E | | XC4000X | |
|---|---|---|---|---|
|  | Vertical | Horizontal | Vertical | Horizontal |
| Singles | 8 | 8 | 8 | 8 |
| Doubles | 4 | 4 | 4 | 4 |
| Quads | 0 | 0 | 12 | 12 |
| Longlines | 6 | 6 | 10 | 6 |
| Direct Connects | 0 | 0 | 2 | 2 |
| Globals | 4 | 0 | 8 | 0 |
| Carry Logic | 2 | 0 | 1 | 0 |
| Total | 24 | 18 | 45 | 32 |
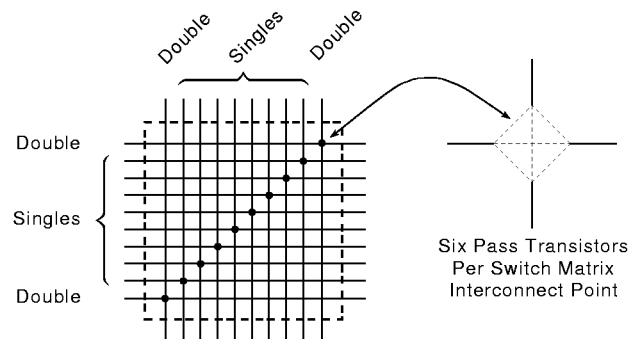


X6600

**Figure 27:   Programmable Switch Matrix (PSM)**

## Programmable Switch Matrices

The horizontal and vertical single- and double-length lines intersect at a box called a programmable switch matrix (PSM). Each switch matrix consists of programmable pass transistors used to establish connections between the lines (see Figure 27).

For example, a single-length signal entering on the right side of the switch matrix can be routed to a single-length line on the top, left, or bottom sides, or any combination thereof, if multiple branches are required. Similarly, a double-length signal can be routed to a double-length line on any or all of the other three edges of the programmable switch matrix.

## Single-Length Lines

Single-length lines provide the greatest interconnect flexibility and offer fast routing between adjacent blocks. There are eight vertical and eight horizontal single-length lines associated with each CLB. These lines connect the switching matrices that are located in every row and a column of CLBs.

Single-length lines are connected by way of the programmable switch matrices, as shown in Figure 29. Routing connectivity is shown in Figure 28.

Single-length lines incur a delay whenever they go through a switching matrix. Therefore, they are not suitable for routing signals for long distances. They are normally used to conduct signals within a localized area and to provide the branching for nets with fanout greater than one.

**Figure 28: Detail of Programmable Interconnect Associated with XC4000 Series CLB**
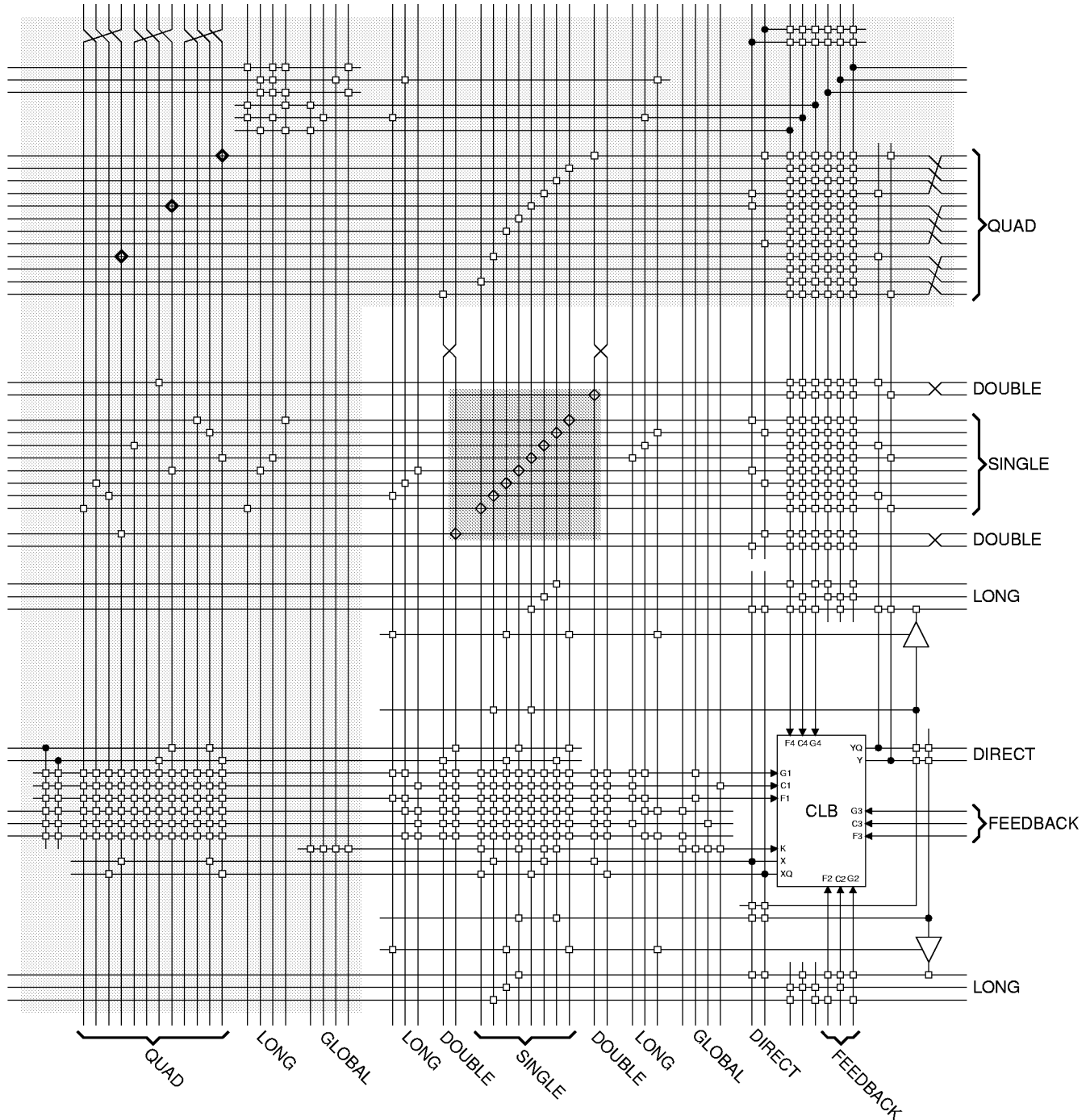
□ Common to XC4000E and XC4000X

▨ XC4000X only

▨ Programmable Switch Matrix
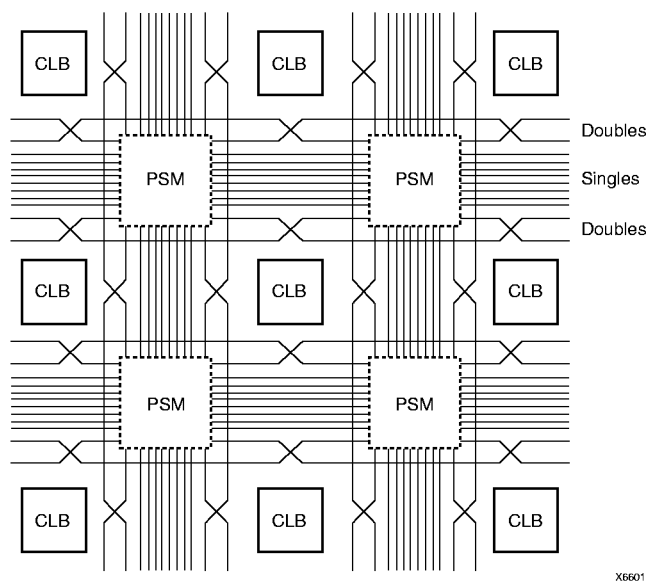
**Figure 29: Single- and Double-Length Lines, with Programmable Switch Matrices (PSMs)**

## Double-Length Lines

The double-length lines consist of a grid of metal segments, each twice as long as the single-length lines: they run past two CLBs before entering a switch matrix. Double-length lines are grouped in pairs with the switch matrices staggered, so that each line goes through a switch matrix at every other row or column of CLBs (see Figure 29).

There are four vertical and four horizontal double-length lines associated with each CLB. These lines provide faster signal routing over intermediate distances, while retaining routing flexibility. Double-length lines are connected by way of the programmable switch matrices. Routing connectivity is shown in Figure 28.

## Quad Lines (XC4000X only)

XC4000X devices also include twelve vertical and twelve horizontal quad lines per CLB row and column. Quad lines are four times as long as the single-length lines. They are interconnected via buffered switch matrices (shown as diamonds in Figure 28 on page 4-31). Quad lines run past four CLBs before entering a buffered switch matrix. They are grouped in fours, with the buffered switch matrices staggered, so that each line goes through a buffered switch matrix at every fourth CLB location in that row or column. (See Figure 30.)

The buffered switch matrixes have four pins, one on each edge. All of the pins are bidirectional. Any pin can drive any or all of the other pins.

Each buffered switch matrix contains one buffer and six pass transistors. It resembles the programmable switch matrix shown in Figure 27, with the addition of a programmable buffer. There can be up to two independent inputs
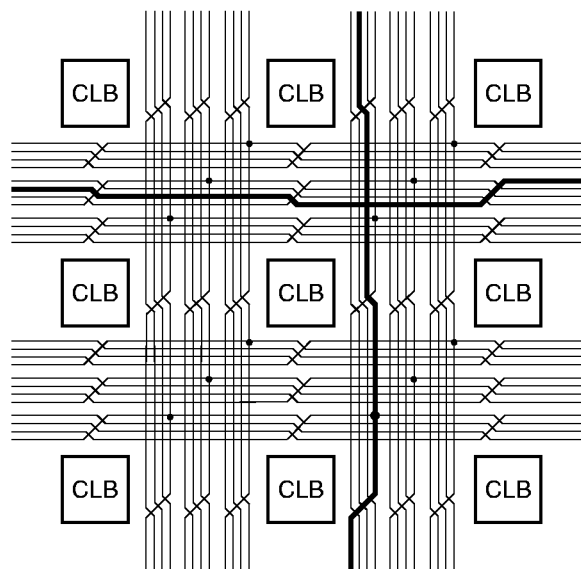


**Figure 30: Quad Lines (XC4000X only)**

and up to two independent outputs. Only one of the independent inputs can be buffered.

The place and route software automatically uses the timing requirements of the design to determine whether or not a quad line signal should be buffered. A heavily loaded signal is typically buffered, while a lightly loaded one is not. One scenario is to alternate buffers and pass transistors. This allows both vertical and horizontal quad lines to be buffered at alternating buffered switch matrices.

Due to the buffered switch matrices, quad lines are very fast. They provide the fastest available method of routing heavily loaded signals for long distances across the device.

## Longlines

Longlines form a grid of metal interconnect segments that run the entire length or width of the array. Longlines are intended for high fan-out, time-critical signal nets, or nets that are distributed over long distances. In XC4000X devices, quad lines are preferred for critical nets, because the buffered switch matrices make them faster for high fan-out nets.

Two horizontal longlines per CLB can be driven by 3-state or open-drain drivers (TBUFs). They can therefore implement unidirectional or bidirectional buses, wide multiplexers, or wired-AND functions. (See "Three-State Buffers" on page 4-27 for more details.)

Each horizontal longline driven by TBUFs has either two (XC4000E) or eight (XC4000X) pull-up resistors. To activate these resistors, attach a PULLUP symbol to the longline net. The software automatically activates the appropriate number of pull-ups. There is also a weak keeper at each end of these two horizontal longlines. This circuit pre-

vents undefined floating levels. However, it is overridden by any driver, even a pull-up resistor.

Each XC4000E longline has a programmable splitter switch at its center, as does each XC4000X longline driven by TBUFs. This switch can separate the line into two independent routing channels, each running half the width or height of the array.

Each XC4000X longline not driven by TBUFs has a buffered programmable splitter switch at the 1/4, 1/2, and 3/4 points of the array. Due to the buffering, XC4000X longline performance does not deteriorate with the larger array sizes. If the longline is split, the resulting partial longlines are independent.

Routing connectivity of the longlines is shown in Figure 28 on page 4-31.

### Direct Interconnect (XC4000X only)

The XC4000X offers two direct, efficient and fast connections between adjacent CLBs. These nets facilitate a data flow from the left to the right side of the device, or from the top to the bottom, as shown in Figure 31. Signals routed on the direct interconnect exhibit minimum interconnect propagation delay and use no general routing resources.

The direct interconnect is also present between CLBs and adjacent IOBs. Each IOB on the left and top device edges has a direct path to the nearest CLB. Each CLB on the right and bottom edges of the array has a direct path to the nearest two IOBs, since there are two IOBs for each row or column of CLBs.

The place and route software uses direct interconnect whenever possible, to maximize routing resources and minimize interconnect delays.
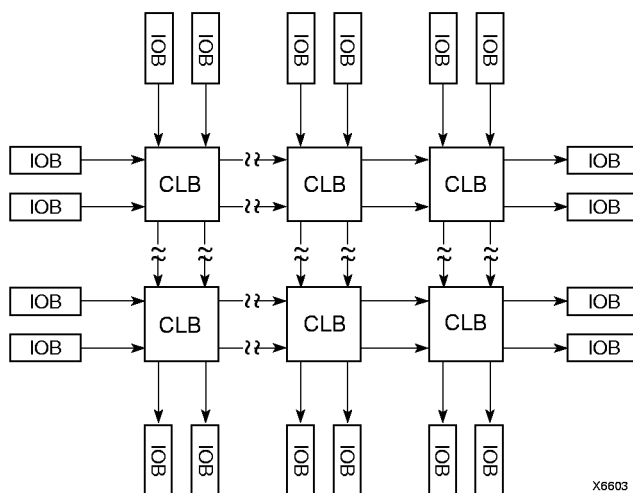


**Figure 31: XC4000X Direct Interconnect**

## I/O Routing

XC4000 Series devices have additional routing around the IOB ring. This routing is called a VersaRing. The VersaRing facilitates pin-swapping and redesign without affecting board layout. Included are eight double-length lines spanning two CLBs (four IOBs), and four longlines. Global lines and Wide Edge Decoder lines are provided. XC4000X devices also include eight octal lines.

A high-level diagram of the VersaRing is shown in Figure 32. The shaded arrows represent routing present only in XC4000X devices.

Figure 34 on page 4-35 is a detailed diagram of the XC4000E and XC4000X VersaRing. The area shown includes two IOBs. There are two IOBs per CLB row or column, therefore this diagram corresponds to the CLB routing diagram shown in Figure 28 on page 4-31. The shaded areas represent routing and routing connections present only in XC4000X devices.

### Octal I/O Routing (XC4000X only)

Between the XC4000X CLB array and the pad ring, eight interconnect tracks provide for versatility in pin assignment and fixed pinout flexibility. (See Figure 33 on page 4-34.)

These routing tracks are called octals, because they can be broken every eight CLBs (sixteen IOBs) by a programmable buffer that also functions as a splitter switch. The buffers are staggered, so each line goes through a buffer at every eighth CLB location around the device edge.

The octal lines bend around the corners of the device. The lines cross at the corners in such a way that the segment most recently buffered before the turn has the farthest distance to travel before the next buffer, as shown in Figure 33.
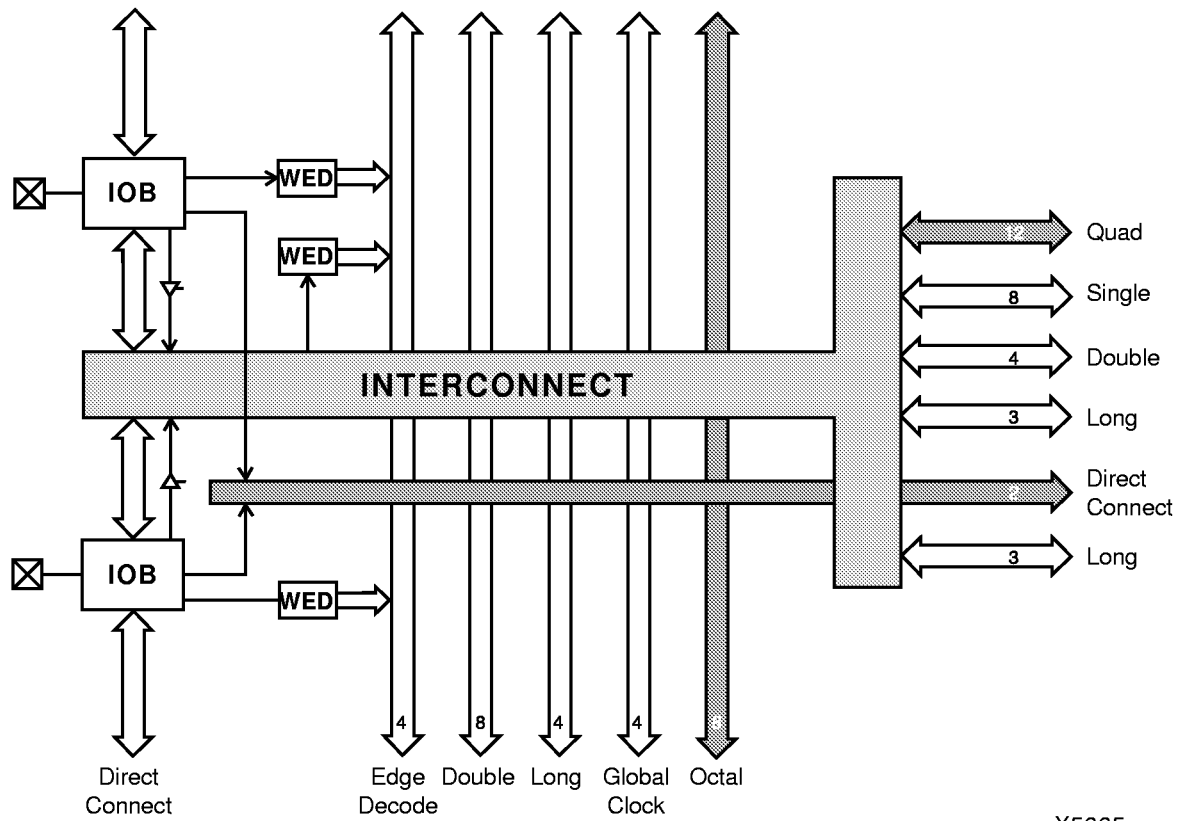
**Figure 32: High-Level Routing Diagram of XC4000 Series VersaRing (Left Edge)**
WED = Wide Edge Decoder, IOB = I/O Block (shaded arrows indicate XC4000X only)
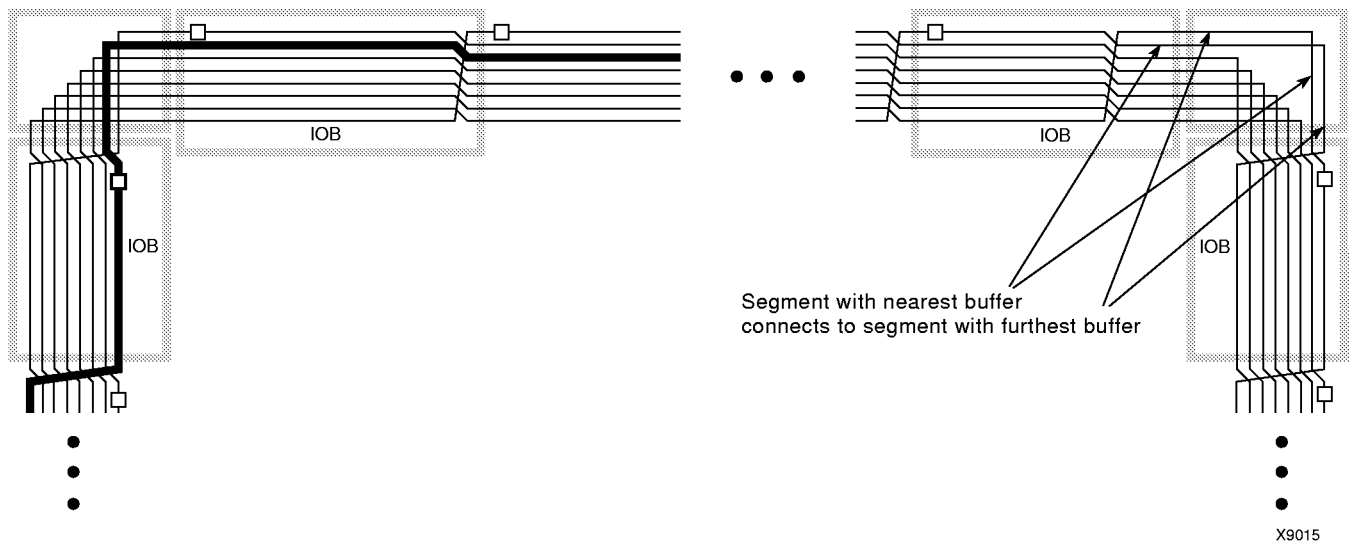


**Figure 33: XC4000X Octal I/O Routing**
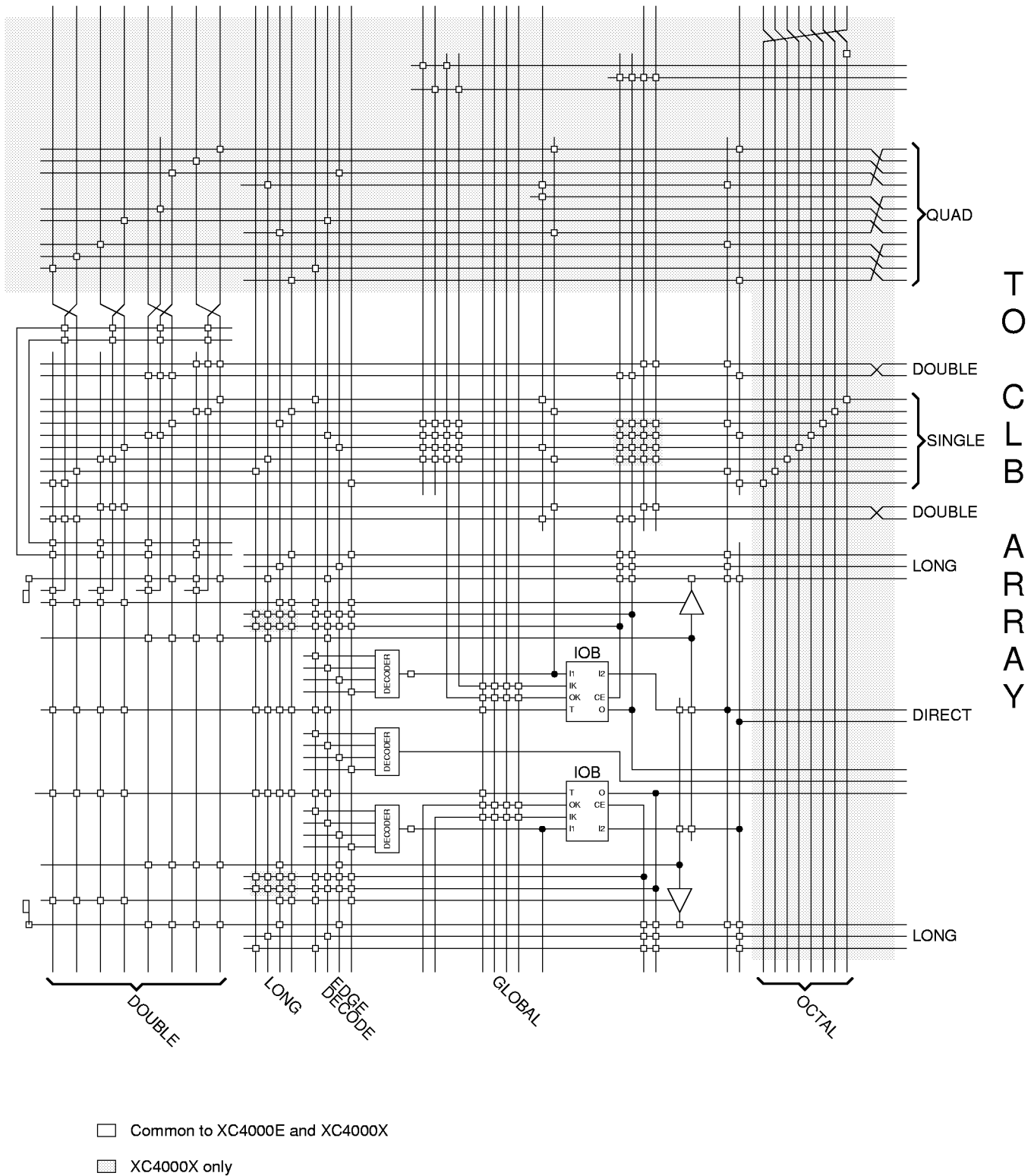
**Figure 34:   Detail of Programmable Interconnect Associated with XC4000 Series IOB (Left Edge)**

Legend:
- Common to XC4000E and XC4000X
- XC4000X only

IOB inputs and outputs interface with the octal lines via the single-length interconnect lines. Single-length lines are also used for communication between the octals and double-length lines, quads, and longlines within the CLB array.

Segmentation into buffered octals was found to be optimal for distributing signals over long distances around the device.

## Global Nets and Buffers

Both the XC4000E and the XC4000X have dedicated global networks. These networks are designed to distribute clocks and other high fanout control signals throughout the devices with minimal skew. The global buffers are described in detail in the following sections. The text descriptions and diagrams are summarized in Table 16. The table shows which CLB and IOB clock pins can be sourced by which global buffers.

In both XC4000E and XC4000X devices, placement of a library symbol called BUFG results in the software choosing the appropriate clock buffer, based on the timing requirements of the design. The detailed information in these sections is included only for reference.

### Global Nets and Buffers (XC4000E only)

Four vertical longlines in each CLB column are driven exclusively by special global buffers. These longlines are in addition to the vertical longlines used for standard interconnect. The four global lines can be driven by either of two types of global buffers. The clock pins of every CLB and IOB can also be sourced from local interconnect.

Two different types of clock buffers are available in the XC4000E:

- Primary Global Buffers (BUFGP)
- Secondary Global Buffers (BUFGS)

Four Primary Global buffers offer the shortest delay and negligible skew. Four Secondary Global buffers have slightly longer delay and slightly more skew due to potentially heavier loading, but offer greater flexibility when used to drive non-clock CLB inputs.

The Primary Global buffers must be driven by the semi-dedicated pads. The Secondary Global buffers can be sourced by either semi-dedicated pads or internal nets.

Each CLB column has four dedicated vertical Global lines. Each of these lines can be accessed by one particular Primary Global buffer, or by any of the Secondary Global buffers, as shown in Figure 35. Each corner of the device has one Primary buffer and one Secondary buffer.

IOBs along the left and right edges have four vertical global longlines. Top and bottom IOBs can be clocked from the global lines in the adjacent CLB column.

A global buffer should be specified for all timing-sensitive global signal distribution. To use a global buffer, place a BUFGP (primary buffer), BUFGS (secondary buffer), or BUFG (either primary or secondary buffer) element in a schematic or in HDL code. If desired, attach a LOC attribute or property to direct placement to the designated location. For example, attach a LOC=L attribute or property to a BUFGS symbol to direct that a buffer be placed in one of the two Secondary Global buffers on the left edge of the device, or a LOC=BL to indicate the Secondary Global buffer on the bottom edge of the device, on the left.

**Table 16: Clock Pin Access**

| | XC4000E | | XC4000X | | | Local |
| | BUFGP | BUFGS | BUFGLS | L & R BUFGE | T & B BUFGE | Inter-connect |
|---|---|---|---|---|---|---|
| All CLBs in Quadrant | √ | √ | √ | √ | √ | √ |
| All CLBs in Device | √ | √ | √ | | | √ |
| IOBs on Adjacent Vertical Half Edge | √ | √ | √ | √ | √ | √ |
| IOBs on Adjacent Vertical Full Edge | √ | √ | √ | √ | | √ |
| IOBs on Adjacent Horizontal Half Edge (Direct) | | | | √ | | √ |
| IOBs on Adjacent Horizontal Half Edge (through CLB globals) | √ | √ | √ | √ | √ | √ |
| IOBs on Adjacent Horizontal Full Edge (through CLB globals) | √ | √ | √ | | | √ |

L = Left, R = Right, T = Top, B = Bottom
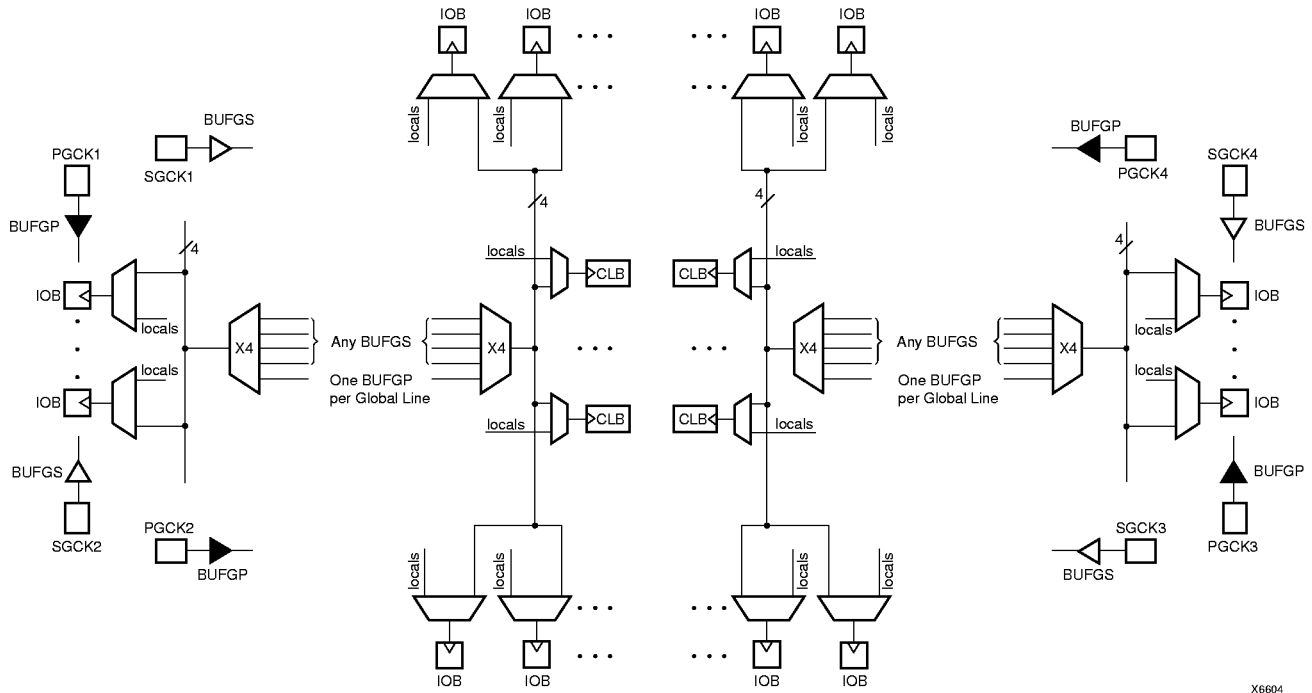
**Figure 35:   XC4000E Global Net Distribution**
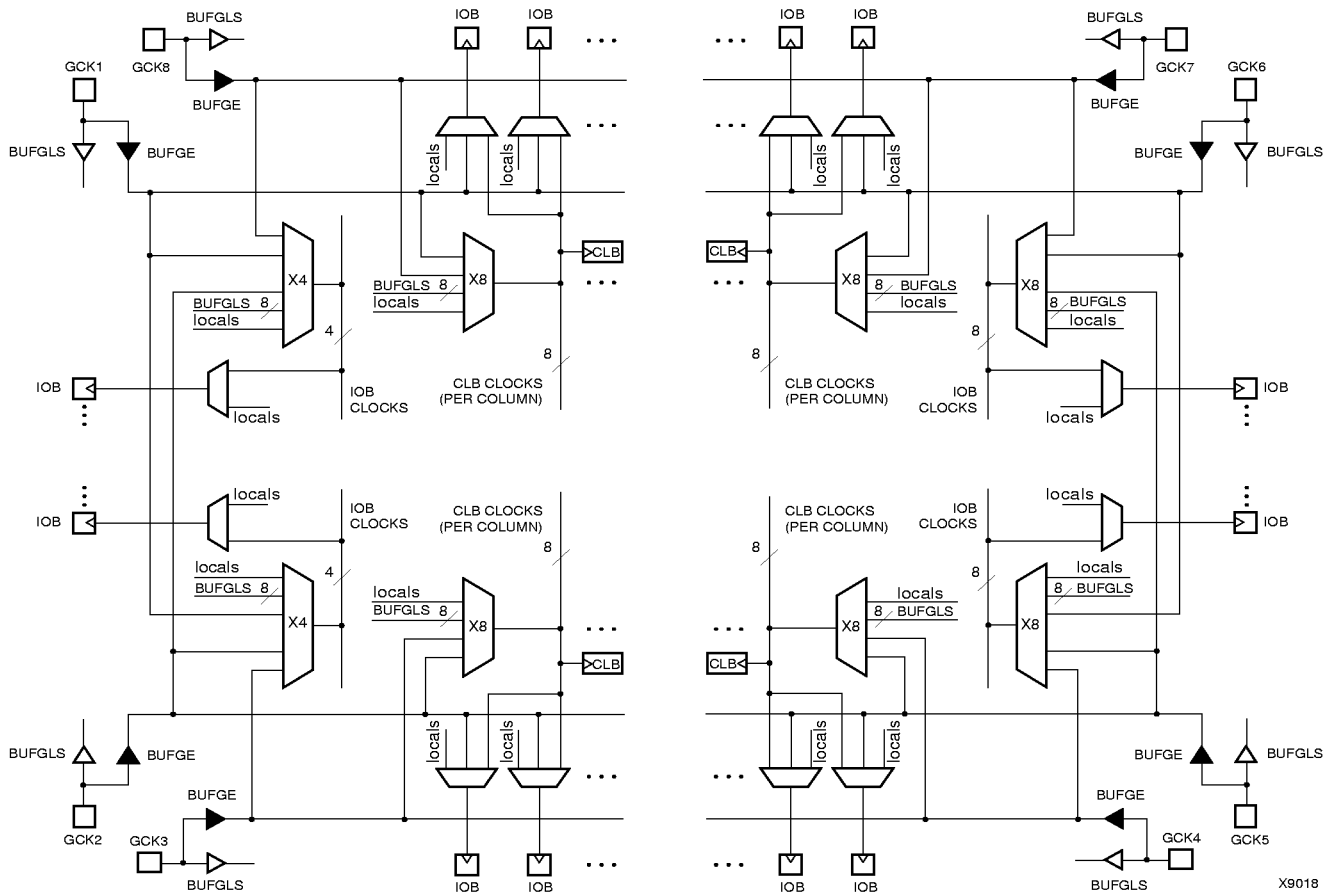


**Figure 36:   XC4000X Global Net Distribution**

## Global Nets and Buffers (XC4000X only)

Eight vertical longlines in each CLB column are driven by special global buffers. These longlines are in addition to the vertical longlines used for standard interconnect. The global lines are broken in the center of the array, to allow faster distribution and to minimize skew across the whole array. Each half-column global line has its own buffered multiplexer, as shown in Figure 36. The top and bottom global lines cannot be connected across the center of the device, as this connection might introduce unacceptable skew. The top and bottom halves of the global lines must be separately driven — although they can be driven by the same global buffer.

The eight global lines in each CLB column can be driven by either of two types of global buffers. They can also be driven by internal logic, because they can be accessed by single, double, and quad lines at the top, bottom, half, and quarter points. Consequently, the number of different clocks that can be used simultaneously in an XC4000X device is very large.

There are four global lines feeding the IOBs at the left edge of the device. IOBs along the right edge have eight global lines. There is a single global line along the top and bottom edges with access to the IOBs. All IOB global lines are broken at the center. They cannot be connected across the center of the device, as this connection might introduce unacceptable skew.

IOB global lines can be driven from two types of global buffers, or from local interconnect. Alternatively, top and bottom IOBs can be clocked from the global lines in the adjacent CLB column.

Two different types of clock buffers are available in the XC4000X:

- Global Low-Skew Buffers (BUFGLS)
- Global Early Buffers (BUFGE)

Global Low-Skew Buffers are the standard clock buffers. They should be used for most internal clocking, whenever a large portion of the device must be driven.

Global Early Buffers are designed to provide a faster clock access, but CLB access is limited to one-fourth of the device. They also facilitate a faster I/O interface.

Figure 36 is a conceptual diagram of the global net structure in the XC4000X.

Global Early buffers and Global Low-Skew buffers share a single pad. Therefore, the same IPAD symbol can drive one buffer of each type, in parallel. This configuration is particularly useful when using the Fast Capture latches, as described in "IOB Input Signals" on page 4-21. Paired Global Early and Global Low-Skew buffers share a common input; they cannot be driven by two different signals.

## Choosing an XC4000X Clock Buffer

The clocking structure of the XC4000X provides a large variety of features. However, it can be simple to use, without understanding all the details. The software automatically handles clocks, along with all other routing, when the appropriate clock buffer is placed in the design. In fact, if a buffer symbol called BUFG is placed, rather than a specific type of buffer, the software even chooses the buffer most appropriate for the design. The detailed information in this section is provided for those users who want a finer level of control over their designs.

If fine control is desired, use the following summary and Table 16 on page 4-36 to choose an appropriate clock buffer.

- The simplest thing to do is to use a Global Low-Skew buffer.
- If a faster clock path is needed, try a BUFG. The software will first try to use a Global Low-Skew Buffer. If timing requirements are not met, a faster buffer will automatically be used.
- If a single quadrant of the chip is sufficient for the clocked logic, and the timing requires a faster clock than the Global Low-Skew buffer, use a Global Early buffer.

### Global Low-Skew Buffers

Each corner of the XC4000X device has two Global Low-Skew buffers. Any of the eight Global Low-Skew buffers can drive any of the eight vertical Global lines in a column of CLBs. In addition, any of the buffers can drive any of the four vertical lines accessing the IOBs on the left edge of the device, and any of the eight vertical lines accessing the IOBs on the right edge of the device. (See Figure 37 on page 4-39.)

IOBs at the top and bottom edges of the device are accessed through the vertical Global lines in the CLB array, as in the XC4000E. Any Global Low-Skew buffer can, therefore, access every IOB and CLB in the device.

The Global Low-Skew buffers can be driven by either semi-dedicated pads or internal logic.

To use a Global Low-Skew buffer, instantiate a BUFGLS element in a schematic or in HDL code. If desired, attach a LOC attribute or property to direct placement to the designated location. For example, attach a LOC=T attribute or property to direct that a BUFGLS be placed in one of the two Global Low-Skew buffers on the top edge of the device, or a LOC=TR to indicate the Global Low-Skew buffer on the top edge of the device, on the right.
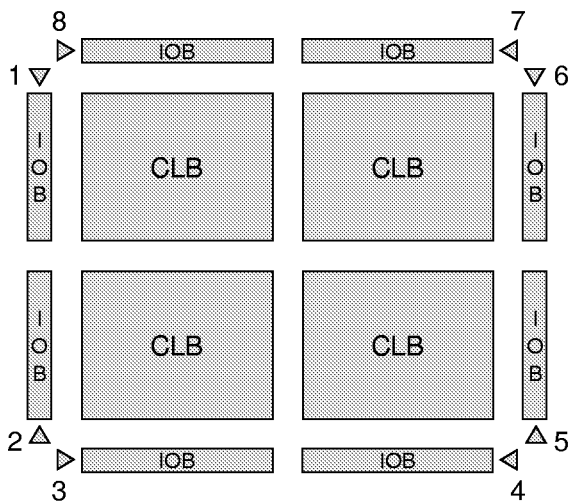
X6753

**Figure 37: Any BUFGLS (GCK1 - GCK8) Can Drive Any or All Clock Inputs on the Device**

### Global Early Buffers

Each corner of the XC4000X device has two Global Early buffers. The primary purpose of the Global Early buffers is to provide an earlier clock access than the potentially heavily-loaded Global Low-Skew buffers. A clock source applied to both buffers will result in the Global Early clock edge occurring several nanoseconds earlier than the Global Low-Skew buffer clock edge, due to the lighter loading.

Global Early buffers also facilitate the fast capture of device inputs, using the Fast Capture latches described in "IOB Input Signals" on page 4-21. For Fast Capture, take a single clock signal, and route it through both a Global Early buffer and a Global Low-Skew buffer. (The two buffers share an input pad.) Use the Global Early buffer to clock the Fast Capture latch, and the Global Low-Skew buffer to clock the normal input flip-flop or latch, as shown in Figure 18 on page 4-24.

The Global Early buffers can also be used to provide a fast Clock-to-Out on device output pins. However, an early clock in the output flip-flop IOB must be taken into consideration when calculating the internal clock speed for the design.

The Global Early buffers at the left and right edges of the chip have slightly different capabilities than the ones at the top and bottom. Refer to Figure 38, Figure 39, and Figure 36 on page 4-37 while reading the following explanation.

Each Global Early buffer can access the eight vertical Global lines for all CLBs in the quadrant. Therefore, only one-fourth of the CLB clock pins can be accessed. This restriction is in large part responsible for the faster speed of the buffers, relative to the Global Low-Skew buffers.
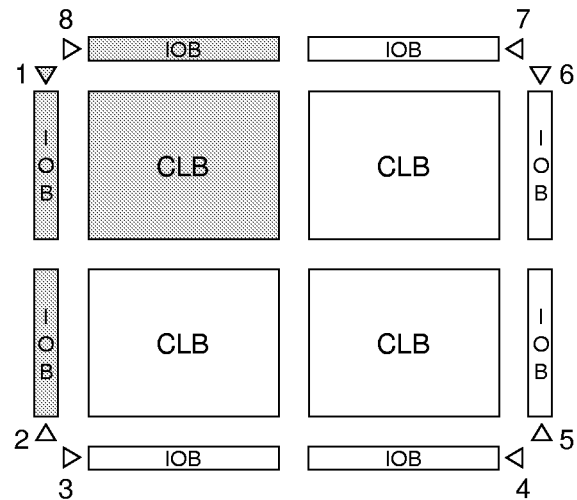


X6751

**Figure 38: Left and Right BUFGEs Can Drive Any or All Clock Inputs in Same Quadrant or Edge (GCK1 is shown. GCK2, GCK5 and GCK6 are similar.)**

The left-side Global Early buffers can each drive two of the four vertical lines accessing the IOBs on the entire left edge of the device. The right-side Global Early buffers can each drive two of the eight vertical lines accessing the IOBs on the entire right edge of the device. (See Figure 38.)

Each left and right Global Early buffer can also drive half of the IOBs along either the top or bottom edge of the device, using a dedicated line that can only be accessed through the Global Early buffers.

The top and bottom Global Early buffers can drive half of the IOBs along either the left or right edge of the device, as shown in Figure 39. They can only access the top and bottom IOBs via the CLB global lines.
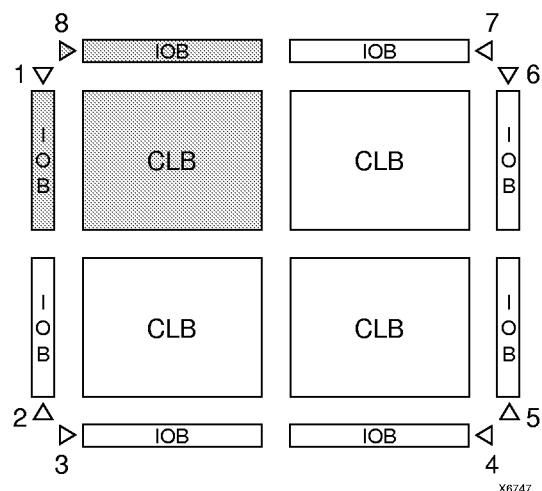


X6747

**Figure 39: Top and Bottom BUFGEs Can Drive Any or All Clock Inputs in Same Quadrant (GCK8 is shown. GCK3, GCK4 and GCK7 are similar.)**

The top and bottom Global Early buffers are about 1 ns slower clock to out than the left and right Global Early buffers.

The Global Early buffers can be driven by either semi-dedicated pads or internal logic. They share pads with the Global Low-Skew buffers, so a single net can drive both global buffers, as described above.

To use a Global Early buffer, place a BUFGE element in a schematic or in HDL code. If desired, attach a LOC attribute or property to direct placement to the designated location. For example, attach a LOC=T attribute or property to direct that a BUFGE be placed in one of the two Global Early buffers on the top edge of the device, or a LOC=TR to indicate the Global Early buffer on the top edge of the device, on the right.

## Power Distribution

Power for the FPGA is distributed through a grid to achieve high noise immunity and isolation between logic and I/O. Inside the FPGA, a dedicated Vcc and Ground ring surrounding the logic array provides power to the I/O drivers, as shown in Figure 40. An independent matrix of Vcc and Ground lines supplies the interior logic of the device.

This power distribution grid provides a stable supply and ground for all internal logic, providing the external package power pins are all connected and appropriately decoupled. Typically, a 0.1 µF capacitor connected between each Vcc pin and the board's Ground plane will provide adequate decoupling.

Output buffers capable of driving/sinking the specified 12 mA loads under specified worst-case conditions may be capable of driving/sinking up to 10 times as much current under best case conditions.

Noise can be reduced by minimizing external load capacitance and reducing simultaneous output transitions in the same direction. It may also be beneficial to locate heavily loaded output buffers near the Ground pads. The I/O Block output buffers have a slew-rate limited mode (default) which should be used where output rise and fall times are not speed-critical.
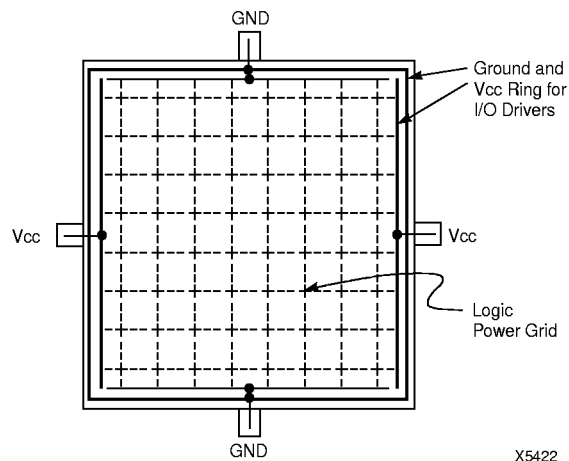


**Figure 40: XC4000 Series Power Distribution**

## Pin Descriptions

There are three types of pins in the XC4000 Series devices:

- Permanently dedicated pins
- User I/O pins that can have special functions
- Unrestricted user-programmable I/O pins.

Before and during configuration, all outputs not used for the configuration process are 3-stated with a 50 kΩ - 100 kΩ pull-up resistor.

After configuration, if an IOB is unused it is configured as an input with a 50 kΩ - 100 kΩ pull-up resistor.

XC4000 Series devices have no dedicated Reset input. Any user I/O can be configured to drive the Global Set/Reset net, GSR.  See "Global Set/Reset" on page 4-11 for more information on GSR.

XC4000 Series devices have no Powerdown control input, as the XC3000 and XC2000 families do. The XC3000/XC2000 Powerdown control also 3-stated all of the device I/O pins. For XC4000 Series devices, use the global 3-state net, GTS, instead. This net 3-states all outputs, but does not place the device in low-power mode. See "IOB Output Signals" on page 4-24 for more information on GTS.

Device pins for XC4000 Series devices are described in Table 17. Pin functions during configuration for each of the seven configuration modes are summarized in Table 23 on page 4-58, in the "Configuration Timing" section.

**Table 17: Pin Descriptions**

| Pin Name | I/O During Config. | I/O After Config. | Pin Description |
|---|---|---|---|
| **Permanently Dedicated Pins** | | | |
| VCC | I | I | Eight or more (depending on package) connections to the nominal +5 V supply voltage (+3.3 V for low-voltage devices). All must be connected, and each must be decoupled with a 0.01 - 0.1 µF capacitor to Ground. |
| GND | I | I | Eight or more (depending on package type) connections to Ground. All must be connected. |
| CCLK | I or O | I | During configuration, Configuration Clock (CCLK) is an output in Master modes or Asynchronous Peripheral mode, but is an input in Slave mode and Synchronous Peripheral mode. After configuration, CCLK has a weak pull-up resistor and can be selected as the Readback Clock. There is no CCLK High time restriction on XC4000 Series devices, except during Readback. See "Violating the Maximum High and Low Time Specification for the Readback Clock" on page 4-57 for an explanation of this exception. |
| DONE | I/O | O | DONE is a bidirectional signal with an optional internal pull-up resistor. As an output, it indicates the completion of the configuration process. As an input, a Low level on DONE can be configured to delay the global logic initialization and the enabling of outputs. The optional pull-up resistor is selected as an option in the XACT*step* program that creates the configuration bitstream. The resistor is included by default. |
| $\overline{\text{PROGRAM}}$ | I | I | $\overline{\text{PROGRAM}}$ is an active Low input that forces the FPGA to clear its configuration memory. It is used to initiate a configuration cycle. When $\overline{\text{PROGRAM}}$ goes High, the FPGA finishes the current clear cycle and executes another complete clear cycle, before it goes into a WAIT state and releases $\overline{\text{INIT}}$. The $\overline{\text{PROGRAM}}$ pin has a permanent weak pull-up, so it need not be externally pulled up to Vcc. |
| **User I/O Pins That Can Have Special Functions** | | | |
| RDY/$\overline{\text{BUSY}}$ | O | I/O | During Peripheral mode configuration, this pin indicates when it is appropriate to write another byte of data into the FPGA. The same status is also available on D7 in Asynchronous Peripheral mode, if a read operation is performed when the device is selected. After configuration, RDY/$\overline{\text{BUSY}}$ is a user-programmable I/O pin. RDY/$\overline{\text{BUSY}}$ is pulled High with a high-impedance pull-up prior to $\overline{\text{INIT}}$ going High. |
| $\overline{\text{RCLK}}$ | O | I/O | During Master Parallel configuration, each change on the A0-A17 outputs (A0 - A21 for XC4000X) is preceded by a rising edge on $\overline{\text{RCLK}}$, a redundant output signal. $\overline{\text{RCLK}}$ is useful for clocked PROMs. It is rarely used during configuration. After configuration, $\overline{\text{RCLK}}$ is a user-programmable I/O pin. |
| M0, M1, M2 | I | I (M0), O (M1), I (M2) | As Mode inputs, these pins are sampled after $\overline{\text{INIT}}$ goes High to determine the configuration mode to be used. After configuration, M0 and M2 can be used as inputs, and M1 can be used as a 3-state output. These three pins have no associated input or output registers. During configuration, these pins have weak pull-up resistors. For the most popular configuration mode, Slave Serial, the mode pins can thus be left unconnected. The three mode inputs can be individually configured with or without weak pull-up or pull-down resistors. A pull-down resistor value of 4.7 kΩ is recommended. These pins can only be used as inputs or outputs when called out by special schematic definitions. To use these pins, place the library components MD0, MD1, and MD2 instead of the usual pad symbols. Input or output buffers must still be used. |
| TDO | O | O | If boundary scan is used, this pin is the Test Data Output. If boundary scan is not used, this pin is a 3-state output without a register, after configuration is completed. This pin can be user output only when called out by special schematic definitions. To use this pin, place the library component TDO instead of the usual pad symbol. An output buffer must still be used. |

**Table 17: Pin Descriptions (Continued)**

| Pin Name | I/O During Config. | I/O After Config. | Pin Description |
|---|---|---|---|
| TDI, TCK, TMS | I | I/O or I (JTAG) | If boundary scan is used, these pins are Test Data In, Test Clock, and Test Mode Select inputs respectively. They come directly from the pads, bypassing the IOBs. These pins can also be used as inputs to the CLB logic after configuration is completed.<br>If the BSCAN symbol is not placed in the design, all boundary scan functions are inhibited once configuration is completed, and these pins become user-programmable I/O. In this case, they must be called out by special schematic definitions. To use these pins, place the library components TDI, TCK, and TMS instead of the usual pad symbols. Input or output buffers must still be used. |
| HDC | O | I/O | High During Configuration (HDC) is driven High until the I/O go active. It is available as a control output indicating that configuration is not yet completed. After configuration, HDC is a user-programmable I/O pin. |
| $\overline{\text{LDC}}$ | O | I/O | Low During Configuration ($\overline{\text{LDC}}$) is driven Low until the I/O go active. It is available as a control output indicating that configuration is not yet completed. After configuration, $\overline{\text{LDC}}$ is a user-programmable I/O pin. |
| $\overline{\text{INIT}}$ | I/O | I/O | Before and during configuration, $\overline{\text{INIT}}$ is a bidirectional signal. A 1 kΩ - 10 kΩ external pull-up resistor is recommended.<br>As an active-Low open-drain output, $\overline{\text{INIT}}$ is held Low during the power stabilization and internal clearing of the configuration memory.  As an active-Low input, it can be used to hold the FPGA in the internal WAIT state before the start of configuration.  Master mode devices stay in a WAIT state an additional 30 to 300 µs after $\overline{\text{INIT}}$ has gone High. During configuration, a Low on this output indicates that a configuration data error has occurred. After the I/O go active, $\overline{\text{INIT}}$ is a user-programmable I/O pin. |
| PGCK1 - PGCK4 (XC4000E only) | Weak Pull-up | I or I/O | Four Primary Global inputs each drive a dedicated internal global net with short delay and minimal skew. If not used to drive a global buffer, any of these pins is a user-programmable I/O.<br>The PGCK1-PGCK4 pins drive the four Primary Global Buffers. Any input pad symbol connected directly to the input of a BUFGP symbol is automatically placed on one of these pins. |
| SGCK1 - SGCK4 (XC4000E only) | Weak Pull-up | I or I/O | Four Secondary Global inputs each drive a dedicated internal global net with short delay and minimal skew. These internal global nets can also be driven from internal logic. If not used to drive a global net, any of these pins is a user-programmable I/O pin.<br>The SGCK1-SGCK4 pins provide the shortest path to the four Secondary Global Buffers. Any input pad symbol connected directly to the input of a BUFGS symbol is automatically placed on one of these pins. |
| GCK1 - GCK8 (XC4000X only) | Weak Pull-up | I or I/O | Eight inputs can each drive a Global Low-Skew buffer. In addition, each can drive a Global Early buffer. Each pair of global buffers can also be driven from internal logic, but must share an input signal. If not used to drive a global buffer, any of these pins is a user-programmable I/O.<br>Any input pad symbol connected directly to the input of a BUFGLS or BUFGE symbol is automatically placed on one of these pins. |
| $\overline{\text{CS0}}$, CS1, $\overline{\text{WS}}$, $\overline{\text{RS}}$ | I | I/O | These four inputs are used in Asynchronous Peripheral mode. The chip is selected when $\overline{\text{CS0}}$ is Low and CS1 is High.  While the chip is selected, a Low on Write Strobe ($\overline{\text{WS}}$) loads the data present on the D0 - D7 inputs into the internal data buffer. A Low on Read Strobe ($\overline{\text{RS}}$) changes D7 into a status output — High if Ready, Low if Busy — and drives D0 - D6 High.<br>In Express mode, CS1 is used as a serial-enable signal for daisy-chaining.<br>$\overline{\text{WS}}$ and $\overline{\text{RS}}$ should be mutually exclusive, but if both are Low simultaneously, the Write Strobe overrides. After configuration, these are user-programmable I/O pins. |
| A0 - A17 | O | I/O | During Master Parallel configuration, these 18 output pins address the configuration EPROM. After configuration, they are user-programmable I/O pins. |

**Table 17: Pin Descriptions (Continued)**

| Pin Name | I/O During Config. | I/O After Config. | Pin Description |
|---|---|---|---|
| A18 - A21 (XC4000X only) | O | I/O | During Master Parallel configuration with an XC4000X master, these 4 output pins add 4 more bits to address the configuration EPROM. After configuration, they are user-programmable I/O pins. (See Master Parallel Configuration section for additional details.) |
| D0 - D7 | I | I/O | During Master Parallel and Peripheral configuration, these eight input pins receive configuration data. After configuration, they are user-programmable I/O pins. |
| DIN | I | I/O | During Slave Serial or Master Serial configuration, DIN is the serial configuration data input receiving data on the rising edge of CCLK. During Parallel configuration, DIN is the D0 input. After configuration, DIN is a user-programmable I/O pin. |
| DOUT | O | I/O | During configuration in any mode but Express mode, DOUT is the serial configuration data output that can drive the DIN of daisy-chained slave FPGAs. DOUT data changes on the falling edge of CCLK, one-and-a-half CCLK periods after it was received at the DIN input. In Express mode, DOUT is the status output that can drive the CS1 of daisy-chained FPGAs, to enable and disable downstream devices. After configuration, DOUT is a user-programmable I/O pin. |
| **Unrestricted User-Programmable I/O Pins** | | | |
| I/O | Weak Pull-up | I/O | These pins can be configured to be input and/or output after configuration is completed. Before configuration is completed, these pins have an internal high-value pull-up resistor (25 kΩ - 100 kΩ) that defines the logic level as High. |

# Boundary Scan

The 'bed of nails' has been the traditional method of testing electronic assemblies. This approach has become less appropriate, due to closer pin spacing and more sophisticated assembly methods like surface-mount technology and multi-layer boards. The IEEE Boundary Scan Standard 1149.1 was developed to facilitate board-level testing of electronic assemblies. Design and test engineers can imbed a standard test logic structure in their device to achieve high fault coverage for I/O and internal logic. This structure is easily implemented with a four-pin interface on any boundary scan-compatible IC. IEEE 1149.1-compatible devices may be serial daisy-chained together, connected in parallel, or a combination of the two.

The XC4000 Series implements IEEE 1149.1-compatible BYPASS, PRELOAD/SAMPLE and EXTEST boundary scan instructions. When the boundary scan configuration option is selected, three normal user I/O pins become dedicated inputs for these functions. Another user output pin becomes the dedicated boundary scan output. The details of how to enable this circuitry are covered later in this section.

By exercising these input signals, the user can serially load commands and data into these devices to control the driving of their outputs and to examine their inputs. This method is an improvement over bed-of-nails testing. It avoids the need to over-drive device outputs, and it reduces the user interface to four pins. An optional fifth pin, a reset for the control logic, is described in the standard but is not implemented in Xilinx devices.

The dedicated on-chip logic implementing the IEEE 1149.1 functions includes a 16-state machine, an instruction register and a number of data registers. The functional details can be found in the IEEE 1149.1 specification and are also discussed in the Xilinx application note XAPP 017: "*Boundary Scan in XC4000 Devices.*"

Figure 41 on page 4-44 shows a simplified block diagram of the XC4000E Input/Output Block with boundary scan implemented. XC4000X boundary scan logic is identical.

Figure 42 on page 4-45 is a diagram of the XC4000 Series boundary scan logic. It includes three bits of Data Register per IOB, the IEEE 1149.1 Test Access Port controller, and the Instruction Register with decodes.

XC4000 Series devices can also be configured through the boundary scan logic. See "Readback" on page 4-56.

## Data Registers

The primary data register is the boundary scan register. For each IOB pin in the FPGA, bonded or not, it includes three bits for In, Out and 3-State Control. Non-IOB pins have appropriate partial bit population for In or Out only. $\overline{PROGRAM}$, CCLK and DONE are not included in the boundary scan register. Each EXTEST CAPTURE-DR state captures all In, Out, and 3-state pins.

The data register also includes the following non-pin bits: TDO.T, and TDO.O, which are always bits 0 and 1 of the data register, respectively, and BSCANT.UPD, which is

always the last bit of the data register. These three boundary scan bits are special-purpose Xilinx test signals.

The other standard data register is the single flip-flop BYPASS register. It synchronizes data being passed through the FPGA to the next downstream boundary scan device.

The FPGA provides two additional data registers that can be specified using the BSCAN macro. The FPGA provides

two user pins (BSCAN.SEL1 and BSCAN.SEL2) which are the decodes of two user instructions. For these instructions, two corresponding pins (BSCAN.TDO1 and BSCAN.TDO2) allow user scan data to be shifted out on TDO. The data register clock (BSCAN.DRCK) is available for control of test logic which the user may wish to implement with CLBs. The NAND of TCK and RUN-TEST-IDLE is also provided (BSCAN.IDLE).
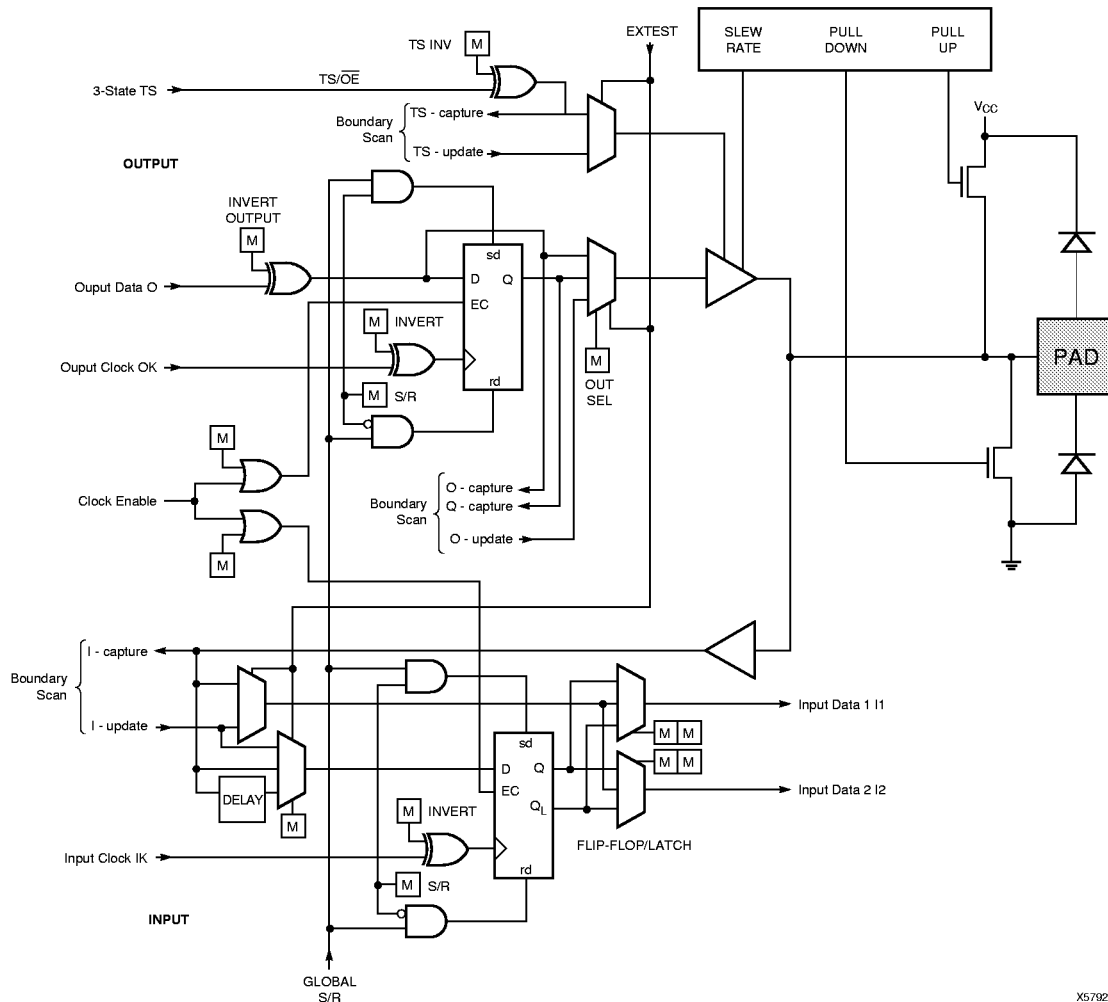


**Figure 41: Block Diagram of XC4000E IOB with Boundary Scan (some details not shown). XC4000X Boundary Scan Logic is Identical.**
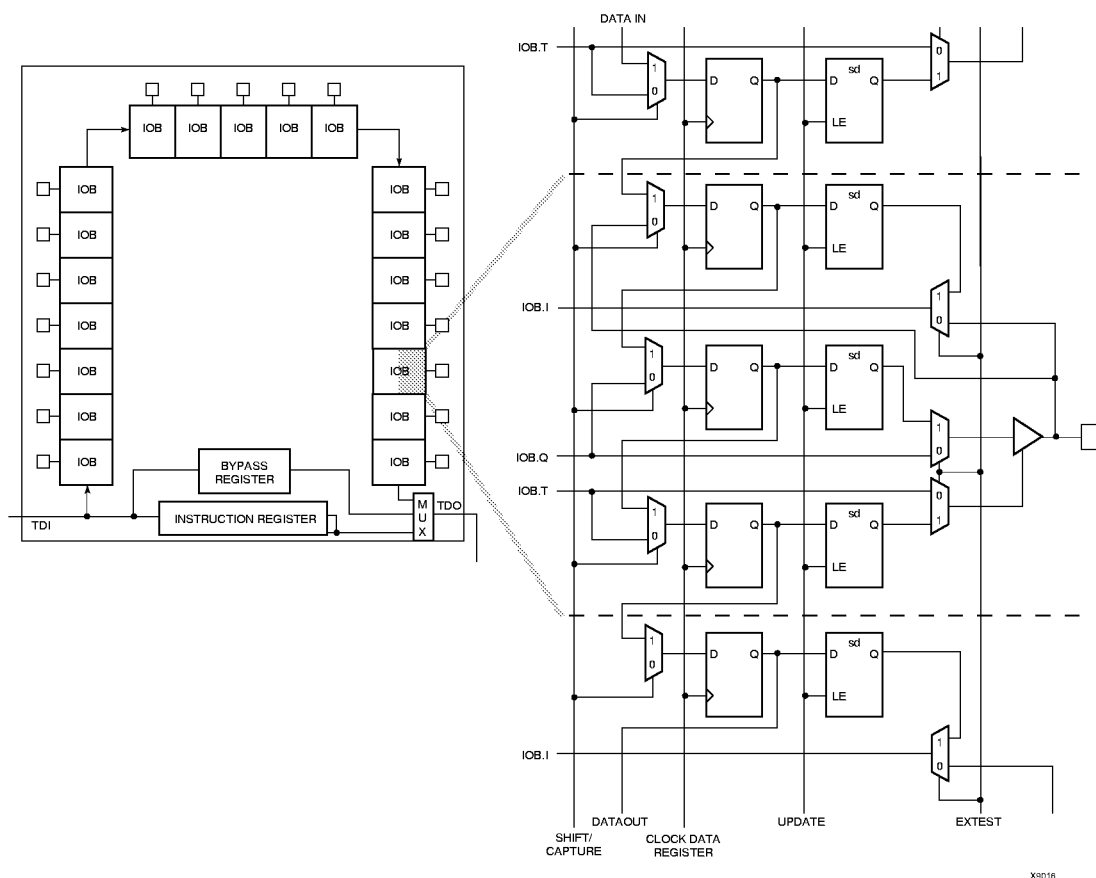
**Figure 42: XC4000 Series Boundary Scan Logic**

## Instruction Set

The XC4000 Series boundary scan instruction set also includes instructions to configure the device and read back the configuration data. The instruction set is coded as shown in Table 18.

## Bit Sequence

The bit sequence within each IOB is: In, Out, 3-State. The input-only M0 and M2 mode pins contribute only the In bit to the boundary scan I/O data register, while the output-only M1 pin contributes all three bits.

The first two bits in the I/O data register are TDO.T and TDO.O, which can be used for the capture of internal signals. The final bit is BSCANT.UPD, which can be used to drive an internal net. These locations are primarily used by Xilinx for internal testing.

From a cavity-up view of the chip (as shown in XDE or Epic), starting in the upper right chip corner, the boundary scan data-register bits are ordered as shown in Figure 43. The device-specific pinout tables for the XC4000 Series include the boundary scan locations for each IOB pin.

BSDL (Boundary Scan Description Language) files for XC4000 Series devices are available on the Xilinx FTP site.

## Including Boundary Scan in a Schematic

If boundary scan is only to be used during configuration, no special schematic elements need be included in the schematic or HDL code. In this case, the special boundary scan pins TDI, TMS, TCK and TDO can be used for user functions after configuration.

To indicate that boundary scan remain enabled after configuration, place the BSCAN library symbol and connect the TDI, TMS, TCK and TDO pad symbols to the appropriate pins, as shown in Figure 44.

Even if the boundary scan symbol is used in a schematic, the input pins TMS, TCK, and TDI can still be used as inputs to be routed to internal logic. Care must be taken not to force the chip into an undesired boundary scan state by inadvertently applying boundary scan input patterns to these pins. The simplest way to prevent this is to keep TMS High, and then apply whatever signal is desired to TDI and TCK.

**Table 18: Boundary Scan Instructions**

| Instruction I2 | I1 | I0 | Test Selected | TDO Source | I/O Data Source |
|---|---|---|---|---|---|
| 0 | 0 | 0 | EXTEST | DR | DR |
| 0 | 0 | 1 | SAMPLE/ PRELOAD | DR | Pin/Logic |
| 0 | 1 | 0 | USER 1 | BSCAN. TDO1 | User Logic |
| 0 | 1 | 1 | USER 2 | BSCAN. TDO2 | User Logic |
| 1 | 0 | 0 | READBACK | Readback Data | Pin/Logic |
| 1 | 0 | 1 | CONFIGURE | DOUT | Disabled |
| 1 | 1 | 0 | Reserved | — | — |
| 1 | 1 | 1 | BYPASS | Bypass Register | — |
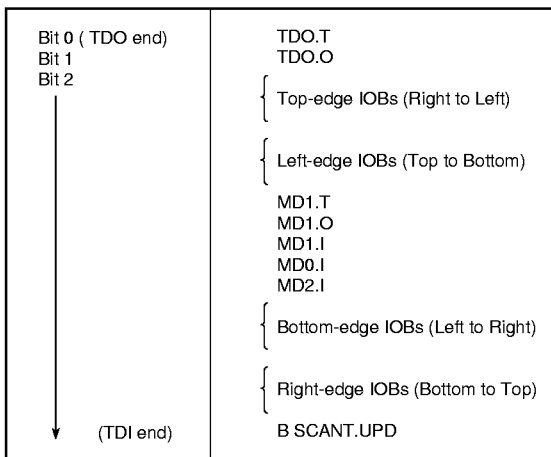


Figure 43: Boundary Scan Bit Sequence

## Avoiding Inadvertent Boundary Scan

If TMS or TCK is used as user I/O, care must be taken to ensure that at least one of these pins is held constant during configuration. In some applications, a situation may occur where TMS or TCK is driven during configuration. This may cause the device to go into boundary scan mode and disrupt the configuration process.

To prevent activation of boundary scan during configuration, do either of the following:

• TMS: Tie High to put the Test Access Port controller in a benign RESET state
• TCK: Tie High or Low—don't toggle this clock input.

For more information regarding boundary scan, refer to the Xilinx Application Note XAPP 017.001, *"Boundary Scan in XC4000E Devices."*
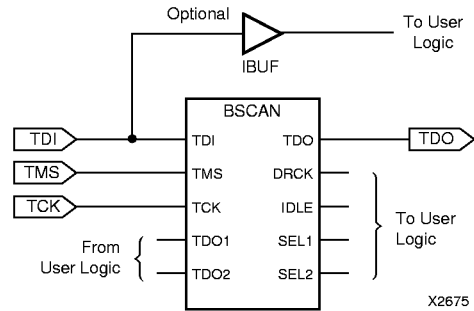


Figure 44: Boundary Scan Schematic Example

## Configuration

Configuration is the process of loading design-specific programming data into one or more FPGAs to define the functional operation of the internal blocks and their interconnections. This is somewhat like loading the command registers of a programmable peripheral chip. XC4000 Series devices use several hundred bits of configuration data per CLB and its associated interconnects. Each configuration bit defines the state of a static memory cell that controls either a function look-up table bit, a multiplexer input, or an interconnect pass transistor. The XACT*step* development system translates the design into a netlist file. It automatically partitions, places and routes the logic and generates the configuration data in PROM format.

## Special Purpose Pins

Three configuration mode pins (M2, M1, M0) are sampled prior to configuration to determine the configuration mode. After configuration, these pins can be used as auxiliary connections. M2 and M0 can be used as inputs, and M1 can be used as an output. The XACT*step* development system does not use these resources unless they are explicitly specified in the design entry. This is done by placing a special pad symbol called MD2, MD1, or MD0 instead of the input or output pad symbol.

In XC4000 Series devices, the mode pins have weak pull-up resistors during configuration. With all three mode pins High, Slave Serial mode is selected, which is the most popular configuration mode. Therefore, for the most common configuration mode, the mode pins can be left unconnected. (Note, however, that the internal pull-up resistor value can be as high as 100 kΩ.) After configuration, these pins can individually have weak pull-up or pull-down resistors, as specified in the design. A pull-down resistor value of 4.7 kΩ is recommended.

These pins are located in the lower left chip corner and are near the readback nets. This location allows convenient routing if compatibility with the XC2000 and XC3000 family conventions of M0/RT, M1/RD is desired.

## Configuration Modes

XC4000E devices have six configuration modes. XC4000X devices have the same six modes, plus an additional configuration mode. These modes are selected by a 3-bit input code applied to the M2, M1, and M0 inputs. There are three self-loading Master modes, two Peripheral modes, and a Serial Slave mode, which is used primarily for daisy-chained devices. The coding for mode selection is shown in Table 19.

**Table 19: Configuration Modes**

| Mode | M2 | M1 | M0 | CCLK | Data |
|---|---|---|---|---|---|
| Master Serial | 0 | 0 | 0 | output | Bit-Serial |
| Slave Serial | 1 | 1 | 1 | input | Bit-Serial |
| Master Parallel Up | 1 | 0 | 0 | output | Byte-Wide, increment from 00000 |
| Master Parallel Down | 1 | 1 | 0 | output | Byte-Wide, decrement from 3FFFF |
| Peripheral Synchronous* | 0 | 1 | 1 | input | Byte-Wide |
| Peripheral Asynchronous | 1 | 0 | 1 | output | Byte-Wide |
| Reserved | 0 | 1 | 0 | — | — |
| Reserved | 0 | 0 | 1 | — | — |

Note: * Peripheral Synchronous can be considered byte-wide Slave Parallel

A detailed description of each configuration mode, with timing information, is included later in this data sheet. During configuration, some of the I/O pins are used temporarily for the configuration process. All pins used during configuration are shown in Table 23 on page 4-58.

### Master Modes

The three Master modes use an internal oscillator to generate a Configuration Clock (CCLK) for driving potential slave devices. They also generate address and timing for external PROM(s) containing the configuration data.

Master Parallel (Up or Down) modes generate the CCLK signal and PROM addresses and receive byte parallel data. The data is internally serialized into the FPGA data-frame format. The up and down selection generates starting addresses at either zero or 3FFFF (3FFFFF when 22 address lines are used), for compatibility with different microprocessor addressing conventions. The Master Serial mode generates CCLK and receives the configuration data in serial form from a Xilinx serial-configuration PROM.

CCLK speed is selectable as either 1 MHz (default) or 8 MHz. Configuration always starts at the default slow frequency, then can switch to the higher frequency during the first frame. Frequency tolerance is -50% to +25%.

### Additional Address lines in XC4000 devices

The XC4000X devices have additional address lines (A18-A21) allowing the additional address space required to daisy-chain several large devices.

The extra address lines are programmable in XC4000EX devices. By default these address lines are not activated. In the default mode, the devices are compatible with existing XC4000 and XC4000E products. If desired, the extra address lines can be used by specifying the address lines option in bitgen as 22 (bitgen -g AddressLines:22). The lines (A18-A21) are driven when a master device detects, via the bitstream, that it should be using all 22 address lines. Because these pins will initially be pulled high by internal pull-ups, designers using Master Parallel Up mode should use external pull down resistors on pins A18-A21. If Master Parallel Down mode is used external resistors are not necessary.

All 22 address lines are always active in Master Parallel modes with XC4000XL devices. The additional address lines behave identically to the lower order address lines. If the Address Lines option in bitgen is set to 18, it will be ignored by the XC4000XL device.

The additional address lines (A18-A21) are not available in the PC84 package.

### Peripheral Modes

The two Peripheral modes accept byte-wide data from a bus. A RDY/BUSY status is available as a handshake signal. In Asynchronous Peripheral mode, the internal oscillator generates a CCLK burst signal that serializes the byte-wide data. CCLK can also drive slave devices. In the synchronous mode, an externally supplied clock input to CCLK serializes the data.

### Slave Serial Mode

In Slave Serial mode, the FPGA receives serial configuration data on the rising edge of CCLK and, after loading its configuration, passes additional data out, resynchronized on the next falling edge of CCLK.

Multiple slave devices with identical configurations can be wired with parallel DIN inputs. In this way, multiple devices can be configured simultaneously.

#### Serial Daisy Chain

Multiple devices with different configurations can be connected together in a "daisy chain," and a single combined bitstream used to configure the chain of slave devices.

To configure a daisy chain of devices, wire the CCLK pins of all devices in parallel, as shown in Figure 52 on page 4-60. Connect the DOUT of each device to the DIN of the next. The lead or master FPGA and following slaves each passes resynchronized configuration data coming from a single source. The header data, including the length count,

is passed through and is captured by each FPGA when it recognizes the 0010 preamble. Following the length-count data, each FPGA outputs a High on DOUT until it has received its required number of data frames.

After an FPGA has received its configuration data, it passes on any additional frame start bits and configuration data on DOUT. When the total number of configuration clocks applied after memory initialization equals the value of the 24-bit length count, the FPGAs begin the start-up sequence and become operational together. FPGA I/O are normally released two CCLK cycles after the last configuration bit is received. Figure 48 on page 4-54 shows the start-up timing for an XC4000 Series device.

The daisy-chained bitstream is not simply a concatenation of the individual bitstreams. The PROM file formatter must be used to combine the bitstreams for a daisy-chained configuration.

### Multi-Family Daisy Chain

All Xilinx FPGAs of the XC2000, XC3000, and XC4000 Series use a compatible bitstream format and can, therefore, be connected in a daisy chain in an arbitrary sequence. There is, however, one limitation. The lead device must belong to the highest family in the chain. If the chain contains XC4000 Series devices, the master normally cannot be an XC2000 or XC3000 device.

The reason for this rule is shown in Figure 48 on page 4-54. Since all devices in the chain store the same length count value and generate or receive one common sequence of CCLK pulses, they all recognize length-count match on the same CCLK edge, as indicated on the left edge of Figure 48. The master device then generates additional CCLK pulses until it reaches its finish point F. The different families generate or require different numbers of additional CCLK pulses until they reach F. Not reaching F means that the device does not really finish its configuration, although DONE may have gone High, the outputs became active, and the internal reset was released. For the XC4000 Series device, not reaching F means that readback cannot be ini-

tiated and most boundary scan instructions cannot be used.

The user has some control over the relative timing of these events and can, therefore, make sure that they occur at the proper time and the finish point F is reached. Timing is controlled using options in the bitstream generation software.

### XC3000 Master with an XC4000 Series Slave

Some designers want to use an inexpensive lead device in peripheral mode and have the more precious I/O pins of the XC4000 Series devices all available for user I/O. Figure 45 provides a solution for that case.

This solution requires one CLB, one IOB and pin, and an internal oscillator with a frequency of up to 5 MHz as a clock source. The XC3000 master device must be configured with late Internal Reset, which is the default option.

One CLB and one IOB in the lead XC3000-family device are used to generate the additional CCLK pulse required by the XC4000 Series devices. When the lead device removes the internal RESET signal, the 2-bit shift register responds to its clock input and generates an active Low output signal for the duration of the subsequent clock period. An external connection between this output and CCLK thus creates the extra CCLK pulse.
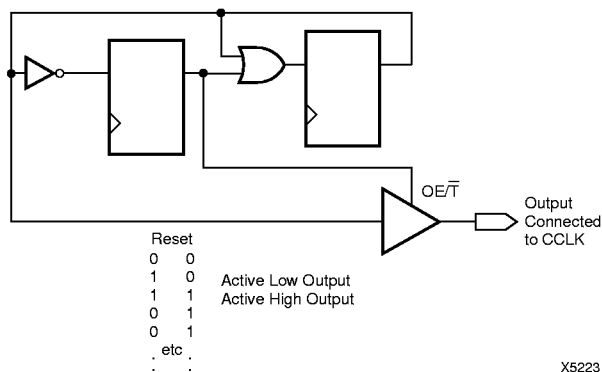


**Figure 45: CCLK Generation for XC3000 Master Driving an XC4000 Series Slave**

## Setting CCLK Frequency

For Master modes, CCLK can be generated in either of two frequencies. In the default slow mode, the frequency ranges from 0.5 MHz to 1.25 MHz for XC4000E and XC4000EX devices and from 0.6 MHz to 1.8 MHz for XC4000XL devices. In fast CCLK mode, the frequency ranges from 4 MHz to 10 MHz for XC4000EX devices and from 5 MHz to 15 MHz for XC4000XL devices. The frequency is selected by an option when running the bitstream generation software. If an XC4000 Series Master is driving an XC3000- or XC2000-family slave, slow CCLK mode must be used. In addition, an XC4000XL device driving a XC4000E or XC4000EX should use slow mode. Slow mode is the default.

**Table 20: XC4000 Series Data Stream Formats**

| Data Type | All Other Modes (D0...) |
|---|---|
| Fill Byte | 11111111b |
| Preamble Code | 0010b |
| Length Count | COUNT(23:0) |
| Fill Bits | 1111b |
| Start Field | 0b |
| Data Frame | DATA(n-1:0) |
| CRC or Constant Field Check | xxxx (CRC) or 0110b |
| Extend Write Cycle | — |
| Postamble | 01111111b |
| Start-Up Bytes | xxh |

LEGEND:

| Unshaded | Once per bitstream |
|---|---|
| Light | Once per data frame |
| Dark | Once per device |

## Data Stream Format

The data stream ("bitstream") format is identical for all configuration modes.

The data stream formats are shown in Table 20. Bit-serial data is read from left to right, and byte-parallel data is effectively assembled from this serial bitstream, with the first bit in each byte assigned to D0.

The configuration data stream begins with a string of eight ones, a preamble code, followed by a 24-bit length count and a separator field of ones. This header is followed by the actual configuration data in frames. The length and number of frames depends on the device type (see Table 21 and Table 22). Each frame begins with a start field and ends with an error check. A postamble code is required to signal the end of data for a single device. In all cases, additional start-up bytes of data are required to provide four clocks for the startup sequence at the end of configuration. Long daisy chains require additional startup bytes to shift the last data through the chain. All startup bytes are don't-cares; these bytes are not included in bitstreams created by the Xilinx software.

A selection of CRC or non-CRC error checking is allowed by the bitstream generation software. The non-CRC error checking tests for a designated end-of-frame field for each frame. For CRC error checking, the software calculates a running CRC and inserts a unique four-bit partial check at the end of each frame. The 11-bit CRC check of the last frame of an FPGA includes the last seven data bits.

Detection of an error results in the suspension of data loading and the pulling down of the $\overline{INIT}$ pin. In Master modes, CCLK and address signals continue to operate externally. The user must detect $\overline{INIT}$ and initialize a new configuration by pulsing the $\overline{PROGRAM}$ pin Low or cycling Vcc.

**Table 21: XC4000E Program Data**

| Device | XC4003E | XC4005E | XC4006E | XC4008E | XC4010E | XC4013E | XC4020E | XC4025E |
|---|---|---|---|---|---|---|---|---|
| Max Logic Gates | 3,000 | 5,000 | 6,000 | 8,000 | 10,000 | 13,000 | 20,000 | 25,000 |
| CLBs (Row x Col.) | 100 (10 x 10) | 196 (14 x 14) | 256 (16 x 16) | 324 (18 x 18) | 400 (20 x 20) | 576 (24 x 24) | 784 (28 x 28) | 1,024 (32 x 32) |
| IOBs | 80 | 112 | 128 | 144 | 160 | 192 | 224 | 256 |
| Flip-Flops | 360 | 616 | 768 | 936 | 1,120 | 1,536 | 2,016 | 2,560 |
| Bits per Frame | 126 | 166 | 186 | 206 | 226 | 266 | 306 | 346 |
| Frames | 428 | 572 | 644 | 716 | 788 | 932 | 1,076 | 1,220 |
| Program Data | 53,936 | 94,960 | 119,792 | 147,504 | 178,096 | 247,920 | 329,264 | 422,128 |
| PROM Size (bits) | 53,984 | 95,008 | 119,840 | 147,552 | 178,144 | 247,968 | 329,312 | 422,176 |

Notes: 1. Bits per Frame = (10 x number of rows) + 7 for the top + 13 for the bottom + 1 + 1 start bit + 4 error check bits
Number of Frames = (36 x number of columns) + 26 for the left edge + 41 for the right edge + 1
Program Data = (Bits per Frame x Number of Frames) + 8 postamble bits
PROM Size = Program Data + 40 (header) + 8
2. The user can add more "one" bits as leading dummy bits in the header, or, if CRC = off, as trailing dummy bits at the end of any frame, following the four error check bits. However, the Length Count value **must** be adjusted for all such extra "one" bits, even for extra leading ones at the beginning of the header.

**Table 22: XC4000EX/XL Program Data**

| Device | XC4005 | XC4010 | XC4013 | XC4020 | XC4028 | XC4036 | XC4044 | XC4052 | XC4062 | XC4085 |
|---|---|---|---|---|---|---|---|---|---|---|
| Max Logic Gates | 5,000 | 10,000 | 13,000 | 20,000 | 28,000 | 36,000 | 44,000 | 52,000 | 62,000 | 85,000 |
| CLBs (Row x Column) | 196 (14 x 14) | 400 (20 x 20) | 576 (24 x 24) | 784 (28 x 28) | 1,024 (32 x 32) | 1,296 (36 x 36) | 1,600 (40 x 40) | 1,936 (44 x 44) | 2,304 (48 x 48) | 3,136 (56 x 56) |
| IOBs | 112 | 160 | 192 | 224 | 256 | 288 | 320 | 352 | 384 | 448 |
| Flip-Flops | 616 | 1,120 | 1,536 | 2,016 | 2,560 | 3,168 | 3,840 | 4,576 | 5,376 | 7,168 |
| Bits per Frame | 205 | 277 | 325 | 373 | 421 | 469 | 517 | 565 | 613 | 709 |
| Frames | 741 | 1,023 | 1,211 | 1,399 | 1,587 | 1,775 | 1,963 | 2,151 | 2,339 | 2,715 |
| Program Data | 151,910 | 283,376 | 393,580 | 521,832 | 668,132 | 832,480 | 1,014,876 | 1,215,320 | 1,433,812 | 1,924,940 |
| PROM Size (bits) | 151,960 | 283,424 | 393,632 | 521,880 | 668,184 | 832,528 | 1,014,928 | 1,215,368 | 1,433,864 | 1,924,992 |

Notes: 1. Bits per frame = (12 x number of rows) + 8 for the top + 16 for the bottom + 8 + 1 start bit + 4 error check bits.
Frames = (47 x number of columns) + 27 for the left edge + 52 for the right edge + 4.
Program data = (bits per frame x number of frames) + 5 postamble bits.
PROM size = (program data + 40 header bits + 8 start bits) rounded up to the nearest byte.
2. The user can add more "one" bits as leading dummy bits in the header, or, if CRC = off, as trailing dummy bits at the end of any frame, following the four error check bits. However, the Length Count value **must** be adjusted for all such extra "one" bits, even for extra leading "ones" at the beginning of the header.t

## Cyclic Redundancy Check (CRC) for Configuration and Readback

The Cyclic Redundancy Check is a method of error detection in data transmission applications. Generally, the transmitting system performs a calculation on the serial bitstream. The result of this calculation is tagged onto the data stream as additional check bits. The receiving system performs an identical calculation on the bitstream and compares the result with the received checksum.

Each data frame of the configuration bitstream has four error bits at the end, as shown in Table 20. If a frame data error is detected during the loading of the FPGA, the configuration process with a potentially corrupted bitstream is terminated. The FPGA pulls the $\overline{INIT}$ pin Low and goes into a Wait state.

During Readback, 11 bits of the 16-bit checksum are added to the end of the Readback data stream. The checksum is computed using the CRC-16 CCITT polynomial, as shown in Figure 46. The checksum consists of the 11 most significant bits of the 16-bit code. A change in the checksum indicates a change in the Readback bitstream. A comparison to a previous checksum is meaningful only if the readback data is independent of the current device state. CLB outputs should not be included (Read Capture option not used), and if RAM is present, the RAM content must be unchanged.

Statistically, one error out of 2048 might go undetected.

## Configuration Sequence

There are four major steps in the XC4000 Series power-up configuration sequence.

• Configuration Memory Clear
• Initialization
• Configuration
• Start-Up

The full process is illustrated in Figure 47.

### Configuration Memory Clear

When power is first applied or is reapplied to an FPGA, an internal circuit forces initialization of the configuration logic. When Vcc reaches an operational level, and the circuit passes the write and read test of a sample pair of configuration bits, a time delay is started. This time delay is nominally 16 ms, and up to 10% longer in the low-voltage devices. The delay is four times as long when in Master Modes (M0 Low), to allow ample time for all slaves to reach a stable Vcc. When all INIT pins are tied together, as recommended, the longest delay takes precedence. Therefore, devices with different time delays can easily be mixed and matched in a daisy chain.

This delay is applied only on power-up. It is not applied when reconfiguring an FPGA by pulsing the PROGRAM pin



Polynomial: X16 + X15 + X2 + 1
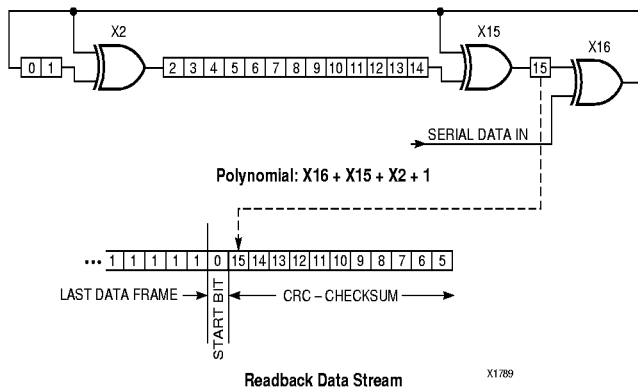
**Figure 46: Circuit for Generating CRC-16**
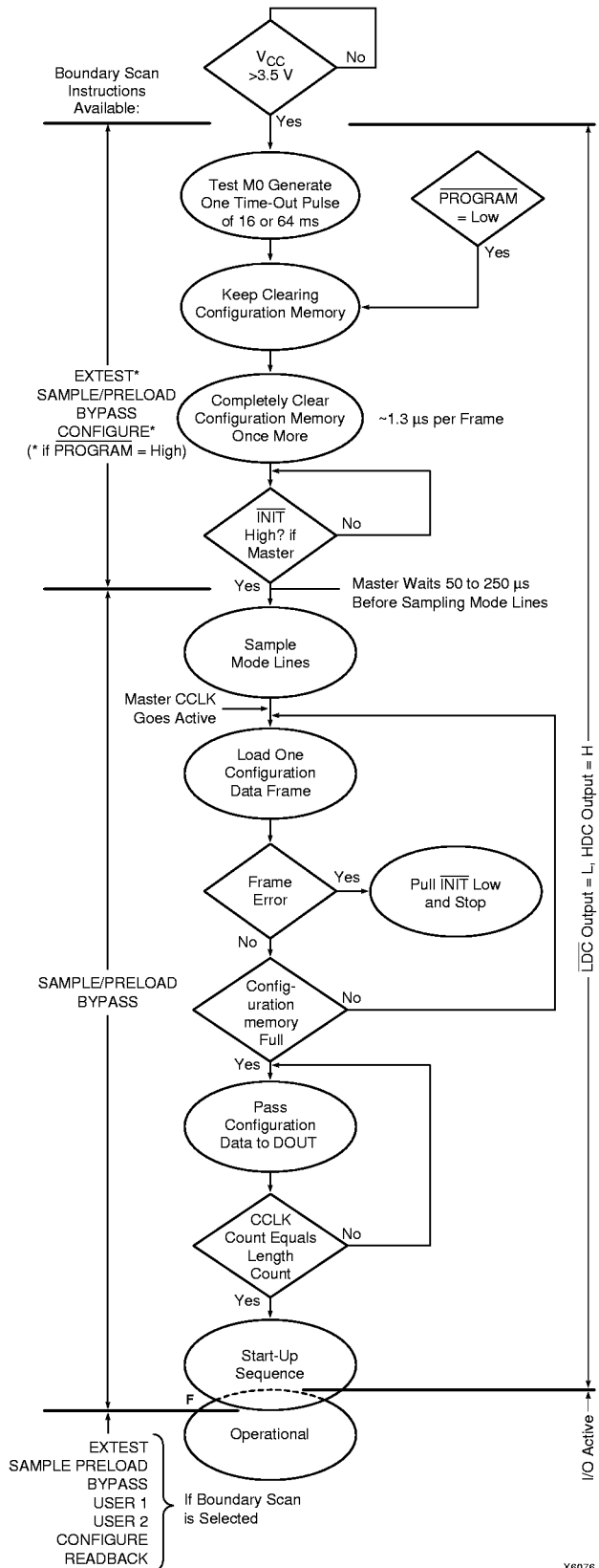


**Figure 47: Power-up Configuration Sequence**

Low. During this time delay, or as long as the $\overline{\text{PROGRAM}}$ input is asserted, the configuration logic is held in a Config-uration Memory Clear state. The configuration-memory frames are consecutively initialized, using the internal oscil-lator.

At the end of each complete pass through the frame addressing, the power-on time-out delay circuitry and the level of the $\overline{\text{PROGRAM}}$ pin are tested. If neither is asserted, the logic initiates one additional clearing of the configura-tion frames and then tests the $\overline{\text{INIT}}$ input.

### Initialization

During initialization and configuration, user pins HDC, $\overline{\text{LDC}}$, $\overline{\text{INIT}}$ and DONE provide status outputs for the system inter-face. The outputs $\overline{\text{LDC}}$, $\overline{\text{INIT}}$ and DONE are held Low and HDC is held High starting at the initial application of power.

The open drain $\overline{\text{INIT}}$ pin is released after the final initializa-tion pass through the frame addresses. There is a deliber-ate delay of 50 to 250 µs (up to 10% longer for low-voltage devices) before a Master-mode device recognizes an inac-tive $\overline{\text{INIT}}$. Two internal clocks after the $\overline{\text{INIT}}$ pin is recognized as High, the FPGA samples the three mode lines to deter-mine the configuration mode. The appropriate interface lines become active and the configuration preamble and data can be loaded.Configuration

The 0010 preamble code indicates that the following 24 bits represent the length count. The length count is the total number of configuration clocks needed to load the com-plete configuration data. (Four additional configuration clocks are required to complete the configuration process, as discussed below.) After the preamble and the length count have been passed through to all devices in the daisy chain, DOUT is held High to prevent frame start bits from reaching any daisy-chained devices.

A specific configuration bit, early in the first frame of a mas-ter device, controls the configuration-clock rate and can increase it by a factor of eight. Therefore, if a fast configu-ration clock is selected by the bitstream, the slower clock rate is used until this configuration bit is detected.

Each frame has a start field followed by the frame-configu-ration data bits and a frame error field. If a frame data error is detected, the FPGA halts loading, and signals the error by pulling the open-drain $\overline{\text{INIT}}$ pin Low. After all configura-tion frames have been loaded into an FPGA, DOUT again follows the input data so that the remaining data is passed on to the next device.

### Delaying Configuration After Power-Up

There are two methods of delaying configuration after power-up: put a logic Low on the $\overline{\text{PROGRAM}}$ input, or pull the bidirectional $\overline{\text{INIT}}$ pin Low, using an open-collector (open-drain) driver. (See Figure 47 on page 4-51.)

A Low on the $\overline{\text{PROGRAM}}$ input is the more radical approach, and is recommended when the power-supply

rise time is excessive or poorly defined. As long as $\overline{\text{PRO-GRAM}}$ is Low, the FPGA keeps clearing its configuration memory. When $\overline{\text{PROGRAM}}$ goes High, the configuration memory is cleared one more time, followed by the begin-ning of configuration, provided the $\overline{\text{INIT}}$ input is not exter-nally held Low. Note that a Low on the $\overline{\text{PROGRAM}}$ input automatically forces a Low on the $\overline{\text{INIT}}$ output. The XC4000 Series $\overline{\text{PROGRAM}}$ pin has a permanent weak pull-up.

Using an open-collector or open-drain driver to hold $\overline{\text{INIT}}$ Low before the beginning of configuration causes the FPGA to wait after completing the configuration memory clear operation. When $\overline{\text{INIT}}$ is no longer held Low exter-nally, the device determines its configuration mode by cap-turing its mode pins, and is ready to start the configuration process. A master device waits up to an additional 250 µs to make sure that any slaves in the optional daisy chain have seen that $\overline{\text{INIT}}$ is High.

### Start-Up

Start-up is the transition from the configuration process to the intended user operation. This transition involves a change from one clock source to another, and a change from interfacing parallel or serial configuration data where most outputs are 3-stated, to normal operation with I/O pins active in the user-system. Start-up must make sure that the user-logic 'wakes up' gracefully, that the outputs become active without causing contention with the configuration sig-nals, and that the internal flip-flops are released from the global Reset or Set at the right time.

Figure 48 describes start-up timing for the three Xilinx fam-ilies in detail. The configuration modes can use any of the four timing sequences.

To access the internal start-up signals, place the STARTUP library symbol.

**Start-up Timing**

Different FPGA families have different start-up sequences.

The XC2000 family goes through a fixed sequence. DONE goes High and the internal global Reset is de-activated one CCLK period after the I/O become active.

The XC3000A family offers some flexibility. DONE can be programmed to go High one CCLK period before or after the I/O become active. Independent of DONE, the internal global Reset is de-activated one CCLK period before or after the I/O become active.

The XC4000 Series offers additional flexibility. The three events — DONE going High, the internal Set/Reset being de-activated, and the user I/O going active — can all occur in any arbitrary sequence. Each of them can occur one CCLK period before or after, or simultaneous with, any of the others. This relative timing is selected by means of soft-ware options in the bitstream generation software.

The default option, and the most practical one, is for DONE to go High first, disconnecting the configuration data source and avoiding any contention when the I/Os become active one clock later. Reset/Set is then released another clock period later to make sure that user-operation starts from stable internal conditions. This is the most common sequence, shown with heavy lines in Figure 48, but the designer can modify it to meet particular requirements.

Normally, the start-up sequence is controlled by the internal device oscillator output (CCLK), which is asynchronous to the system clock.

XC4000 Series offers another start-up clocking option, UCLK_NOSYNC. The three events described above need not be triggered by CCLK. They can, as a configuration option, be triggered by a user clock. This means that the device can wake up in synchronism with the user system.

When the UCLK_SYNC option is enabled, the user can externally hold the open-drain DONE output Low, and thus stall all further progress in the start-up sequence until DONE is released and has gone High. This option can be used to force synchronization of several FPGAs to a common user clock, or to guarantee that all devices are successfully configured before any I/Os go active.

If either of these two options is selected, and no user clock is specified in the design or attached to the device, the chip could reach a point where the configuration of the device is complete and the Done pin is asserted, but the outputs do not become active. The solution is either to recreate the bitstream specifying the start-up clock as CCLK, or to supply the appropriate user clock.

**Start-up Sequence**

The Start-up sequence begins when the configuration memory is full, and the total number of configuration clocks received since $\overline{INIT}$ went High equals the loaded value of the length count.

The next rising clock edge sets a flip-flop Q0, shown in Figure 49. Q0 is the leading bit of a 5-bit shift register. The outputs of this register can be programmed to control three events.

- The release of the open-drain DONE output
- The change of configuration-related pins to the user function, activating all IOBs.
- The termination of the global Set/Reset initialization of all CLB and IOB storage elements.

The DONE pin can also be wire-ANDed with DONE pins of other FPGAs or with other external signals, and can then be used as input to bit Q3 of the start-up register. This is called "Start-up Timing Synchronous to Done In" and is selected by either CCLK_SYNC or UCLK_SYNC.

When DONE is not used as an input, the operation is called "Start-up Timing Not Synchronous to DONE In," and is selected by either CCLK_NOSYNC or UCLK_NOSYNC.

As a configuration option, the start-up control register beyond Q0 can be clocked either by subsequent CCLK pulses or from an on-chip user net called STARTUP.CLK. These signals can be accessed by placing the STARTUP library symbol.

**Start-up from CCLK**

If CCLK is used to drive the start-up, Q0 through Q3 provide the timing. Heavy lines in Figure 48 show the default timing, which is compatible with XC2000 and XC3000 devices using early DONE and late Reset. The thin lines indicate all other possible timing options.

**F** = Finished, no more
configuration clocks needed
Daisy-chain lead device
must have latest F

Heavy lines describe
default timing

X9024
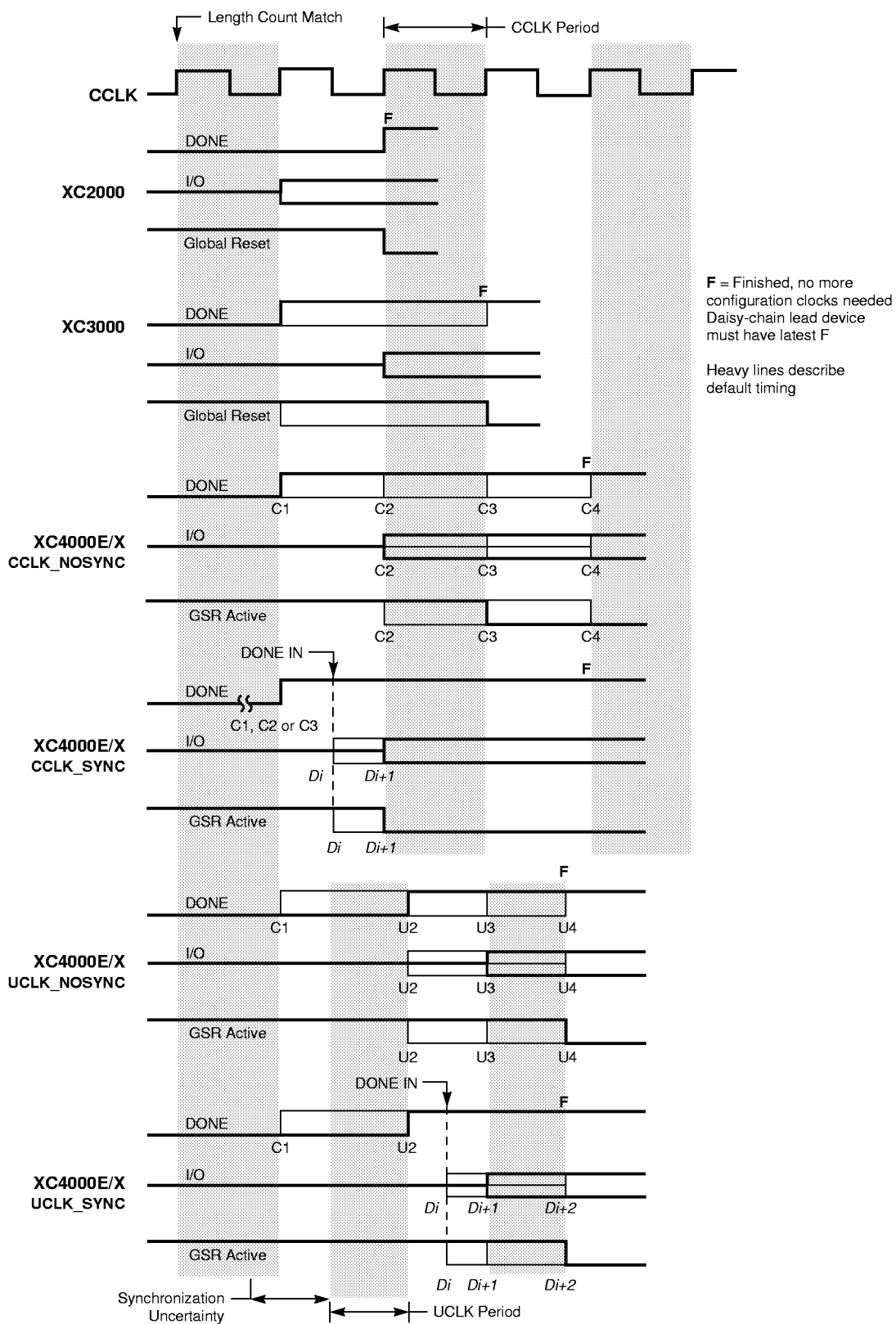
**Figure 48: Start-up Timing**

### Start-up from a User Clock (STARTUP.CLK)

When, instead of CCLK, a user-supplied start-up clock is selected, Q1 is used to bridge the unknown phase relationship between CCLK and the user clock. This arbitration causes an unavoidable one-cycle uncertainty in the timing of the rest of the start-up sequence.

## DONE Goes High to Signal End of Configuration

XC4000 Series devices read the expected length count from the bitstream and store it in an internal register. The length count varies according to the number of devices and the composition of the daisy chain. Each device also counts the number of CCLKs during configuration.

Two conditions have to be met in order for the DONE pin to go high:

- the chip's internal memory must be full, and
- the configuration length count must be met, *exactly.*

This is important because the counter that determines when the length count is met begins with the very first CCLK, not the first one after the preamble.

Therefore, if a stray bit is inserted before the preamble, or the data source is not ready at the time of the first CCLK, the internal counter that holds the number of CCLKs will be one ahead of the actual number of data bits read. At the end of configuration, the configuration memory will be full, but the number of bits in the internal counter will not match the expected length count.

As a consequence, a Master mode device will continue to send out CCLKs until the internal counter turns over to zero, and then reaches the correct length count a second time. This will take several seconds [$2^{24}$ ∗ CCLK period] — which is sometimes interpreted as the device not configuring at all.

If it is not possible to have the data ready at the time of the first CCLK, the problem can be avoided by increasing the number in the length count by the appropriate value. The *XACT User Guide* includes detailed information about manually altering the length count.

Note that DONE is an open-drain output and does not go High unless an internal pull-up is activated or an external pull-up is attached. The internal pull-up is activated as the default by the bitstream generation software.

## Release of User I/O After DONE Goes High

By default, the user I/O are released one CCLK cycle after the DONE pin goes High. If CCLK is not clocked after DONE goes High, the outputs remain in their initial state — 3-stated, with a 50 kΩ - 100 kΩ pull-up. The delay from DONE High to active user I/O is controlled by an option to the bitstream generation software.

## Release of Global Set/Reset After DONE Goes High

By default, Global Set/Reset (GSR) is released two CCLK cycles after the DONE pin goes High. If CCLK is not clocked twice after DONE goes High, all flip-flops are held in their initial set or reset state. The delay from DONE High to GSR inactive is controlled by an option to the bitstream generation software.

## Configuration Complete After DONE Goes High

Three full CCLK cycles are required after the DONE pin goes High, as shown in Figure 48 on page 4-54. If CCLK is not clocked three times after DONE goes High, readback cannot be initiated and most boundary scan instructions cannot be used.

# Configuration Through the Boundary Scan Pins

XC4000 Series devices can be configured through the boundary scan pins. The basic procedure is as follows:

- Power up the FPGA with $\overline{INIT}$ held Low (or drive the $\overline{PROGRAM}$ pin Low for more than 300 ns followed by a High while holding $\overline{INIT}$ Low). Holding $\overline{INIT}$ Low allows enough time to issue the CONFIG command to the FPGA. The pin can be used as I/O after configuration if a resistor is used to hold $\overline{INIT}$ Low.
- Issue the CONFIG command to the TMS input
- Wait for $\overline{INIT}$ to go High
- Sequence the boundary scan Test Access Port to the SHIFT-DR state
- Toggle TCK to clock data into TDI pin.

The user must account for all TCK clock cycles after INIT goes High, as all of these cycles affect the Length Count compare.

For more detailed information, refer to the Xilinx application note XAPP017, "*Boundary Scan in XC4000 Devices.*" This application note also applies to XC4000E and XC4000X devices.
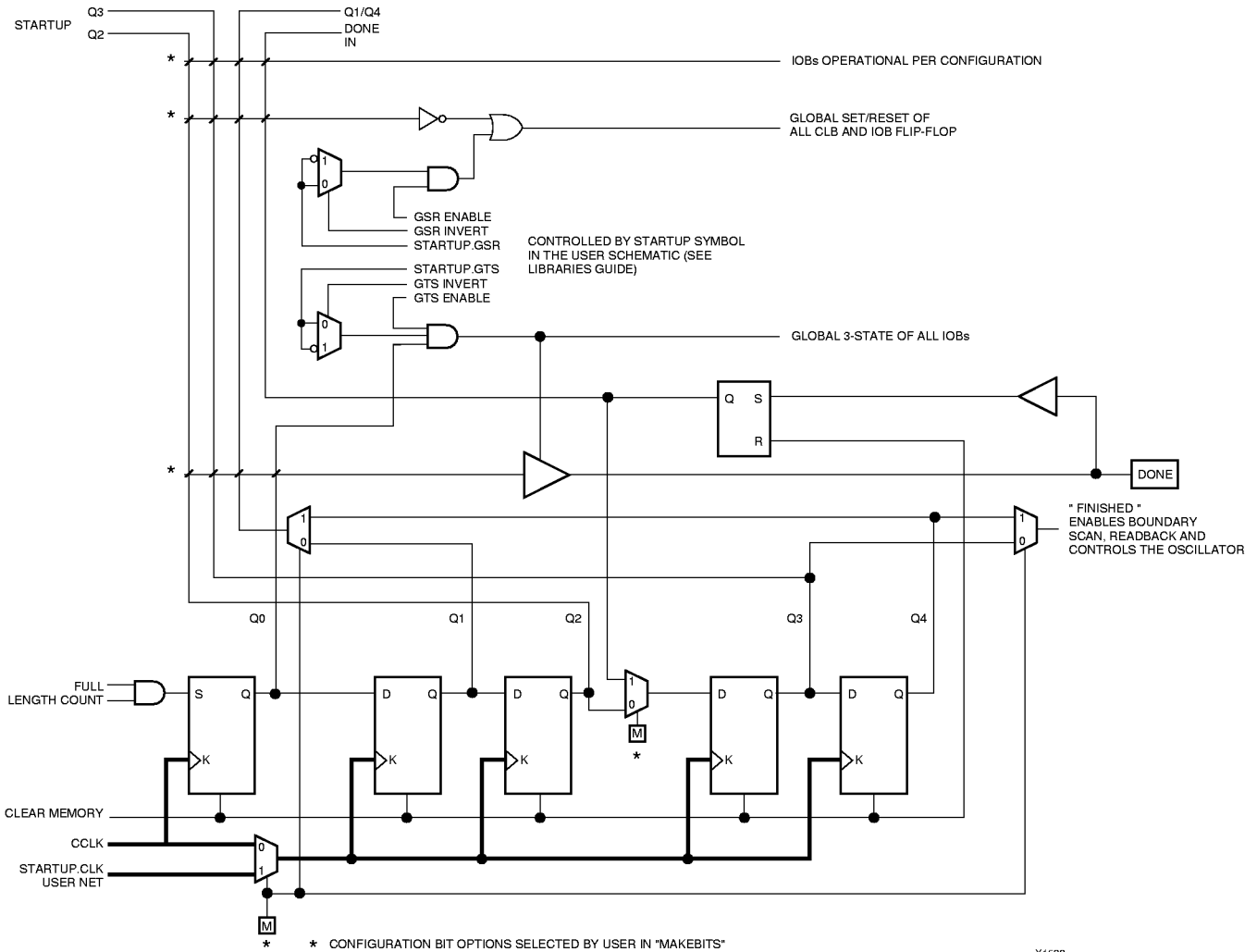
**Figure 49: Start-up Logic**

## Readback

The user can read back the content of configuration memory and the level of certain internal nodes without interfering with the normal operation of the device.

Readback not only reports the downloaded configuration bits, but can also include the present state of the device, represented by the content of all flip-flops and latches in CLBs and IOBs, as well as the content of function generators used as RAMs.

Note that in XC4000 Series devices, configuration data is *not* inverted with respect to configuration as it is in XC2000 and XC3000 families.

XC4000 Series Readback does not use any dedicated pins, but uses four internal nets (RDBK.TRIG, RDBK.DATA, RDBK.RIP and RDBK.CLK) that can be routed to any IOB. To access the internal Readback signals, place the READ-

BACK library symbol and attach the appropriate pad symbols, as shown in Figure 50.

After Readback has been initiated by a Low-to-High transition on RDBK.TRIG, the RDBK.RIP (Read In Progress) output goes High on the next rising edge of RDBK.CLK. Subsequent rising edges of this clock shift out Readback data on the RDBK.DATA net.

Readback data does not include the preamble, but starts with five dummy bits (all High) followed by the Start bit (Low) of the first frame. The first two data bits of the first frame are always High.

Each frame ends with four error check bits. They are read back as High. The last seven bits of the last frame are also read back as High. An additional Start bit (Low) and an 11-bit Cyclic Redundancy Check (CRC) signature follow, before RDBK.RIP returns Low.
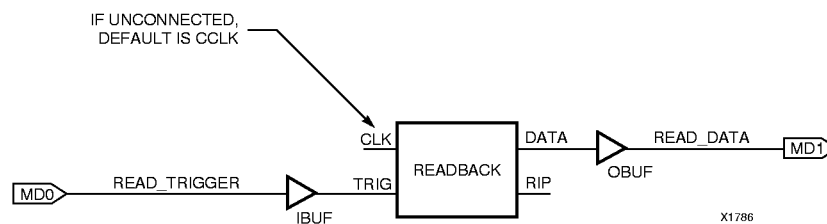
**Figure 50: Readback Schematic Example**

## Readback Options

Readback options are: Read Capture, Read Abort, and Clock Select. They are set with the bitstream generation software.

### Read Capture

When the Read Capture option is selected, the readback data stream includes sampled values of CLB and IOB signals. The rising edge of RDBK.TRIG latches the inverted values of the four CLB outputs, the IOB output flip-flops and the input signals I1 and I2. Note that while the bits describing configuration (interconnect, function generators, and RAM content) are *not* inverted, the CLB and IOB output signals *are* inverted.

When the Read Capture option is not selected, the values of the capture bits reflect the configuration data originally written to those memory locations.

If the RAM capability of the CLBs is used, RAM data are available in readback, since they directly overwrite the F and G function-table configuration of the CLB.

RDBK.TRIG is located in the lower-left corner of the device, as shown in Figure 51.

### Read Abort

When the Read Abort option is selected, a High-to-Low transition on RDBK.TRIG terminates the readback operation and prepares the logic to accept another trigger.

After an aborted readback, additional clocks (up to one readback clock per configuration frame) may be required to re-initialize the control logic. The status of readback is indicated by the output control net RDBK.RIP. RDBK.RIP is High whenever a readback is in progress.

### Clock Select

CCLK is the default clock. However, the user can insert another clock on RDBK.CLK. Readback control and data are clocked on rising edges of RDBK.CLK. If readback must be inhibited for security reasons, the readback control nets are simply not connected.

RDBK.CLK is located in the lower right chip corner, as shown in Figure 51.
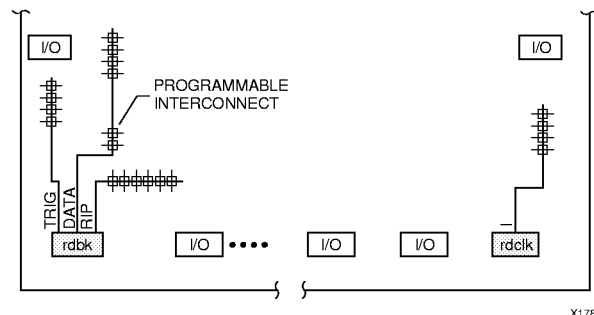


**Figure 51: READBACK Symbol in Graphical Editor**

## Violating the Maximum High and Low Time Specification for the Readback Clock

The readback clock has a maximum High and Low time specification. In some cases, this specification cannot be met. For example, if a processor is controlling readback, an interrupt may force it to stop in the middle of a readback. This necessitates stopping the clock, and thus violating the specification.

The specification is mandatory only on clocking data at the end of a frame prior to the next start bit. The transfer mechanism will load the data to a shift register during the last six clock cycles of the frame, prior to the start bit of the following frame. This loading process is dynamic, and is the source of the maximum High and Low time requirements.

Therefore, the specification only applies to the six clock cycles prior to and including any start bit, including the clocks before the first start bit in the readback data stream. At other times, the frame data is already in the register and the register is not dynamic. Thus, it can be shifted out just like a regular shift register.

The user must precisely calculate the location of the readback data relative to the frame. The system must keep track of the position within a data frame, and disable interrupts before frame boundaries. Frame lengths and data formats are listed in Table 20, Table 21 and Table 22.

## Readback with the XChecker Cable

The XChecker Universal Download/Readback Cable and Logic Probe uses the readback feature for bitstream verification. It can also display selected internal signals on the PC or workstation screen, functioning as a low-cost in-circuit emulator.

## Table 23: Pin Functions During Configuration

| CONFIGURATION MODE <M2:M1:M0> | | | | | | |
|---|---|---|---|---|---|---|
| SLAVE SERIAL <1:1:1> | MASTER SERIAL <0:0:0> | SYNCH. PERIPHERAL <0:1:1> | ASYNCH. PERIPHERAL <1:0:1> | MASTER PARALLEL DOWN <1:1:0> | MASTER PARALLEL UP <1:0:0> | USER OPERATION |
| M2(HIGH) (I) | M2(LOW) (I) | M2(LOW) (I) | M2(HIGH) (I) | M2(HIGH) (I) | M2(HIGH) (I) | (I) |
| M1(HIGH) (I) | M1(LOW) (I) | M1(HIGH) (I) | M1(LOW) (I) | M1(HIGH) (I) | M1(LOW) (I) | (O) |
| M0(HIGH) (I) | M0(LOW) (I) | M0(HIGH) (I) | M0(HIGH) (I) | M0(LOW) (I) | M0(LOW) (I) | (I) |
| HDC (HIGH) | HDC (HIGH) | HDC (HIGH) | HDC (HIGH) | HDC (HIGH) | HDC (HIGH) | I/O |
| LDC (LOW) | LDC (LOW) | LDC (LOW) | LDC (LOW) | LDC (LOW) | LDC (LOW) | I/O |
| INIT | INIT | INIT | INIT | INIT | INIT | I/O |
| DONE | DONE | DONE | DONE | DONE | DONE | DONE |
| PROGRAM (I) | PROGRAM (I) | PROGRAM (I) | PROGRAM (I) | PROGRAM (I) | PROGRAM (I) | PROGRAM |
| CCLK (I) | CCLK (O) | CCLK (I) | CCLK (O) | CCLK (O) | CCLK (O) | CCLK (I) |
| | | RDY/BUSY (O) | RDY/BUSY (O) | RCLK (O) | RCLK (O) | I/O |
| | | | RS (I) | | | I/O |
| | | | CS0 (I) | | | I/O |
| | | DATA 7 (I) | DATA 7 (I) | DATA 7 (I) | DATA 7 (I) | I/O |
| | | DATA 6 (I) | DATA 6 (I) | DATA 6 (I) | DATA 6 (I) | I/O |
| | | DATA 5 (I) | DATA 5 (I) | DATA 5 (I) | DATA 5 (I) | I/O |
| | | DATA 4 (I) | DATA 4 (I) | DATA 4 (I) | DATA 4 (I) | I/O |
| | | DATA 3 (I) | DATA 3 (I) | DATA 3 (I) | DATA 3 (I) | I/O |
| | | DATA 2 (I) | DATA 2 (I) | DATA 2 (I) | DATA 2 (I) | I/O |
| | | DATA 1 (I) | DATA 1 (I) | DATA 1 (I) | DATA 1 (I) | I/O |
| DIN (I) | DIN (I) | DATA 0 (I) | DATA 0 (I) | DATA 0 (I) | DATA 0 (I) | I/O |
| DOUT | DOUT | DOUT | DOUT | DOUT | DOUT | SGCK4-GCK5-I/O |
| TDI | TDI | TDI | TDI | TDI | TDI | TDI-I/O |
| TCK | TCK | TCK | TCK | TCK | TCK | TCK-I/O |
| TMS | TMS | TMS | TMS | TMS | TMS | TMS-I/O |
| TDO | TDO | TDO | TDO | TDO | TDO | TDO-(O) |
| | | | WS (I) | A0 | A0 | I/O |
| | | | | A1 | A1 | PGCK4-GCK6-I/O |
| | | | CS1 | A2 | A2 | I/O |
| | | | | A3 | A3 | I/O |
| | | | | A4 | A4 | I/O |
| | | | | A5 | A5 | I/O |
| | | | | A6 | A6 | I/O |
| | | | | A7 | A7 | I/O |
| | | | | A8 | A8 | I/O |
| | | | | A9 | A9 | I/O |
| | | | | A10 | A10 | I/O |
| | | | | A11 | A11 | I/O |
| | | | | A12 | A12 | I/O |
| | | | | A13 | A13 | I/O |
| | | | | A14 | A14 | I/O |
| | | | | A15 | A15 | SGCK1-GCK7-I/O |
| | | | | A16 | A16 | PGCK1-GCK8-I/O |
| | | | | A17 | A17 | I/O |
| | | | | A18* | A18* | I/O |
| | | | | A19* | A19* | I/O |
| | | | | A20* | A20* | I/O |
| | | | | A21* | A21* | I/O |
| | | | | | | ALL OTHERS |

* XC4000X only

Notes   1. A shaded table cell represents a 50 kΩ - 100 kΩ pull-up before and during configuration.

          2. (I) represents an input; (O) represents an output.

          3. INIT is an open-drain output during configuration.

# XC4000E/EX/XL Program Readback Switching Characteristic Guidelines

Testing of the switching parameters is modeled after testing methods specified by MIL-M-38510/605. All devices are 100% functionally tested. Internal timing parameters are not measured directly. They are derived from benchmark timing patterns that are taken at device introduction, prior to any process improvements.

The following guidelines reflect worst-case values over the recommended operating conditions.



X1790

## E/EX

| | Description | | Symbol | Min | Max | Units |
|---|---|---|---|---|---|---|
| rdbk.TRIG | rdbk.TRIG setup to initiate and abort Readback | 1 | $T_{RTRC}$ | 200 | - | ns |
| | rdbk.TRIG hold to initiate and abort Readback | 2 | $T_{RCRT}$ | 50 | - | ns |
| rdclk.1 | rdbk.DATA delay | 7 | $T_{RCRD}$ | - | 250 | ns |
| | rdbk.RIP delay | 6 | $T_{RCRR}$ | - | 250 | ns |
| | High time | 5 | $T_{RCH}$ | 250 | 500 | ns |
| | Low time | 4 | $T_{RCL}$ | 250 | 500 | ns |

Note 1:   Timing parameters apply to all speed grades.
Note 2:   If rdbk.TRIG is High prior to Finished, Finished will trigger the first Readback.

## XL

| | Description | | Symbol | Min | Max | Units |
|---|---|---|---|---|---|---|
| rdbk.TRIG | rdbk.TRIG setup to initiate and abort Readback | 1 | $T_{RTRC}$ | 200 | - | ns |
| | rdbk.TRIG hold to initiate and abort Readback | 2 | $T_{RCRT}$ | 50 | - | ns |
| rdclk.1 | rdbk.DATA delay | 7 | $T_{RCRD}$ | - | 250 | ns |
| | rdbk.RIP delay | 6 | $T_{RCRR}$ | - | 250 | ns |
| | High time | 5 | $T_{RCH}$ | 250 | 500 | ns |
| | Low time | 4 | $T_{RCL}$ | 250 | 500 | ns |

Note 1:   Timing parameters apply to all speed grades.
Note 2:   If rdbk.TRIG is High prior to Finished, Finished will trigger the first Readback.

# Configuration Timing

The seven configuration modes are discussed in detail in this section. Timing specifications are included.

## Slave Serial Mode

In Slave Serial mode, an external signal drives the CCLK input of the FPGA. The serial configuration bitstream must be available at the DIN input of the lead FPGA a short setup time before each rising CCLK edge.

The lead FPGA then presents the preamble data—and all data that overflows the lead device—on its DOUT pin.

There is an internal delay of 0.5 CCLK periods, which means that DOUT changes on the falling CCLK edge, and the next FPGA in the daisy chain accepts data on the subsequent rising CCLK edge.

Figure 52 shows a full master/slave system. An XC4000 Series device in Slave Serial mode should be connected as shown in the third device from the left.

Slave Serial mode is selected by a <111> on the mode pins (M2, M1, M0). Slave Serial is the default mode if the mode pins are left unconnected, as they have weak pull-up resistors during configuration.
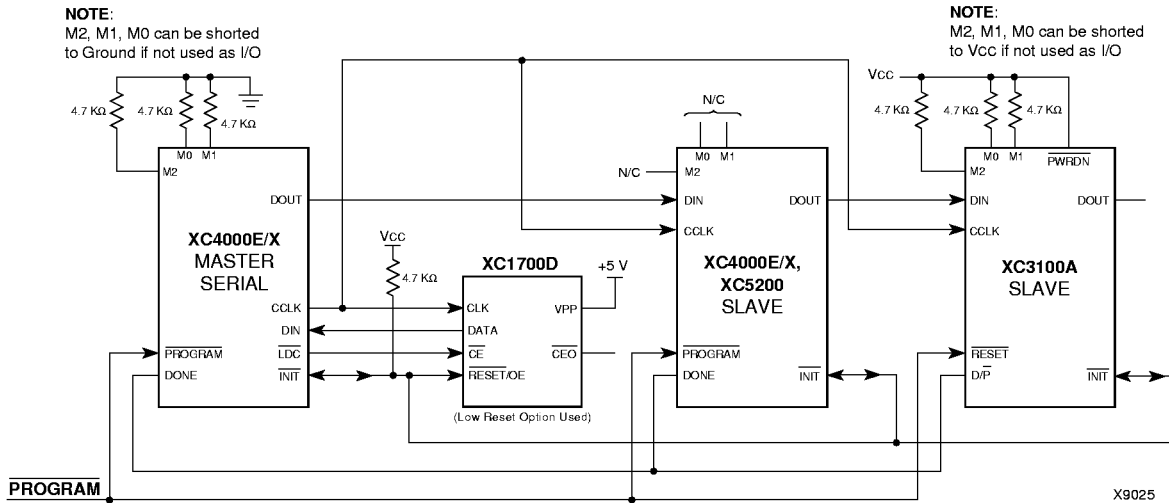


**Figure 52:  Master/Slave Serial Mode Circuit Diagram**
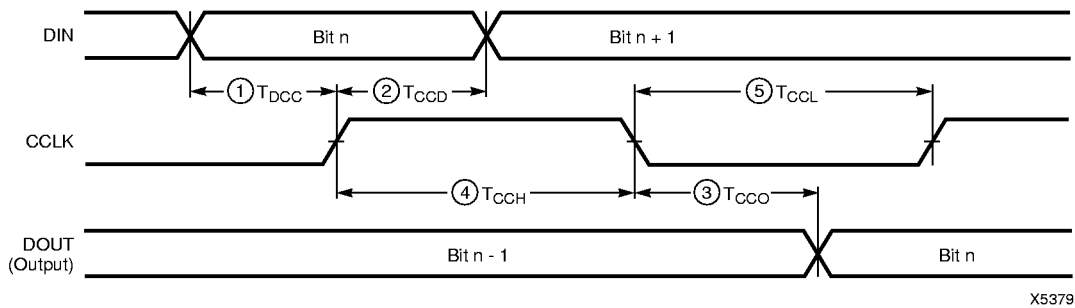


|  | Description |  | Symbol | Min | Max | Units |
|---|---|---|---|---|---|---|
| **CCLK** | DIN setup | 1 | $T_{DCC}$ | 20 |  | ns |
|  | DIN hold | 2 | $T_{CCD}$ | 0 |  | ns |
|  | DIN to DOUT | 3 | $T_{CCO}$ |  | 30 | ns |
|  | High time | 4 | $T_{CCH}$ | 45 |  | ns |
|  | Low time | 5 | $T_{CCL}$ | 45 |  | ns |
|  | Frequency |  | $F_{CC}$ |  | 10 | MHz |

Note:    Configuration must be delayed until the $\overline{INIT}$ pins of all daisy-chained FPGAs are High.

**Figure 53:  Slave Serial Mode Programming Switching Characteristics**

## Master Serial Mode

In Master Serial mode, the CCLK output of the lead FPGA drives a Xilinx Serial PROM that feeds the FPGA DIN input. Each rising edge of the CCLK output increments the Serial PROM internal address counter. The next data bit is put on the SPROM data output, connected to the FPGA DIN pin. The lead FPGA accepts this data on the subsequent rising CCLK edge.

The lead FPGA then presents the preamble data—and all data that overflows the lead device—on its DOUT pin. There is an internal pipeline delay of 1.5 CCLK periods, which means that DOUT changes on the falling CCLK edge, and the next FPGA in the daisy chain accepts data on the subsequent rising CCLK edge.

In the bitstream generation software, the user can specify Fast ConfigRate, which, starting several bits into the first frame, increases the CCLK frequency by a factor of eight. For actual timing values please refer to "Configuration Switching Characteristics" on page 4-68. Be sure that the serial PROM and slaves are fast enough to support this data rate. XC2000, XC3000/A, and XC3100A devices do not support the Fast ConfigRate option.

The SPROM CE input can be driven from either $\overline{LDC}$ or DONE. Using $\overline{LDC}$ avoids potential contention on the DIN pin, if this pin is configured as user-I/O, but $\overline{LDC}$ is then restricted to be a permanently High user output after configuration. Using DONE can also avoid contention on DIN, provided the early DONE option is invoked.

Figure 52 on page 4-60 shows a full master/slave system. The leftmost device is in Master Serial mode.

Master Serial mode is selected by a <000> on the mode pins (M2, M1, M0).
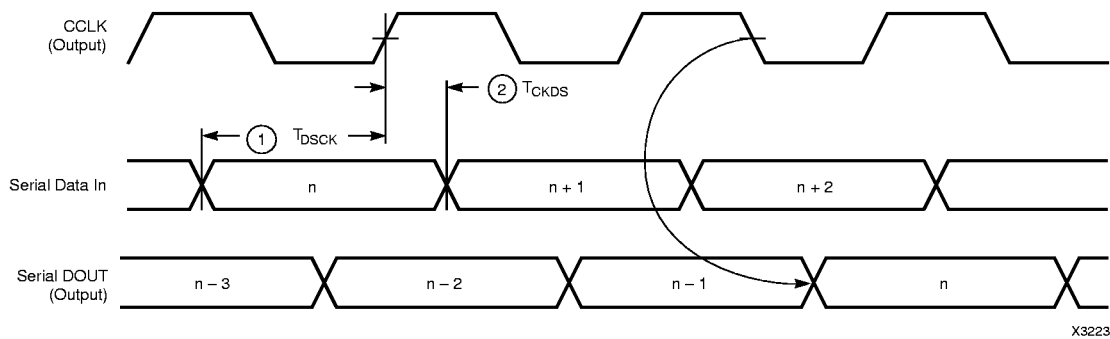


| | Description | | Symbol | Min | Max | Units |
|---|---|---|---|---|---|---|
| CCLK | DIN setup | 1 | $T_{DSCK}$ | 20 | | ns |
| | DIN hold | 2 | $T_{CKDS}$ | 0 | | ns |

Notes: 1. At power-up, Vcc must rise from 2.0 V to Vcc min in less than 25 ms, otherwise delay configuration by pulling $\overline{PROGRAM}$ Low until Vcc is valid.
2. Master Serial mode timing is based on testing in slave mode.

**Figure 54: Master Serial Mode Programming Switching Characteristics**

## Master Parallel Modes

In the two Master Parallel modes, the lead FPGA directly addresses an industry-standard byte-wide EPROM, and accepts eight data bits just before incrementing or decrementing the address outputs.

The eight data bits are serialized in the lead FPGA, which then presents the preamble data—and all data that overflows the lead device—on its DOUT pin. There is an internal delay of 1.5 CCLK periods, after the rising CCLK edge that accepts a byte of data (and also changes the EPROM address) until the falling CCLK edge that makes the LSB (D0) of this byte appear at DOUT. This means that DOUT changes on the falling CCLK edge, and the next FPGA in the daisy chain accepts data on the subsequent rising CCLK edge.

The PROM address pins can be incremented or decremented, depending on the mode pin settings. This option allows the FPGA to share the PROM with a wide variety of microprocessors and microcontrollers. Some processors must boot from the bottom of memory (all zeros) while others must boot from the top. The FPGA is flexible and can load its configuration bitstream from either end of the memory.

Master Parallel Up mode is selected by a <100> on the mode pins (M2, M1, M0). The EPROM addresses start at 00000 and increment.

Master Parallel Down mode is selected by a <110> on the mode pins. The EPROM addresses start at 3FFFF and decrement.

### Additional Address lines in XC4000 devices

The XC4000X devices have additional address lines (A18-A21) allowing the additional address space required to daisy-chain several large devices.

The extra address lines are programmable in XC4000EX devices. By default these address lines are not activated. In the default mode, the devices are compatible with existing XC4000 and XC4000E products. If desired, the extra address lines can be used by specifying the address lines option in bitgen as 22 (bitgen -g AddressLines:22). The lines (A18-A21) are driven when a master device detects, via the bitstream, that it should be using all 22 address lines. Because these pins will initially be pulled high by internal pull-ups, designers using Master Parallel Up mode should use external pull down resistors on pins A18-A21. If Master Parallel Down mode is used external resistors are not necessary.

All 22 address lines are always active in Master Parallel modes with XC4000XL devices. The additional address lines behave identically to the lower order address lines. If the Address Lines option in bitgen is set to 18, it will be ignored by the XC4000XL device.

The additional address lines (A18-A21) are not available in the PC84 package.



**Figure 55:  Master Parallel Mode Circuit Diagram**
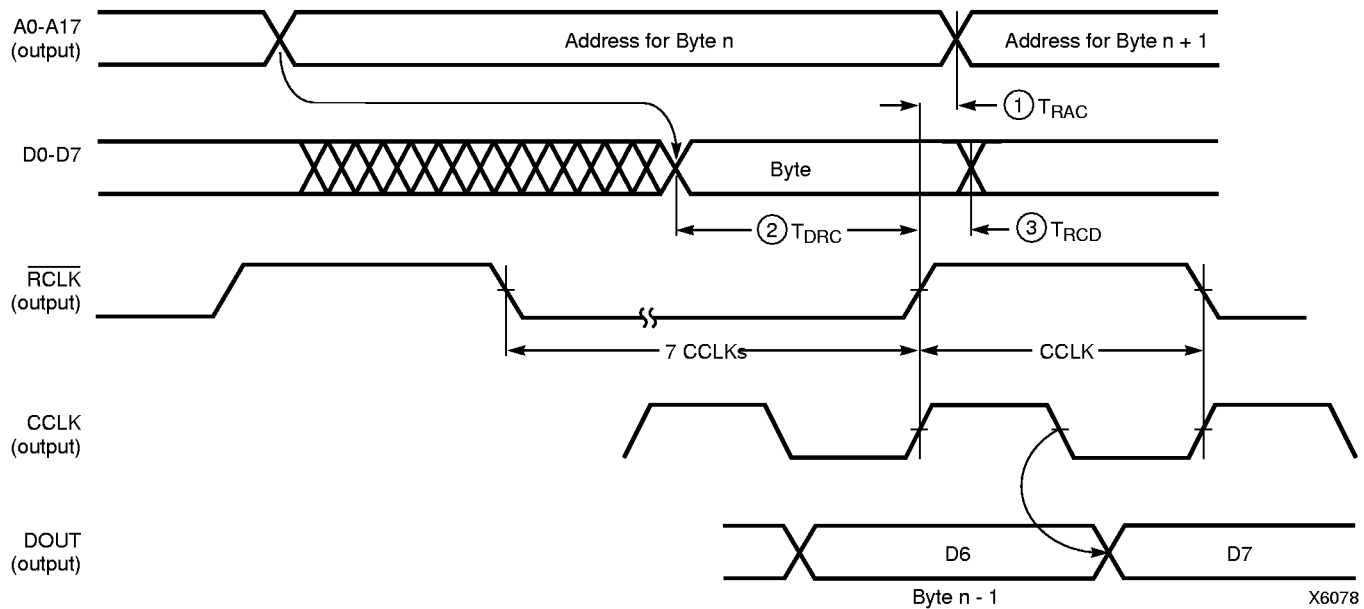
| | Description | Symbol | | Min | Max | Units |
|---|---|---|---|---|---|---|
| | Delay to Address valid | 1 | $T_{RAC}$ | 0 | 200 | ns |
| RCLK | Data setup time | 2 | $T_{DRC}$ | 60 | | ns |
| | Data hold time | 3 | $T_{RCD}$ | 0 | | ns |

Notes: 1. At power-up, Vcc must rise from 2.0 V to Vcc min in less than 25 ms, otherwise delay configuration by pulling $\overline{PROGRAM}$ Low until Vcc is valid.
2. The first Data byte is loaded and CCLK starts at the end of the first $\overline{RCLK}$ active cycle (rising edge).

This timing diagram shows that the EPROM requirements are extremely relaxed. EPROM access time can be longer than 500 ns. EPROM data output has no hold-time requirements.

**Figure 56: Master Parallel Mode Programming Switching Characteristics**

## Synchronous Peripheral Mode

Synchronous Peripheral mode can also be considered Slave Parallel mode. An external signal drives the CCLK input(s) of the FPGA(s). The first byte of parallel configuration data must be available at the Data inputs of the lead FPGA a short setup time before the rising CCLK edge. Subsequent data bytes are clocked in on every eighth consecutive rising CCLK edge.

The same CCLK edge that accepts data, also causes the RDY/$\overline{BUSY}$ output to go High for one CCLK period. The pin name is a misnomer. In Synchronous Peripheral mode it is really an ACKNOWLEDGE signal. Synchronous operation does not require this response, but it is a meaningful signal for test purposes. Note that RDY/$\overline{BUSY}$ is pulled High with a high-impedance pullup prior to $\overline{INIT}$ going High.

The lead FPGA serializes the data and presents the preamble data (and all data that overflows the lead device) on its DOUT pin. There is an internal delay of 1.5 CCLK periods, which means that DOUT changes on the falling CCLK edge, and the next FPGA in the daisy chain accepts data on the subsequent rising CCLK edge.

In order to complete the serial shift operation, 10 additional CCLK rising edges are required after the last data byte has been loaded, plus one more CCLK cycle for each daisy-chained device.

Synchronous Peripheral mode is selected by a <011> on the mode pins (M2, M1, M0).
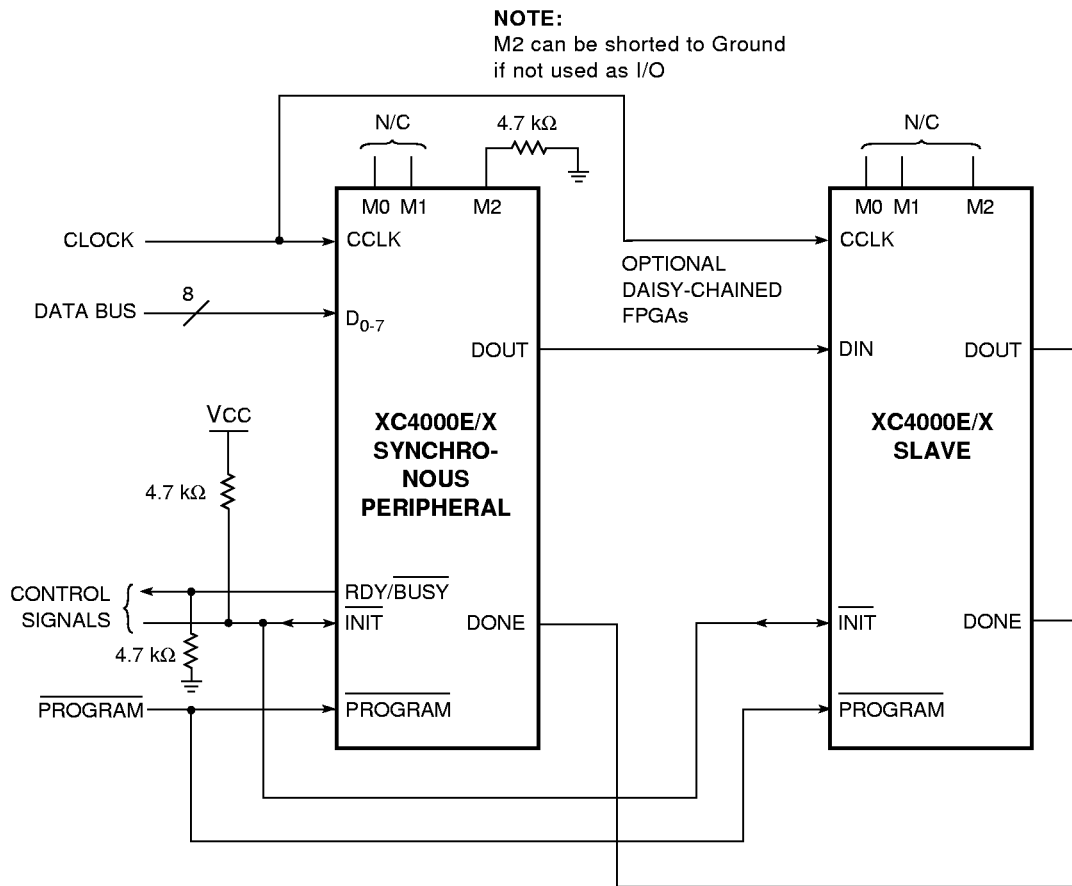


Figure 57: Synchronous Peripheral Mode Circuit Diagram
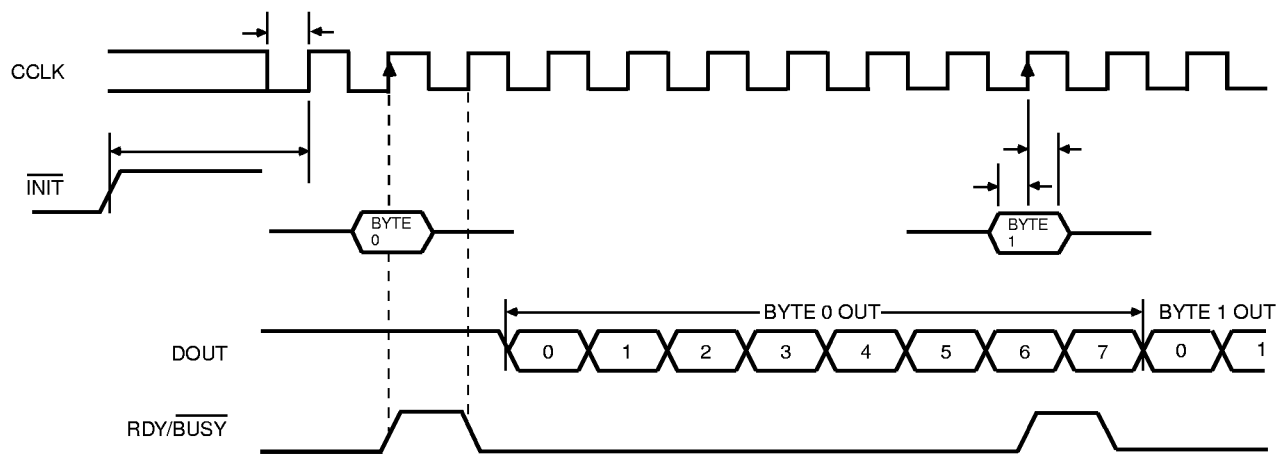
X6096

| | Description | Symbol | Min | Max | Units |
|---|---|---|---|---|---|
| CCLK | $\overline{\text{INIT}}$ (High) setup time | $T_{IC}$ | 5 | | μs |
| | D0 - D7 setup time | $T_{DC}$ | 60 | | ns |
| | D0 - D7 hold time | $T_{CD}$ | 0 | | ns |
| | CCLK High time | $T_{CCH}$ | 50 | | ns |
| | CCLK Low time | $T_{CCL}$ | 60 | | ns |
| | CCLK Frequency | $F_{CC}$ | | 8 | MHz |

Notes:  1. Peripheral Synchronous mode can be considered Slave Parallel mode. An external CCLK provides timing, clocking in the **first** data byte on the **second** rising edge of CCLK after $\overline{\text{INIT}}$ goes High. Subsequent data bytes are clocked in on every eighth consecutive rising edge of CCLK.
2. The RDY/$\overline{\text{BUSY}}$ line goes High for one CCLK period after data has been clocked in, although synchronous operation does not require such a response.
3. The pin name RDY/$\overline{\text{BUSY}}$ is a misnomer. In Synchronous Peripheral mode this is really an ACKNOWLEDGE signal.
4. Note that data starts to shift out serially on the DOUT pin 0.5 CCLK periods after it was loaded in parallel. Therefore, additional CCLK pulses are clearly required after the last byte has been loaded.

**Figure 58:  Synchronous Peripheral Mode Programming Switching Characteristics**

## Asynchronous Peripheral Mode

### Write to FPGA

Asynchronous Peripheral mode uses the trailing edge of the logic AND condition of $\overline{WS}$ and $\overline{CS0}$ being Low and $\overline{RS}$ and CS1 being High to accept byte-wide data from a microprocessor bus. In the lead FPGA, this data is loaded into a double-buffered UART-like parallel-to-serial converter and is serially shifted into the internal logic.

The lead FPGA presents the preamble data (and all data that overflows the lead device) on its DOUT pin. The RDY/$\overline{BUSY}$ output from the lead FPGA acts as a handshake signal to the microprocessor. RDY/$\overline{BUSY}$ goes Low when a byte has been received, and goes High again when the byte-wide input buffer has transferred its information into the shift register, and the buffer is ready to receive new data. A new write may be started immediately, as soon as the RDY/$\overline{BUSY}$ output has gone Low, acknowledging receipt of the previous data. Write may not be terminated until RDY/$\overline{BUSY}$ is High again for one CCLK period. Note that RDY/$\overline{BUSY}$ is pulled High with a high-impedance pull-up prior to $\overline{INIT}$ going High.

The length of the $\overline{BUSY}$ signal depends on the activity in the UART. If the shift register was empty when the new byte was received, the $\overline{BUSY}$ signal lasts for only two CCLK periods. If the shift register was still full when the new byte was received, the $\overline{BUSY}$ signal can be as long as nine CCLK periods.

Note that after the last byte has been entered, only seven of its bits are shifted out. CCLK remains High with DOUT equal to bit 6 (the next-to-last bit) of the last byte entered.

The READY/$\overline{BUSY}$ handshake can be ignored if the delay from any one Write to the end of the next Write is guaranteed to be longer than 10 CCLK periods.

### Status Read

The logic AND condition of the $\overline{CS0}$, CS1 and $\overline{RS}$ inputs puts the device status on the Data bus.

- D7 High indicates Ready
- D7 Low indicates Busy
- D0 through D6 go unconditionally High

It is mandatory that the whole start-up sequence be started and completed by one byte-wide input. Otherwise, the pins used as Write Strobe or Chip Enable might become active outputs and interfere with the final byte transfer. If this transfer does not occur, the start-up sequence is not completed all the way to the finish (point F in Figure 48 on page 4-54).

In this case, at worst, the internal reset is not released. At best, Readback and Boundary Scan are inhibited. The length-count value, as generated by the XACT*step* software, ensures that these problems never occur.

Although RDY/$\overline{BUSY}$ is brought out as a separate signal, microprocessors can more easily read this information on one of the data lines. For this purpose, D7 represents the RDY/$\overline{BUSY}$ status when $\overline{RS}$ is Low, $\overline{WS}$ is High, and the two chip select lines are both active.

Asynchronous Peripheral mode is selected by a <101> on the mode pins (M2, M1, M0).
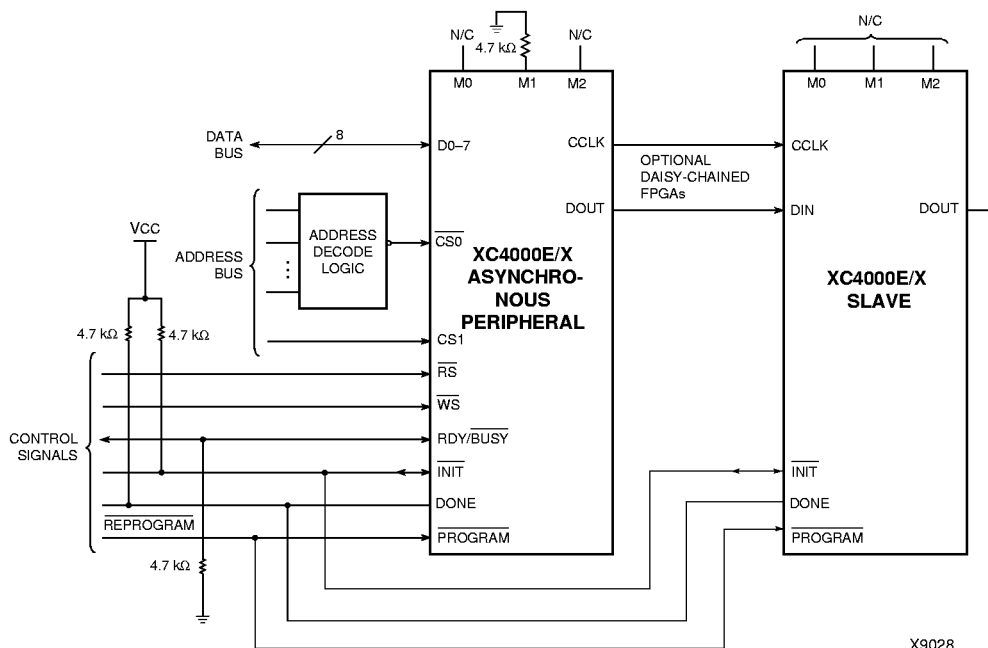


**Figure 59: Asynchronous Peripheral Mode Circuit Diagram**

Write to LCA  Read Status

WS/CS0  RS, CS0

RS, CS1  WS, CS1

D0-D7  D7

CCLK

RDY/BUSY

DOUT    Previous Byte D6    D7    D0    D1    D2
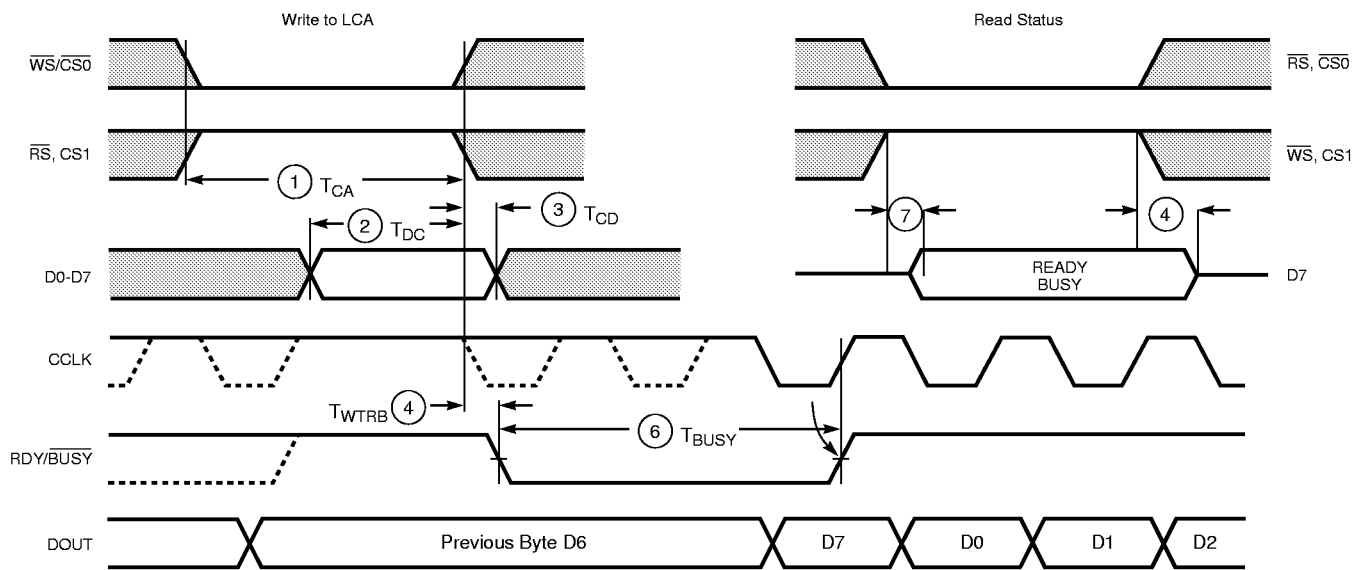
X6097

| | Description | | Symbol | Min | Max | Units |
|---|---|---|---|---|---|---|
| Write | Effective Write time (CS0, WS=Low; RS, CS1=High) | 1 | $T_{CA}$ | 100 | | ns |
| | DIN setup time | 2 | $T_{DC}$ | 60 | | ns |
| | DIN hold time | 3 | $T_{CD}$ | 0 | | ns |
| RDY | RDY/BUSY delay after end of Write or Read | 4 | $T_{WTRB}$ | | 60 | ns |
| | RDY/BUSY active after beginning of Read | 7 | | | 60 | ns |
| | RDY/BUSY Low output (Note 4) | 6 | $T_{BUSY}$ | 2 | 9 | CCLK periods |

Notes: 1. Configuration must be delayed until the INIT pins of all daisy-chained FPGAs are High.
2. The time from the end of WS to CCLK cycle for the new byte of data depends on the completion of previous byte processing and the phase of the internal timing generator for CCLK.
3. CCLK and DOUT timing is tested in slave mode.
4. $T_{BUSY}$ indicates that the double-buffered parallel-to-serial converter is not yet ready to receive new data. The shortest $T_{BUSY}$ occurs when a byte is loaded into an empty parallel-to-serial converter. The longest $T_{BUSY}$ occurs when a new word is loaded into the input register before the second-level buffer has started shifting out data.

This timing diagram shows very relaxed requirements. Data need not be held beyond the rising edge of WS. RDY/BUSY will go active within 60 ns after the end of WS. A new write may be asserted immediately after RDY/BUSY goes Low, but write may not be terminated until RDY/BUSY has been High for one CCLK period.

**Figure 60: Asynchronous Peripheral Mode Programming Switching Characteristics**

# Configuration Switching Characteristics



X1532
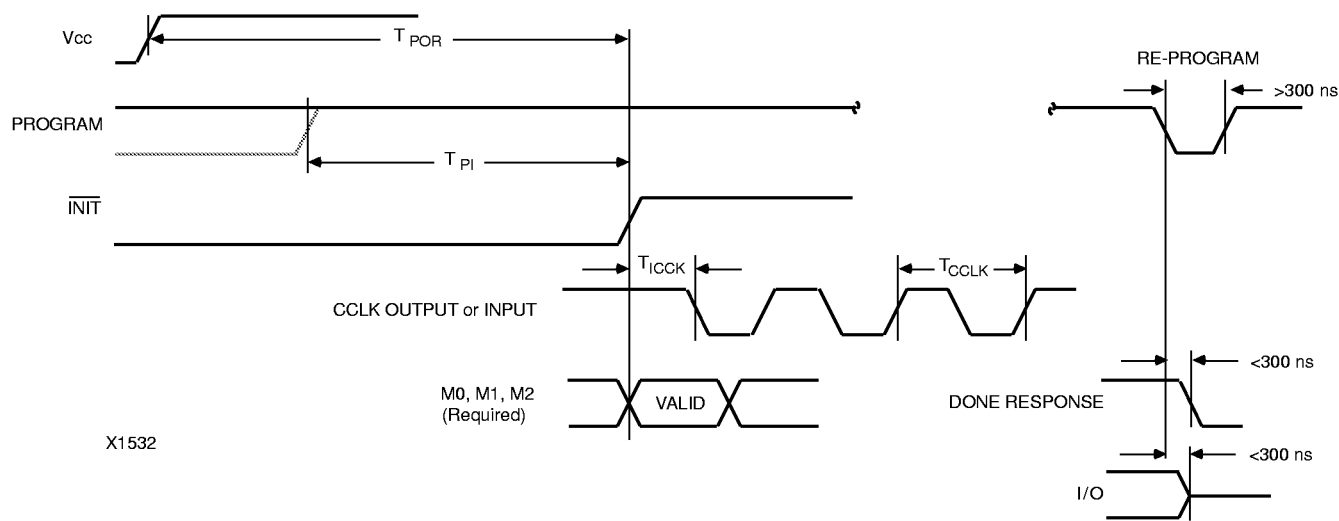
## Master Modes (XC4000E/EX)

| Description | | Symbol | Min | Max | Units |
|---|---|---|---|---|---|
| Power-On Reset | M0 = High | $T_{POR}$ | 10 | 40 | ms |
| | M0 = Low | $T_{POR}$ | 40 | 130 | ms |
| Program Latency | | $T_{PI}$ | 1 | 4 | µs per CLB column |
| CCLK (output) Delay | | $T_{ICCK}$ | 40 | 250 | µs |
| CCLK (output) Period, slow | | $T_{CCLK}$ | 640 | 2000 | ns |
| CCLK (output) Period, fast | | $T_{CCLK}$ | 80 | 250 | ns |

## Master Modes (XC4000XL)

| Description | | Symbol | Min | Max | Units |
|---|---|---|---|---|---|
| Power-On Reset | M0 = High | $T_{POR}$ | 10 | 40 | ms |
| | M0 = Low | $T_{POR}$ | 40 | 130 | ms |
| Program Latency | | $T_{PI}$ | 1 | 4 | µs per CLB column |
| CCLK (output) Delay | | $T_{ICCK}$ | 40 | 250 | µs |
| CCLK (output) Period, slow | | $T_{CCLK}$ | 540 | 1600 | ns |
| CCLK (output) Period, fast | | $T_{CCLK}$ | 67 | 200 | ns |

## Slave and Peripheral Modes(All)

| Description | Symbol | Min | Max | Units |
|---|---|---|---|---|
| Power-On Reset | $T_{POR}$ | 10 | 33 | ms |
| Program Latency | $T_{PI}$ | 1 | 4 | µs per CLB column |
| CCLK (input) Delay (required) | $T_{ICCK}$ | 4 | | µs |
| CCLK (input) Period (required) | $T_{CCLK}$ | 100 | | ns |

# XC4000XL Switching Characteristics

Definition of Terms

In the following tables, some specifications may be designated as Advance or Preliminary. These terms are defined as follows:

**Advance:** Initial estimates based on simulation and/or extrapolation from other speed grades, devices, or device families. Values are subject to change. Use as estimates, not for production.

**Preliminary:** Based on preliminary characterization. Further changes are not expected.

**Unmarked:** Specifications not identified as either Advance or Preliminary are to be considered Final.

**All specifications subject to change without notice.**

## Additional Specifications

Except for pin-to-pin input and output parameters, the a.c. parameter delay specifications included in this document are derived from measuring internal test patterns.All specifications are representative of worst- case supply voltage and junction temperature conditions. The parameters included are common to popular designs and typical applications. For design considerations requiring more detailed timing information, see the appropriate family a.c. supplements available on the Xilinx WEBLINX at http://www.xilinx.com.

## XC4000XL Absolute Maximum Ratings

| Symbol | Description | | Value | Units |
|---|---|---|---|---|
| $V_{CC}$ | Supply voltage relative to GND | | -0.5 to 4.0 | V |
| $V_{IN}$ | Input voltage relative to GND (Note 1) | | -0.5 to 5.5 | V |
| $V_{TS}$ | Voltage applied to 3-state output (Note 1) | | -0.5 to 5.5 | V |
| $V_{CCt}$ | Longest Supply Voltage Rise Time from 1V to 3V | | 50 | ms |
| $T_{STG}$ | Storage temperature (ambient) | | -65 to +150 | °C |
| $T_{SOL}$ | Maximum soldering temperature (10 s @ 1/16 in. = 1.5 mm) | | +260 | °C |
| $T_J$ | Junction temperature | Ceramic packages | +150 | °C |
| | | Plastic packages | +125 | °C |

Notes:   1. Maximum DC undershoot below GND must be limited to either 0.5 V or 10 mA, whichever is easier to achieve. During transitions, the device pins may undershoot to -2.0 V or overshoot to + 7.0 V, provided this over- or undershoot lasts less than 10 ns and with the forcing current being limited to 200 mA.
2. Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those listed under Operating Conditions is not implied. Exposure to Absolute Maximum Ratings conditions for extended periods of time may affect device reliability.

## XC4000XL Recommended Operating Conditions

| Symbol | Description | | Min | Max | Units |
|---|---|---|---|---|---|
| $V_{CC}$ | Supply voltage relative to GND, $T_J = 0$°C to +85°C | Commercial | 3.0 | 3.6 | V |
| | Supply voltage relative to GND, $T_J = -40$°C to +100°C | Industrial | 3.0 | 3.6 | V |
| $V_{IH}$ | High-level input voltage | | 50% of $V_{CC}$ | 5.5 | V |
| $V_{IL}$ | Low-level input voltage | | 0 | 30% of $V_{CC}$ | V |
| $T_{IN}$ | Input signal transition time | | | 250 | ns |

Notes:   At junction temperatures above those listed as Operating Conditions, all delay parameters increase by 0.35% per °C.
Input and output measurement threshold is ~40% of $V_{CC}$.

## XC4000XL DC Characteristics Over Recommended Operating Conditions

| Symbol | Description | | Min | Max | Units |
|---|---|---|---|---|---|
| $V_{OH}$ | High-level output voltage @ $I_{OH}$ = -4.0 mA, $V_{CC}$ min (LVTTL) | | 2.4 | | V |
| | High-level output voltage @ $I_{OH}$ = -500 µA, (LVCMOS) | | 90% $V_{CC}$ | | V |
| $V_{OL}$ | Low-level output voltage @ $I_{OL}$ = 12.0 mA, $V_{CC}$ min (LVTTL) (Note 1) | | | 0.4 | V |
| | Low-level output voltage @ $I_{OL}$ = 1500 µA, (LVCMOS) | | | 10% $V_{CC}$ | V |
| $V_{DR}$ | Data Retention Supply Voltage (below which configuration data may be lost) | | 2.5 | | V |
| $I_{CCO}$ | Quiescent FPGA supply current (Note 2) | | | 5 | mA |
| $I_L$ | Input or output leakage current | | -10 | +10 | µA |
| $C_{IN}$ | Input capacitance (sample tested) | BGA, SBGA, PQ, HQ, MQ packages | | 10 | pF |
| | | PGA packages | | 16 | pF |
| $I_{RPU}$ | Pad pull-up (when selected) @ $V_{in}$ = 0V (sample tested) | | 0.02 | 0.25 | mA |
| $I_{RPD}$ | Pad pull-down (when selected) @ $V_{in}$ = 3.6V (sample tested) | | 0.02 | 0.15 | mA |
| $I_{RLL}$ | Horizontal Longline pull-up (when selected) @ logic Low | | 0.3 | 2.0 | mA |

Note 1:    With up to 64 pins simultaneously sinking 12 mA.
Note 2:    With no output current loads, no active input or Longline pull-up resistors, all I/O pins Tri-stated and floating.

## XC4000XL Global Buffer Switching Characteristic Guidelines

Testing of the switching parameters is modeled after testing methods specified by MIL-M-38510/605. All devices are 100% functionally tested. Internal timing parameters are derived from measuring internal test patterns. Listed below are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net.

When fewer vertical clock lines are connected, the clock distribution is faster; when multiple clock lines per column are driven from the same global clock, the delay is longer. For more specific, more precise, and worst-case guaranteed data, reflecting the actual routing structure, use the values provided by the static timing analyzer (TRCE in the Xilinx Development System) and back-annotated to the simulation netlist. These path delays, provided as a guideline, have been extracted from the static timing analyzer report. All timing parameters assume worst-case operating conditions (supply voltage and junction temperature).

| Description | Symbol | Speed Grade Device | -3 Max | -2 Max | -1 Max | -09 Max | Units |
|---|---|---|---|---|---|---|---|
| From pad through Global Low Skew buffer, to any clock K | $T_{GLS}$ | XC4005XL | 2.7 | 2.3 | 2.0 | 1.9 | ns |
| | | XC4010XL | 3.2 | 2.8 | 2.4 | 2.3 | ns |
| | | XC4013XL | 3.6 | 3.1 | 2.7 | 2.6 | ns |
| | | XC4020XL | 4.0 | 3.5 | 3.0 | 2.9 | ns |
| | | XC4028XL | 4.4 | 3.8 | 3.3 | 3.2 | ns |
| | | XC4036XL | 4.8 | 4.2 | 3.6 | 3.5 | ns |
| | | XC4044XL | 5.3 | 4.6 | 4.0 | 3.9 | ns |
| | | XC4052XL | 5.7 | 5.0 | 4.5 | 4.4 | ns |
| | | XC4062XL | 6.3 | 5.4 | 4.7 | 4.6 | ns |
| | | XC4085XL | 7.2 | 6.2 | 5.7 | 5.5 | ns |
| From pad through Global Early buffer, to any clock K in same quadrant Values are for BUFGE #s 1, 2, 5 and 6. Add 1 - 2 ns for BUFGE #s 3, 4, 7 and 8 or consult TRCE. | $T_{GE}$ | XC4005XL | 1.9 | 1.8 | 1.7 | 1.6 | ns |
| | | XC4010XL | 2.2 | 1.9 | 1.7 | 1.7 | ns |
| | | XC4013XL | 2.4 | 2.1 | 1.8 | 1.7 | ns |
| | | XC4020XL | 2.6 | 2.2 | 2.1 | 2.0 | ns |
| | | XC4028XL | 2.8 | 2.4 | 2.1 | 2.0 | ns |
| | | XC4036XL | 3.1 | 2.7 | 2.3 | 2.2 | ns |
| | | XC4044XL | 3.5 | 3.0 | 2.6 | 2.4 | ns |
| | | XC4052XL | 4.0 | 3.5 | 3.0 | 3.0 | ns |
| | | XC4062XL | 4.9 | 4.3 | 3.7 | 3.4 | ns |
| | | XC4085XL | 5.8 | 5.1 | 4.7 | 4.3 | ns |
| | | | **Preliminary** | | | | |

## XC4000XL CLB Switching Characteristic Guidelines

Testing of switching parameters is modeled after testing methods specified by MIL-M-38510/605. All devices are 100% functionally tested. Internal timing parameters are derived from measuring internal test patterns. Listed below are representative values. For more specific, more precise, and worst-case guaranteed data, use the values reported by the static timing analyzer (TRCE in the Xilinx Development System) and back-annotated to the simulation netlist. All timing parameters assume worst-case operating conditions (supply voltage and junction temperature). Values apply to all XC4000XL devices and expressed in nanoseconds unless otherwise noted.

| Description | Speed Grade | -3 | | -2 | | -1 | | -09 | | Units |
|---|---|---|---|---|---|---|---|---|---|---|
| | Symbol | Min | Max | Min | Max | Min | Max | Min | Max | |
| **Combinatorial Delays** | | | | | | | | | | |
| F/G inputs to X/Y outputs | $T_{ILO}$ | | 1.6 | | 1.5 | | 1.3 | | 1.2 | ns |
| F/G inputs via H' to X/Y outputs | $T_{IHO}$ | | 2.7 | | 2.4 | | 2.2 | | 2.0 | ns |
| F/G inputs via transparent latch to Q outputs | $T_{ITO}$ | | 2.9 | | 2.6 | | 2.2 | | 2.0 | ns |
| C inputs via SR/H0 via H to X/Y outputs | $T_{HH0O}$ | | 2.5 | | 2.2 | | 2.0 | | 1.8 | ns |
| C inputs via H1 via H to X/Y outputs | $T_{HH1O}$ | | 2.4 | | 2.1 | | 1.9 | | 1.6 | ns |
| C inputs via DIN/H2 via H to X/Y outputs | $T_{HH2O}$ | | 2.5 | | 2.2 | | 2.0 | | 1.8 | ns |
| C inputs via EC, DIN/H2 to YQ, XQ output (bypass) | $T_{CBYP}$ | | 1.5 | | 1.3 | | 1.1 | | 1.0 | ns |
| **CLB Fast Carry Logic** | | | | | | | | | | |
| Operand inputs (F1, F2, G1, G4) to $C_{OUT}$ | $T_{OPCY}$ | | 2.7 | | 2.3 | | 2.0 | | 1.6 | |
| Add/Subtract input (F3) to $C_{OUT}$ | $T_{ASCY}$ | | 3.3 | | 2.9 | | 2.5 | | 1.8 | |
| Initialization inputs (F1, F3) to $C_{OUT}$ | $T_{INCY}$ | | 2.0 | | 1.8 | | 1.5 | | 1.0 | |
| $C_{IN}$ through function generators to X/Y outputs | $T_{SUM}$ | | 2.8 | | 2.6 | | 2.4 | | 1.7 | |
| $C_{IN}$ to $C_{OUT}$, bypass function generators | $T_{BYP}$ | | 0.26 | | 0.23 | | 0.20 | | 0.14 | |
| Carry Net Delay, $C_{OUT}$ to $C_{IN}$ | $T_{NET}$ | | 0.32 | | 0.28 | | 0.25 | | 0.24 | |
| **Sequential Delays** | | | | | | | | | | |
| Clock K to Flip-Flop outputs Q | $T_{CKO}$ | | 2.1 | | 1.9 | | 1.6 | | 1.5 | ns |
| Clock K to Latch outputs Q | $T_{CKLO}$ | | 2.1 | | 1.9 | | 1.6 | | 1.5 | ns |
| **Setup Time before Clock K** | | | | | | | | | | |
| F/G inputs | $T_{ICK}$ | 1.1 | | 1.0 | | 0.9 | | 0.8 | | ns |
| F/G inputs via H | $T_{IHCK}$ | 2.2 | | 1.9 | | 1.7 | | 1.6 | | ns |
| C inputs via H0 through H | $T_{HH0CK}$ | 2.0 | | 1.7 | | 1.6 | | 1.4 | | ns |
| C inputs via H1 through H | $T_{HH1CK}$ | 1.9 | | 1.6 | | 1.4 | | 1.2 | | ns |
| C inputs via H2 through H | $T_{HH2CK}$ | 2.0 | | 1.7 | | 1.6 | | 1.4 | | ns |
| C inputs via DIN | $T_{DICK}$ | 0.9 | | 0.8 | | 0.7 | | 0.6 | | ns |
| C inputs via EC | $T_{ECCK}$ | 1.0 | | 0.9 | | 0.8 | | 0.7 | | ns |
| C inputs via S/R, going Low (inactive) | $T_{RCK}$ | 0.6 | | 0.5 | | 0.5 | | 0.4 | | ns |
| CIN input via F/G | $T_{CCK}$ | 2.3 | | 2.1 | | 1.9 | | 1.7 | | ns |
| CIN input via F/G and H | $T_{CHCK}$ | 3.4 | | 3.0 | | 2.7 | | 2.5 | | ns |
| **Hold Time after Clock K** | | | | | | | | | | |
| F/G inputs | $T_{CKI}$ | 0 | | 0 | | 0 | | 0 | | ns |
| F/G inputs via H | $T_{CKIH}$ | 0 | | 0 | | 0 | | 0 | | ns |
| C inputs via SR/H0 through H | $T_{CKHH0}$ | 0 | | 0 | | 0 | | 0 | | ns |
| C inputs via H1 through H | $T_{CKHH1}$ | 0 | | 0 | | 0 | | 0 | | ns |
| C inputs via DIN/H2 through H | $T_{CKHH2}$ | 0 | | 0 | | 0 | | 0 | | ns |
| C inputs via DIN/H2 | $T_{CKDI}$ | 0 | | 0 | | 0 | | 0 | | ns |
| C inputs via EC | $T_{CKEC}$ | 0 | | 0 | | 0 | | 0 | | ns |
| C inputs via SR, going Low (inactive) | $T_{CKR}$ | 0 | | 0 | | 0 | | 0 | | ns |
| **Clock** | | | | | | | | | | |
| Clock High time | $T_{CH}$ | 3.0 | | 2.8 | | 2.5 | | 2.3 | | ns |
| Clock Low time | $T_{CL}$ | 3.0 | | 2.8 | | 2.5 | | 2.3 | | ns |
| **Set/Reset Direct** | | | | | | | | | | |
| Width (High) | $T_{RPW}$ | 3.0 | | 2.8 | | 2.5 | | 2.3 | | ns |
| Delay from C inputs via S/R, going High to Q | $T_{RIO}$ | | 3.7 | | 3.2 | | 2.8 | | 2.7 | ns |
| **Global Set/Reset** | | | | | | | | | | |
| Minimum GSR Pulse Width | $T_{MRW}$ | | 19.8 | | 17.3 | | 15.0 | | 14.0 | ns |
| Delay from GSR input to any Q | $T_{MRQ}$ | See page 4-78 for $T_{RRI}$ values per device | | | | | | | | |
| **Toggle Frequency (MHz)** (for export control purposes) | $F_{TOG}$ | | 166 | | 179 | | 200 | | 217 | MHz |

**Preliminary**

## XC4000XL CLB RAM Synchronous (Edge-Triggered) Write Operation Guidelines

Testing of switching parameters is modeled after testing methods specified by MIL-M-38510/605. All devices are 100% functionally tested. Internal timing parameters are derived from measuring internal test patterns. Listed below are representative values. For more specific, more precise, and worst-case guaranteed data, use the values reported by the static timing analyzer (TRCE in the Xilinx Development System) and back-annotated to the simulation netlist. All timing parameters assume worst-case operating conditions (supply voltage and junction temperature). Values apply to all XC4000XL devices and are expressed in nanoseconds unless otherwise noted.

| Single Port RAM | Speed Grade | | -3 | | -2 | | -1 | | -09 | | Units |
|---|---|---|---|---|---|---|---|---|---|---|---|
| | Size | Symbol | Min | Max | Min | Max | Min | Max | Min | Max | |
| **Write Operation** | | | | | | | | | | | |
| Address write cycle time (clock K period) | 16x2 | $T_{WCS}$ | 9.0 | | 8.4 | | 7.7 | | 7.4 | | ns |
| | 32x1 | $T_{WCTS}$ | 9.0 | | 8.4 | | 7.7 | | 7.4 | | ns |
| Clock K pulse width (active edge) | 16x2 | $T_{WPS}$ | 4.5 | | 4.2 | | 3.9 | | 3.7 | | ns |
| | 32x1 | $T_{WPTS}$ | 4.5 | | 4.2 | | 3.9 | | 3.7 | | ns |
| Address setup time before clock K | 16x2 | $T_{ASS}$ | 2.2 | | 2.0 | | 1.7 | | 1.7 | | ns |
| | 32x1 | $T_{ASTS}$ | 2.2 | | 2.0 | | 1.7 | | 1.7 | | ns |
| Address hold time after clock K | 16x2 | $T_{AHS}$ | 0 | | 0 | | 0 | | 0 | | ns |
| | 32x1 | $T_{AHTS}$ | 0 | | 0 | | 0 | | 0 | | ns |
| DIN setup time before clock K | 16x2 | $T_{DSS}$ | 2.0 | | 1.9 | | 1.7 | | 1.7 | | ns |
| | 32x1 | $T_{DSTS}$ | 2.5 | | 2.3 | | 2.1 | | 2.1 | | ns |
| DIN hold time after clock K | 16x2 | $T_{DHS}$ | 0 | | 0 | | 0 | | 0 | | ns |
| | 32x1 | $T_{DHTS}$ | 0 | | 0 | | 0 | | 0 | | ns |
| WE setup time before clock K | 16x2 | $T_{WSS}$ | 2.0 | | 1.8 | | 1.6 | | 1.6 | | ns |
| | 32x1 | $T_{WSTS}$ | 1.8 | | 1.7 | | 1.5 | | 1.5 | | ns |
| WE hold time after clock K | 16x2 | $T_{WHS}$ | 0 | | 0 | | 0 | | 0 | | ns |
| | 32x1 | $T_{WHTS}$ | 0 | | 0 | | 0 | | 0 | | ns |
| Data valid after clock K | 16x2 | $T_{WOS}$ | | 6.8 | | 6.3 | | 5.8 | | 5.8 | ns |
| | 32x1 | $T_{WOTS}$ | | 8.1 | | 7.5 | | 6.9 | | 6.9 | ns |
| | | | | | | | **Preliminary** | | | | |

| Dual Port RAM | Speed Grade | | -3 | | -2 | | -1 | | -09 | | Units |
|---|---|---|---|---|---|---|---|---|---|---|---|
| | Size | Symbol | Min | Max | Min | Max | Min | Max | Min | Max | |
| **Write Operation** | | | | | | | | | | | |
| Address write cycle time (clock K period) | 16x1 | $T_{WCDS}$ | 9.0 | | 8.4 | | 7.7 | | 7.4 | | ns |
| Clock K pulse width (active edge) | 16x1 | $T_{WPDS}$ | 4.5 | | 4.2 | | 3.9 | | 3.7 | | ns |
| Address setup time before clock K | 16x1 | $T_{ASDS}$ | 2.5 | | 2.0 | | 1.7 | | 1.7 | | ns |
| Address hold time after clock K | 16x1 | $T_{AHDS}$ | 0 | | 0 | | 0 | | 0 | | ns |
| DIN setup time before clock K | 16x1 | $T_{DSDS}$ | 2.5 | | 2.3 | | 2.0 | | 2.0 | | ns |
| DIN hold time after clock K | 16x1 | $T_{DHDS}$ | 0 | | 0 | | 0 | | 0 | | ns |
| WE setup time before clock K | 16x1 | $T_{WSDS}$ | 1.8 | | 1.7 | | 1.6 | | 1.6 | | ns |
| WE hold time after clock K | 16x1 | $T_{WHDS}$ | 0 | | 0 | | 0 | | 0 | | ns |
| Data valid after clock K | 16x1 | $T_{WODS}$ | | 7.8 | | 7.3 | | 6.7 | | 6.7 | ns |
| | | | | | | | **Preliminary** | | | | |

Note:   Timing for the 16 x1 RAM option is identical to 16 x 2 RAM timing.

## CLB RAM Synchronous (Edge-Triggered) Write Timing



X6461

## CLB Dual-Port RAM Synchronous (Edge-Triggered) Write Timing
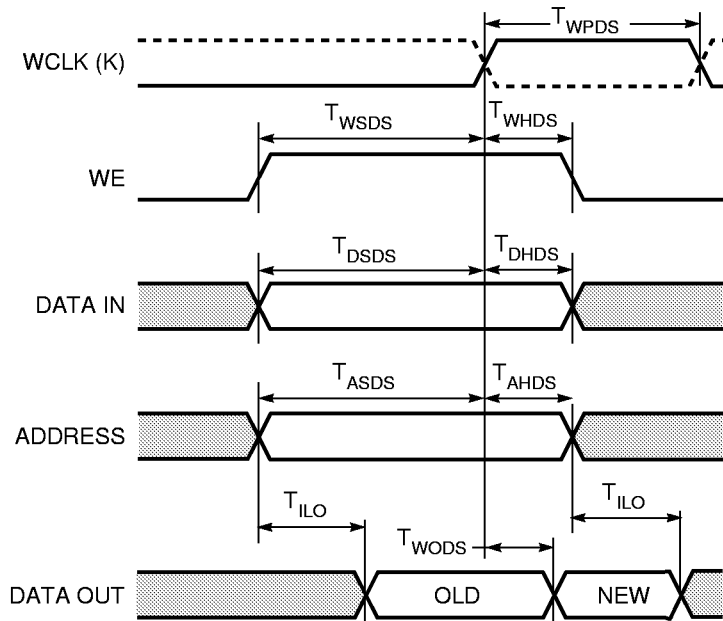


X6474

# XC4000XL Pin-to-Pin Output Parameter Guidelines

Testing of switching parameters is modeled after testing methods specified by MIL-M-38510/605. All devices are 100% functionally tested. Pin-to-pin timing parameters are derived from measuring external and internal test patterns and are guaranteed over worst-case operating conditions (supply voltage and junction temperature). Listed below are representative values for typical pin locations and normal clock loading. For more specific, more precise, and worst-case guaranteed data, reflecting the actual routing structure, use the values provided by the static timing analyzer (TRCE in the Xilinx Development System) and back-annotated to the simulation netlist. These path delays, provided as a guideline, have been extracted from the static timing analyzer report.

## XC4000XL Output Flip-Flop, Clock to Out

| Description | Symbol | Speed Grade / Device | -3 Max | -2 Max | -1 Max | -09 Max | Units |
|---|---|---|---|---|---|---|---|
| Global Low Skew Clock to Output using OFF | $T_{ICKOF}$ | XC4005XL | 7.7 | 6.7 | 5.8 | 5.4 | ns |
| | | XC4010XL | 8.3 | 7.2 | 6.2 | 5.8 | ns |
| | | XC4013XL | 8.6 | 7.5 | 6.5 | 6.1 | ns |
| | | XC4020XL | 9.0 | 7.9 | 6.8 | 6.4 | ns |
| | | XC4028XL | 9.4 | 8.2 | 7.1 | 6.7 | ns |
| | | XC4036XL | 9.8 | 8.5 | 7.4 | 7.0 | ns |
| | | XC4044XL | 10.3 | 9.0 | 7.8 | 7.4 | ns |
| | | XC4052XL | 10.7 | 9.3 | 8.3 | 7.9 | ns |
| | | XC4062XL | 11.3 | 9.7 | 8.5 | 8.1 | ns |
| | | XC4085XL | 12.2 | 10.5 | 9.5 | 9.0 | ns |
| Global Early Clock to Output using OFF Values are for BUFGE #s 1, 2, 5 and 6. Add 1 - 2 ns for BUFGE #s 3, 4, 7 and 8, or consult TRCE | $T_{ICKEOF}$ | XC4005XL | 6.9 | 6.1 | 5.5 | 5.1 | ns |
| | | XC4010XL | 7.2 | 6.2 | 5.5 | 5.2 | ns |
| | | XC4013XL | 7.4 | 6.4 | 5.6 | 5.2 | ns |
| | | XC4020XL | 7.6 | 6.5 | 5.9 | 5.5 | ns |
| | | XC4028XL | 7.8 | 6.7 | 5.9 | 5.5 | ns |
| | | XC4036XL | 8.1 | 7.0 | 6.1 | 5.7 | ns |
| | | XC4044XL | 8.5 | 7.3 | 6.4 | 5.9 | ns |
| | | XC4052XL | 9.0 | 7.8 | 6.8 | 6.5 | ns |
| | | XC4062XL | 9.9 | 8.6 | 7.5 | 6.9 | ns |
| | | XC4085XL | 10.8 | 9.4 | 8.5 | 7.8 | ns |
| For output SLOW option add | $T_{SLOW}$ | All Devices | 3.0 | 2.5 | 2.5 | 1.7 | ns |

OFF = Output Flip Flop **Preliminary**

Notes: Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net.
Output timing is measured at ~50% $V_{CC}$ threshold with 50 pF external capacitive load. For different loads, see graph below.

## Capacitive Load Factor

Figure 1 shows the relationship between I/O output delay and load capacitance. It allows a user to adjust the specified output delay if the load capacitance is different than 50 pF. For example, if the actual load capacitance is 120 pF, add 2.5 ns to the specified delay. If the load capacitance is 20 pF, subtract 0.8 ns from the specified output delay.

Figure 1 is usable over the specified operating conditions of voltage and temperature and is independent of the output slew rate control.
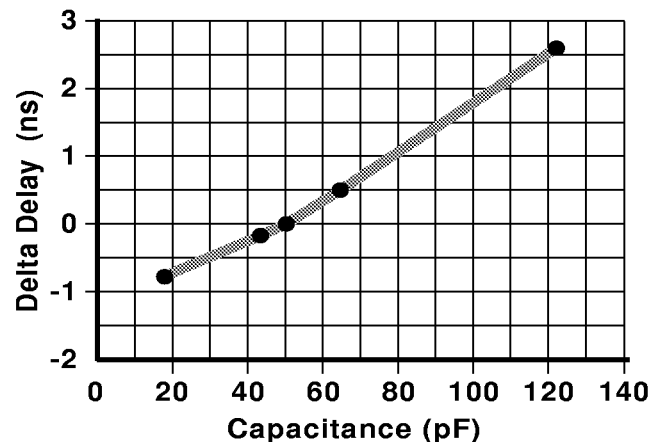


Figure 61: Additional Delay VS Capacitive Loads[XR257]

# XC4000XL Pin-to-Pin Input Parameter Guidelines

Testing of switching parameters is modeled after testing methods specified by MIL-M-38510/605. All devices are 100% functionally tested. Pin-to-pin timing parameters are derived from measuring external and internal test patterns and are guaranteed over worst-case operating conditions (supply voltage and junction temperature). Listed below are representative values for typical pin locations and normal clock loading. For more specific, more precise, and worst-case guaranteed data, reflecting the actual routing structure, use the values provided by the static timing analyzer (TRCE in the Xilinx Development System) and back-annotated to the simulation netlist. These path delays, provided as a guideline, have been extracted from the static timing analyzer report.

## XC4000XL Global Low Skew Clock, Set-Up and Hold

| | | Speed Grade | -3 | -2 | -1 | -09 | Units |
|---|---|---|---|---|---|---|---|
| Description | Symbol | Device | Min | Min | Min | Min | |
| Input Setup Time, using Global Low Skew clock and IFF (full delay) | $T_{PSD}$ | XC4005XL | 8.8 | 7.6 | 6.6 | 5.6 | ns |
| | | XC4010XL | 9.0 | 7.8 | 6.8 | 5.8 | ns |
| | | XC4013XL* | 6.4 | 6.0 | 5.6 | 4.8 | ns |
| | | XC4020XL | 8.8 | 7.6 | 6.6 | 6.2 | ns |
| | | XC4028XL | 9.3 | 8.1 | 7.0 | 6.4 | ns |
| | | XC4036XL* | 6.6 | 6.2 | 5.8 | 5.3 | ns |
| | | XC4044XL | 10.6 | 9.2 | 8.0 | 6.8 | ns |
| | | XC4052XL | 11.2 | 9.7 | 8.4 | 7.0 | ns |
| | | XC4062XL* | 6.8 | 6.4 | 6.0 | 5.5 | ns |
| | | XC4085XL | 12.7 | 11.0 | 9.6 | 8.4 | ns |
| Input Hold Time, using Global Low Skew clock and IFF (full delay) | $T_{PHD}$ | All Devices | 0 | 0 | 0 | 0 | ns |
| IFF = Input Flip-Flop or Latch | | | Preliminary | | | | |

Notes:   Setup time is measured with the fastest route and the lightest load. Use the static timing analyzer to determine the setup time under given design conditions. Hold time is measured using the furthest distance and a reference load of one clock pin per two IOBs. Use the static timing analyzer to determine the setup and hold times under given design conditions.

For Setup and Hold parameter adjustments related to Voltage and Temperature, check the latest XC4000XL data sheet supplement on the Xilinx website, WEBLINX at http://www.xilinx.com, or contact your local sales representative.

For partial and no delay input path parameters, check the latest XC4000XL data sheet supplement on the Xilinx website, WEBLINX at http://www.xilinx.com, or contact your local sales representative.

* The XC4013XL, XC4036XL, and 4062XL have significantly faster setup times than other family members.

## XC4000XL BUFGE #s 3, 4, 7, and 8 Global Early Clock, Set-Up and Hold for IFF and FCL

| Description | Symbol | Speed Grade | -3 | -2 | -1 | -09 | Units |
|---|---|---|---|---|---|---|---|
| | | Device | Min | Min | Min | Min | |
| Input Setup Time | | XC4005XL | 8.4 | 7.9 | 7.4 | 7.2 | ns |
| Global Early clock and IFF (partial delay) | T$_{PSEP}$ | XC4010XL | 10.3 | 9.0 | 7.8 | 7.4 | ns |
| Global Early clock and FCL (partial delay) | T$_{PFSEP}$ | XC4013XL* | 5.4 | 4.9 | 4.4 | 4.3 | ns |
| | | XC4020XL | 9.8 | 9.3 | 8.8 | 8.5 | ns |
| | | XC4028XL | 12.7 | 11.0 | 9.6 | 9.3 | ns |
| | | XC4036XL* | 6.4 | 5.9 | 5.4 | 5.0 | ns |
| | | XC4044XL | 13.8 | 12.0 | 10.4 | 10.2 | ns |
| | | XC4052XL | 14.5 | 12.7 | 11.0 | 10.7 | ns |
| | | XC4062XL* | 8.4 | 7.9 | 7.4 | 6.8 | ns |
| | | XC4085XL | 14.5 | 12.7 | 11.0 | 10.8 | ns |
| Input Hold Time | | XC4005XL | 0 | 0 | 0 | 0 | ns |
| Global Early clock and IFF (partial delay) | T$_{PHEP}$ | XC4010XL | 0 | 0 | 0 | 0 | ns |
| Global Early clock and FCL (partial delay) | T$_{PFHEP}$ | XC4013XL | 0 | 0 | 0 | 0 | ns |
| | | XC4020XL | 0 | 0 | 0 | 0 | ns |
| | | XC4028XL | 0 | 0 | 0 | 0 | ns |
| | | XC4036XL | 0.8 | 0.8 | 0.8 | 0.8 | ns |
| | | XC4044XL | 0 | 0 | 0 | 0 | ns |
| | | XC4052XL | 0 | 0 | 0 | 0 | ns |
| | | XC4062XL | 1.5 | 1.5 | 1.5 | 1.5 | ns |
| | | XC4085XL | 0 | 0 | 0 | 0 | ns |

IFF = Input Flip-Flop or Latch, FCL = Fast Capture Latch          **Preliminary**

## XC4000XL BUFGE #s 1, 2, 5, and 6 Global Early Clock, Set-Up and Hold for IFF and FCL

| Description | Symbol | Speed Grade | -3 | -2 | -1 | -09 | Units |
|---|---|---|---|---|---|---|---|
| | | Device | Min | Min | Min | Min | |
| Input Setup Time | | XC4005XL | 9.0 | 8.5 | 8.0 | 7.5 | ns |
| Global Early clock and IFF (partial delay) | T$_{PSEP}$ | XC4010XL | 11.9 | 10.4 | 9.0 | 8.0 | ns |
| Global Early clock and FCL (partial delay) | T$_{PFSEP}$ | XC4013XL* | 6.4 | 5.9 | 5.4 | 4.9 | ns |
| | | XC4020XL | 10.8 | 10.3 | 9.8 | 9.0 | ns |
| | | XC4028XL | 14.0 | 12.2 | 10.6 | 9.8 | ns |
| | | XC4036XL* | 7.0 | 6.6 | 6.2 | 5.2 | ns |
| | | XC4044XL | 14.6 | 12.7 | 11.0 | 10.8 | ns |
| | | XC4052XL | 16.4 | 14.3 | 12.4 | 11.4 | ns |
| | | XC4062XL* | 9.0 | 8.6 | 8.2 | 7.0 | ns |
| | | XC4085XL | 16.7 | 14.5 | 12.6 | 11.6 | ns |
| Input Hold Time | | XC4005XL | 0 | 0 | 0 | 0 | ns |
| Global Early clock and IFF (partial delay) | T$_{PHEP}$ | XC4010XL | 0 | 0 | 0 | 0 | ns |
| Global Early clock and FCL (partial delay) | T$_{PFHEP}$ | XC4013XL | 0 | 0 | 0 | 0 | ns |
| | | XC4020XL | 0 | 0 | 0 | 0 | ns |
| | | XC4028XL | 0 | 0 | 0 | 0 | ns |
| | | XC4036XL | 0 | 0 | 0 | 0 | ns |
| | | XC4044XL | 0 | 0 | 0 | 0 | ns |
| | | XC4052XL | 0 | 0 | 0 | 0 | ns |
| | | XC4062XL | 0.8 | 0.8 | 0.8 | 0.8 | ns |
| | | XC4085XL | 0 | 0 | 0 | 0 | ns |

IFF = Input Flip-Flop or Latch, FCL = Fast Capture Latch          **Preliminary**

Notes: Setup time is measured with the fastest route and the lightest load. Hold time is measured using the farthest distance and a reference load of one clock pin per two IOBs. Use the static timing analyzer to determine the setup and hold times under given design conditions.

* The XC4013XL, XC4036XL, and 4062XL have significantly faster setup times than other family members.

## XC4000XL IOB Input Switching Characteristic Guidelines

Testing of switching parameters is modeled after testing methods specified by MIL-M-38510/605. All devices are 100% functionally tested. Internal timing parameters are derived from measuring internal test patterns. Listed below are representative values. For more specific, more precise, and worst-case guaranteed data, use the values reported by the static timing analyzer (TRCE in the Xilinx Development System) and back-annotated to the simulation netlist. These path delays, provided as a guideline, have been extracted from the static timing analyzer report. All timing parameters assume worst-case operating conditions (supply voltage and junction temperature).

| Description | Symbol | Speed Grade Device | -3 Min | -2 Min | -1 Min | -09 Min | Units |
|---|---|---|---|---|---|---|---|
| **Clocks** | | | | | | | |
| Clock Enable (EC) to Clock (IK) | $T_{ECIK}$ | All devices | 0.3 | 0.2 | 0.1 | 0.0 | ns |
| Delay from FCL enable (OK) active edge to IFF clock (IK) active edge | $T_{OKIK}$ | All devices | 1.7 | 1.5 | 1.3 | 1.2 | ns |
| **Setup Times** | | | | | | | |
| Pad to Clock (IK), no delay | $T_{PICK}$ | All devices | 1.7 | 1.5 | 1.3 | 1.3 | ns |
| Pad to Clock (IK), via transparent Fast Capture Latch, no delay | $T_{PICKF}$ | All devices | 2.3 | 2.1 | 1.8 | 1.7 | ns |
| Pad to Fast Capture Latch Enable (OK), no delay | $T_{POCK}$ | All devices | 0.7 | 0.6 | 0.5 | 0.5 | ns |
| **Hold Times** | | | | | | | |
| All Hold Times | | All devices | 0 | 0 | 0 | 0 | ns |
| **Propagation Delays** | | | Max | Max | Max | Max | |
| Pad to I1, I2 | $T_{PID}$ | All devices | 1.6 | 1.4 | 1.2 | 1.1 | ns |
| Pad to I1, I2 via transparent input latch, no delay | $T_{PLI}$ | All devices | 2.6 | 2.2 | 1.9 | 1.8 | ns |
| Pad to I1, I2 via transparent FCL and input latch, no delay | $T_{PFLI}$ | All devices | 3.1 | 2.7 | 2.4 | 2.2 | ns |
| Clock (IK) to I1, I2 (flip-flop) | $T_{IKRI}$ | All devices | 1.8 | 1.5 | 1.3 | 1.2 | ns |
| Clock (IK) to I1, I2 (latch enable, active Low) | $T_{IKLI}$ | All devices | 1.9 | 1.7 | 1.4 | 1.3 | ns |
| FCL Enable (OK) active edge to I1, I2 (via transparent standard input latch) | $T_{OKLI}$ | All devices | 3.6 | 3.1 | 2.7 | 2.6 | ns |
| **Global Set/Reset** | | | | | | | |
| Minimum GSR Pulse Width | $T_{MRW}$ | All devices | 19.8 | 17.3 | 15.0 | 14.0 | ns |
| Delay from GSR input to any Q | $T_{RRI}$ | XC4005XL | 11.3 | 9.8 | 8.5 | 8.1 | ns |
| | | XC4010XL | 13.9 | 12.1 | 10.5 | 10.0 | ns |
| | | XC4013XL | 15.9 | 13.8 | 12.0 | 11.4 | ns |
| | | XC4020XL | 18.6 | 16.1 | 14.0 | 13.3 | ns |
| | | XC4028XL | 20.5 | 17.9 | 15.5 | 14.3 | ns |
| | | XC4036XL | 22.5 | 19.6 | 17.0 | 16.2 | ns |
| | | XC4044XL | 25.1 | 21.9 | 19.0 | 18.1 | ns |
| | | XC4052XL | 27.2 | 23.6 | 20.5 | 19.5 | ns |
| | | XC4062XL | 29.1 | 25.3 | 22.0 | 20.9 | ns |
| | | XC4085XL | 34.4 | 29.9 | 26.0 | 24.7 | ns |
| | | | Preliminary | | | | |

IFF = Input Flip-Flop or Latch, FCL = Fast Capture Latch

## XC4000XL IOB Output Switching Characteristic Guidelines

Testing of switching parameters is modeled after testing methods specified by MIL-M-38510/605. All devices are 100% functionally tested. Internal timing parameters are derived from measuring internal test patterns. Listed below are representative values. For more specific, more precise, and worst-case guaranteed data, use the values reported by the static timing analyzer (TRCE in the Xilinx Development System) and back-annotated to the simulation netlist. These path delays, provided as a guideline, have been extracted from the static timing analyzer report. All timing parameters assume worst-case operating conditions (supply voltage and junction temperature). For Propagation Delays, slew-rate = fast unless otherwise noted. Values are expressed in nanoseconds unless otherwise noted.

| Description | Symbol | -3 Min | -3 Max | -2 Min | -2 Max | -1 Min | -1 Max | -09 Min | -09 Max | Units |
|---|---|---|---|---|---|---|---|---|---|---|
| **Clocks** | | | | | | | | | | |
| Clock High | $T_{CH}$ | 3.0 | | 2.8 | | 2.5 | | 2.3 | | ns |
| Clock Low | $T_{CL}$ | 3.0 | | 2.8 | | 2.5 | | 2.3 | | ns |
| **Propagation Delays** | | | | | | | | | | |
| Clock (OK) to Pad | $T_{OKPOF}$ | | 5.0 | | 4.4 | | 3.8 | | 3.5 | ns |
| Output (O) to Pad | $T_{OPF}$ | | 4.1 | | 3.6 | | 3.1 | | 3.0 | ns |
| 3-state to Pad hi-Z (slew-rate independent) | $T_{TSHZ}$ | | 4.4 | | 3.8 | | 3.3 | | 3.3 | ns |
| 3-state to Pad active and valid | $T_{TSONF}$ | | 4.1 | | 3.6 | | 3.1 | | 3.0 | ns |
| Output (O) to Pad via Fast Output MUX | $T_{OFPF}$ | | 5.5 | | 4.8 | | 4.2 | | 4.0 | ns |
| Select (OK) to Pad via Fast MUX | $T_{OKFPF}$ | | 5.1 | | 4.5 | | 3.9 | | 3.7 | ns |
| **Setup and Hold Times** | | | | | | | | | | |
| Output (O) to clock (OK) setup time | $T_{OOK}$ | 0.5 | | 0.4 | | 0.3 | | 0.3 | | ns |
| Output (O) to clock (OK) hold time | $T_{OKO}$ | 0.0 | | 0.0 | | 0.0 | | 0.0 | | ns |
| Clock Enable (EC) to clock (OK) setup time | $T_{ECOK}$ | 0.0 | | 0.0 | | 0.0 | | 0.0 | | ns |
| Clock Enable (EC) to clock (OK) hold time | $T_{OKEC}$ | 0.3 | | 0.2 | | 0.1 | | 0.0 | | ns |
| **Global Set/Reset** | | | | | | | | | | |
| Minimum GSR pulse width | $T_{MRW}$ | 19.8 | | 17.3 | | 15.0 | | 14.0 | | ns |
| Delay from GSR input to any Pad | $T_{RPO}$ | | | | | | | | | |
| XC4005XL | | 15.9 | | 13.8 | | 12.0 | | 11.4 | | ns |
| XC4010XL | | 18.5 | | 16.1 | | 14.0 | | 13.3 | | ns |
| XC4013XL | | 20.5 | | 17.8 | | 15.5 | | 14.7 | | ns |
| XC4020XL | | 23.2 | | 20.1 | | 17.5 | | 16.6 | | ns |
| XC4028XL | | 25.1 | | 21.9 | | 19.0 | | 17.6 | | ns |
| XC4036XL | | 27.1 | | 23.6 | | 20.5 | | 19.4 | | ns |
| XC4044XL | | 29.7 | | 25.9 | | 22.5 | | 21.4 | | ns |
| XC4052XL | | 31.7 | | 27.6 | | 24.0 | | 22.8 | | ns |
| XC4062XL | | 33.7 | | 29.3 | | 25.5 | | 24.2 | | ns |
| XC4085XL | | 39.0 | | 33.9 | | 29.5 | | 28.0 | | ns |
| **Slew Rate Adjustment** | | | | | | | | | | |
| For output SLOW option add | $T_{SLOW}$ | | 3.0 | | 2.5 | | 2.0 | | 1.7 | ns |
| | | | | Preliminary | | | | | | |

Note: Output timing is measured at ~50% $V_{CC}$ threshold, with 50 pF external capacitive loads.

# XC4000EX Switching Characteristics

## Definition of Terms

In the following tables, some specifications may be designated as Advance or Preliminary. These terms are defined as follows:

**Advance:**     Initial estimates based on simulation and/or extrapolation from other speed grades, devices, or device families. Values are subject to change. Use as estimates, not for production.

**Preliminary:** Based on preliminary characterization. Further changes are not expected.

**Unmarked:**   Specifications not identified as either Advance or Preliminary are to be considered Final.

**All specifications subject to change without notice.**

## XC4000EX Absolute Maximum Ratings

| Symbol | Description | | Value | Units |
|--------|-------------|--|-------|-------|
| $V_{CC}$ | Supply voltage relative to GND | | -0.5 to +7.0 | V |
| $V_{IN}$ | Input voltage relative to GND (Note 1) | | -0.5 to $V_{CC}$ +0.5 | V |
| $V_{TS}$ | Voltage applied to 3-state output (Note 1) | | -0.5 to $V_{CC}$ +0.5 | V |
| $V_{CCt}$ | Longest Supply Voltage Rise Time from 1 V to 4 V | | 50 | ms |
| $T_{STG}$ | Storage temperature (ambient) | | -65 to +150 | °C |
| $T_{SOL}$ | Maximum soldering temperature (10 s @ 1/16 in. = 1.5 mm) | | +260 | °C |
| $T_J$ | Junction temperature | Ceramic packages | +150 | °C |
| | | Plastic packages | +125 | °C |

Notes:   1. Maximum DC overshoot or undershoot

above $V_{cc}$ or below GND must be limited to either 0.5 V or 10 mA, whichever is easier to achieve. During transitions, the device pins may undershoot to -2.0 V or overshoot to Vcc + 2.0 V, provided this over- or undershoot lasts less than 20 ns.

2. Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those listed under Operating Conditions is not implied. Exposure to Absolute Maximum Ratings conditions for extended periods of time may affect device reliability.

## XC4000EX Recommended Operating Conditions

| Symbol | Description | | Min | Max | Units |
|--------|-------------|--|-----|-----|-------|
| $V_{CC}$ | Supply voltage relative to GND, $T_J$ = 0 °C to +85°C | Commercial | 4.75 | 5.25 | V |
| | Supply voltage relative to GND, $T_J$ = -40°C to +100°C | Industrial | 4.5 | 5.5 | V |
| $V_{IH}$ | High-level input voltage | TTL inputs | 2.0 | $V_{CC}$ | V |
| | | CMOS inputs | 70% | 100% | $V_{CC}$ |
| $V_{IL}$ | Low-level input voltage | TTL inputs | 0 | 0.8 | V |
| | | CMOS inputs | 0 | 20% | $V_{CC}$ |
| $T_{IN}$ | Input signal transition time | | | 250 | ns |

Notes:   At junction temperatures above those listed as Operating Conditions, all delay parameters increase by 0.35% per °C.
Input and output measurement thresholds for TTL are 1.5 V. Input and output measurement thresholds for CMOS are 2.5 V.
All timing parameters are specified for Commercial temperature range only.

## XC4000EX DC Characteristics Over Recommended Operating Conditions

| Symbol | Description | | Min | Max | Units |
|---|---|---|---|---|---|
| $V_{OH}$ | High-level output voltage @ $I_{OH}$ = -4.0 mA, $V_{CC}$ min | TTL outputs | 2.4 | | V |
| | High-level output voltage @ $I_{OH}$ = -1.0 mA | CMOS outputs | $V_{CC}$-0.5 | | V |
| $V_{OL}$ | Low-level output voltage @ $I_{OL}$ = 12.0 mA, $V_{CC}$ min (Note 1) | TTL outputs | | 0.4 | V |
| | | CMOS outputs | | 0.4 | V |
| $V_{DR}$ | Data Retention Supply Voltage (below which configuration data may be lost) | | 3.0 | | V |
| $I_{CCO}$ | Quiescent FPGA supply current (Note 2) | | | 25 | mA |
| $I_L$ | Input or output leakage current | | -10 | +10 | µA |
| $C_{IN}$ | Input capacitance (sample tested) | BGA, SBGA, PQ, HQ, MQ packages | | 10 | pF |
| | | PGA packages | | 16 | pF |
| $I_{RPU}$ | Pad pull-up (when selected) @ $V_{in}$ = 0 V (sample tested) | | 0.02 | 0.25 | mA |
| $I_{RPD}$ | Pad pull-down (when selected) @ $V_{in}$ = 5.5 V (sample tested) | | 0.02 | 0.25 | mA |
| $I_{RLL}$ | Horizontal Longline pull-up (when selected) @ logic Low | | 0.3 | 2.0 | mA |

Note 1: With up to 64 pins simultaneously sinking 12 mA.
Note 2: With no output current loads, no active input or Longline pull-up resistors, all package pins at Vcc or GND.

## XC4000EX Global Buffer Switching Characteristic Guidelines

Testing of the switching parameters is modeled after testing methods specified by MIL-M-38510/605. All devices are 100% functionally tested. Internal timing parameters are derived from measuring internal test patterns. Listed below are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net.

When fewer vertical clock lines are connected, the clock distribution is faster; when multiple clock lines per column are driven from the same global clock, the delay is longer. For more specific, more precise, and worst-case guaranteed data, reflecting the actual routing structure, use the values provided by the static timing analyzer (TRCE in the Xilinx Development System) and back-annotated to the simulation netlist. These path delays, provided as a guideline, have been extracted from the static timing analyzer report. All timing parameters assume worst-case operating conditions (supply voltage and junction temperature).

| | | Speed Grade | -4 | -3 | -2 | -1 | Units |
|---|---|---|---|---|---|---|---|
| Description | Symbol | Device | Max | Max | Max | Max | |
| From pad through Global Low Skew buffer, to any clock K | $T_{GLS}$ | XC4028EX | 9.2 | 7.5 | 6.4 | | ns |
| | | XC4036EX | 9.8 | 7.9 | 7.1 | | ns |
| From pad through Global Early buffer, to any clock K in same quadrant | $T_{GE}$ | XC4028EX | 5.7 | 4.4 | 4.2 | | ns |
| | | XC4036EX | 5.9 | 4.6 | 4.4 | | ns |
| | | Preliminary | | | | | |

# XC4000EX Longline and Wide Decoder Timing Guidelines

Testing of switching parameters is modeled after testing methods specified by MIL-M-38510/605. All devices are 100% functionally tested. Internal timing parameters are derived from measuring internal test patterns. Listed below are representative values. For more specific, more precise, and worst-case guaranteed data, use the values reported by the static timing analyzer (TRCE in the Xilinx Development System) and back-annotated to the simulation netlist. These path delays, provided as a guideline, have been extracted from the static timing analyzer report. All timing parameters assume worst-case operating conditions (supply voltage and junction temperature). Values apply to all XC4000EX devices unless otherwise noted. Fewer than the specified number of pullup resistors can be used, if desired. Using fewer pullups reduces power consumption but increases delays. Use the static timing analyzer to determine delays if fewer pullups are used.

## XC4000EX Horizontal Longline Switching Characteristic Guidelines

| Description | Symbol | Speed Grade<br>Device | -4<br>Max | -3<br>Max | -2<br>Max | -1<br>Max | Units |
|---|---|---|---|---|---|---|---|
| **TBUF driving a Horizontal Longline** | | | | | | | |
| I going High or Low to Horizontal Longline going High or Low, while T is Low. Buffer is constantly active. | $T_{IO1}$ | XC4028EX<br>XC4036EX | 13.7<br>16.5 | 11.3<br>13.6 | 10.9<br>13.2 | | ns<br>ns |
| T going Low to Horizontal Longline going from resistive pull-up or floating High to active Low. TBUF configured as open-drain or active buffer with I = Low. | $T_{ON}$ | XC4028EX<br>XC4036EX | 14.7<br>17.4 | 12.1<br>14.4 | 11.7<br>14.0 | | ns<br>ns |
| T going High to Horizontal Longline going from Low to High, pulled up by two resistors. (Note 1) | $T_{PU2}$ | XC4028EX<br>XC4036EX | | | | | ns<br>ns |
| **TBUF driving Half a Horizontal Longline** | | | | | | | |
| I going High or Low to half of a Horizontal Longline going High or Low, while T is Low. Buffer is constantly active. | $T_{HIO1}$ | XC4028EX<br>XC4036EX | 6.3<br>7.3 | 5.6<br>6.0 | 4.6<br>5.7 | | ns<br>ns |
| T going Low to half of a Horizontal Longline going from resistive pull-up or floating High to active Low. TBUF configured as open-drain or active buffer with I = Low. | $T_{HON}$ | XC4028EX<br>XC4036EX | 7.2<br>8.2 | 6.4<br>6.8 | 5.4<br>6.5 | | ns<br>ns |
| T going High to half of a Horizontal Longline going from Low to High, pulled up by four resistors. (Note 1) | $T_{HPU4}$ | XC4028EX<br>XC4036EX | | | | | ns<br>ns |
| | | | **Preliminary** | | | | |

Note: These values include a minimum load of one output, spaced as far as possible from the activated pullup(s). Use the static timing analyzer to determine the delay for each destination.

## XC4000EX Wide Decoder Switching Characteristic Guidelines

| Description | Symbol | Speed Grade<br>Device | -4<br>Max | -3<br>Max | -2<br>Max | -1<br>Max | Units |
|---|---|---|---|---|---|---|---|
| Full length, two pull-ups, inputs from IOB I-pins | $T_{WAF2}$ | XC4028EX<br>XC4036EX | | | | | ns<br>ns |
| Full length, two pull-ups, inputs from internal logic | $T_{WAF2L}$ | XC4028EX<br>XC4036EX | | | | | ns<br>ns |
| Half length, two pull-ups, inputs from IOB I-pins | $T_{WAO2}$ | XC4028EX<br>XC4036EX | | | | | ns<br>ns |
| Half length, two pull-ups, inputs from internal logic | $T_{WAO2L}$ | XC4028EX<br>XC4036EX | | | | | ns<br>ns |
| | | | **Preliminary** | | | | |

Notes: These delays are specified from the decoder input to the decoder output.

## XC4000EX CLB Switching Characteristic Guidelines

Testing of switching parameters is modeled after testing methods specified by MIL-M-38510/605. All devices are 100% functionally tested. Internal timing parameters are derived from measuring internal test patterns. Listed below are representative values. For more specific, more precise, and worst-case guaranteed data, use the values reported by the static timing analyzer (TRCE in the Xilinx Development System) and back-annotated to the simulation netlist. All timing parameters assume worst-case operating conditions (supply voltage and junction temperature). Values apply to all XC4000EX devices unless otherwise noted.

| Description | Symbol | -4 Min | -4 Max | -3 Min | -3 Max | -2 Min | -2 Max | -1 Min | -1 Max | Units |
|---|---|---|---|---|---|---|---|---|---|---|
| **Combinatorial Delays** | | | | | | | | | | |
| F/G inputs to X/Y outputs | $T_{ILO}$ | | 2.2 | | 1.8 | | 1.5 | | | ns |
| F/G inputs via H' to X/Y outputs | $T_{IHO}$ | | 3.8 | | 3.2 | | 2.7 | | | ns |
| F/G inputs via transparent latch to Q outputs | $T_{ITO}$ | | 3.2 | | 2.7 | | 2.5 | | | ns |
| C inputs via SR/H0 via H' to X/Y outputs | $T_{HH0O}$ | | 3.6 | | 3.0 | | 2.5 | | | ns |
| C inputs via H1 via H' to X/Y outputs | $T_{HH1O}$ | | 3.0 | | 2.5 | | 2.3 | | | ns |
| C inputs via DIN/H2 via H' to X/Y outputs | $T_{HH2O}$ | | 3.6 | | 3.0 | | 2.5 | | | ns |
| C inputs via EC, DIN/H2 to YQ, XQ output (bypass) | $T_{CBYP}$ | | 2.0 | | 1.6 | | 1.4 | | | ns |
| **CLB Fast Carry Logic** | | | | | | | | | | |
| Operand inputs (F1, F2, G1, G4) to COUT | $T_{OPCY}$ | | 2.5 | | 2.2 | | 1.9 | | | ns |
| Add/Subtract input (F3) to COUT | $T_{ASCY}$ | | 4.1 | | 3.6 | | 3.1 | | | ns |
| Initialization inputs (F1, F3) to COUT | $T_{INCY}$ | | 1.9 | | 1.6 | | 1.4 | | | ns |
| CIN through function generators to X/Y outputs | $T_{SUM}$ | | 3.0 | | 2.6 | | 2.2 | | | ns |
| $C_{IN}$ to $C_{OUT}$, bypass function generators | $T_{BYP}$ | | 0.60 | | 0.50 | | 0.40 | | | ns |
| Carry Net Delay, $C_{OUT}$ to $C_{IN}$ | $T_{NET}$ | | 0.18 | | 0.15 | | 0.15 | | | ns |
| **Sequential Delays** | | | | | | | | | | |
| Clock K to Flip-Flop outputs Q | $T_{CKO}$ | | 2.2 | | 1.9 | | 1.7 | | | ns |
| Clock K to Latch outputs Q | $T_{CKLO}$ | | 2.2 | | 1.9 | | 1.7 | | | ns |
| **Setup Time before Clock K** | | | | | | | | | | |
| F/G inputs | $T_{ICK}$ | 1.3 | | 1.1 | | 1.1 | | | | ns |
| F/G inputs via H' | $T_{IHCK}$ | 3.0 | | 2.5 | | 2.2 | | | | ns |
| C inputs via H0 through H' | $T_{HH0CK}$ | 2.8 | | 2.3 | | 2.0 | | | | ns |
| C inputs via H1 through H' | $T_{HH1CK}$ | 2.2 | | 1.8 | | 1.8 | | | | ns |
| C inputs via H2 through H' | $T_{HH2CK}$ | 2.8 | | 2.3 | | 2.0 | | | | ns |
| C inputs via DIN | $T_{DICK}$ | 1.2 | | 0.9 | | 0.9 | | | | ns |
| C inputs via EC | $T_{ECCK}$ | 1.2 | | 1.0 | | 0.9 | | | | ns |
| C inputs via S/R, going Low (inactive) | $T_{RCK}$ | 0.8 | | 0.7 | | 0.6 | | | | ns |
| CIN input via F'/G' | $T_{CCK}$ | 2.2 | | 1.8 | | 2.1 | | | | ns |
| CIN input via F'/G' and H' | $T_{CHCK}$ | 3.9 | | 3.2 | | 3.2 | | | | ns |
| **Hold Time after Clock K** | | | | | | | | | | |
| F/G inputs | $T_{CKI}$ | 0 | | 0 | | 0 | | | | ns |
| F/G inputs via H' | $T_{CKIH}$ | 0 | | 0 | | 0 | | | | ns |
| C inputs via SR/H0 through H' | $T_{CKHH0}$ | 0 | | 0 | | 0 | | | | ns |
| C inputs via H1 through H' | $T_{CKHH1}$ | 0 | | 0 | | 0 | | | | ns |
| C inputs via DIN/H2 through H' | $T_{CKHH2}$ | 0 | | 0 | | 0 | | | | ns |
| C inputs via DIN/H2 | $T_{CKDI}$ | 0 | | 0 | | 0 | | | | ns |
| C inputs via EC | $T_{CKEC}$ | 0 | | 0 | | 0 | | | | ns |
| C inputs via SR, going Low (inactive) | $T_{CKR}$ | 0 | | 0 | | 0 | | | | ns |
| **Clock** | | | | | | | | | | |
| Clock High time | $T_{CH}$ | 3.5 | | 3.0 | | 3.0 | | | | ns |
| Clock Low time | $T_{CL}$ | 3.5 | | 3.0 | | 3.0 | | | | ns |
| **Set/Reset Direct** | | | | | | | | | | |
| Width (High) | $T_{RPW}$ | 3.5 | | 3.0 | | 3.0 | | | | ns |
| Delay from C inputs via S/R, going High to Q | $T_{RIO}$ | | 4.5 | | 3.8 | | 3.6 | | | ns |
| **Global Set/Reset** | | | | | | | | | | |
| Minimum GSR Pulse Width | $T_{MRW}$ | | 13.0 | | 11.5 | | 11.5 | | | ns |
| Delay from GSR input to any Q (XC4028EX) | $T_{MRQ}$ | | 22.8 | | 19.0 | | 19.0 | | | ns |
| Delay from GSR input to any Q (XC4036EX) | $T_{MRQ}$ | | 24.0 | | 21.0 | | 21.0 | | | ns |
| **Toggle Frequency )** (for export control purposes) | $F_{TOG}$ | | 143 | | 166 | | 166 | | | MHz |

**Preliminary**

## XC4000EX CLB RAM Synchronous (Edge-Triggered) Write Operation Guidelines

Testing of switching parameters is modeled after testing methods specified by MIL-M-38510/605. All devices are 100% functionally tested. Internal timing parameters are derived from measuring internal test patterns. Listed below are representative values. For more specific, more precise, and worst-case guaranteed data, use the values reported by the static timing analyzer (TRCE in the Xilinx Development System) and back-annotated to the simulation netlist. All timing parameters assume worst-case operating conditions (supply voltage and junction temperature). Values apply to all XC4000EX devices unless otherwise noted.

| Single Port RAM | Speed Grade | | -4 | | -3 | | -2 | | -1 | | Units |
| --- | --- | --- | --- | --- | --- | --- | --- | --- | --- | --- | --- |
| | Size | Symbol | Min | Max | Min | Max | Min | Max | Min | Max | |
| **Write Operation** | | | | | | | | | | | |
| Address write cycle time (clock K period) | 16x2 | $T_{WCS}$ | 11.0 | | 9.0 | | 9.0 | | | | ns |
| | 32x1 | $T_{WCTS}$ | 11.0 | | 9.0 | | 9.0 | | | | ns |
| Clock K pulse width (active edge) | 16x2 | $T_{WPS}$ | 5.5 | | 4.5 | | 4.5 | | | | ns |
| | 32x1 | $T_{WPTS}$ | 5.5 | | 4.5 | | 4.5 | | | | ns |
| Address setup time before clock K | 16x2 | $T_{ASS}$ | 2.7 | | 2.3 | | 2.2 | | | | ns |
| | 32x1 | $T_{ASTS}$ | 2.6 | | 2.2 | | 2.2 | | | | ns |
| Address hold time after clock K | 16x2 | $T_{AHS}$ | 0 | | 0 | | 0 | | | | ns |
| | 32x1 | $T_{AHTS}$ | 0 | | 0 | | 0 | | | | ns |
| DIN setup time before clock K | 16x2 | $T_{DSS}$ | 2.4 | | 2.0 | | 2.0 | | | | ns |
| | 32x1 | $T_{DSTS}$ | 2.9 | | 2.5 | | 2.5 | | | | ns |
| DIN hold time after clock K | 16x2 | $T_{DHS}$ | 0 | | 0 | | 0 | | | | ns |
| | 32x1 | $T_{DHTS}$ | 0 | | 0 | | 0 | | | | ns |
| WE setup time before clock K | 16x2 | $T_{WSS}$ | 2.3 | | 2.0 | | 2.0 | | | | ns |
| | 32x1 | $T_{WSTS}$ | 2.1 | | 1.8 | | 1.8 | | | | ns |
| WE hold time after clock K | 16x2 | $T_{WHS}$ | 0 | | 0 | | 0 | | | | ns |
| | 32x1 | $T_{WHTS}$ | 0 | | 0 | | 0 | | | | ns |
| Data valid after clock K | 16x2 | $T_{WOS}$ | | 8.2 | | 6.8 | | 6.8 | | | ns |
| | 32x1 | $T_{WOTS}$ | | 10.1 | | 8.4 | | 8.2 | | | ns |
| | | | | | | **Preliminary** | | | | | |

Notes: Timing for the 16x1 RAM option is identical to 16x2 RAM timing.
Applicable Read timing specifications are identical to Level-Sensitive Read timing.

| Dual-Port RAM | Speed Grade | | -4 | | -3 | | -2 | | -1 | | Units |
| --- | --- | --- | --- | --- | --- | --- | --- | --- | --- | --- | --- |
| | Size | Symbol | Min | Max | Min | Max | Min | Max | Min | Max | |
| **Write Operation** | | | | | | | | | | | |
| Address write cycle time (clock K period) | 16x1 | $T_{WCDS}$ | 11.0 | | 9.0 | | 9.0 | | | | ns |
| Clock K pulse width (active edge) | 16x1 | $T_{WPDS}$ | 5.5 | | 4.5 | | 4.5 | | | | ns |
| Address setup time before clock K | 16x1 | $T_{ASDS}$ | 3.1 | | 2.6 | | 2.5 | | | | ns |
| Address hold time after clock K | 16x1 | $T_{AHDS}$ | 0 | | 0 | | 0 | | | | ns |
| DIN setup time before clock K | 16x1 | $T_{DSDS}$ | 2.9 | | 2.5 | | 2.5 | | | | ns |
| DIN hold time after clock K | 16x1 | $T_{DHDS}$ | 0 | | 0 | | 0 | | | | ns |
| WE setup time before clock K | 16x1 | $T_{WSDS}$ | 2.1 | | 1.8 | | 1.8 | | | | ns |
| WE hold time after clock K | 16x1 | $T_{WHDS}$ | 0 | | 0 | | 0 | | | | ns |
| Data valid after clock K | 16x1 | $T_{WODS}$ | | 9.4 | | 7.8 | | 7.8 | | | ns |
| | | | | | | **Preliminary** | | | | | |

## XC4000EX CLB RAM Synchronous (Edge-Triggered) Write Timing
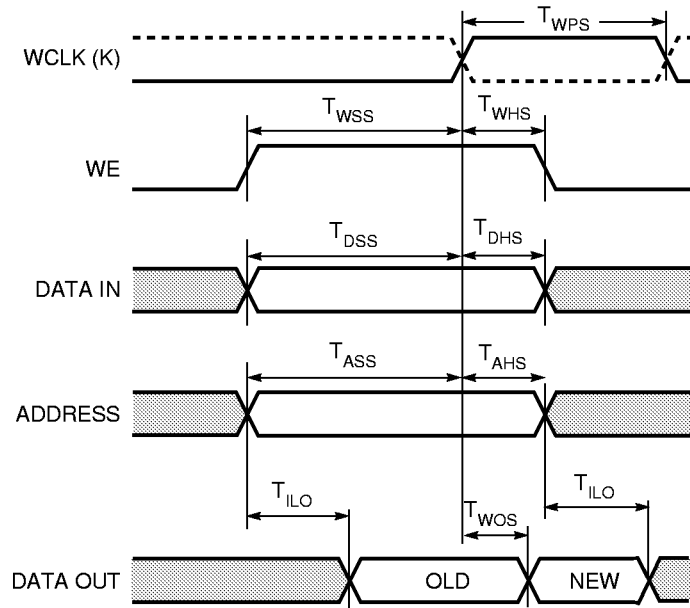


X6461

## XC4000EX CLB Dual-Port RAM Synchronous (Edge-Triggered) Write Timing
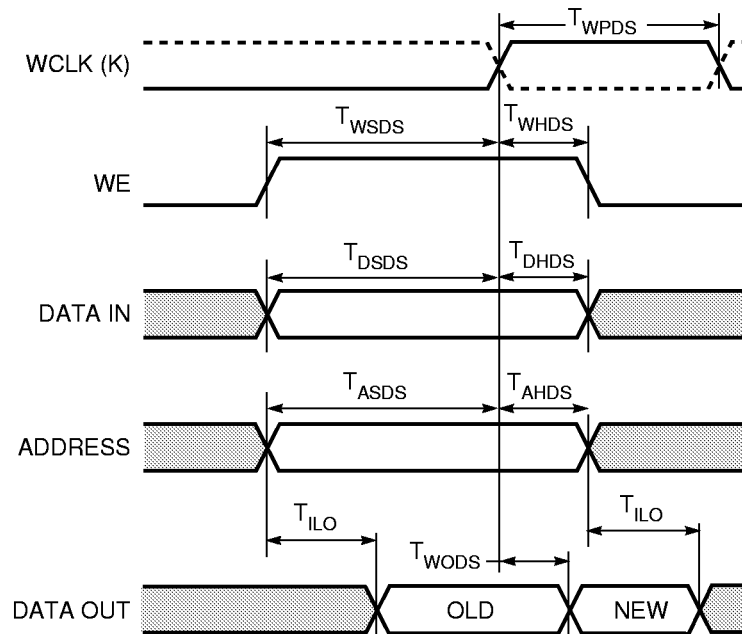


X6474

## XC4000EX CLB RAM Asynchronous (Level-Sensitive) Write and Read Operation Guidelines

Testing of switching parameters is modeled after testing methods specified by MIL-M-38510/605. All devices are 100% functionally tested. Internal timing parameters are derived from measuring internal test patterns. Listed below are representative values. For more specific, more precise, and worst-case guaranteed data, use the values reported by the static timing analyzer (TRCE in the Xilinx Development System) and back-annotated to the simulation netlist. All timing parameters assume worst-case operating conditions (supply voltage and junction temperature). Values apply to all XC4000EX devices unless otherwise noted.

| Description | Size | Symbol | -4 Min | -4 Max | -3 Min | -3 Max | -2 Min | -2 Max | -1 Min | -1 Max | Units |
|---|---|---|---|---|---|---|---|---|---|---|---|
| **Write Operation** | | | | | | | | | | | |
| Address write cycle time | 16x2 | $T_{WC}$ | 10.6 | | 9.2 | | 8.0 | | | | ns |
| | 32x1 | $T_{WCT}$ | 10.6 | | 9.2 | | 8.0 | | | | ns |
| Write Enable pulse width (High) | 16x2 | $T_{WP}$ | 5.3 | | 4.6 | | 4.0 | | | | ns |
| | 32x1 | $T_{WPT}$ | 5.3 | | 4.6 | | 4.0 | | | | ns |
| Address setup time before WE | 16x2 | $T_{AS}$ | 2.8 | | 2.4 | | 2.0 | | | | ns |
| | 32x1 | $T_{AST}$ | 2.9 | | 2.5 | | 2.0 | | | | ns |
| Address hold time after end of WE | 16x2 | $T_{AH}$ | 1.7 | | 1.4 | | 1.4 | | | | ns |
| | 32x1 | $T_{AHT}$ | 1.7 | | 1.4 | | 1.4 | | | | ns |
| DIN setup time before end of WE | 16x2 | $T_{DS}$ | 1.1 | | 0.9 | | 0.8 | | | | ns |
| | 32x1 | $T_{DST}$ | 1.1 | | 0.9 | | 0.8 | | | | ns |
| DIN hold time after end of WE | 16x2 | $T_{DH}$ | 6.6 | | 5.7 | | 5.0 | | | | ns |
| | 32x1 | $T_{DHT}$ | 6.6 | | 5.7 | | 5.0 | | | | ns |
| **Read Operation** | | | | | | | | | | | |
| Address read cycle time | 16x2 | $T_{RC}$ | 4.5 | | 3.1 | | 3.1 | | | | ns |
| | 32x1 | $T_{RCT}$ | 6.5 | | 5.5 | | 5.5 | | | | ns |
| Data valid after address change (no Write Enable) | 16x2 | $T_{ILO}$ | | 2.2 | | 1.8 | | 1.5 | | | ns |
| | 32x1 | $T_{IHO}$ | | 3.8 | | 3.2 | | 2.7 | | | ns |
| **Read Operation, Clocking Data into Flip-Flop** | | | | | | | | | | | |
| Address setup time before clock K | 16x2 | $T_{ICK}$ | 1.5 | | 1.2 | | 1.2 | | | | ns |
| | 32x1 | $T_{IHCK}$ | 3.2 | | 2.6 | | 2.6 | | | | ns |
| **Read During Write** | | | | | | | | | | | |
| Data valid after WE goes active (DIN stable before WE) | 16x2 | $T_{WO}$ | | 6.5 | | 5.7 | | 4.9 | | | ns |
| | 32x1 | $T_{WOT}$ | | 7.4 | | 6.5 | | 5.6 | | | ns |
| Data valid after DIN (DIN changes during WE) | 16x2 | $T_{DO}$ | | 7.7 | | 6.7 | | 5.8 | | | ns |
| | 32x1 | $T_{DOT}$ | | 8.2 | | 7.2 | | 6.2 | | | ns |
| **Read During Write, Clocking Data into Flip-Flop** | | | | | | | | | | | |
| WE setup time before clock K | 16x2 | $T_{WCK}$ | 7.1 | | 6.2 | | 5.5 | | | | ns |
| | 32x1 | $T_{WCKT}$ | 9.2 | | 8.1 | | 7.0 | | | | ns |
| Data setup time before clock K | 16x2 | $T_{DCK}$ | 5.9 | | 5.2 | | 4.6 | | | | ns |
| | 32x1 | $T_{DCKT}$ | 8.4 | | 7.4 | | 6.4 | | | | ns |
| **Preliminary** | | | | | | | | | | | |

Note: Timing for the 16x1 RAM option is identical to 16x2 RAM timing.

# XC4000EX CLB RAM Asynchronous (Level-Sensitive) Timing Characteristics



**WRITE**

ADDRESS

WRITE ENABLE

DATA IN — REQUIRED

$T_{WC}$, $T_{AS}$, $T_{WP}$, $T_{AH}$, $T_{DS}$, $T_{DH}$

**READ WITHOUT WRITE**

X,Y OUTPUTS — VALID — VALID

$T_{ILO}$

**READ, CLOCKING DATA INTO FLIP-FLOP**

CLOCK

XQ, YQ OUTPUTS — VALID (OLD) — VALID (NEW)

$T_{ICK}$, $T_{CH}$, $T_{CKO}$

**READ DURING WRITE**

WRITE ENABLE

DATA IN (stable during WE)

X, Y OUTPUTS — VALID — VALID

DATA IN (changing during WE) — OLD — NEW

X, Y OUTPUTS — VALID (PREVIOUS) — VALID (OLD) — VALID (NEW)

$T_{WP}$, $T_{DH}$, $T_{WO}$, $T_{DO}$

**READ DURING WRITE, CLOCKING DATA INTO FLIP-FLOP**

WRITE ENABLE

DATA IN

CLOCK

XQ, YQ OUTPUTS

$T_{WP}$, $T_{WCK}$, $T_{DCK}$, $T_{CKO}$

X2640

# XC4000EX Pin-to-Pin Output Parameter Guidelines

Testing of switching parameters is modeled after testing methods specified by MIL-M-38510/605. All devices are 100% functionally tested. Pin-to-pin timing parameters are derived from measuring external and internal test patterns and are guaranteed over worst-case operating conditions (supply voltage and junction temperature). Listed below are representative values for typical pin locations and normal clock loading. For more specific, more precise, and worst-case guaranteed data, reflecting the actual routing structure, use the values provided by the static timing analyzer (TRCE in the Xilinx Development System) and back-annotated to the simulation netlist. These path delays, provided as a guideline, have been extracted from the static timing analyzer report. Values apply to all XC4000EX devices unless otherwise noted.

## XC4000EX Output Flip-Flop, Clock to Out

| Speed Grade | | | -4 | -3 | -2 | -1 | Units |
|---|---|---|---|---|---|---|---|
| Description | Symbol | Device | Max | Max | Max | Max | |
| Global Low Skew Clock to TTL Output (fast) using OFF | $T_{ICKOF}$ | XC4028EX | 16.6 | 13.7 | 12.4 | | ns |
| | | XC4036EX | 17.2 | 14.1 | 13.1 | | ns |
| Global Early Clock to TTL Output (fast) using OFF | $T_{ICKEOF}$ | XC4028EX | 13.1 | 10.6 | 10.2 | | ns |
| | | XC4036EX | 13.3 | 10.8 | 10.4 | | ns |

OFF = Output Flip Flop                                **Preliminary**

## XC4000EX Output MUX, Clock to Out

| Speed Grade | | | -4 | -3 | -2 | -1 | Units |
|---|---|---|---|---|---|---|---|
| Description | Symbol | Device | Max | Max | Max | Max | |
| Global Low Skew Clock to TTL Output (fast) using OMUX | $T_{PFPF}$ | XC4028EX | 15.9 | 13.1 | 11.8 | | ns |
| | | XC4036EX | 16.5 | 13.5 | 12.5 | | ns |
| Global Early Clock to TTL Output (fast) using OMUX | $T_{PEFPF}$ | XC4028EX | 12.4 | 10.0 | 9.6 | | ns |
| | | XC4036EX | 12.6 | 10.2 | 9.8 | | ns |

OMUX = Output MUX                                    **Preliminary**

Notes:   Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net.
Output timing is measured at TTL threshold with 35 pF external capacitive load.
Set-up time is measured with the fastest route and the lightest load. Hold time is measured using the farthest distance and a reference load of one clock pin per two IOBs. Use the static timing analyzer to determine the setup and hold times under given design conditions.

## XC4000EX Output Level and Slew Rate Adjustments

The following table must be used to adjust output parameters and output switching characteristics.

| Speed Grade | | | -4 | -3 | -2 | -1 | Units |
|---|---|---|---|---|---|---|---|
| Description | Symbol | Device | Max | Max | Max | Max | |
| For TTL output FAST add | $T_{TTLOF}$ | All Devices | 0 | 0 | 0 | | ns |
| For TTL output SLOW add | $T_{TTLO}$ | All Devices | 2.9 | 2.4 | 2.4 | | ns |
| For CMOS FAST output add | $T_{CMOSOF}$ | All Devices | 1.0 | 0.8 | 0.8 | | ns |
| For CMOS SLOW output add | $T_{CMOSO}$ | All Devices | 3.6 | 3.0 | 3.0 | | ns |

**Preliminary**

# XC4000EX Pin-to-Pin Input Parameter Guidelines

Testing of switching parameters is modeled after testing methods specified by MIL-M-38510/605. All devices are 100% functionally tested. Pin-to-pin timing parameters are derived from measuring external and internal test patterns and are guaranteed over worst-case operating conditions (supply voltage and junction temperature). Listed below are representative values for typical pin locations and normal clock loading. For more specific, more precise, and worst-case guaranteed data, reflecting the actual routing structure, use the values provided by the static timing analyzer (TRCE in the Xilinx Development System) and back-annotated to the simulation netlist. These path delays, provided as a guideline, have been extracted from the static timing analyzer report. Values apply to all XC4000EX devices unless otherwise noted

## XC4000EX Global Low Skew Clock, Set-Up and Hold

| Description | Symbol | Speed Grade Device | -4 Min | -3 Min | -2 Min | -1 Min | Units |
|---|---|---|---|---|---|---|---|
| Input Setup Time, using Global Low Skew clock and IFF (full delay) | $T_{PSD}$ | XC4028EX | 8.0 | 6.8 | 6.8 | | ns |
| | | XC4036EX | 8.0 | 6.8 | 6.8 | | ns |
| Input Hold Time, using Global Low Skew clock and IFF (full delay) | $T_{PHD}$ | XC4028EX | 0 | 0 | 0 | | ns |
| | | XC4036EX | 0 | 0 | 0 | | ns |
| IFF = Flip-Flop or Latch | | | **Preliminary** | | | | |

## XC4000EX Global Early Clock, Set-Up and Hold for IFF

| Description | Symbol | Speed Grade Device | -4 Min | -3 Min | -2 Min | -1 Min | Units |
|---|---|---|---|---|---|---|---|
| Input Setup Time, using Global Early clock and IFF (partial delay) | $T_{PSEP}$ | XC4028EX | 6.5 | 5.4 | 5.4 | | ns |
| | | XC4036EX | 6.5 | 5.4 | 5.4 | | ns |
| Input Hold Time, using Global Early clock and IFF (partial delay) | $T_{PHEP}$ | XC4028EX | 0 | 0 | 0 | | ns |
| | | XC4036EX | 0 | 0 | 0 | | ns |
| IFF = Flip-Flop or Latch | | | **Preliminary** | | | | |

Note: Set-up parameters are for BUFGE #s 3, 4, 7 and 8. Add 1.6 ns for BUFGE #s 1, 2, 5 and 6.

## XC4000EX Global Early Clock, Set-Up and Hold for FCL

| Description | Symbol | Speed Grade Device | -4 Min | -3 Min | -2 Min | -1 Min | Units |
|---|---|---|---|---|---|---|---|
| Input Setup Time, using Global Early clock and FCL (partial delay) | $T_{PFSEP}$ | XC4028EX | 3.4 | 3.4 | 3.4 | | ns |
| | | XC4036EX | 4.4 | 4.2 | 4.2 | | ns |
| Input Hold Time, using Global Early clock and FCL (partial delay) | $T_{PFHEP}$ | XC4028EX | 0 | 0 | 0 | | ns |
| | | XC4036EX | 0 | 0 | 0 | | ns |
| FCL = Fast Capture Latch | | | **Preliminary** | | | | |

Notes: For CMOS output levels, see the Output Level and Slew Rate Adjustments tables on page 10.
Setup time is measured with the fastest route and the lightest load. Use the static timing analyzer to determine the setup time under given design conditions. Hold time is measured using the farthest distance and a reference load of one clock pin per two IOBs. Use the static timing analyzer to determine the setup and hold times under given design conditions.
Note:Set-up parameters are for BUFGE #s 3, 4, 7 and 8. Add 1.2 ns for BUFGE #s 1, 2, 5 and 6.

## XC4000EX Input Threshold and Slew Rate Adjustments

The following table must be used to adjust input parameters and input switching characteristics.

| Description | Symbol | Speed Grade Device | -4 Max | -3 Max | -2 Max | -1 Max | Units |
|---|---|---|---|---|---|---|---|
| For TTL input add | $T_{TTLI}$ | All Devices | 0 | 0 | 0 | | ns |
| For CMOS input add | $T_{CMOSI}$ | All Devices | 0.3 | 0.2 | 0.2 | | ns |
| | | | **Preliminary** | | | | |

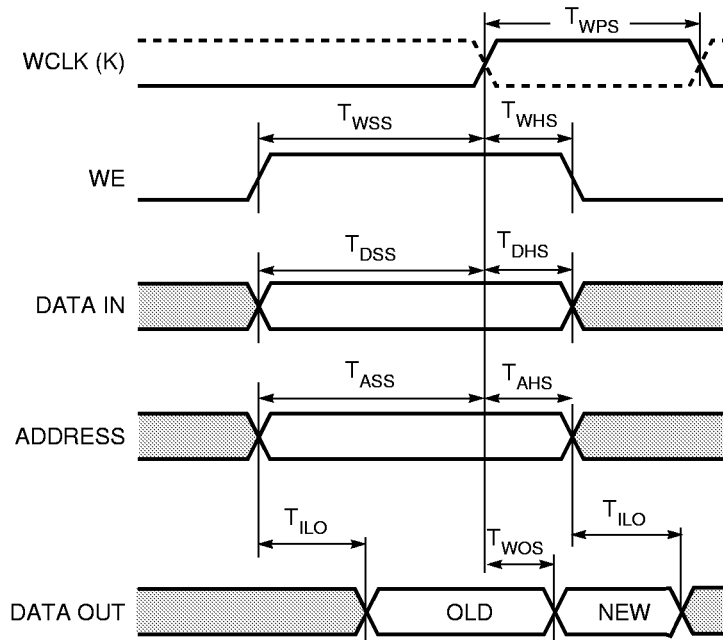## XC4000EX IOB Input Switching Characteristic Guidelines

Testing of switching parameters is modeled after testing methods specified by MIL-M-38510/605. All devices are 100% functionally tested. Internal timing parameters are derived from measuring internal test patterns. Listed below are representative values. For more specific, more precise, and worst-case guaranteed data, use the values reported by the static timing analyzer (TRCE in the Xilinx Development System) and back-annotated to the simulation netlist. These path delays, provided as a guideline, have been extracted from the static timing analyzer report. All timing parameters assume worst-case operating conditions (supply voltage and junction temperature). Values apply to all XC4000EX devices unless otherwise noted.

| | | Speed Grade | -4 | -3 | -2 | -1 | Units |
|---|---|---|---|---|---|---|---|
| **Description** | **Symbol** | **Device** | **Min** | **Min** | **Min** | **Min** | |
| **Clocks** | | | | | | | |
| Delay from FCL enable (OK) active edge to IFF clock (IK) active edge | $T_{OKIK}$ | All devices | 3.2 | 2.6 | 2.6 | | ns |
| **Propagation Delays** | | | **Max** | **Max** | **Max** | **Max** | |
| Pad to I1, I2 | $T_{PID}$ | All devices | 2.2 | 1.9 | 1.8 | | ns |
| Pad to I1, I2 via transparent input latch, no delay | $T_{PLI}$ | All devices | 3.8 | 3.2 | 3.0 | | ns |
| Pad to I1, I2 via transparent input latch, partial delay | $T_{PPLI}$ | XC4028EX | 13.3 | 11.1 | 10.9 | | ns |
| | | XC4036EX | 14.5 | 12.1 | 11.9 | | ns |
| Pad to I1, I2 via transparent input latch, full delay | $T_{PDLI}$ | XC4028EX | 18.2 | 15.2 | 14.9 | | ns |
| | | XC4036EX | 19.4 | 16.2 | 15.9 | | ns |
| Pad to I1, I2 via transparent FCL and input latch, no delay | $T_{PFLI}$ | All devices | 5.3 | 4.4 | 4.2 | | ns |
| Pad to I1, I2 via transparent FCL and input latch, partial delay | $T_{PPFLI}$ | XC4028EX | 13.6 | 11.3 | 11.1 | | ns |
| | | XC4036EX | 14.8 | 12.3 | 12.1 | | ns |
| **Propagation Delays** | | | | | | | |
| Clock (IK) to I1, I2 (flip-flop) | $T_{IKRI}$ | All devices | 3.0 | 2.5 | 2.4 | | ns |
| Clock (IK) to I1, I2 (latch enable, active Low) | $T_{IKLI}$ | All devices | 3.2 | 2.7 | 2.6 | | ns |
| FCL Enable (OK) active edge to I1, I2 (via transparent standard input latch) | $T_{OKLI}$ | All devices | 6.2 | 5.2 | 5.0 | | ns |
| **Global Set/Reset** | | | | | | | |
| Minimum GSR Pulse Width | $T_{MRW}$ | All devices | 13.0 | 11.5 | 11.5 | | ns |
| Delay from GSR input to any Q | $T_{RRI}$ | XC4028EX | 22.8 | 19.0 | 19.0 | | ns |
| Delay from GSR input to any Q | $T_{RRI}$ | XC4036EX | 24.0 | 21.0 | 21.0 | | ns |

FCL = Fast Capture Latch, IFF = Input Flip-Flop or Latch     **Preliminary**

Notes: For CMOS output levels, see the Output Level and Slew Rate Adjustments table on page 10.
For setup and hold times with respect to the clock input pin, see the Global Low Skew Clock and Global Early Clock Set-up and Hold tables on page 11.

## XC4000EX IOB Input Switching Characteristic Guidelines (Continued)

Testing of switching parameters is modeled after testing methods specified by MIL-M-38510/605. All devices are 100% functionally tested. Internal timing parameters are derived from measuring internal test patterns. Listed below are representative values. For more specific, more precise, and worst-case guaranteed data, use the values reported by the static timing analyzer (TRCE in the Xilinx Development System) and back-annotated to the simulation netlist. These path delays, provided as a guideline, have been extracted from the static timing analyzer report. All timing parameters assume worst-case operating conditions (supply voltage and junction temperature). Values apply to all XC4000EX devices unless otherwise noted.

| | | Speed Grade | -4 | -3 | -2 | -1 | Units |
|---|---|---|---|---|---|---|---|
| Description | Symbol | Device | Min | Min | Min | Min | |
| **Setup Times** | | | | | | | |
| Pad to Clock (IK), no delay | $T_{PICK}$ | All devices | 2.5 | 2.0 | 2.0 | | ns |
| Pad to Clock (IK), partial delay | $T_{PICKP}$ | XC4028EX | 10.8 | 9.0 | 9.0 | | ns |
| | | XC4036EX | 12.0 | 10.0 | 10.0 | | ns |
| Pad to Clock (IK), full delay | $T_{PICKD}$ | XC4028EX | 15.7 | 13.1 | 13.1 | | ns |
| | | XC4036EX | 16.9 | 14.1 | 14.1 | | ns |
| Pad to Clock (IK), via transparent Fast Capture Latch, no delay | $T_{PICKF}$ | All devices | 3.9 | 3.3 | 3.3 | | ns |
| Pad to Clock (IK), via transparent Fast Capture Latch, partial delay | $T_{PICKFP}$ | XC4028EX | 12.3 | 10.2 | 10.2 | | ns |
| | | XC4036EX | 13.5 | 11.2 | 11.2 | | ns |
| Pad to Fast Capture Latch Enable (OK), no delay | $T_{POCK}$ | All devices | 0.8 | 0.7 | 0.7 | | ns |
| Pad to Fast Capture Latch Enable (OK), partial delay | $T_{POCKP}$ | XC4028EX | 9.1 | 7.6 | 7.6 | | ns |
| | | XC4036EX | 10.3 | 8.6 | 8.6 | | ns |
| **Setup Times (TTL or CMOS Inputs)** | | | | | | | |
| Clock Enable (EC) to Clock (IK) | $T_{ECIK}$ | All devices | 0.3 | 0.2 | 0.2 | | ns |
| **Hold Times** | | | | | | | |
| Pad to Clock (IK), | | | | | | | |
| no delay | $T_{IKPI}$ | All devices | 0 | 0 | 0 | | ns |
| partial delay | $T_{IKPIP}$ | All devices | 0 | 0 | 0 | | ns |
| full delay | $T_{IKPID}$ | All devices | 0 | 0 | 0 | | ns |
| Pad to Clock (IK) via transparent Fast Capture Latch, | | | | | | | |
| no delay | $T_{IKFPI}$ | All devices | 0 | 0 | 0 | | ns |
| partial delay | $T_{IKFPIP}$ | All devices | 0 | 0 | 0 | | ns |
| full delay | $T_{IKFPID}$ | All devices | 0 | 0 | 0 | | ns |
| Clock Enable (EC) to Clock (IK), | | | | | | | |
| no delay | $T_{IKEC}$ | All devices | 0 | 0 | 0 | | ns |
| partial delay | $T_{IKECP}$ | All devices | 0 | 0 | 0 | | ns |
| full delay | $T_{IKECD}$ | All devices | 0 | 0 | 0 | | ns |
| Pad to Fast Capture Latch Enable (OK), | | | | | | | |
| no delay | $T_{OKPI}$ | All devices | 0 | 0 | 0 | | ns |
| partial delay | $T_{OKPIP}$ | All devices | 0 | 0 | 0 | | ns |
| | | | **Preliminary** | | | | |

Notes: For CMOS output levels, see the Output Level and Slew Rate Adjustments table on page 10.
For setup and hold times with respect to the clock input pin, see the Global Low Skew Clock and Global Early Clock Set-up and Hold tables on page 11.

## XC4000EX IOB Output Switching Characteristic Guidelines

Testing of switching parameters is modeled after testing methods specified by MIL-M-38510/605. All devices are 100% functionally tested. Internal timing parameters are derived from measuring internal test patterns. Listed below are representative values. For more specific, more precise, and worst-case guaranteed data, use the values reported by the static timing analyzer (TRCE in the Xilinx Development System) and back-annotated to the simulation netlist. These path delays, provided as a guideline, have been extracted from the static timing analyzer report. All timing parameters assume worst-case operating conditions (supply voltage and junction temperature). For Propagation Delays, slew-rate = fast unless otherwise noted. Values apply to all XC4000EX devices unless otherwise noted.

| Description | Speed Grade | -4 | | -3 | | -2 | | -1 | | Units |
| --- | --- | --- | --- | --- | --- | --- | --- | --- | --- | --- |
| | Symbol | Min | Max | Min | Max | Min | Max | Min | Max | |
| **Propagation Delays** | | | | | | | | | | |
| Clock (OK) to Pad | $T_{OKPOF}$ | | 7.4 | | 6.2 | | 6.0 | | | ns |
| Output (O) to Pad | $T_{OPF}$ | | 6.2 | | 5.2 | | 5.0 | | | ns |
| 3-state to Pad hi-Z (slew-rate independent) | $T_{TSHZ}$ | | 4.9 | | 4.1 | | 4.1 | | | ns |
| 3-state to Pad active and valid | $T_{TSONF}$ | | 6.2 | | 5.2 | | 5.0 | | | ns |
| Output MUX Select (OK) to Pad | $T_{OKFPF}$ | | 6.7 | | 5.6 | | 5.4 | | | ns |
| Fast Path Output MUX Input (EC) to Pad | $T_{CEFPF}$ | | 6.2 | | 5.1 | | 5.0 | | | ns |
| Slowest Path Output MUX Input (O) to Pad | $T_{OFPF}$ | | 7.3 | | 6.0 | | 5.9 | | | ns |
| **Setup and Hold Times** | | | | | | | | | | |
| Output (O) to clock (OK) setup time | $T_{OOK}$ | 0.6 | | 0.5 | | 0.5 | | | | ns |
| Output (O) to clock (OK) hold time | $T_{OKO}$ | 0 | | 0 | | 0 | | | | ns |
| Clock Enable (EC) to clock (OK) setup | $T_{ECOK}$ | 0 | | 0 | | 0 | | | | ns |
| Clock Enable (EC) to clock (OK) hold | $T_{OKEC}$ | 0 | | 0 | | 0 | | | | ns |
| **Clock** | | | | | | | | | | |
| Clock High | $T_{CH}$ | 3.5 | | 3.0 | | 3.0 | | | | ns |
| Clock Low | $T_{CL}$ | 3.5 | | 3.0 | | 3.0 | | | | ns |
| **Global Set/Reset** | | | | | | | | | | |
| Minimum GSR pulse width | $T_{MRW}$ | 13.0 | | 11.5 | | 11.5 | | | | ns |
| Delay from GSR input to any Pad (XC4028EX) | $T_{RPO}$ | **30.2** | | **25.2** | | **25.0** | | | | ns |
| Delay from GSR input to any Pad (XC4036EX) | $T_{RPO}$ | **31.4** | | **27.2** | | **27.0** | | | | ns |
| | | | | | **Preliminary** | | | | | |

Notes:  Output timing is measured at TTL threshold, with 35pF external capacitive loads.
For CMOS output levels, see the Output Level and Slew Rate Adjustments table on page 10

# XC4000E Switching Characteristics

## Definition of Terms

In the following tables, some specifications may be designated as Advance or Preliminary. These terms are defined as follows:

**Advance:** Initial estimates based on simulation and/or extrapolation from other speed grades, devices, or device families. Use as estimates, not for production.

**Preliminary:** Based on preliminary characterization. Further changes are not expected.

**Unmarked:** Specifications not identified as either Advance or Preliminary are to be considered Final.[1]

## XC4000E Absolute Maximum Ratings

| Symbol | Description | | Value | Units |
|--------|-------------|---|-------|-------|
| $V_{CC}$ | Supply voltage relative to GND | | -0.5 to +7.0 | V |
| $V_{IN}$ | Input voltage relative to GND (Note 1) | | -0.5 to $V_{CC}$ +0.5 | V |
| $V_{TS}$ | Voltage applied to 3-state output (Note 1) | | -0.5 to $V_{CC}$ +0.5 | V |
| $T_{STG}$ | Storage temperature (ambient) | | -65 to +150 | °C |
| $T_{SOL}$ | Maximum soldering temperature (10 s @ 1/16 in. = 1.5 mm) | | +260 | °C |
| $T_J$ | Junction temperature | Ceramic packages | +150 | °C |
| | | Plastic packages | +125 | °C |

Note 1: Maximum DC overshoot or undershoot above Vcc or below GND must be limited to either 0.5 V or 10 mA, whichever is easier to achieve. During transitions, the device pins may undershoot to -2.0 V or overshoot to Vcc + 2.0 V, provided this over- or undershoot lasts less than 20 ns.

Note 2: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those listed under Operating Conditions is not implied. Exposure to Absolute Maximum Ratings conditions for extended periods of time may affect device reliability.

## XC4000E Recommended Operating Conditions

| Symbol | Description | | Min | Max | Units |
|--------|-------------|---|-----|-----|-------|
| $V_{CC}$ | Supply voltage relative to GND, $T_J$ = -0 °C to +85°C | Commercial | 4.75 | 5.25 | V |
| | Supply voltage relative to GND, $T_J$ = -40°C to +100°C | Industrial | 4.5 | 5.5 | V |
| | Supply voltage relative to GND, $T_C$ = -55°C to +125°C | Military | 4.5 | 5.5 | V |
| $V_{IH}$ | High-level input voltage | TTL inputs | 2.0 | $V_{CC}$ | V |
| | | CMOS inputs | 70% | 100% | $V_{CC}$ |
| $V_{IL}$ | Low-level input voltage | TTL inputs | 0 | 0.8 | V |
| | | CMOS inputs | 0 | 20% | $V_{CC}$ |
| $T_{IN}$ | Input signal transition time | | | 250 | ns |

Note: At junction temperatures above those listed as Recommended Operating Conditions, all delay parameters increase by 0.35% per °C.

Input and output Measurement thresholds are: 1.5V for TTL and 2.5V for CMOS.

1. Notwithstanding the definition of the above terms, all specifications are subject to change without notice.

## XC4000E DC Characteristics Over Operating Conditions

| Symbol | Description | | Min | Max | Units |
|---|---|---|---|---|---|
| $V_{OH}$ | High-level output voltage @ $I_{OH}$ = -4.0mA, $V_{CC}$ min | TTL outputs | 2.4 | | V |
| | High-level output voltage @ $I_{OH}$ = -1.0mA, $V_{CC}$ min | CMOS outputs | $V_{CC}$-0.5 | | V |
| $V_{OL}$ | Low-level output voltage @ $I_{OL}$ = 12.0mA, $V_{CC}$ min (Note 1) | TTL outputs | | 0.4 | V |
| | | CMOS outputs | | 0.4 | V |
| $I_{CCO}$ | Quiescent FPGA supply current (Note 2) | Commercial | | 3.0 | mA |
| | | Industrial | | 6.0 | mA |
| | | Military | | 6.0 | mA |
| $I_L$ | Input or output leakage current | | -10 | +10 | µA |
| $C_{IN}$ | Input capacitance (sample tested) | PQFP and MQFP packages | | 10 | pF |
| | | Other packages | | 16 | pF |
| $I_{RIN}$* | Pad pull-up (when selected) @ $V_{IN}$ = 0V (sample tested) | | -0.02 | -0.25 | mA |
| $I_{RLL}$* | Horizontal Longline pull-up (when selected) @ logic Low | | 0.2 | 2.5 | mA |

Note 1: With 50% of the outputs simultaneously sinking 12mA, up to a maximum of 64 pins.
Note 2: With no output current loads, no active input or Longline pull-up resistors, all package pins at Vcc or GND, and the FPGA configured with a MakeBits Tie option.
* Characterized Only.

## XC4000E Global Buffer Switching Characteristic Guidelines

Testing of the switching parameters is modeled after testing methods specified by MIL-M-38510/605. All devices are 100% functionally tested. Internal timing parameters are derived from measuring internal test patterns. Listed below are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net.

When fewer vertical clock lines are connected, the clock distribution is faster; when multiple clock lines per column are driven from the same global clock, the delay is longer. For more specific, more precise, and worst-case guaranteed data, reflecting the actual routing structure, use the values provided by the static timing analyzer (TRCE in the Xilinx Development System) and back-annotated to the simulation netlist. These path delays, provided as a guideline, have been extracted from the static timing analyzer report. All timing parameters assume worst-case operating conditions (supply voltage and junction temperature)

| | | Speed Grade | -4 | -3 | -2 | -1 | |
|---|---|---|---|---|---|---|---|
| Description | Symbol | Device | Max | Max | Max | Max | Units |
| From pad through Primary buffer, to any clock K | $T_{PG}$ | XC4003E | 7.0 | 4.7 | 4.0 | 3.5 | ns |
| | | XC4005E | 7.0 | 4.7 | 4.3 | 3.8 | ns |
| | | XC4006E | 7.5 | 5.3 | 5.2 | 4.6 | ns |
| | | XC4008E | 8.0 | 6.1 | 5.2 | 4.6 | ns |
| | | XC4010E | 11.0 | 6.3 | 5.4 | 4.8 | ns |
| | | XC4013E | 11.5 | 6.8 | 5.8 | 5.2 | ns |
| | | XC4020E | 12.0 | 7.0 | 6.4 | 6.0 | ns |
| | | XC4025E | 12.5 | 7.2 | 6.9 | – | ns |
| From pad through Secondary buffer, to any clock K | $T_{SG}$ | XC4003E | 7.5 | 5.2 | 4.4 | 4.0 | ns |
| | | XC4005E | 7.5 | 5.2 | 4.7 | 4.3 | ns |
| | | XC4006E | 8.0 | 5.8 | 5.6 | 5.1 | ns |
| | | XC4008E | 8.5 | 6.6 | 5.6 | 5.1 | ns |
| | | XC4010E | 11.5 | 6.8 | 5.8 | 5.3 | ns |
| | | XC4013E | 12.0 | 7.3 | 6.2 | 5.7 | ns |
| | | XC4020E | 12.5 | 7.5 | 6.7 | 6.5 | ns |
| | | XC4025E | 13.0 | 7.7 | 7.2 | – | ns |

**Preliminary**

## XC4000E Horizontal Longline Switching Characteristic Guidelines

Testing of switching parameters is modeled after testing methods specified by MIL-M-38510/605. All devices are 100% functionally tested. Internal timing parameters are derived from measuring internal test patterns. Listed below are representative values. For more specific, more precise, and worst-case guaranteed data, use the values reported by the static timing analyzer (TRCE in the Xilinx Development System) and back-annotated to the simulation netlist. These path delays, provided as a guideline, have been extracted from the static timing analyzer report. All timing parameters assume worst-case operating conditions (supply voltage and junction temperature). Values apply to all XC4000E devices unless otherwise noted.

The following guidelines reflect worst-case values over the recommended operating conditions.

| Description | Symbol | Device | Speed Grade -4 Max | -3 Max | -2 Max | -1 Max | Units |
|---|---|---|---|---|---|---|---|
| **TBUF driving a Horizontal Longline (LL):** | | | | | | | |
| I going High or Low to LL going High or Low, while T is Low. Buffer is constantly active. (Note1) | T_IO1 | XC4003E | 5.0 | 4.2 | 3.4 | 2.9 | ns |
| | | XC4005E | 5.0 | 5.0 | 4.0 | 3.4 | ns |
| | | XC4006E | 6.0 | 5.9 | 4.7 | 4.0 | ns |
| | | XC4008E | 7.0 | 6.3 | 5.0 | 4.3 | ns |
| | | XC4010E | 8.0 | 6.4 | 5.1 | 4.4 | ns |
| | | XC4013E | 9.0 | 7.2 | 5.7 | 4.9 | ns |
| | | XC4020E | 10.0 | 8.2 | 7.3 | 5.6 | ns |
| | | XC4025E | 11.0 | 9.1 | 7.3 | – | ns |
| I going Low to LL going from resistive pull-up High to active Low. TBUF configured as open-drain. (Note1) | T_IO2 | XC4003E | 5.0 | 4.2 | 3.6 | 3.1 | ns |
| | | XC4005E | 6.0 | 5.3 | 4.5 | 3.8 | ns |
| | | XC4006E | 7.8 | 6.4 | 5.4 | 4.6 | ns |
| | | XC4008E | 8.1 | 6.8 | 5.8 | 4.9 | ns |
| | | XC4010E | 10.5 | 6.9 | 5.9 | 5.0 | ns |
| | | XC4013E | 11.0 | 7.7 | 6.5 | 5.5 | ns |
| | | XC4020E | 12.0 | 8.7 | 8.7 | 7.4 | ns |
| | | XC4025E | 12.0 | 9.6 | 9.6 | – | ns |
| T going Low to LL going from resistive pull-up or floating High to active Low. TBUF configured as open-drain or active buffer with I = Low. (Note1) | T_ON | XC4003E | 5.5 | 4.6 | 3.9 | 3.5 | ns |
| | | XC4005E | 7.0 | 6.0 | 5.7 | 4.7 | ns |
| | | XC4006E | 7.5 | 6.7 | 5.7 | 4.9 | ns |
| | | XC4008E | 8.0 | 7.1 | 6.0 | 5.2 | ns |
| | | XC4010E | 8.5 | 7.3 | 6.2 | 5.4 | ns |
| | | XC4013E | 8.7 | 7.5 | 7.0 | 6.2 | ns |
| | | XC4020E | 11.0 | 8.4 | 7.1 | 6.3 | ns |
| | | XC4025E | 11.0 | 8.4 | 7.1 | – | ns |
| T going High to TBUF going inactive, not driving LL | T_OFF | All devices | 1.8 | 1.5 | 1.3 | 1.1 | ns |
| T going High to LL going from Low to High, pulled up by a single resistor. (Note 1) | T_PUS | XC4003E | 20.0 | 14.0 | 14.0 | 12.0 | ns |
| | | XC4005E | 23.0 | 16.0 | 16.0 | 14.0 | ns |
| | | XC4006E | 25.0 | 18.0 | 18.0 | 16.0 | ns |
| | | XC4008E | 27.0 | 20.0 | 20.0 | 16.0 | ns |
| | | XC4010E | 29.0 | 22.0 | 22.0 | 18.0 | ns |
| | | XC4013E | 32.0 | 26.0 | 26.0 | 21.0 | ns |
| | | XC4020E | 35.0 | 32.5 | 32.5 | 26.0 | ns |
| | | XC4025E | 42.0 | 39.1 | 39.1 | – | ns |
| T going High to LL going from Low to High, pulled up by two resistors. (Note1) | T_PUF | XC4003E | 9.0 | 7.0 | 6.0 | 5.4 | ns |
| | | XC4005E | 10.0 | 8.0 | 6.8 | 5.8 | ns |
| | | XC4006E | 11.5 | 9.0 | 7.7 | 6.5 | ns |
| | | XC4008E | 12.5 | 10.0 | 8.5 | 7.5 | ns |
| | | XC4010E | 13.5 | 11.0 | 9.4 | 8.0 | ns |
| | | XC4013E | 15.0 | 13.0 | 11.7 | 9.4 | ns |
| | | XC4020E | 16.0 | 14.8 | 14.8 | 10.5 | ns |
| | | XC4025E | 18.0 | 16.5 | 16.5 | – | ns |

**Preliminary**

Note 1:   These values include a minimum load. Use the static timing analyzer to determine the delay for each destination.

## XC4000E Wide Decoder Switching Characteristic Guidelines

Testing of switching parameters is modeled after testing methods specified by MIL-M-38510/605. All devices are 100% functionally tested. Internal timing parameters are derived from measuring internal test patterns. Listed below are representative values. For more specific, more precise, and worst-case guaranteed data, use the values reported by the static timing analyzer (TRCE in the Xilinx Development System) and back-annotated to the simulation netlist. These path delays, provided as a guideline, have been extracted from the static timing analyzer report. All timing parameters assume worst-case operating conditions (supply voltage and junction temperature). Values apply to all XC4000E devices unless otherwise noted.

The following guidelines reflect worst-case values over the recommended operating conditions.

| Description | Symbol | Device | Speed Grade -4 Max | -3 Max | -2 Max | -1 Max | Units |
|---|---|---|---|---|---|---|---|
| Full length, both pull-ups, inputs from IOB I-pins | $T_{WAF}$ | XC4003E | 9.2 | 5.0 | 5.0 | 4.3 | ns |
| | | XC4005E | 9.5 | 6.0 | 6.0 | 5.1 | ns |
| | | XC4006E | 12.0 | 7.0 | 7.0 | 6.0 | ns |
| | | XC4008E | 12.5 | 8.0 | 8.0 | 6.5 | ns |
| | | XC4010E | 15.0 | 9.0 | 9.0 | 7.5 | ns |
| | | XC4013E | 16.0 | 11.0 | 11.0 | 8.6 | ns |
| | | XC4020E | 17.0 | 13.9 | 13.9 | 10.1 | ns |
| | | XC4025E | 18.0 | 16.9 | 16.9 | – | ns |
| Full length, both pull-ups, inputs from internal logic | $T_{WAFL}$ | XC4003E | 12.0 | 7.0 | 7.0 | 5.5 | ns |
| | | XC4005E | 12.5 | 8.0 | 8.0 | 6.4 | ns |
| | | XC4006E | 14.0 | 9.0 | 9.0 | 7.0 | ns |
| | | XC4008E | 16.0 | 10.0 | 10.0 | 7.5 | ns |
| | | XC4010E | 18.0 | 11.0 | 11.0 | 8.5 | ns |
| | | XC4013E | 19.0 | 13.0 | 13.0 | 10.0 | ns |
| | | XC4020E | 20.0 | 15.5 | 15.5 | 11.8 | ns |
| | | XC4025E | 21.0 | 18.9 | 18.9 | – | ns |
| Half length, one pull-up, inputs from IOB I-pins | $T_{WAO}$ | XC4003E | 10.5 | 6.0 | 6.0 | 5.1 | ns |
| | | XC4005E | 10.5 | 7.0 | 7.0 | 6.0 | ns |
| | | XC4006E | 13.5 | 8.0 | 8.0 | 6.5 | ns |
| | | XC4008E | 14.0 | 9.0 | 9.0 | 7.0 | ns |
| | | XC4010E | 16.0 | 10.0 | 10.0 | 7.5 | ns |
| | | XC4013E | 17.0 | 12.0 | 12.0 | 10.0 | ns |
| | | XC4020E | 18.0 | 15.0 | 15.0 | 11.8 | ns |
| | | XC4025E | 19.0 | 17.6 | 17.6 | – | ns |
| Half length, one pull-up, inputs from internal logic | $T_{WAOL}$ | XC4003E | 12.0 | 8.0 | 8.0 | 6.0 | ns |
| | | XC4005E | 12.5 | 9.0 | 9.0 | 7.0 | ns |
| | | XC4006E | 14.0 | 10.0 | 10.0 | 7.6 | ns |
| | | XC4008E | 16.0 | 11.0 | 11.0 | 8.4 | ns |
| | | XC4010E | 18.0 | 12.0 | 12.0 | 9.2 | ns |
| | | XC4013E | 19.0 | 14.0 | 14.0 | 10.8 | ns |
| | | XC4020E | 20.0 | 16.8 | 16.8 | 12.6 | ns |
| | | XC4025E | 21.0 | 19.6 | 19.6 | – | ns |

**Preliminary**

Notes: These delays are specified from the decoder input to the decoder output.
Fewer than the specified number of pullup resistors can be used, if desired. Using fewer pullups reduces power consumption but increases delays. Use the static timing analyzer to determine delays if fewer pullups are used.

## XC4000E CLB Switching Characteristic Guidelines

Testing of switching parameters is modeled after testing methods specified by MIL-M-38510/605. All devices are 100% functionally tested. Internal timing parameters are derived from measuring internal test patterns. Listed below are representative values. For more specific, more precise, and worst-case guaranteed data, use the values reported by the static timing analyzer (TRCE in the Xilinx Development System) and back-annotated to the simulation netlist. These path delays, provided as a guideline, have been extracted from the static timing analyzer report. All timing parameters assume worst-case operating conditions (supply voltage and junction temperature). Values apply to all XC4000E devices unless otherwise noted.

| Speed Grade | | -4 | | -3 | | -2 | | -1 | | Units |
|---|---|---|---|---|---|---|---|---|---|---|
| Description | Symbol | Min | Max | Min | Max | Min | Max | Min | Max | |
| **Combinatorial Delays** | | | | | | | | | | |
| F/G inputs to X/Y outputs | $T_{ILO}$ | | 2.7 | | 2.0 | | 1.6 | | 1.3 | ns |
| F/G inputs via H to X/Y outputs | $T_{IHO}$ | | 4.7 | | 4.3 | | 2.7 | | 2.2 | ns |
| C inputs via SR through H to X/Y outputs | $T_{HH0O}$ | | 4.1 | | 3.3 | | 2.4 | | 1.9 | ns |
| C inputs via H to X/Y outputs | $T_{HH1O}$ | | 3.7 | | 3.6 | | 2.2 | | 1.6 | ns |
| C inputs via DIN through H to X/Y outputs | $T_{HH2O}$ | | 4.5 | | 3.6 | | 2.6 | | 1.9 | ns |
| **CLB Fast Carry Logic** | | | | | | | | | | |
| Operand inputs (F1, F2, G1, G4) to COUT | $T_{OPCY}$ | | 3.2 | | 2.6 | | 2.1 | | 1.7 | ns |
| Add/Subtract input (F3) to COUT | $T_{ASCY}$ | | 5.5 | | 4.4 | | 3.7 | | 2.5 | ns |
| Initialization inputs (F1, F3) to COUT | $T_{INCY}$ | | 1.7 | | 1.7 | | 1.4 | | 1.2 | ns |
| CIN through function generators to X/Y outputs | $T_{SUM}$ | | 3.8 | | 3.3 | | 2.6 | | 1.8 | ns |
| CIN to COUT, bypass function generators | $T_{BYP}$ | | 1.0 | | 0.7 | | 0.6 | | 0.5 | ns |
| **Sequential Delays** | | | | | | | | | | |
| Clock K to outputs Q | $T_{CKO}$ | | 3.7 | | 2.8 | | 2.8 | | 1.9 | ns |
| **Setup Time before Clock K** | | | | | | | | | | |
| F/G inputs | $T_{ICK}$ | 4.0 | | 3.0 | | 2.4 | | 1.8 | | ns |
| F/G inputs via H | $T_{IHCK}$ | 6.1 | | 4.6 | | 3.9 | | 2.8 | | ns |
| C inputs via H0 through H | $T_{HH0CK}$ | 4.5 | | 3.6 | | 3.5 | | 2.4 | | ns |
| C inputs via H1 through H | $T_{HH1CK}$ | 5.0 | | 4.1 | | 3.3 | | 2.1 | | ns |
| C inputs via H2 through H | $T_{HH2CK}$ | 4.8 | | 3.8 | | 3.7 | | 2.5 | | ns |
| C inputs via DIN | $T_{DICK}$ | 3.0 | | 2.4 | | 2.0 | | 1.0 | | ns |
| C inputs via EC | $T_{ECCK}$ | 4.0 | | 3.0 | | 2.6 | | 2.0 | | ns |
| C inputs via S/R, going Low (inactive) | $T_{RCK}$ | 4.2 | | 4.0 | | 4.0 | | 1.5 | | ns |
| $C_{IN}$ input via F/G | $T_{CCK}$ | 2.5 | | 2.1 | | | | | | ns |
| $C_{IN}$ input via F/G and H | $T_{CHCK}$ | 4.2 | | 3.5 | | | | | | ns |

**Preliminary**

## XC4000E CLB Switching Characteristic Guidelines (continued)

Testing of the switching parameters is modeled after testing methods specified by MIL-M-38510/605. All devices are 100% functionally tested. Internal timing parameters are not measured directly. They are derived from benchmark timing patterns that are taken at device introduction, prior to any process improvements. For more detailed, more precise, and more up-to-date information, use the values provided by the XACT timing calculator and used in the simulator. These values can be printed in tabular format by running LCA2XNF -S.

The following guidelines reflect worst-case values over the recommended operating conditions. They are expressed in units of nanoseconds and apply to all XC4000E devices unless otherwise noted.

| Speed Grade | | -4 | | -3 | | -2 | | -1 | | Units |
|---|---|---|---|---|---|---|---|---|---|---|
| Description | Symbol | Min | Max | Min | Max | Min | Max | Min | Max | |
| **Hold Time after Clock K** | | | | | | | | | | |
| F/G inputs | $T_{CKI}$ | 0 | | 0 | | 0 | | 0 | | ns |
| F/G inputs via H | $T_{CKIH}$ | 0 | | 0 | | 0 | | 0 | | ns |
| C inputs via H0 through H | $T_{CKHH0}$ | 0 | | 0 | | 0 | | 0 | | ns |
| C inputs via H1 through H | $T_{CKHH1}$ | 0 | | 0 | | 0 | | 0 | | ns |
| C inputs via H2 through H | $T_{CKHH2}$ | 0 | | 0 | | 0 | | 0 | | ns |
| C inputs via DIN | $T_{CKDI}$ | 0 | | 0 | | 0 | | 0 | | ns |
| C inputs via EC | $T_{CKEC}$ | 0 | | 0 | | 0 | | 0 | | ns |
| C inputs via SR, going Low (inactive) | $T_{CKR}$ | 0 | | 0 | | 0 | | 0 | | ns |
| **Clock** | | | | | | | | | | |
| Clock High time | $T_{CH}$ | 4.5 | | 4.0 | | 4.0 | | 3.0 | | ns |
| Clock Low time | $T_{CL}$ | 4.5 | | 4.0 | | 4.0 | | 3.0 | | ns |
| **Set/Reset Direct** | | | | | | | | | | |
| Width (High) | $T_{RPW}$ | 5.5 | | 4.0 | | 4.0 | | 3.0 | | ns |
| Delay from C inputs via S/R, going High to Q | $T_{RIO}$ | | 6.5 | | 4.0 | | 4.0 | | 3.0 | ns |
| **Master Set/Reset (Note 1)** | | | | | | | | | | |
| Width (High or Low) | $T_{MRW}$ | 13.0 | | 11.5 | | 11.5 | | 10.0 | | ns |
| Delay from Global Set/Reset net to Q | $T_{MRQ}$ | | 23.0 | | 18.7 | | 17.4 | | 15.0 | ns |
| Global Set/Reset inactive to first active clock K edge | $T_{MRK}$ | | | | | | | | | |
| Toggle Frequency (Note 2) | $F_{TOG}$ | | 111 | | 125 | | 125 | | 166 | MHz |

**Preliminary**

Note 1:    Timing is based on the XC4005E. For other devices see the XACT timing calculator.
Note 2:    Export Control Max. flip-flop toggle rate.

# XC4000E CLB Edge-Triggered (Synchronous) RAM Switching Characteristic Guidelines

Testing of switching parameters is modeled after testing methods specified by MIL-M-38510/605. All devices are 100% functionally tested. Internal timing parameters are derived from measuring internal test patterns. Listed below are representative values. For more specific, more precise, and worst-case guaranteed data, use the values reported by the static timing analyzer (TRCE in the Xilinx Development System) and back-annotated to the simulation netlist. All timing parameters assume worst-case operating conditions (supply voltage and junction temperature). Values apply to all XC4000E devices unless otherwise noted.

| Single Port RAM | Speed Grade | | -4 | | -3 | | -2 | | -1 | | Units |
|---|---|---|---|---|---|---|---|---|---|---|---|
| | Size | Symbol | Min | Max | Min | Max | Min | Max | Min | Max | |
| **Write Operation** | | | | | | | | | | | |
| Address write cycle time (clock K period) | 16x2 | T$_{WCS}$ | 15.0 | | 14.4 | | 11.6 | | 8.0 | | ns |
| | 32x1 | T$_{WCTS}$ | 15.0 | | 14.4 | | 11.6 | | 8.0 | | ns |
| Clock K pulse width (active edge) | 16x2 | T$_{WPS}$ | 7.5 | 1 ms | 7.2 | 1 ms | 5.8 | 1 ms | 4.0 | | ns |
| | 32x1 | T$_{WPTS}$ | 7.5 | 1 ms | 7.2 | 1 ms | 5.8 | 1 ms | 4.0 | | ns |
| Address setup time before clock K | 16x2 | T$_{ASS}$ | 2.8 | | 2.4 | | 2.0 | | 1.5 | | ns |
| | 32x1 | T$_{ASTS}$ | 2.8 | | 2.4 | | 2.0 | | 1.5 | | ns |
| Address hold time after clock K | 16x2 | T$_{AHS}$ | 0 | | 0 | | 0 | | 0 | | ns |
| | 32x1 | T$_{AHTS}$ | 0 | | 0 | | 0 | | 0 | | ns |
| DIN setup time before clock K | 16x2 | T$_{DSS}$ | 3.5 | | 3.2 | | 2.7 | | 1.5 | | ns |
| | 32x1 | T$_{DSTS}$ | 2.5 | | 1.9 | | 1.7 | | 1.5 | | ns |
| DIN hold time after clock K | 16x2 | T$_{DHS}$ | 0 | | 0 | | 0 | | 0 | | ns |
| | 32x1 | T$_{DHTS}$ | 0 | | 0 | | 0 | | 0 | | ns |
| WE setup time before clock K | 16x2 | T$_{WSS}$ | 2.2 | | 2.0 | | 1.6 | | 1.5 | | ns |
| | 32x1 | T$_{WSTS}$ | 2.2 | | 2.0 | | 1.6 | | 1.5 | | ns |
| WE hold time after clock K | 16x2 | T$_{WHS}$ | 0 | | 0 | | 0 | | 0 | | ns |
| | 32x1 | T$_{WHTS}$ | 0 | | 0 | | 0 | | 0 | | ns |
| Data valid after clock K | 16x2 | T$_{WOS}$ | | 10.3 | | 8.8 | | 7.9 | | 6.5 | ns |
| | 32x1 | T$_{WOTS}$ | | 11.6 | | 10.3 | | 9.3 | | 7.0 | ns |

**Preliminary**

Notes: Timing for the 16x1 RAM option is identical to 16x2 RAM timing.
Applicable Read timing specifications are identical to Level-Sensitive Read timing.

| Dual-Port RAM | Speed Grade | | -4 | | -3 | | -2 | | -1 | | Units |
|---|---|---|---|---|---|---|---|---|---|---|---|
| | Size | Symbol | Min | Max | Min | Max | Min | Max | Min | Max | |
| **Write Operation** | | | | | | | | | | | |
| Address write cycle time (clock K period) | 16x1 | T$_{WCDS}$ | 15.0 | | 9.0 | | 11.6 | | 8.0 | | ns |
| Clock K pulse width (active edge) | 16x1 | T$_{WPDS}$ | | 1 ms | 4.5 | 1 ms | 5.8 | 1 ms | 4.0 | | ns |
| Address setup time before clock K | 16x1 | T$_{ASDS}$ | 7.5 | | 2.5 | | 2.1 | | 1.5 | | ns |
| Address hold time after clock K | 16x1 | T$_{AHDS}$ | 2.8 | | 0 | | 0 | | 0 | | ns |
| DIN setup time before clock K | 16x1 | T$_{DSDS}$ | 0 | | 2.5 | | 1.6 | | 1.5 | | ns |
| DIN hold time after clock K | 16x1 | T$_{DHDS}$ | 2.2 | | 0 | | 0 | | 0 | | ns |
| WE setup time before clock K | 16x1 | T$_{WSDS}$ | 0 | | 1.8 | | 1.6 | | 1.5 | | ns |
| WE hold time after clock K | 16x1 | T$_{WHDS}$ | 2.2 | | 0 | | 0 | | 0 | | ns |
| Data valid after clock K | 16x1 | T$_{WODS}$ | 0.3 | 10.0 | | 7.8 | | 7.0 | | 6.5 | ns |

**Preliminary**

Note:    Applicable Read timing specifications are identical to Level-Sensitive Read timing.

## XC4000E CLB RAM Synchronous (Edge-Triggered) Write Timing



X6461
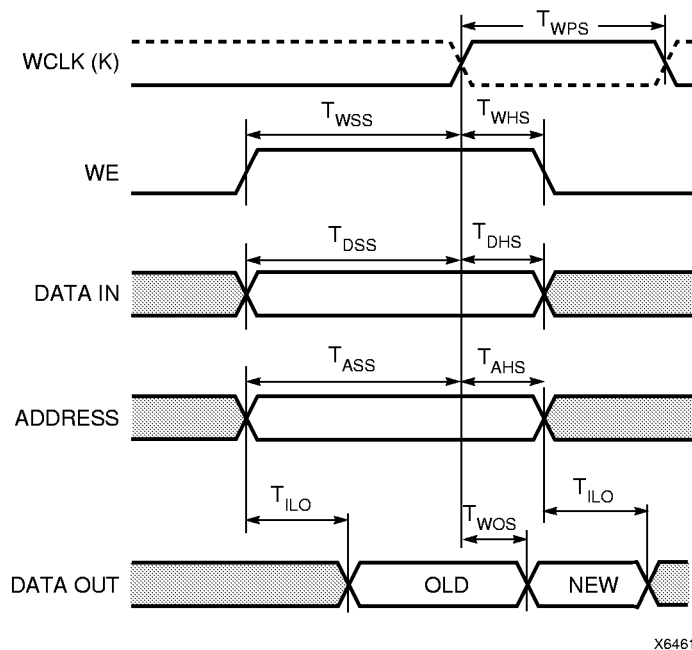
## XC4000E CLB Dual-Port RAM Synchronous (Edge-Triggered) Write Timing



X6474
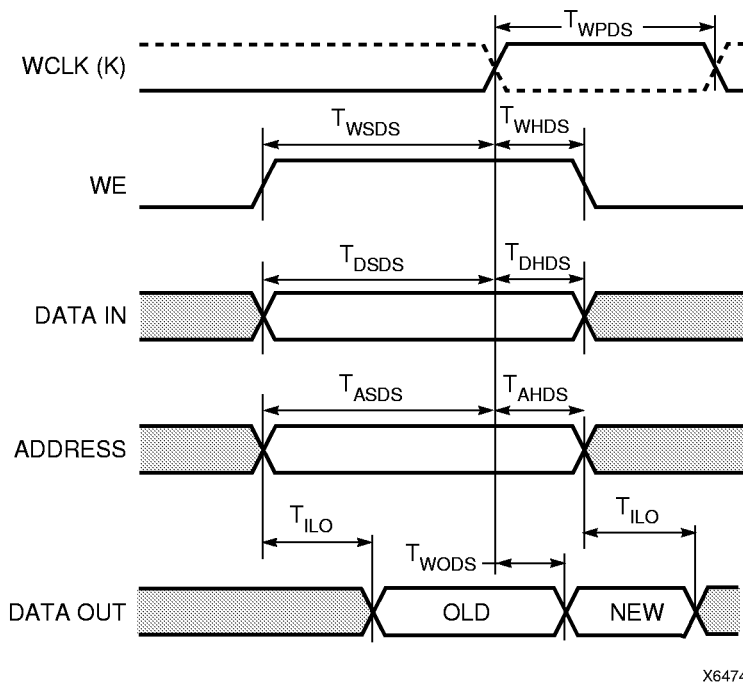
## XC4000E CLB Level-Sensitive RAM Switching Characteristic Guidelines

Testing of switching parameters is modeled after testing methods specified by MIL-M-38510/605. All devices are 100% functionally tested. Internal timing parameters are derived from measuring internal test patterns. Listed below are representative values. For more specific, more precise, and worst-case guaranteed data, use the values reported by the static timing analyzer (TRCE in the Xilinx Development System) and back-annotated to the simulation netlist. All timing parameters assume worst-case operating conditions (supply voltage and junction temperature). Values apply to all XC4000E devices unless otherwise noted.

| Description | Size | Symbol | Speed Grade -4 Min | -4 Max | -3 Min | -3 Max | -2 Min | -2 Max | -1 Min | -1 Max | Units |
|---|---|---|---|---|---|---|---|---|---|---|---|
| **Write Operation** | | | | | | | | | | | |
| Address write cycle time | 16x2 | $T_{WC}$ | 8.0 | | 8.0 | | 8.0 | | 8.0 | | ns |
| | 32x1 | $T_{WCT}$ | 8.0 | | 8.0 | | 8.0 | | 8.0 | | ns |
| Write Enable pulse width (High) | 16x2 | $T_{WP}$ | 4.0 | | 4.0 | | 4.0 | | 4.0 | | ns |
| | 32x1 | $T_{WPT}$ | 4.0 | | 4.0 | | 4.0 | | 4.0 | | ns |
| Address setup time before WE | 16x2 | $T_{AS}$ | 2.0 | | 2.0 | | 2.0 | | 2.0 | | ns |
| | 32x1 | $T_{AST}$ | 2.0 | | 2.0 | | 2.0 | | 2.0 | | ns |
| Address hold time after end of WE | 16x2 | $T_{AH}$ | 2.5 | | 2.0 | | 2.0 | | 2.0 | | ns |
| | 32x1 | $T_{AHT}$ | 2.0 | | 2.0 | | 2.0 | | 2.0 | | ns |
| DIN setup time before end of WE | 16x2 | $T_{DS}$ | 4.0 | | 2.2 | | 0.8 | | 0.8 | | ns |
| | 32x1 | $T_{DST}$ | 5.0 | | 2.2 | | 0.8 | | 0.8 | | ns |
| DIN hold time after end of WE | 16x2 | $T_{DH}$ | 2.0 | | 2.0 | | 2.0 | | 2.0 | | ns |
| | 32x1 | $T_{DHT}$ | 2.0 | | 2.0 | | 2.0 | | 2.0 | | ns |
| **Read Operation** | | | | | | | | | | | |
| Address read cycle time | 16x2 | $T_{RC}$ | 4.5 | | 3.1 | | 2.6 | | 2.6 | | ns |
| | 32x1 | $T_{RCT}$ | 6.5 | | 5.5 | | 3.8 | | 3.8 | | ns |
| Data valid after address change (no Write Enable) | 16x2 | $T_{ILO}$ | | 2.7 | | 1.8 | | 1.6 | | 1.6 | ns |
| | 32x1 | $T_{IHO}$ | | 4.7 | | 3.2 | | 2.7 | | 2.7 | ns |
| **Read Operation, Clocking Data into Flip-Flop** | | | | | | | | | | | |
| Address setup time before clock K | 16x2 | $T_{ICK}$ | 4.0 | | 3.0 | | 2.4 | | 2.4 | | ns |
| | 32x1 | $T_{IHCK}$ | 6.1 | | 4.6 | | 3.9 | | 3.9 | | ns |
| **Read During Write** | | | | | | | | | | | |
| Data valid after WE goes active (DIN stable before WE) | 16x2 | $T_{WO}$ | | 10.0 | | 6.0 | | 4.9 | | 4.9 | ns |
| | 32x1 | $T_{WOT}$ | | 12.0 | | 7.3 | | 5.6 | | 5.6 | ns |
| Data valid after DIN (DIN changes during WE) | 16x2 | $T_{DO}$ | | 9.0 | | 6.6 | | 5.8 | | 5.8 | ns |
| | 32x1 | $T_{DOT}$ | | 11.0 | | 7.6 | | 6.2 | | 6.2 | ns |
| **Read During Write, Clocking Data into Flip-Flop** | | | | | | | | | | | |
| WE setup time before clock K | 16x2 | $T_{WCK}$ | 8.0 | | 6.0 | | 5.1 | | 5.1 | | ns |
| | 32x1 | $T_{WCKT}$ | 9.6 | | 6.8 | | 5.8 | | 5.8 | | ns |
| Data setup time before clock K | 16x2 | $T_{DCK}$ | 7.0 | | 5.2 | | 4.4 | | 4.4 | | ns |
| | 32x1 | $T_{DCKT}$ | 8.0 | | 6.2 | | 5.3 | | 5.3 | | ns |
| | | | | | | | | | **Preliminary** | | |

Note:    Timing for the 16x1 RAM option is identical to 16x2 RAM timing.

## XC4000E CLB Level-Sensitive RAM Timing Characteristics



ADDRESS

$T_{WC}$

**WRITE**

WRITE ENABLE

$T_{AS}$  $T_{WP}$  $T_{AH}$

$T_{DS}$  $T_{DH}$

DATA IN — REQUIRED

**READ WITHOUT WRITE**

X,Y OUTPUTS — VALID — $T_{ILO}$ — VALID

**READ, CLOCKING DATA INTO FLIP-FLOP**

CLOCK — $T_{ICK}$ — $T_{CH}$

XQ, YQ OUTPUTS — VALID (OLD) — $T_{CKO}$ — VALID (NEW)

**READ DURING WRITE**

WRITE ENABLE — $T_{WP}$

DATA IN (stable during WE) — $T_{DH}$

X, Y OUTPUTS — VALID — $T_{WO}$ — VALID

DATA IN (changing during WE) — OLD — NEW

X, Y OUTPUTS — VALID (PREVIOUS) — $T_{WO}$ — VALID (OLD) — $T_{DO}$ — VALID (NEW)

**READ DURING WRITE, CLOCKING DATA INTO FLIP-FLOP**

WRITE ENABLE — $T_{WP}$

$T_{WCK}$

DATA IN — $T_{DCK}$

CLOCK

XQ, YQ OUTPUTS — $T_{CKO}$

X2640

## XC4000E Guaranteed Input and Output Parameters (Pin-to-Pin, TTL I/O)

Testing of switching parameters is modeled after testing methods specified by MIL-M-38510/605. All devices are 100% functionally tested. Pin-to-pin timing parameters are derived from measuring external and internal test patterns and are guaranteed over worst-case operating conditions (supply voltage and junction temperature). Listed below are representative values for typical pin locations and normal clock loading. For more specific, more precise, and worst-case guaranteed data, reflecting the actual routing structure, use the values provided by the static timing analyzer (TRCE in the Xilinx Development System) and back-annotated to the simulation netlist. These path delays, provided as a guideline, have been extracted from the static timing analyzer report. Values apply to all XC4000E devices unless otherwise noted.

| Description | Speed Grade Symbol | Device | -4 | -3 | -2 | -1 | Units |
|---|---|---|---|---|---|---|---|
| Global Clock to Output (fast) using OFF (Max) | $T_{ICKOF}$ | XC4003E | 12.5 | 10.2 | 8.7 | 5.8 | ns |
| | | XC4005E | 14.0 | 10.7 | 9.1 | 6.2 | ns |
| | | XC4006E | 14.5 | 10.7 | 9.1 | 6.4 | ns |
| | | XC4008E | 15.0 | 10.8 | 9.2 | 6.6 | ns |
| | | XC4010E | 16.0 | 10.9 | 9.3 | 6.8 | ns |
| | | XC4013E | 16.5 | 11.0 | 9.4 | 7.2 | ns |
| | | XC4020E | 17.0 | 11.0 | 10.2 | 7.4 | ns |
| | | XC4025E | 17.0 | 12.6 | 10.8 | – | ns |
| Global Clock to Output (slew-limited) using OFF (Max) | $T_{ICKO}$ | XC4003E | 16.5 | 14.0 | 11.5 | 7.8 | ns |
| | | XC4005E | 18.0 | 14.7 | 12.0 | 8.2 | ns |
| | | XC4006E | 18.5 | 14.7 | 12.0 | 8.4 | ns |
| | | XC4008E | 19.0 | 14.8 | 12.1 | 8.6 | ns |
| | | XC4010E | 20.0 | 14.9 | 12.2 | 8.8 | ns |
| | | XC4013E | 20.5 | 15.0 | 12.8 | 9.2 | ns |
| | | XC4020E | 21.0 | 15.1 | 12.8 | 9.4 | ns |
| | | XC4025E | 21.0 | 15.3 | 13.0 | – | ns |
| Input Setup Time, using IFF (no delay) (Min) | $T_{PSUF}$ | XC4003E | 2.5 | 2.3 | 2.3 | 1.5 | ns |
| | | XC4005E | 2.0 | 1.2 | 1.2 | 0.8 | ns |
| | | XC4006E | 1.9 | 1.0 | 1.0 | 0.6 | ns |
| | | XC4008E | 1.4 | 0.6 | 0.6 | 0.2 | ns |
| | | XC4010E | 1.0 | 0.2 | 0.2 | 0 | ns |
| | | XC4013E | 0.5 | 0 | 0 | 0 | ns |
| | | XC4020E | 0 | 0 | 0 | 0 | ns |
| | | XC4025E | 0 | 0 | 0 | – | ns |
| Input Hold Time, using IFF (no delay) (Min) | $T_{PHF}$ | XC4003E | 4.0 | 4.0 | 4.0 | 1.5 | ns |
| | | XC4005E | 4.6 | 4.5 | 4.5 | 2.0 | ns |
| | | XC4006E | 5.0 | 4.7 | 4.7 | 2.0 | ns |
| | | XC4008E | 6.0 | 5.1 | 5.1 | 2.5 | ns |
| | | XC4010E | 6.0 | 5.5 | 5.5 | 2.5 | ns |
| | | XC4013E | 7.0 | 6.5 | 5.5 | 3.0 | ns |
| | | XC4020E | 7.5 | 6.7 | 5.7 | 3.5 | ns |
| | | XC4025E | 8.0 | 7.0 | 5.9 | – | ns |
| Input Setup Time, using IFF (with delay) (Min) | $T_{PSU}$ | XC4003E | 8.5 | 7.0 | 6.0 | 5.0 | ns |
| | | XC4005E | 8.5 | 7.0 | 6.0 | 5.0 | ns |
| | | XC4006E | 8.5 | 7.0 | 6.0 | 5.0 | ns |
| | | XC4008E | 8.5 | 7.0 | 6.0 | 5.0 | ns |
| | | XC4010E | 8.5 | 7.0 | 6.0 | 5.0 | ns |
| | | XC4013E | 8.5 | 7.0 | 6.0 | 5.0 | ns |
| | | XC4020E | 9.5 | 7.0 | 6.8 | 5.0 | ns |
| | | XC4025E | 9.5 | 7.6 | 6.8 | – | ns |
| Input Hold Time, using IFF (with delay) (Min) | $T_{PH}$ | XC4003E | 0 | 0 | 0 | 0 | ns |
| | | XC4005E | 0 | 0 | 0 | 0 | ns |
| | | XC4006E | 0 | 0 | 0 | 0 | ns |
| | | XC4008E | 0 | 0 | 0 | 0 | ns |
| | | XC4010E | 0 | 0 | 0 | 0 | ns |
| | | XC4013E | 0 | 0 | 0 | 0 | ns |
| | | XC4020E | 0 | 0 | 0 | 0 | ns |
| | | XC4025E | 0 | 0 | 0 | – | ns |

OFF = Output Flip-Flop     IFF = Input Flip-Flop or Latch

**Preliminary**

## XC4000E IOB Input Switching Characteristic Guidelines

Testing of switching parameters is modeled after testing methods specified by MIL-M-38510/605. All devices are 100% functionally tested. Pin-to-pin timing parameters are derived from measuring external and internal test patterns and are guaranteed over worst-case operating conditions (supply voltage and junction temperature). Listed below are representative values for typical pin locations and normal clock loading. For more specific, more precise, and worst-case guaranteed data, reflecting the actual routing structure, use the values provided by the static timing analyzer (TRCE in the Xilinx Development System) and back-annotated to the simulation netlist. These path delays, provided as a guideline, have been extracted from the static timing analyzer report. Values apply to all XC4000E devices unless otherwise noted.

| | Speed Grade | | -4 | | -3 | | -2 | | -1 | | Units |
|---|---|---|---|---|---|---|---|---|---|---|---|
| **Description** | **Symbol** | **Device** | **Min** | **Max** | **Min** | **Max** | **Min** | **Max** | **Min** | **Max** | |
| **Propagation Delays (TTL Inputs)** | | | | | | | | | | | |
| Pad to I1, I2 Pad to I1, I2 via transparent latch, no delay | $T_{PID}$ | All devices | | 3.0 | | 2.5 | | 2.0 | | 1.4 | ns |
| with delay | $T_{PLI}$ | All devices | | 4.8 | | 3.6 | | 3.6 | | 2.8 | ns |
| | $T_{PDLI}$ | XC4003E | | 10.4 | | 9.3 | | 6.9 | | 6.4 | ns |
| | | XC4005E | | 10.8 | | 9.6 | | 7.4 | | 6.5 | ns |
| | | XC4006E | | 10.8 | | 10.2 | | 8.1 | | 6.9 | ns |
| | | XC4008E | | 10.8 | | 10.6 | | 8.2 | | 7.0 | ns |
| | | XC4010E | | 11.0 | | 10.8 | | 8.3 | | 7.3 | ns |
| | | XC4013E | | 11.4 | | 11.2 | | 9.8 | | 8.4 | ns |
| | | XC4020E | | 13.8 | | 12.4 | | 11.5 | | 9.0 | ns |
| | | XC4025E | | 13.8 | | 13.7 | | 12.4 | | – | ns |
| **Propagation Delays (CMOS Inputs)** | | | | | | | | | | | |
| Pad to I1, I2 Pad to I1, I2 via transparent | $T_{PIDC}$ | All devices | | 5.5 | | 4.1 | | 3.7 | | 1.9 | ns |
| latch, no delay | $T_{PLIC}$ | All devices | | 8.8 | | 6.8 | | 6.2 | | 3.3 | ns |
| with delay | $T_{PDLIC}$ | XC4003E | | 16.5 | | 12.4 | | 11.0 | | 6.9 | ns |
| | | XC4005E | | 16.5 | | 13.2 | | 11.9 | | 7.0 | ns |
| | | XC4006E | | 16.8 | | 13.4 | | 12.1 | | 7.4 | ns |
| | | XC4008E | | 17.3 | | 13.8 | | 12.4 | | 7.4 | ns |
| | | XC4010E | | 17.5 | | 14.0 | | 12.6 | | 7.8 | ns |
| | | XC4013E | | 18.0 | | 14.4 | | 13.0 | | 9.0 | ns |
| | | XC4020E | | 20.8 | | 15.6 | | 14.0 | | 9.5 | ns |
| | | XC4025E | | 20.8 | | 15.6 | | 14.0 | | – | ns |
| **Propagation Delays** | | | | | | | | | | | |
| Clock (IK) to I1, I2 (flip-flop) | $T_{IKRI}$ | All devices | | 5.6 | | 2.8 | | 2.8 | | 2.7 | ns |
| Clock (IK) to I1, I2 (latch enable, active Low) | $T_{IKLI}$ | All devices | | 6.2 | | 4.0 | | 3.9 | | 3.2 | ns |
| **Hold Times (Note 1)** | | | | | | | | | | | |
| Pad to Clock (IK), no delay | $T_{IKPI}$ | All devices | 0 | | 0 | | 0 | | 0 | | ns |
| with delay | $T_{IKPID}$ | All devices | 0 | | 0 | | 0 | | 0 | | ns |
| Clock Enable (EC) to Clock (IK), no delay | $T_{IKEC}$ | All devices | 1.5 | | 1.5 | | 0.9 | | 0 | | ns |
| with delay | $T_{IKECD}$ | All devices | 0 | | 0 | | 0 | | 0 | | ns |

**Preliminary**

Note 1: Input pad setup and hold times are specified with respect to the internal clock (IK). For setup and hold times with respect to the clock input pin, see the pin-to-pin parameters in the Guaranteed Input and Output Parameters table.

Note 2: Voltage levels of unused pads, bonded or unbonded, must be valid logic levels. Each can be configured with the internal pull-up (default) or pull-down resistor, or configured as a driven output, or can be driven from an external source.

## XC4000E IOB Input Switching Characteristic Guidelines (continued)

Testing of switching parameters is modeled after testing methods specified by MIL-M-38510/605. All devices are 100% functionally tested. Internal timing parameters are derived from measuring internal test patterns. Listed below are representative values. For more specific, more precise, and worst-case guaranteed data, use the values reported by the static timing analyzer (TRCE in the Xilinx Development System) and back-annotated to the simulation netlist. These path delays, provided as a guideline, have been extracted from the static timing analyzer report. All timing parameters assume worst-case operating conditions (supply voltage and junction temperature). Values apply to all XC4000E devices unless otherwise noted.

| Speed Grade | | | -4 | | -3 | | -2 | | -1 | | Units |
|---|---|---|---|---|---|---|---|---|---|---|---|
| Description | Symbol | Device | Min | Max | Min | Max | Min | Max | Min | Max | |
| **Setup Times (TTL Inputs)** | | | | | | | | | | | |
| Pad to Clock (IK),   no delay | $T_{PICK}$ | All devices | 4.0 | | 2.6 | | 2.0 | | 1.5 | | ns |
| with delay | $T_{PICKD}$ | XC4003E | 10.9 | | 8.2 | | 6.0 | | 4.8 | | ns |
| | | XC4005E | 10.9 | | 8.7 | | 6.1 | | 5.1 | | ns |
| | | XC4006E | 10.9 | | 9.2 | | 6.2 | | 5.8 | | ns |
| | | XC4008E | 11.1 | | 9.6 | | 6.3 | | 5.8 | | ns |
| | | XC4010E | 11.3 | | 9.8 | | 6.4 | | 6.0 | | ns |
| | | XC4013E | 11.8 | | 10.2 | | 7.9 | | 7.6 | | ns |
| | | XC4020E | 14.0 | | 11.4 | | 9.4 | | 8.2 | | ns |
| | | XC4025E | 14.0 | | 11.4 | | 10.0 | | – | | ns |
| **Setup Time (CMOS Inputs)** | | | | | | | | | | | |
| Pad to Clock (IK),   no delay | $T_{PICKC}$ | All devices | 6.0 | | 3.3 | | 2.4 | | 2.4 | | ns |
| with delay | $T_{PICKDC}$ | XC4003E | 12.0 | | 8.8 | | 6.9 | | 5.3 | | ns |
| | | XC4005E | 12.0 | | 9.7 | | 8.0 | | 5.6 | | ns |
| | | XC4006E | 12.3 | | 9.9 | | 8.1 | | 6.3 | | ns |
| | | XC4008E | 12.8 | | 10.3 | | 8.2 | | 6.3 | | ns |
| | | XC4010E | 13.0 | | 10.5 | | 8.3 | | 6.5 | | ns |
| | | XC4013E | 13.5 | | 10.9 | | 10.0 | | 7.9 | | ns |
| | | XC4020E | 16.0 | | 12.1 | | 12.1 | | 8.1 | | ns |
| | | XC4025E | 16.0 | | 12.1 | | 12.1 | | – | | ns |
| **(TTL or CMOS)** | | | | | | | | | | | |
| Clock Enable (EC) to Clock (IK), no delay | $T_{ECIK}$ | All devices | 3.5 | | 2.5 | | 2.1 | | 1.5 | | ns |
| with delay | $T_{ECIKD}$ | XC4003E | 10.4 | | 8.1 | | 4.3 | | 4.3 | | ns |
| | | XC4005E | 10.4 | | 8.5 | | 5.6 | | 5.0 | | ns |
| | | XC4006E | 10.4 | | 9.1 | | 6.7 | | 6.0 | | ns |
| | | XC4008E | 10.4 | | 9.5 | | 6.9 | | 6.0 | | ns |
| | | XC4010E | 10.7 | | 9.7 | | 7.1 | | 6.5 | | ns |
| | | XC4013E | 11.1 | | 10.1 | | 9.0 | | 8.0 | | ns |
| | | XC4020E | 14.0 | | 11.3 | | 10.6 | | 9.0 | | ns |
| | | XC4025E | 14.0 | | 11.3 | | 11.0 | | – | | ns |
| **Global Set/Reset (Note 3)** | | | | | | | | | | | |
| Delay from GSR net through Q to I1, I2 | $T_{RRI}$ | | | 12.0 | | 7.8 | | 6.8 | | 6.8 | ns |
| GSR width | $T_{MRW}$ | | 13.0 | | 11.5 | | 11.5 | | 10.0 | | ns |
| GSR inactive to first active Clock (IK) edge | $T_{MRI}$ | | | | | | | | | | |

**Preliminary**

Note 1:    Input pad setup and hold times are specified with respect to the internal clock (IK). For setup and hold times with respect to the clock input pin, see the pin-to-pin parameters in the Guaranteed Input and Output Parameters table.

Note 2:    Voltage levels of unused pads, bonded or unbonded, must be valid logic levels. Each can be configured with the internal pull-up (default) or pull-down resistor, or configured as a driven output, or can be driven from an external source.

Note 3:    Timing is based on the XC4005E. For other devices see the XACT timing calculator.

## XC4000E IOB Output Switching Characteristic Guidelines

Testing of switching parameters is modeled after testing methods specified by MIL-M-38510/605. All devices are 100% functionally tested. Internal timing parameters are derived from measuring internal test patterns. Listed below are representative values. For more specific, more precise, and worst-case guaranteed data, use the values reported by the static timing analyzer (TRCE in the Xilinx Development System) and back-annotated to the simulation netlist. These path delays, provided as a guideline, have been extracted from the static timing analyzer report. All timing parameters assume worst-case operating conditions (supply voltage and junction temperature). Values apply to all XC4000E devices unless otherwise noted.

| Speed Grade | | -4 | | -3 | | -2 | | -1 | | Units |
|---|---|---|---|---|---|---|---|---|---|---|
| Description | Symbol | Min | Max | Min | Max | Min | Max | Min | Max | |
| **Propagation Delays (TTL Output Levels)** | | | | | | | | | | |
| Clock (OK) to Pad, fast | $T_{OKPOF}$ | | 7.5 | | 6.5 | | 4.5 | | 3.0 | ns |
| slew-rate limited | $T_{OKPOS}$ | | 11.5 | | 9.5 | | 7.0 | | 5.0 | ns |
| Output (O) to Pad, fast | $T_{OPF}$ | | 8.0 | | 5.5 | | 4.8 | | 3.2 | ns |
| slew-rate limited | $T_{OPS}$ | | 12.0 | | 8.5 | | 7.3 | | 5.2 | ns |
| 3-state to Pad hi-Z (slew-rate independent) | $T_{TSHZ}$ | | 5.0 | | 4.2 | | 3.8 | | 3.0 | ns |
| 3-state to Pad active and valid, fast | $T_{TSONF}$ | | 9.7 | | 8.1 | | 7.3 | | 6.8 | ns |
| slew-rate limited | $T_{TSONS}$ | | 13.7 | | 11.1 | | 9.8 | | 8.8 | ns |
| **Propagation Delays (CMOS Output Levels)** | | | | | | | | | | |
| Clock (OK) to Pad, fast | $T_{OKPOFC}$ | | 9.5 | | 7.8 | | 7.0 | | 4.0 | ns |
| slew-rate limited | $T_{OKPOSC}$ | | 13.5 | | 11.6 | | 10.4 | | 7.0 | ns |
| Output (O) to Pad, fast | $T_{OPFC}$ | | 10.0 | | 9.7 | | 8.7 | | 4.0 | ns |
| slew-rate limited | $T_{OPSC}$ | | 14.0 | | 13.4 | | 12.1 | | 6.0 | ns |
| 3-state to Pad hi-Z (slew-rate independent) | $T_{TSHZC}$ | | 5.2 | | 4.3 | | 3.9 | | 3.9 | ns |
| 3-state to Pad active and valid, fast | $T_{TSONFC}$ | | 9.1 | | 7.6 | | 6.8 | | 6.8 | ns |
| slew-rate limited | $T_{TSONSC}$ | | 13.1 | | 11.4 | | 10.2 | | 8.8 | ns |

**Preliminary**

Note 1: Output timing is measured at pin threshold, with 50pF external capacitive loads (incl. test fixture). Slew-rate limited output rise/fall times are approximately two times longer than fast output rise/fall times. For the effect of capacitive loads on ground bounce, see the "Additional XC4000 Data" section of the Programmable Logic Data Book.

Note 2: Voltage levels of unused pads, bonded or unbonded, must be valid logic levels. Each can be configured with the internal pull-up (default) or pull-down resistor, or configured as a driven output, or can be driven from an external source.

# XC4000E IOB Output Switching Characteristic Guidelines (continued)

Testing of switching parameters is modeled after testing methods specified by MIL-M-38510/605. All devices are 100% functionally tested. Internal timing parameters are derived from measuring internal test patterns. Listed below are representative values. For more specific, more precise, and worst-case guaranteed data, use the values reported by the static timing analyzer (TRCE in the Xilinx Development System) and back-annotated to the simulation netlist. These path delays, provided as a guideline, have been extracted from the static timing analyzer report. All timing parameters assume worst-case operating conditions (supply voltage and junction temperature). For Propagation Delays, slew-rate = fast unless otherwise noted. Values apply to all XC4000E devices unless otherwise noted.

| Speed Grade | | -4 | | -3 | | -2 | | -1 | | Units |
| Description | Symbol | Min | Max | Min | Max | Min | Max | Min | Max | |
|---|---|---|---|---|---|---|---|---|---|---|
| **Setup and Hold** | | | | | | | | | | |
| Output (O) to clock (OK) setup time | $T_{OOK}$ | 5.0 | | 4.6 | | 3.8 | | 2.3 | | ns |
| Output (O) to clock (OK) hold time | $T_{OKO}$ | 0 | | 0 | | 0 | | 0 | | ns |
| Clock Enable (EC) to clock (OK) setup | $T_{ECOK}$ | 4.8 | | 3.5 | | 2.7 | | 2.0 | | ns |
| Clock Enable (EC) to clock (OK) hold | $T_{OKEC}$ | 1.2 | | 1.2 | | 0.5 | | 0 | | ns |
| **Clock** | | | | | | | | | | |
| Clock High | $T_{CH}$ | 4.5 | | 4.0 | | 4.0 | | | 3.0 | ns |
| Clock Low | $T_{CL}$ | 4.5 | | 4.0 | | 4.0 | | | 3.0 | ns |
| **Global Set/Reset (Note 3)** | | | | | | | | | | |
| Delay from GSR net to Pad | $T_{RPO}$ | | 15.0 | | 11.8 | | 8.7 | | 7.0 | ns |
| GSR width | $T_{MRW}$ | 13.0 | | 11.5 | | 11.5 | | | | ns |
| GSR inactive to first active clock (OK) edge | $T_{MRO}$ | | | | | | | | | |

**Preliminary**

Note 1:   Output timing is measured at pin threshold, with 50pF external capacitive loads (incl. test fixture). Slew-rate limited output rise/fall times are approximately two times longer than fast output rise/fall times. For the effect of capacitive loads on ground bounce, see the "Additional XC4000 Data" section of the Programmable Logic Data Book.

Note 2:   Voltage levels of unused pads, bonded or unbonded, must be valid logic levels. Each can be configured with the internal pull-up (default) or pull-down resistor, or configured as a driven output, or can be driven from an external source.

Note 3:   Timing is based on the XC4005E. For other devices see the XACT timing calculator.

# Device-Specific Pinout Tables

Device-specific tables include all packages for each XC4000 and XC4000X Series device. They follow the pad locations around the die, and include boundary scan register locations..

## Pin Locations for XC4003E Devices

| XC4003E Pad Name | PC84 | PQ100 | VQ100 | PG120 | Bndry Scan |
|---|---|---|---|---|---|
| VCC | P2 | P92 | P89 | G3 | - |
| I/O (A8) | P3 | P93 | P90 | G1 | 32 |
| I/O (A9) | P4 | P94 | P91 | F1 | 35 |
| I/O | - | P95 | P92 | E1 | 38 |
| I/O | - | P96 | P93 | F2 | 41 |
| I/O (A10) | P5 | P97 | P94 | F3 | 44 |
| I/O (A11) | P6 | P98 | P95 | D1 | 47 |
| I/O (A12) | P7 | P99 | P96 | C1 | 50 |
| I/O (A13) | P8 | P100 | P97 | D2 | 53 |
| I/O (A14) | P9 | P1 | P98 | C2 | 56 |
| I/O, SGCK1 (A15) | P10 | P2 | P99 | D3 | 59 |
| VCC | P11 | P3 | P100 | C3 | - |
| GND | P12 | P4 | P1 | C4 | - |
| I/O, PGCK1 (A16) | P13 | P5 | P2 | B2 | 62 |
| I/O (A17) | P14 | P6 | P3 | B3 | 65 |
| I/O, TDI | P15 | P7 | P4 | C5 | 68 |
| I/O, TCK | P16 | P8 | P5 | B4 | 71 |
| I/O, TMS | P17 | P9 | P6 | B5 | 74 |
| I/O | P18 | P10 | P7 | A4 | 77 |
| I/O | - | - | - | C6 | 80 |
| I/O | - | P11 | P8 | A5 | 83 |
| I/O | P19 | P12 | P9 | B6 | 86 |
| I/O | P20 | P13 | P10 | A6 | 89 |
| GND | P21 | P14 | P11 | B7 | - |
| VCC | P22 | P15 | P12 | C7 | - |
| I/O | P23 | P16 | P13 | A7 | 92 |
| I/O | P24 | P17 | P14 | A8 | 95 |
| I/O | - | P18 | P15 | A9 | 98 |
| I/O | - | - | - | B8 | 101 |
| I/O | P25 | P19 | P16 | C8 | 104 |
| I/O | P26 | P20 | P17 | A10 | 107 |
| I/O | P27 | P21 | P18 | B9 | 110 |
| I/O | - | P22 | P19 | A11 | 113 |
| I/O | P28 | P23 | P20 | C9 | 116 |
| I/O, SGCK2 | P29 | P24 | P21 | A12 | 119 |
| O (M1) | P30 | P25 | P22 | B11 | 122 |
| GND | P31 | P26 | P23 | C10 | - |
| I (M0) | P32 | P27 | P24 | C11 | 125 |
| VCC | P33 | P28 | P25 | D11 | - |
| I (M2) | P34 | P29 | P26 | B12 | 126 |
| I/O, PGCK2 | P35 | P30 | P27 | C12 | 127 |
| I/O (HDC) | P36 | P31 | P28 | A13 | 130 |
| I/O | - | P32 | P29 | D12 | 133 |
| I/O (LDC) | P37 | P33 | P30 | C13 | 136 |
| I/O | P38 | P34 | P31 | E12 | 139 |
| I/O | P39 | P35 | P32 | D13 | 142 |
| I/O | - | P36 | P33 | F11 | 145 |
| I/O | - | P37 | P34 | E13 | 148 |
| I/O | P40 | P38 | P35 | F12 | 151 |
| I/O (INIT) | P41 | P39 | P36 | F13 | 154 |
| VCC | P42 | P40 | P37 | G12 | - |
| GND | P43 | P41 | P38 | G11 | - |
| I/O | P44 | P42 | P39 | G13 | 157 |
| I/O | P45 | P43 | P40 | H13 | 160 |
| I/O | - | P44 | P41 | J13 | 163 |
| I/O | - | P45 | P42 | H12 | 166 |
| I/O | P46 | P46 | P43 | H11 | 169 |

| XC4003E Pad Name | PC84 | PQ100 | VQ100 | PG120 | Bndry Scan |
|---|---|---|---|---|---|
| I/O | P47 | P47 | P44 | K13 | 172 |
| I/O | P48 | P48 | P45 | J12 | 175 |
| I/O | P49 | P49 | P46 | L13 | 178 |
| I/O | P50 | P50 | P47 | M13 | 181 |
| I/O, SGCK3 | P51 | P51 | P48 | L12 | 184 |
| GND | P52 | P52 | P49 | K11 | - |
| DONE | P53 | P53 | P50 | L11 | - |
| VCC | P54 | P54 | P51 | L10 | - |
| PROGRAM | P55 | P55 | P52 | M12 | - |
| I/O (D7) | P56 | P56 | P53 | M11 | 187 |
| I/O, PGCK3 | P57 | P57 | P54 | N13 | 190 |
| I/O (D6) | P58 | P58 | P55 | M10 | 193 |
| I/O | - | P59 | P56 | N11 | 196 |
| I/O (D5) | P59 | P60 | P57 | M9 | 199 |
| I/O (CS0) | P60 | P61 | P58 | N10 | 202 |
| I/O | - | P62 | P59 | L8 | 205 |
| I/O | - | P63 | P60 | N9 | 208 |
| I/O (D4) | P61 | P64 | P61 | M8 | 211 |
| I/O | P62 | P65 | P62 | N8 | 214 |
| VCC | P63 | P66 | P63 | M7 | - |
| GND | P64 | P67 | P64 | L7 | - |
| I/O (D3) | P65 | P68 | P65 | N7 | 217 |
| I/O (RS) | P66 | P69 | P66 | N6 | 220 |
| I/O | - | P70 | P67 | N5 | 223 |
| I/O | - | - | - | M6 | 226 |
| I/O (D2) | P67 | P71 | P68 | L6 | 229 |
| I/O | P68 | P72 | P69 | N4 | 232 |
| I/O (D1) | P69 | P73 | P70 | M5 | 235 |
| I/O (RCLK, RDY/BUSY) | P70 | P74 | P71 | N3 | 238 |
| I/O (D0, DIN) | P71 | P75 | P72 | N2 | 241 |
| I/O, SGCK4 (DOUT) | P72 | P76 | P73 | M3 | 244 |
| CCLK | P73 | P77 | P74 | L4 | - |
| VCC | P74 | P78 | P75 | L3 | - |
| O, TDO | P75 | P79 | P76 | M2 | 0 |
| GND | P76 | P80 | P77 | K3 | - |
| I/O (A0, WS) | P77 | P81 | P78 | L2 | 2 |
| I/O, PGCK4 (A1) | P78 | P82 | P79 | N1 | 5 |
| I/O (CS1, A2) | P79 | P83 | P80 | K2 | 8 |
| I/O (A3) | P80 | P84 | P81 | L1 | 11 |
| I/O (A4) | P81 | P85 | P82 | J2 | 14 |
| I/O (A5) | P82 | P86 | P83 | K1 | 17 |
| I/O | - | P87 | P84 | H3 | 20 |
| I/O | - | P88 | P85 | J1 | 23 |
| I/O (A6) | P83 | P89 | P86 | H2 | 26 |
| I/O (A7) | P84 | P90 | P87 | H1 | 29 |
| GND | P1 | P91 | P88 | G2 | - |

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## Additional XC4003E Package Pins

### PG120

| N.C. Pins | | | | | |
|---|---|---|---|---|---|
| A1 | A2 | A3 | B1 | B10 | B13 |
| E2 | E3 | E11 | J3 | J11 | K12 |
| L5 | L9 | M1 | M4 | N12 | - |

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## Pin Locations for XC4005E/XL Devices

The following table may contain pinout information for unsupported device/package combinations. Please see the availability charts elsewhere in the XC4000 Series data sheet for availability information.

| XC4005E/XL Pad Name | PC 84 | PQ 100 | VQ 100†† | TQ 144 | PG 156† | PQ 160 | PQ 208 | Bndry Scan |
|---|---|---|---|---|---|---|---|---|
| VCC | P2 | P92 | P89 | P128 | H3 | P142 | P183 | - |
| I/O (A8) | P3 | P93 | P90 | P129 | H1 | P143 | P184 | 44 |
| I/O (A9) | P4 | P94 | P91 | P130 | G1 | P144 | P185 | 47 |
| I/O (A19) †† | - | P95 | P92 | P131 | G2 | P145 | P186 | 50 |
| I/O (A18) †† | - | P96 | P93 | P132 | G3 | P146 | P187 | 53 |
| I/O (A10) | P5 | P97 | P94 | P133 | F1 | P147 | P190 | 56 |
| I/O (A11) | P6 | P98 | P95 | P134 | F2 | P148 | P191 | 59 |
| I/O | - | - | - | P135 | E1 | P149 | P192 | 62 |
| I/O | - | - | - | P136 | E2 | P150 | P193 | 65 |
| GND | - | - | - | P137 | F3 | P151 | P194 | - |
| I/O (A12) | P7 | P99 | P96 | P138 | E3 | P154 | P199 | 68 |
| I/O (A13) | P8 | P100 | P97 | P139 | C1 | P155 | P200 | 71 |
| I/O | - | - | - | P140 | C2 | P156 | P201 | 74 |
| I/O | - | - | - | P141 | D3 | P157 | P202 | 77 |
| I/O (A14) | P9 | P1 | P98 | P142 | B1 | P158 | P203 | 80 |
| I/O, SGCK1 †, GCK8 †† (A15) | P10 | P2 | P99 | P143 | B2 | P159 | P204 | 83 |
| VCC | P11 | P3 | P100 | P144 | C3 | P160 | P205 | - |
| GND | P12 | P4 | P1 | P1 | C4 | P1 | P2 | - |
| I/O, PGCK1†, GCK1†† (A16) | P13 | P5 | P2 | P2 | B3 | P2 | P4 | 86 |
| I/O (A17) | P14 | P6 | P3 | P3 | A1 | P3 | P5 | 89 |
| I/O | - | - | - | P4 | A2 | P4 | P6 | 92 |
| I/O | - | - | - | P5 | C5 | P5 | P7 | 95 |
| I/O, TDI | P15 | P7 | P4 | P6 | B4 | P6 | P8 | 98 |
| I/O, TCK | P16 | P8 | P5 | P7 | A3 | P7 | P9 | 101 |
| GND | - | - | - | P8 | C6 | P10 | P14 | - |
| I/O | - | - | - | P9 | B5 | P11 | P15 | 104 |
| I/O | - | - | - | P10 | B6 | P12 | P16 | 107 |
| I/O, TMS | P17 | P9 | P6 | P11 | A5 | P13 | P17 | 110 |
| I/O | P18 | P10 | P7 | P12 | C7 | P14 | P18 | 113 |
| I/O | - | - | - | P13 | B7 | P15 | P21 | 116 |
| I/O | - | P11 | P8 | P14 | A6 | P16 | P22 | 119 |
| I/O | P19 | P12 | P9 | P15 | A7 | P17 | P23 | 122 |
| I/O | P20 | P13 | P10 | P16 | A8 | P18 | P24 | 125 |
| GND | P21 | P14 | P11 | P17 | C8 | P19 | P25 | - |
| VCC | P22 | P15 | P12 | P18 | B8 | P20 | P26 | - |
| I/O | P23 | P16 | P13 | P19 | C9 | P21 | P27 | 128 |
| I/O | P24 | P17 | P14 | P20 | B9 | P22 | P28 | 131 |
| I/O | - | P18 | P15 | P21 | A9 | P23 | P29 | 134 |
| I/O | - | - | - | P22 | B10 | P24 | P30 | 137 |
| I/O | P25 | P19 | P16 | P23 | C10 | P25 | P33 | 140 |
| I/O | P26 | P20 | P17 | P24 | A10 | P26 | P34 | 143 |
| I/O | - | - | - | P25 | A11 | P27 | P35 | 146 |
| I/O | - | - | - | P26 | B11 | P28 | P36 | 149 |
| GND | - | - | - | P27 | C11 | P29 | P37 | - |
| I/O | P27 | P21 | P18 | P28 | B12 | P32 | P42 | 152 |
| I/O | - | P22 | P19 | P29 | A13 | P33 | P43 | 155 |
| I/O | - | - | - | P30 | A14 | P34 | P44 | 158 |
| I/O | - | - | - | P31 | C12 | P35 | P45 | 161 |
| I/O | P28 | P23 | P20 | P32 | B13 | P36 | P46 | 164 |
| I/O, SGCK2 †, GCK2 †† | P29 | P24 | P21 | P33 | B14 | P37 | P47 | 167 |
| O (M1) | P30 | P25 | P22 | P34 | A15 | P38 | P48 | 170 |
| GND | P31 | P26 | P23 | P35 | C13 | P39 | P49 | - |
| I (M0) | P32 | P27 | P24 | P36 | A16 | P40 | P50 | 173 |
| VCC | P33 | P28 | P25 | P37 | C14 | P41 | P55 | - |
| I (M2) | P34 | P29 | P26 | P38 | B15 | P42 | P56 | 174 |
| I/O, PGCK2 †, GCK3 †† | P35 | P30 | P27 | P39 | B16 | P43 | P57 | 175 |
| I/O (HDC) | P36 | P31 | P28 | P40 | D14 | P44 | P58 | 178 |
| I/O | - | - | - | P41 | C15 | P45 | P59 | 181 |
| I/O | - | - | - | P42 | D15 | P46 | P60 | 184 |
| I/O | - | P32 | P29 | P43 | E14 | P47 | P61 | 187 |
| I/O (LDC) | P37 | P33 | P30 | P44 | C16 | P48 | P62 | 190 |

| XC4005E/XL Pad Name | PC 84 | PQ 100 | VQ 100†† | TQ 144 | PG 156† | PQ 160 | PQ 208 | Bndry Scan |
|---|---|---|---|---|---|---|---|---|
| GND | - | - | - | P45 | F14 | P51 | P67 | - |
| I/O | - | - | - | P46 | F15 | P52 | P68 | 193 |
| I/O | - | - | - | P47 | E16 | P53 | P69 | 196 |
| I/O | P38 | P34 | P31 | P48 | F16 | P54 | P70 | 199 |
| I/O | P39 | P35 | P32 | P49 | G14 | P55 | P71 | 202 |
| I/O | - | P36 | P33 | P50 | G15 | P56 | P74 | 205 |
| I/O | - | P37 | P34 | P51 | G16 | P57 | P75 | 208 |
| I/O | P40 | P38 | P35 | P52 | H16 | P58 | P76 | 211 |
| I/O (INIT) | P41 | P39 | P36 | P53 | H15 | P59 | P77 | 214 |
| VCC | P42 | P40 | P37 | P54 | H14 | P60 | P78 | - |
| GND | P43 | P41 | P38 | P55 | J14 | P61 | P79 | - |
| I/O | P44 | P42 | P39 | P56 | J15 | P62 | P80 | 217 |
| I/O | P45 | P43 | P40 | P57 | J16 | P63 | P81 | 220 |
| I/O | - | P44 | P41 | P58 | K16 | P64 | P82 | 223 |
| I/O | - | P45 | P42 | P59 | K15 | P65 | P83 | 226 |
| I/O | P46 | P46 | P43 | P60 | K14 | P66 | P86 | 229 |
| I/O | P47 | P47 | P44 | P61 | L16 | P67 | P87 | 232 |
| I/O | - | - | - | P62 | M16 | P68 | P88 | 235 |
| I/O | - | - | - | P63 | L15 | P69 | P89 | 238 |
| GND | - | - | - | P64 | L14 | P70 | P90 | - |
| I/O | P48 | P48 | P45 | P65 | P16 | P73 | P95 | 241 |
| I/O | P49 | P49 | P46 | P66 | M14 | P74 | P96 | 244 |
| I/O | - | - | - | P67 | N15 | P75 | P97 | 247 |
| I/O | - | - | - | P68 | P15 | P76 | P98 | 250 |
| I/O | P50 | P50 | P47 | P69 | N14 | P77 | P99 | 253 |
| I/O, SGCK3 †, GCK4 †† | P51 | P51 | P48 | P70 | R16 | P78 | P100 | 256 |
| GND | P52 | P52 | P49 | P71 | P14 | P79 | P101 | - |
| DONE | P53 | P53 | P50 | P72 | R15 | P80 | P103 | - |
| VCC | P54 | P54 | P51 | P73 | P13 | P81 | P106 | - |
| PROGRAM | P55 | P55 | P52 | P74 | R14 | P82 | P108 | - |
| I/O (D7) | P56 | P56 | P53 | P75 | T16 | P83 | P109 | 259 |
| I/O, PGCK3†, GCK5†† | P57 | P57 | P54 | P76 | T15 | P84 | P110 | 262 |
| I/O | - | - | - | P77 | R13 | P85 | P111 | 265 |
| I/O | - | - | - | P78 | P12 | P86 | P112 | 268 |
| I/O (D6) | P58 | P58 | P55 | P79 | T14 | P87 | P113 | 271 |
| I/O | - | P59 | P56 | P80 | T13 | P88 | P114 | 274 |
| GND | - | - | - | P81 | P11 | P91 | P119 | - |
| I/O | - | - | - | P82 | R11 | P92 | P120 | 277 |
| I/O | - | - | - | P83 | T11 | P93 | P121 | 280 |
| I/O (D5) | P59 | P60 | P57 | P84 | T10 | P94 | P122 | 283 |
| I/O (CS0) | P60 | P61 | P58 | P85 | P10 | P95 | P123 | 286 |
| I/O | - | P62 | P59 | P86 | R10 | P96 | P126 | 289 |
| I/O | - | P63 | P60 | P87 | T9 | P97 | P127 | 292 |
| I/O (D4) | P61 | P64 | P61 | P88 | R9 | P98 | P128 | 295 |
| I/O | P62 | P65 | P62 | P89 | P9 | P99 | P129 | 298 |
| VCC | P63 | P66 | P63 | P90 | R8 | P100 | P130 | - |
| GND | P64 | P67 | P64 | P91 | P8 | P101 | P131 | - |
| I/O (D3) | P65 | P68 | P65 | P92 | T8 | P102 | P132 | 301 |
| I/O (RS) | P66 | P69 | P66 | P93 | T7 | P103 | P133 | 304 |
| I/O | - | P70 | P67 | P94 | T6 | P104 | P134 | 307 |
| I/O | - | - | - | P95 | R7 | P105 | P135 | 310 |
| I/O (D2) | P67 | P71 | P68 | P96 | P7 | P106 | P138 | 313 |
| I/O | P68 | P72 | P69 | P97 | T5 | P107 | P139 | 316 |
| I/O | - | - | - | P98 | R6 | P108 | P140 | 319 |
| I/O | - | - | - | P99 | T4 | P109 | P141 | 322 |
| GND | - | - | - | P100 | P6 | P110 | P142 | - |
| I/O (D1) | P69 | P73 | P70 | P101 | T3 | P113 | P147 | 325 |
| I/O (RCLK, RDY/BUSY) | P70 | P74 | P71 | P102 | P5 | P114 | P148 | 328 |
| I/O | - | - | - | P103 | R4 | P115 | P149 | 331 |
| I/O | - | - | - | P104 | R3 | P116 | P150 | 334 |
| I/O (D0, DIN) | P71 | P75 | P72 | P105 | P4 | P117 | P151 | 337 |

| XC4005E/XL Pad Name | PC 84 | PQ 100 | VQ 100†† | TQ 144 | PG 156† | PQ 160 | PQ 208 | Bndry Scan |
|---|---|---|---|---|---|---|---|---|
| I/O, SGCK4 †, GCK6 †† (DOUT) | P72 | P76 | P73 | P106 | T2 | P118 | P152 | 340 |
| CCLK | P73 | P77 | P74 | P107 | R2 | P119 | P153 | - |
| VCC | P74 | P78 | P75 | P108 | P3 | P120 | P154 | - |
| O, TDO | P75 | P79 | P76 | P109 | T1 | P121 | P159 | 0 |
| GND | P76 | P80 | P77 | P110 | N3 | P122 | P160 | - |
| I/O (A0, $\overline{WS}$) | P77 | P81 | P78 | P111 | R1 | P123 | P161 | 2 |
| I/O, PGCK4 †, GCK7 †† (A1) | P78 | P82 | P79 | P112 | P2 | P124 | P162 | 5 |
| I/O | - | - | - | P113 | N2 | P125 | P163 | 8 |
| I/O | - | - | - | P114 | M3 | P126 | P164 | 11 |
| I/O (CS1, A2) | P79 | P83 | P80 | P115 | P1 | P127 | P165 | 14 |
| I/O (A3) | P80 | P84 | P81 | P116 | N1 | P128 | P166 | 17 |
| GND | - | - | - | P118 | L3 | P131 | P171 | - |
| I/O | - | - | - | P119 | L2 | P132 | P172 | 20 |
| I/O | - | - | - | P120 | L1 | P133 | P173 | 23 |
| I/O (A4) | P81 | P85 | P82 | P121 | K3 | P134 | P174 | 26 |
| I/O (A5) | P82 | P86 | P83 | P122 | K2 | P135 | P175 | 29 |
| I/O (A21) †† | - | P87 | P84 | P123 | K1 | P137 | P178 | 32 |
| I/O (A20) †† | - | P88 | P85 | P124 | J1 | P138 | P179 | 35 |
| I/O (A6) | P83 | P89 | P86 | P125 | J2 | P139 | P180 | 38 |
| I/O (A7) | P84 | P90 | P87 | P126 | J3 | P140 | P181 | 41 |
| GND | P1 | P91 | P88 | P127 | H2 | P141 | P182 | - |

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† = E only
†† = XL only

## Additional XC4005E/XL Package Pins

**TQ144**

| N.C. Pins | | | | | |
|---|---|---|---|---|---|
| P117 | - | - | - | - | - |

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**PG156**

| N.C. Pins | | | | | |
|---|---|---|---|---|---|
| A4 | A12 | D1 | D2 | D16 | E15 |
| M1 | M2 | M15 | N16 | R5 | R12 |
| T12 | - | - | - | - | - |

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**PQ160**

| N.C. Pins | | | | | |
|---|---|---|---|---|---|
| P8 | P9 | P30 | P31 | P49 | P50 |
| P71 | P72 | P89 | P90 | P111 | P112 |
| P129 | P130 | P136 | P152 | P153 | - |

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**PQ208**

| N.C. Pins | | | | | |
|---|---|---|---|---|---|
| P1 | P3 | P10 | P11 | P12 | P13 |
| P19 | P20 | P31 | P32 | P38 | P39 |
| P40 | P41 | P51 | P52 | P53 | P54 |
| P63 | P64 | P65 | P66 | P72 | P73 |
| P84 | P85 | P91 | P92 | P93 | P94 |
| P102 | P104 | P105 | P107 | P115 | P116 |
| P117 | P118 | P124 | P125 | P136 | P137 |
| P143 | P144 | P145 | P146 | P155 | P156 |
| P157 | P158 | P167 | P168 | P169 | P170 |
| P176 | P177 | P188 | P189 | P195 | P196 |
| P197 | P198 | P206 | P207 | P208 | - |

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# Pin Locations for XC4006E Devices

| XC4006E Pad Name | PC 84 | TQ 144 | PG 156 | PQ 160 | PQ 208 | Bndry Scan |
|---|---|---|---|---|---|---|
| VCC | P2 | P128 | H3 | P142 | P183 | - |
| I/O (A8) | P3 | P129 | H1 | P143 | P184 | 50 |
| I/O (A9) | P4 | P130 | G1 | P144 | P185 | 53 |
| I/O | - | P131 | G2 | P145 | P186 | 56 |
| I/O | - | P132 | G3 | P146 | P187 | 59 |
| I/O (A10) | P5 | P133 | F1 | P147 | P190 | 62 |
| I/O (A11) | P6 | P134 | F2 | P148 | P191 | 65 |
| I/O | - | P135 | E1 | P149 | P192 | 68 |
| I/O | - | P136 | E2 | P150 | P193 | 71 |
| GND | - | P137 | F3 | P151 | P194 | - |
| I/O | - | - | D1 | P152 | P197 | 74 |
| I/O | - | - | D2 | P153 | P198 | 77 |
| I/O (A12) | P7 | P138 | E3 | P154 | P199 | 80 |
| I/O (A13) | P8 | P139 | C1 | P155 | P200 | 83 |
| I/O | - | P140 | C2 | P156 | P201 | 86 |
| I/O | - | P141 | D3 | P157 | P202 | 89 |
| I/O (A14) | P9 | P142 | B1 | P158 | P203 | 92 |
| I/O, SGCK1 (A15) | P10 | P143 | B2 | P159 | P204 | 95 |
| VCC | P11 | P144 | C3 | P160 | P205 | - |
| GND | P12 | P1 | C4 | P1 | P2 | - |
| I/O, PGCK1 (A16) | P13 | P2 | B3 | P2 | P4 | 98 |
| I/O (A17) | P14 | P3 | A1 | P3 | P5 | 101 |
| I/O | - | P4 | A2 | P4 | P6 | 104 |
| I/O | - | P5 | C5 | P5 | P7 | 107 |
| I/O, TDI | P15 | P6 | B4 | P6 | P8 | 110 |
| I/O, TCK | P16 | P7 | A3 | P7 | P9 | 113 |
| I/O | - | - | A4 | P8 | P10 | 116 |
| I/O | - | - | - | P9 | P11 | 119 |
| GND | - | P8 | C6 | P10 | P14 | - |

| XC4006E Pad Name | PC 84 | TQ 144 | PG 156 | PQ 160 | PQ 208 | Bndry Scan |
|---|---|---|---|---|---|---|
| I/O | - | P9 | B5 | P11 | P15 | 122 |
| I/O | - | P10 | B6 | P12 | P16 | 125 |
| I/O, TMS | P17 | P11 | A5 | P13 | P17 | 128 |
| I/O | P18 | P12 | C7 | P14 | P18 | 131 |
| I/O | - | P13 | B7 | P15 | P21 | 134 |
| I/O | - | P14 | A6 | P16 | P22 | 137 |
| I/O | P19 | P15 | A7 | P17 | P23 | 140 |
| I/O | P20 | P16 | A8 | P18 | P24 | 143 |
| GND | P21 | P17 | C8 | P19 | P25 | - |
| VCC | P22 | P18 | B8 | P20 | P26 | - |
| I/O | P23 | P19 | C9 | P21 | P27 | 146 |
| I/O | P24 | P20 | B9 | P22 | P28 | 149 |
| I/O | - | P21 | A9 | P23 | P29 | 152 |
| I/O | - | P22 | B10 | P24 | P30 | 155 |
| I/O | P25 | P23 | C10 | P25 | P33 | 158 |
| I/O | P26 | P24 | A10 | P26 | P34 | 161 |
| I/O | - | P25 | A11 | P27 | P35 | 164 |
| I/O | - | P26 | B11 | P28 | P36 | 167 |
| GND | - | P27 | C11 | P29 | P37 | - |
| I/O | - | - | A12 | P30 | P40 | 170 |
| I/O | - | - | - | P31 | P41 | 173 |
| I/O | P27 | P28 | B12 | P32 | P42 | 176 |
| I/O | - | P29 | A13 | P33 | P43 | 179 |
| I/O | - | P30 | A14 | P34 | P44 | 182 |
| I/O | - | P31 | C12 | P35 | P45 | 185 |
| I/O | P28 | P32 | B13 | P36 | P46 | 188 |
| I/O, SGCK2 | P29 | P33 | B14 | P37 | P47 | 191 |
| O (M1) | P30 | P34 | A15 | P38 | P48 | 194 |
| GND | P31 | P35 | C13 | P39 | P49 | - |

| XC4006E Pad Name | PC 84 | TQ 144 | PG 156 | PQ 160 | PQ 208 | Bndry Scan |
|---|---|---|---|---|---|---|
| I (M0) | P32 | P36 | A16 | P40 | P50 | 197 |
| VCC | P33 | P37 | C14 | P41 | P55 | - |
| I (M2) | P34 | P38 | B15 | P42 | P56 | 198 |
| I/O, PGCK2 | P35 | P39 | B16 | P43 | P57 | 199 |
| I/O (HDC) | P36 | P40 | D14 | P44 | P58 | 202 |
| I/O | - | P41 | C15 | P45 | P59 | 205 |
| I/O | - | P42 | D15 | P46 | P60 | 208 |
| I/O | - | P43 | E14 | P47 | P61 | 211 |
| I/O (LDC) | P37 | P44 | C16 | P48 | P62 | 214 |
| I/O | - | - | E15 | P49 | P63 | 217 |
| I/O | - | - | D16 | P50 | P64 | 220 |
| GND | - | P45 | F14 | P51 | P67 | - |
| I/O | - | P46 | F15 | P52 | P68 | 223 |
| I/O | - | P47 | E16 | P53 | P69 | 226 |
| I/O | P38 | P48 | F16 | P54 | P70 | 229 |
| I/O | P39 | P49 | G14 | P55 | P71 | 232 |
| I/O | - | P50 | G15 | P56 | P74 | 235 |
| I/O | - | P51 | G16 | P57 | P75 | 238 |
| I/O | P40 | P52 | H16 | P58 | P76 | 241 |
| I/O (INIT) | P41 | P53 | H15 | P59 | P77 | 244 |
| VCC | P42 | P54 | H14 | P60 | P78 | - |
| GND | P43 | P55 | J14 | P61 | P79 | - |
| I/O | P44 | P56 | J15 | P62 | P80 | 247 |
| I/O | P45 | P57 | J16 | P63 | P81 | 250 |
| I/O | - | P58 | K16 | P64 | P82 | 253 |
| I/O | - | P59 | K15 | P65 | P83 | 256 |
| I/O | P46 | P60 | K14 | P66 | P86 | 259 |
| I/O | P47 | P61 | L16 | P67 | P87 | 262 |
| I/O | - | P62 | M16 | P68 | P88 | 265 |
| I/O | - | P63 | L15 | P69 | P89 | 268 |
| GND | - | P64 | L14 | P70 | P90 | - |
| I/O | - | - | N16 | P71 | P93 | 271 |
| I/O | - | - | M15 | P72 | P94 | 274 |
| I/O | P48 | P65 | P16 | P73 | P95 | 277 |
| I/O | P49 | P66 | M14 | P74 | P96 | 280 |
| I/O | - | P67 | N15 | P75 | P97 | 283 |
| I/O | - | P68 | P15 | P76 | P98 | 286 |
| I/O | P50 | P69 | N14 | P77 | P99 | 289 |
| I/O, SGCK3 | P51 | P70 | R16 | P78 | P100 | 292 |
| GND | P52 | P71 | P14 | P79 | P101 | - |
| DONE | P53 | P72 | R15 | P80 | P103 | - |
| VCC | P54 | P73 | P13 | P81 | P106 | - |
| PROGRAM | P55 | P74 | R14 | P82 | P108 | - |
| I/O (D7) | P56 | P75 | T16 | P83 | P109 | 295 |
| I/O, PGCK3 | P57 | P76 | T15 | P84 | P110 | 298 |
| I/O | - | P77 | R13 | P85 | P111 | 301 |
| I/O | - | P78 | P12 | P86 | P112 | 304 |
| I/O (D6) | P58 | P79 | T14 | P87 | P113 | 307 |
| I/O | - | P80 | T13 | P88 | P114 | 310 |
| I/O | - | - | R12 | P89 | P115 | 313 |
| I/O | - | - | T12 | P90 | P116 | 316 |
| GND | - | P81 | P11 | P91 | P119 | - |
| I/O | - | P82 | R11 | P92 | P120 | 319 |
| I/O | - | P83 | T11 | P93 | P121 | 322 |
| I/O (D5) | P59 | P84 | T10 | P94 | P122 | 325 |
| I/O (CS0) | P60 | P85 | P10 | P95 | P123 | 328 |
| I/O | - | P86 | R10 | P96 | P126 | 331 |
| I/O | - | P87 | T9 | P97 | P127 | 334 |
| I/O (D4) | P61 | P88 | R9 | P98 | P128 | 337 |
| I/O | P62 | P89 | P9 | P99 | P129 | 340 |
| VCC | P63 | P90 | R8 | P100 | P130 | - |
| GND | P64 | P91 | P8 | P101 | P131 | - |
| I/O (D3) | P65 | P92 | T8 | P102 | P132 | 343 |
| I/O (RS) | P66 | P93 | T7 | P103 | P133 | 346 |

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| XC4006E Pad Name | PC 84 | TQ 144 | PG 156 | PQ 160 | PQ 208 | Bndry Scan |
|---|---|---|---|---|---|---|
| I/O | - | P94 | T6 | P104 | P134 | 349 |
| I/O | - | P95 | R7 | P105 | P135 | 352 |
| I/O (D2) | P67 | P96 | P7 | P106 | P138 | 355 |
| I/O | P68 | P97 | T5 | P107 | P139 | 358 |
| I/O | - | P98 | R6 | P108 | P140 | 361 |
| I/O | - | P99 | T4 | P109 | P141 | 364 |
| GND | - | P100 | P6 | P110 | P142 | - |
| I/O | - | - | R5 | P111 | P145 | 367 |
| I/O | - | - | - | P112 | P146 | 370 |
| I/O (D1) | P69 | P101 | T3 | P113 | P147 | 373 |
| I/O (RCLK, RDY/BUSY) | P70 | P102 | P5 | P114 | P148 | 376 |
| I/O | - | P103 | R4 | P115 | P149 | 379 |
| I/O | - | P104 | R3 | P116 | P150 | 382 |
| I/O (D0, DIN) | P71 | P105 | P4 | P117 | P151 | 385 |
| I/O, SGCK4 (DOUT) | P72 | P106 | T2 | P118 | P152 | 388 |
| CCLK | P73 | P107 | R2 | P119 | P153 | - |
| VCC | P74 | P108 | P3 | P120 | P154 | - |
| O, TDO | P75 | P109 | T1 | P121 | P159 | 0 |
| GND | P76 | P110 | N3 | P122 | P160 | - |
| I/O (A0, WS) | P77 | P111 | R1 | P123 | P161 | 2 |
| I/O, PGCK4 (A1) | P78 | P112 | P2 | P124 | P162 | 5 |
| I/O | - | P113 | N2 | P125 | P163 | 8 |
| I/O | - | P114 | M3 | P126 | P164 | 11 |
| I/O (CS1, A2) | P79 | P115 | P1 | P127 | P165 | 14 |
| I/O (A3) | P80 | P116 | N1 | P128 | P166 | 17 |
| I/O | - | P117 | M2 | P129 | P167 | 20 |
| I/O | - | - | M1 | P130 | P168 | 23 |
| GND | - | P118 | L3 | P131 | P171 | - |
| I/O | - | P119 | L2 | P132 | P172 | 26 |
| I/O | - | P120 | L1 | P133 | P173 | 29 |
| I/O (A4) | P81 | P121 | K3 | P134 | P174 | 32 |
| I/O (A5) | P82 | P122 | K2 | P135 | P175 | 35 |
| I/O | - | P123 | K1 | P137 | P178 | 38 |
| I/O | - | P124 | J1 | P138 | P179 | 41 |
| I/O (A6) | P83 | P125 | J2 | P139 | P180 | 44 |
| I/O (A7) | P84 | P126 | J3 | P140 | P181 | 47 |
| GND | P1 | P127 | H2 | P141 | P182 | - |

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## Additional XC4006E Package Pins

**PQ160**

| N.C. Pins | | | | |
|---|---|---|---|---|
| P136 | - | - | - | - |

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**PQ208**

| N.C. Pins | | | | |
|---|---|---|---|---|
| P1 | P3 | P12 | P13 | P19 |
| P20 | P31 | P32 | P38 | P39 |
| P51 | P52 | P53 | P54 | P65 |
| P66 | P72 | P73 | P84 | P85 |
| P91 | P92 | P102 | P104 | P105 |
| P107 | P117 | P118 | P124 | P125 |
| P136 | P137 | P143 | P144 | P155 |
| P156 | P157 | P158 | P169 | P170 |
| P176 | P177 | P188 | P189 | P195 |
| P196 | P206 | P207 | P208 | - |

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## Pin Locations for XC4008E Devices

| XC4008E Pad Name | PC84 | PQ160 | PG191 | PQ208 | Bndry Scan |
|---|---|---|---|---|---|
| VCC | P2 | P142 | J4 | P183 | - |
| I/O (A8) | P3 | P143 | J3 | P184 | 56 |
| I/O (A9) | P4 | P144 | J2 | P185 | 59 |
| I/O | - | P145 | J1 | P186 | 62 |
| I/O | - | P146 | H1 | P187 | 65 |
| I/O | - | - | H2 | P188 | 68 |
| I/O | - | - | H3 | P189 | 71 |
| I/O (A10) | P5 | P147 | G1 | P190 | 74 |
| I/O (A11) | P6 | P148 | G2 | P191 | 77 |
| I/O | - | P149 | F1 | P192 | 80 |
| I/O | - | P150 | E1 | P193 | 83 |
| GND | - | P151 | G3 | P194 | - |
| I/O | - | P152 | C1 | P197 | 86 |
| I/O | - | P153 | E2 | P198 | 89 |
| I/O (A12) | P7 | P154 | F3 | P199 | 92 |
| I/O (A13) | P8 | P155 | D2 | P200 | 95 |
| I/O | - | P156 | B1 | P201 | 98 |
| I/O | - | P157 | E3 | P202 | 101 |
| I/O (A14) | P9 | P158 | C2 | P203 | 104 |
| I/O, SGCK1 (A15) | P10 | P159 | B2 | P204 | 107 |
| VCC | P11 | P160 | D3 | P205 | - |
| GND | P12 | P1 | D4 | P2 | - |
| I/O, PGCK1 (A16) | P13 | P2 | C3 | P4 | 110 |
| I/O (A17) | P14 | P3 | C4 | P5 | 113 |
| I/O | - | P4 | B3 | P6 | 116 |
| I/O | - | P5 | C5 | P7 | 119 |
| I/O, TDI | P15 | P6 | A2 | P8 | 122 |
| I/O, TCK | P16 | P7 | B4 | P9 | 125 |
| I/O | - | P8 | C6 | P10 | 128 |
| I/O | - | P9 | A3 | P11 | 131 |
| GND | - | P10 | C7 | P14 | - |
| I/O | - | P11 | A4 | P15 | 134 |
| I/O | - | P12 | A5 | P16 | 137 |
| I/O, TMS | P17 | P13 | B7 | P17 | 140 |
| I/O | P18 | P14 | A6 | P18 | 143 |
| I/O | - | - | C8 | P19 | 146 |
| I/O | - | - | A7 | P20 | 149 |
| I/O | - | P15 | B8 | P21 | 152 |
| I/O | - | P16 | A8 | P22 | 155 |
| I/O | P19 | P17 | B9 | P23 | 158 |
| I/O | P20 | P18 | C9 | P24 | 161 |
| GND | P21 | P19 | D9 | P25 | - |
| VCC | P22 | P20 | D10 | P26 | - |
| I/O | P23 | P21 | C10 | P27 | 164 |
| I/O | P24 | P22 | B10 | P28 | 167 |
| I/O | - | P23 | A9 | P29 | 170 |
| I/O | - | P24 | A10 | P30 | 173 |
| I/O | - | - | A11 | P31 | 176 |
| I/O | - | - | C11 | P32 | 179 |
| I/O | P25 | P25 | B11 | P33 | 182 |
| I/O | P26 | P26 | A12 | P34 | 185 |
| I/O | - | P27 | B12 | P35 | 188 |
| I/O | - | P28 | A13 | P36 | 191 |
| GND | - | P29 | C12 | P37 | - |
| I/O | - | P30 | A15 | P40 | 194 |
| I/O | - | P31 | C13 | P41 | 197 |
| I/O | P27 | P32 | B14 | P42 | 200 |
| I/O | - | P33 | A16 | P43 | 203 |
| I/O | - | P34 | B15 | P44 | 206 |
| I/O | - | P35 | C14 | P45 | 209 |
| I/O | P28 | P36 | A17 | P46 | 212 |
| I/O, SGCK2 | P29 | P37 | B16 | P47 | 215 |
| O (M1) | P30 | P38 | C15 | P48 | 218 |
| GND | P31 | P39 | D15 | P49 | - |
| I (M0) | P32 | P40 | A18 | P50 | 221 |
| VCC | P33 | P41 | D16 | P55 | - |
| I (M2) | P34 | P42 | C16 | P56 | 222 |
| I/O, PGCK2 | P35 | P43 | B17 | P57 | 223 |

| XC4008E Pad Name | PC84 | PQ160 | PG191 | PQ208 | Bndry Scan |
|---|---|---|---|---|---|
| I/O (HDC) | P36 | P44 | E16 | P58 | 226 |
| I/O | - | P45 | C17 | P59 | 229 |
| I/O | - | P46 | D17 | P60 | 232 |
| I/O | - | P47 | B18 | P61 | 235 |
| I/O (LDC) | P37 | P48 | E17 | P62 | 238 |
| I/O | - | P49 | F16 | P63 | 241 |
| I/O | - | P50 | C18 | P64 | 244 |
| GND | - | P51 | G16 | P67 | - |
| I/O | - | P52 | E18 | P68 | 247 |
| I/O | - | P53 | F18 | P69 | 250 |
| I/O | P38 | P54 | G17 | P70 | 253 |
| I/O | P39 | P55 | G18 | P71 | 256 |
| I/O | - | - | H16 | P72 | 259 |
| I/O | - | - | H17 | P73 | 262 |
| I/O | - | P56 | H18 | P74 | 265 |
| I/O | - | P57 | J18 | P75 | 268 |
| I/O | P40 | P58 | J17 | P76 | 271 |
| I/O (INIT) | P41 | P59 | J16 | P77 | 274 |
| VCC | P42 | P60 | J15 | P78 | - |
| GND | P43 | P61 | K15 | P79 | - |
| I/O | P44 | P62 | K16 | P80 | 277 |
| I/O | P45 | P63 | K17 | P81 | 280 |
| I/O | - | P64 | K18 | P82 | 283 |
| I/O | - | P65 | L18 | P83 | 286 |
| I/O | - | - | L17 | P84 | 289 |
| I/O | - | - | L16 | P85 | 292 |
| I/O | P46 | P66 | M18 | P86 | 295 |
| I/O | P47 | P67 | M17 | P87 | 298 |
| I/O | - | P68 | N18 | P88 | 301 |
| I/O | - | P69 | P18 | P89 | 304 |
| GND | - | P70 | M16 | P90 | - |
| I/O | - | P71 | T18 | P93 | 307 |
| I/O | - | P72 | P17 | P94 | 310 |
| I/O | P48 | P73 | N16 | P95 | 313 |
| I/O | P49 | P74 | T17 | P96 | 316 |
| I/O | - | P75 | R17 | P97 | 319 |
| I/O | - | P76 | P16 | P98 | 322 |
| I/O | P50 | P77 | U18 | P99 | 325 |
| I/O, SGCK3 | P51 | P78 | T16 | P100 | 328 |
| GND | P52 | P79 | R16 | P101 | - |
| DONE | P53 | P80 | U17 | P103 | - |
| VCC | P54 | P81 | R15 | P106 | - |
| PROGRAM | P55 | P82 | V18 | P108 | - |
| I/O (D7) | P56 | P83 | T15 | P109 | 331 |
| I/O, PGCK3 | P57 | P84 | U16 | P110 | 334 |
| I/O | - | P85 | T14 | P111 | 337 |
| I/O | - | P86 | U15 | P112 | 340 |
| I/O (D6) | P58 | P87 | V17 | P113 | 343 |
| I/O | - | P88 | V16 | P114 | 346 |
| I/O | - | P89 | T13 | P115 | 349 |
| I/O | - | P90 | U14 | P116 | 352 |
| GND | - | P91 | T12 | P119 | - |
| I/O | - | P92 | U13 | P120 | 355 |
| I/O | - | P93 | V13 | P121 | 358 |
| I/O (D5) | P59 | P94 | U12 | P122 | 361 |
| I/O (CS0) | P60 | P95 | V12 | P123 | 364 |
| I/O | - | - | T11 | P124 | 367 |
| I/O | - | - | U11 | P125 | 370 |
| I/O | - | P96 | V11 | P126 | 373 |
| I/O | - | P97 | V10 | P127 | 376 |
| I/O (D4) | P61 | P98 | U10 | P128 | 379 |
| I/O | P62 | P99 | T10 | P129 | 382 |
| VCC | P63 | P100 | R10 | P130 | - |
| GND | P64 | P101 | R9 | P131 | - |
| I/O (D3) | P65 | P102 | T9 | P132 | 385 |
| I/O (RS) | P66 | P103 | U9 | P133 | 388 |
| I/O | - | P104 | V9 | P134 | 391 |
| I/O | - | P105 | V8 | P135 | 394 |
| I/O | - | - | U8 | P136 | 397 |

| XC4008E Pad Name | PC84 | PQ160 | PG191 | PQ208 | Bndry Scan |
|---|---|---|---|---|---|
| I/O | - | - | T8 | P137 | 400 |
| I/O (D2) | P67 | P106 | V7 | P138 | 403 |
| I/O | P68 | P107 | U7 | P139 | 406 |
| I/O | - | P108 | V6 | P140 | 409 |
| I/O | - | P109 | U6 | P141 | 412 |
| GND | - | P110 | T7 | P142 | - |
| I/O | - | P111 | U5 | P145 | 415 |
| I/O | - | P112 | T6 | P146 | 418 |
| I/O (D1) | P69 | P113 | V3 | P147 | 421 |
| I/O (RCLK, RDY/BUSY) | P70 | P114 | V2 | P148 | 424 |
| I/O | - | P115 | U4 | P149 | 427 |
| I/O | - | P116 | T5 | P150 | 430 |
| I/O (D0, DIN) | P71 | P117 | U3 | P151 | 433 |
| I/O, SGCK4 (DOUT) | P72 | P118 | T4 | P152 | 436 |
| CCLK | P73 | P119 | V1 | P153 | - |
| VCC | P74 | P120 | R4 | P154 | - |
| O, TDO | P75 | P121 | U2 | P159 | 0 |
| GND | P76 | P122 | R3 | P160 | - |
| I/O (A0, WS) | P77 | P123 | T3 | P161 | 2 |
| I/O, PGCK4 (A1) | P78 | P124 | U1 | P162 | 5 |
| I/O | - | P125 | P3 | P163 | 8 |
| I/O | - | P126 | R2 | P164 | 11 |
| I/O (CS1, A2) | P79 | P127 | T2 | P165 | 14 |
| I/O (A3) | P80 | P128 | N3 | P166 | 17 |
| I/O | - | P129 | P2 | P167 | 20 |
| I/O | - | P130 | T1 | P168 | 23 |
| GND | - | P131 | M3 | P171 | - |
| I/O | - | P132 | P1 | P172 | 26 |
| I/O | - | P133 | N1 | P173 | 29 |
| I/O (A4) | P81 | P134 | M2 | P174 | 32 |
| I/O (A5) | P82 | P135 | M1 | P175 | 35 |

| XC4008E Pad Name | PC84 | PQ160 | PG191 | PQ208 | Bndry Scan |
|---|---|---|---|---|---|
| I/O | - | - | L3 | P176 | 38 |
| I/O | - | P136 | L2 | P177 | 41 |
| I/O | - | P137 | L1 | P178 | 44 |
| I/O | - | P138 | K1 | P179 | 47 |
| I/O (A6) | P83 | P139 | K2 | P180 | 50 |
| I/O (A7) | P84 | P140 | K3 | P181 | 53 |
| GND | P1 | P141 | K4 | P182 | - |

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## Additional XC4008E Package Pins

**PG191**

| N.C. Pins | | | | | |
|---|---|---|---|---|---|
| A14 | B5 | B6 | B13 | D1 | D18 |
| F2 | F17 | N2 | N17 | R1 | R18 |
| V4 | V5 | V14 | V15 | - | - |

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**PQ208**

| N.C. Pins | | | | | |
|---|---|---|---|---|---|
| P1 | P3 | P12 | P13 | P38 | P39 |
| P51 | P52 | P53 | P54 | P65 | P66 |
| P91 | P92 | P102 | P104 | P105 | P107 |
| P117 | P118 | P143 | P144 | P155 | P156 |
| P157 | P158 | P169 | P170 | P195 | P196 |
| P206 | P207 | P208 | - | - | - |

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## Pin Locations for XC4010E/XL Devices

The following table may contain pinout information for unsupported device/package combinations. Please see the availability charts elsewhere in the XC4000 Series data sheet for availability information.

| XC4010E/XL Pad Name | PC84 | PQ 100†† | TQ 144†† | PQ 160 | TQ 176†† | PG 191† | PQ/HQ 208 | BG 225† | BG 256†† | Bndry Scan |
|---|---|---|---|---|---|---|---|---|---|---|
| VCC | P2 | P92 | P128 | P142 | P155 | VCC* | P183 | VCC* | VCC* | - |
| I/O (A8) | P3 | P93 | P129 | P143 | P156 | J3 | P184 | E8 | C10 | 62 |
| I/O (A9) | P4 | P94 | P130 | P144 | P157 | J2 | P185 | B7 | D10 | 65 |
| I/O (19) | - | P95 | P131 | P145 | P158 | J1 | P186 | A7 | A9 | 68 |
| I/O (18) | - | P96 | P132 | P146 | P159 | H1 | P187 | C7 | B9 | 71 |
| I/O | - | - | - | - | P160 | H2 | P188 | D7 | C9 | 74 |
| I/O | - | - | - | - | P161 | H3 | P189 | E7 | D9 | 77 |
| I/O (A10) | P5 | P97 | P133 | P147 | P162 | G1 | P190 | A6 | A8 | 80 |
| I/O (A11) | P6 | P98 | P134 | P148 | P163 | G2 | P191 | B6 | B8 | 83 |
| VCC | - | - | - | - | - | VCC* | - | VCC* | VCC* | - |
| I/O | - | - | P135 | P149 | P164 | F1 | P192 | A5 | B6 | 86 |
| I/O | - | - | P136 | P150 | P165 | E1 | P193 | B5 | A5 | 89 |
| GND | - | - | P137 | P151 | P166 | GND* | P194 | GND* | GND* | - |
| I/O | - | - | - | - | - | F2 | P195 | D6 | C6 | 92 |
| I/O | - | - | - | - | P167 | D1 | P196 | C5 | B5 | 95 |
| I/O | - | - | - | P152 | P168 | C1 | P197 | A4 | A4 | 98 |
| I/O | - | - | - | P153 | P169 | E2 | P198 | E6 | C5 | 101 |
| I/O (A12) | P7 | P99 | P138 | P154 | P170 | F3 | P199 | B4 | B4 | 104 |
| I/O (A13) | P8 | P100 | P139 | P155 | P171 | D2 | P200 | D5 | A3 | 107 |
| I/O | - | - | P140 | P156 | P172 | B1 | P201 | B3 | B3 | 110 |
| I/O | - | - | P141 | P157 | P173 | E3 | P202 | F6 | B2 | 113 |
| I/O (A14) | P9 | P1 | P142 | P158 | P174 | C2 | P203 | A2 | A2 | 116 |
| I/O, SGCK1 †, GCK8 †† (A15) | P10 | P2 | P143 | P159 | P175 | B2 | P204 | C3 | C3 | 119 |
| VCC | P11 | P3 | P144 | P160 | P176 | VCC* | P205 | VCC* | VCC* | - |
| GND | P12 | P4 | P1 | P1 | P1 | GND* | P2 | GND* | GND* | - |
| I/O, PGCK1†, GCK1†† (A16) | P13 | P5 | P2 | P2 | P2 | C3 | P4 | D4 | B1 | 122 |
| I/O (A17) | P14 | P6 | P3 | P3 | P3 | C4 | P5 | B1 | C2 | 125 |

| XC4010E/XL Pad Name | PC84 | PQ 100†† | TQ 144†† | PQ 160 | TQ 176†† | PG 191† | PQ/HQ 208 | BG 225† | BG 256†† | Bndry Scan |
|---|---|---|---|---|---|---|---|---|---|---|
| I/O | - | - | P4 | P4 | P4 | B3 | P6 | C2 | D2 | 128 |
| I/O | - | - | P5 | P5 | P5 | C5 | P7 | E5 | D3 | 131 |
| I/O, TDI | P15 | P7 | P6 | P6 | P6 | A2 | P8 | D3 | E4 | 134 |
| I/O, TCK | P16 | P8 | P7 | P7 | P7 | B4 | P9 | C1 | C1 | 137 |
| I/O | - | - | - | P8 | P8 | C6 | P10 | D2 | D1 | 140 |
| I/O | - | - | - | P9 | P9 | A3 | P11 | G6 | E3 | 143 |
| I/O | - | - | - | - | - | B5 | P12 | E4 | E2 | 146 |
| I/O | - | - | - | - | - | B6 | P13 | D1 | E1 | 149 |
| GND | - | - | P8 | P10 | P10 | GND* | P14 | GND* | GND* | - |
| I/O | - | - | P9 | P11 | P11 | A4 | P15 | F5 | G3 | 152 |
| I/O | - | - | P10 | P12 | P12 | A5 | P16 | E1 | G2 | 155 |
| I/O, TMS | P17 | P9 | P11 | P13 | P13 | B7 | P17 | F4 | G1 | 158 |
| I/O | P18 | P10 | P12 | P14 | P14 | A6 | P18 | F3 | H3 | 161 |
| VCC | - | - | - | - | - | VCC* | - | VCC* | VCC* | - |
| I/O | - | - | - | - | P15 | C8 | P19 | G4 | J2 | 164 |
| I/O | - | - | - | - | P16 | A7 | P20 | G3 | J1 | 167 |
| I/O | - | - | P13 | P15 | P17 | B8 | P21 | G2 | K2 | 170 |
| I/O | - | P11 | P14 | P16 | P18 | A8 | P22 | G1 | K3 | 173 |
| I/O | P19 | P12 | P15 | P17 | P19 | B9 | P23 | G5 | K1 | 176 |
| I/O | P20 | P13 | P16 | P18 | P20 | C9 | P24 | H3 | L1 | 179 |
| GND | P21 | P14 | P17 | P19 | P21 | GND* | P25 | GND* | GND* | - |
| VCC | P22 | P15 | P18 | P20 | P22 | VCC* | P26 | VCC* | VCC* | - |
| I/O | P23 | P16 | P19 | P21 | P23 | C10 | P27 | H4 | L2 | 182 |
| I/O | P24 | P17 | P20 | P22 | P24 | B10 | P28 | H5 | L3 | 185 |
| I/O | - | P18 | P21 | P23 | P25 | A9 | P29 | J2 | L4 | 188 |
| I/O | - | - | P22 | P24 | P26 | A10 | P30 | J1 | M1 | 191 |
| I/O | - | - | - | - | P27 | A11 | P31 | J3 | M2 | 194 |
| I/O | - | - | - | - | P28 | C11 | P32 | J4 | M3 | 197 |
| VCC | - | - | - | - | - | VCC* | - | VCC* | VCC* | - |
| I/O | P25 | P19 | P23 | P25 | P29 | B11 | P33 | K2 | P1 | 200 |
| I/O | P26 | P20 | P24 | P26 | P30 | A12 | P34 | K3 | P2 | 203 |

| XC4010E/XL Pad Name | PC 84 | PQ 100†† | TQ 144†† | PQ 160 | TQ 176†† | PG 191† | PQ/HQ 208 | BG 225† | BG 256†† | Bndry Scan |
|---|---|---|---|---|---|---|---|---|---|---|
| I/O | - | - | P25 | P27 | P31 | B12 | P35 | J6 | R1 | 206 |
| I/O | - | - | P26 | P28 | P32 | A13 | P36 | L1 | P3 | 209 |
| GND | - | - | P27 | P29 | P33 | GND* | P37 | GND* | GND* | - |
| I/O | - | - | - | - | - | B13 | P38 | L3 | T2 | 212 |
| I/O | - | - | - | - | - | A14 | P39 | M1 | U1 | 215 |
| I/O | - | - | - | P30 | P34 | A15 | P40 | K5 | T3 | 218 |
| I/O | - | - | - | P31 | P35 | C13 | P41 | M2 | U2 | 221 |
| I/O | P27 | P21 | P28 | P32 | P36 | B14 | P42 | L4 | V1 | 224 |
| I/O | - | P22 | P29 | P33 | P37 | A16 | P43 | N1 | T4 | 227 |
| I/O | - | - | P30 | P34 | P38 | B15 | P44 | M3 | U3 | 230 |
| I/O | - | - | P31 | P35 | P39 | C14 | P45 | N2 | V2 | 233 |
| I/O | P28 | P23 | P32 | P36 | P40 | A17 | P46 | K6 | W1 | 236 |
| I/O, SGCK2 †, GCK2 †† | P29 | P24 | P33 | P37 | P41 | B16 | P47 | P1 | V3 | 239 |
| O (M1) | P30 | P25 | P34 | P38 | P42 | C15 | P48 | N3 | W2 | 242 |
| GND | P31 | P26 | P35 | P39 | P43 | GND* | P49 | GND* | GND* | - |
| I (M0) | P32 | P27 | P36 | P40 | P44 | A18 | P50 | P2 | Y1 | 245 |
| VCC | P33 | P28 | P37 | P41 | P45 | VCC* | P55 | VCC* | VCC* | - |
| I (M2) | P34 | P29 | P38 | P42 | P46 | C16 | P56 | M4 | W3 | 246 |
| I/O, PGCK2 †, GCK3 †† | P35 | P30 | P39 | P43 | P47 | B17 | P57 | R2 | Y2 | 247 |
| I/O (HDC) | P36 | P31 | P40 | P44 | P48 | E16 | P58 | P3 | W4 | 250 |
| I/O | - | - | P41 | P45 | P49 | C17 | P59 | L5 | V4 | 253 |
| I/O | - | - | P42 | P46 | P50 | D17 | P60 | N4 | U5 | 256 |
| I/O | - | P32 | P43 | P47 | P51 | B18 | P61 | R3 | Y3 | 259 |
| I/O (LDC) | P37 | P33 | P44 | P48 | P52 | E17 | P62 | P4 | Y4 | 262 |
| I/O | - | - | - | P49 | P53 | F16 | P63 | K7 | V5 | 265 |
| I/O | - | - | - | P50 | P54 | C18 | P64 | M5 | W5 | 268 |
| I/O | - | - | - | - | - | D18 | P65 | R4 | Y5 | 271 |
| I/O | - | - | - | - | - | F17 | P66 | N5 | V6 | 274 |
| GND | - | - | P45 | P51 | P55 | GND* | P67 | GND* | GND* | - |
| I/O | - | - | P46 | P52 | P56 | E18 | P68 | R5 | W7 | 277 |
| I/O | - | - | P47 | P53 | P57 | F18 | P69 | M6 | Y7 | 280 |
| I/O | P38 | P34 | P48 | P54 | P58 | G17 | P70 | N6 | V8 | 283 |
| I/O | P39 | P35 | P49 | P55 | P59 | G18 | P71 | P6 | W8 | 286 |
| VCC | - | - | - | - | - | VCC* | - | VCC* | VCC* | - |
| I/O | - | - | - | - | P60 | H16 | P72 | R6 | Y8 | 289 |
| I/O | - | - | - | - | P61 | H17 | P73 | M7 | U9 | 292 |
| I/O | - | P36 | P50 | P56 | P62 | H18 | P74 | R7 | V10 | 295 |
| I/O | - | P37 | P51 | P57 | P63 | J18 | P75 | L7 | Y10 | 298 |
| I/O | P40 | P38 | P52 | P58 | P64 | J17 | P76 | N8 | Y11 | 301 |
| I/O (INIT) | P41 | P39 | P53 | P59 | P65 | J16 | P77 | P8 | W11 | 304 |
| VCC | P42 | P40 | P54 | P60 | P66 | VCC* | P78 | VCC* | VCC* | - |
| GND | P43 | P41 | P55 | P61 | P67 | GND* | P79 | GND* | GND* | - |
| I/O | P44 | P42 | P56 | P62 | P68 | K16 | P80 | L8 | V11 | 307 |
| I/O | P45 | P43 | P57 | P63 | P69 | K17 | P81 | P9 | U11 | 310 |
| I/O | - | P44 | P58 | P64 | P70 | K18 | P82 | R9 | Y12 | 313 |
| I/O | - | P45 | P59 | P65 | P71 | L18 | P83 | N9 | W12 | 316 |
| I/O | - | - | - | - | P72 | L17 | P84 | M9 | V12 | 319 |
| I/O | - | - | - | - | P73 | L16 | P85 | L9 | U12 | 322 |
| VCC | - | - | - | - | - | VCC* | - | VCC* | VCC* | - |
| I/O | P46 | P46 | P60 | P66 | P74 | M18 | P86 | N10 | Y15 | 325 |
| I/O | P47 | P47 | P61 | P67 | P75 | M17 | P87 | K9 | V14 | 328 |
| I/O | - | - | P62 | P68 | P76 | N18 | P88 | R11 | W15 | 331 |
| I/O | - | - | P63 | P69 | P77 | P18 | P89 | P11 | Y16 | 334 |
| GND | - | - | P64 | P70 | P78 | GND* | P90 | GND* | GND* | - |
| I/O | - | - | - | - | - | N17 | P91 | R12 | Y17 | 337 |
| I/O | - | - | - | - | - | R18 | P92 | L10 | V16 | 340 |
| I/O | - | - | - | P71 | P79 | T18 | P93 | P12 | W17 | 343 |
| I/O | - | - | - | P72 | P80 | P17 | P94 | M11 | Y18 | 346 |
| I/O | P48 | P48 | P65 | P73 | P81 | N16 | P95 | R13 | U16 | 349 |
| I/O | P49 | P49 | P66 | P74 | P82 | T17 | P96 | N12 | V17 | 352 |
| I/O | - | - | P67 | P75 | P83 | R17 | P97 | P13 | W18 | 355 |
| I/O | - | - | P68 | P76 | P84 | P16 | P98 | K10 | Y19 | 358 |
| I/O | - | P50 | P69 | P77 | P85 | U18 | P99 | R14 | V18 | 361 |
| I/O, SGCK3 †, GCK4 †† | P51 | P51 | P70 | P78 | P86 | T16 | P100 | N13 | W19 | 364 |
| GND | P52 | P52 | P71 | P79 | P87 | GND* | P101 | GND* | GND* | - |
| DONE | P53 | P53 | P72 | P80 | P88 | U17 | P103 | P14 | Y20 | - |
| VCC | P54 | P54 | P73 | P81 | P89 | VCC* | P106 | VCC* | VCC* | - |
| PROGRAM | P55 | P55 | P74 | P82 | P90 | V18 | P108 | M12 | V19 | - |
| I/O (D7) | P56 | P56 | P75 | P83 | P91 | T15 | P109 | P15 | U19 | 367 |
| I/O, PGCK3 †, GCK5 †† | P57 | P57 | P76 | P84 | P92 | U16 | P110 | N14 | U18 | 370 |

| XC4010E/XL Pad Name | PC 84 | PQ 100†† | TQ 144†† | PQ 160 | TQ 176†† | PG 191† | PQ/HQ 208 | BG 225† | BG 256†† | Bndry Scan |
|---|---|---|---|---|---|---|---|---|---|---|
| I/O | - | - | P77 | P85 | P93 | T14 | P111 | L11 | T17 | 373 |
| I/O | - | - | P78 | P86 | P94 | U15 | P112 | M13 | V20 | 376 |
| I/O (D6) | P58 | P58 | P79 | P87 | P95 | V17 | P113 | J10 | T19 | 379 |
| I/O | - | P59 | P80 | P88 | P96 | V16 | P114 | L12 | T20 | 382 |
| I/O | - | - | - | P89 | P97 | T13 | P115 | M15 | R18 | 385 |
| I/O | - | - | - | P90 | P98 | U14 | P116 | L13 | R19 | 388 |
| I/O | - | - | - | - | - | V15 | P117 | L14 | R20 | 391 |
| I/O | - | - | - | - | - | V14 | P118 | K11 | P18 | 394 |
| GND | - | - | P81 | P91 | P99 | GND* | P119 | GND* | GND* | - |
| I/O | - | - | P82 | P92 | P100 | U13 | P120 | K13 | N19 | 397 |
| I/O | - | - | P83 | P93 | P101 | V13 | P121 | K14 | N20 | 400 |
| VCC | - | - | - | - | - | VCC* | - | VCC* | VCC* | - |
| I/O (D5) | P59 | P60 | P84 | P94 | P102 | U12 | P122 | K15 | M17 | 403 |
| I/O (CS0) | P60 | P61 | P85 | P95 | P103 | V12 | P123 | J12 | M18 | 406 |
| I/O | - | - | - | - | P104 | T11 | P124 | J13 | M20 | 409 |
| I/O | - | - | - | - | P105 | U11 | P125 | J14 | L19 | 412 |
| I/O | - | P62 | P86 | P96 | P106 | V11 | P126 | J15 | L18 | 415 |
| I/O | - | P63 | P87 | P97 | P107 | V10 | P127 | J11 | L20 | 418 |
| I/O (D4) | P61 | P64 | P88 | P98 | P108 | U10 | P128 | H13 | K20 | 421 |
| I/O | P62 | P65 | P89 | P99 | P109 | T10 | P129 | H14 | K19 | 424 |
| VCC | P63 | P66 | P90 | P100 | P110 | VCC* | P130 | VCC* | VCC* | - |
| GND | P64 | P67 | P91 | P101 | P111 | GND* | P131 | GND* | GND* | - |
| I/O (D3) | P65 | P68 | P92 | P102 | P112 | T9 | P132 | H12 | K18 | 427 |
| I/O (RS) | P66 | P69 | P93 | P103 | P113 | U9 | P133 | H11 | K17 | 430 |
| I/O | - | P70 | P94 | P104 | P114 | V9 | P134 | G14 | J20 | 433 |
| I/O | - | - | P95 | P105 | P115 | V8 | P135 | G15 | J19 | 436 |
| I/O | - | - | - | - | P116 | U8 | P136 | G13 | J18 | 439 |
| I/O | - | - | - | - | P117 | T8 | P137 | G12 | J17 | 442 |
| I/O (D2) | P67 | P71 | P96 | P106 | P118 | V7 | P138 | G11 | H19 | 445 |
| I/O | P68 | P72 | P97 | P107 | P119 | U7 | P139 | F15 | H18 | 448 |
| VCC | - | - | - | - | - | VCC* | - | VCC* | VCC* | - |
| I/O | - | - | P98 | P108 | P120 | V6 | P140 | F14 | G19 | 451 |
| I/O | - | - | P99 | P109 | P121 | U6 | P141 | F13 | F20 | 454 |
| GND | - | - | P100 | P110 | P122 | GND* | P142 | GND* | GND* | - |
| I/O | - | - | - | - | - | V5 | P143 | E13 | D20 | 457 |
| I/O | - | - | - | - | - | V4 | P144 | D15 | E18 | 460 |
| I/O | - | - | - | P111 | P123 | U5 | P145 | F11 | D19 | 463 |
| I/O | - | - | - | P112 | P124 | T6 | P146 | D14 | C20 | 466 |
| I/O (D1) | P69 | P73 | P101 | P113 | P125 | V3 | P147 | E12 | E17 | 469 |
| I/O (RCLK, RDY/BUSY) | P70 | P74 | P102 | P114 | P126 | V2 | P148 | C15 | D18 | 472 |
| I/O | - | - | P103 | P115 | P127 | U4 | P149 | D13 | C19 | 475 |
| I/O | - | - | P104 | P116 | P128 | T5 | P150 | C14 | B20 | 478 |
| I/O (D0, DIN) | P71 | P75 | P105 | P117 | P129 | U3 | P151 | F10 | C18 | 481 |
| I/O, SGCK4 †, GCK6 †† (DOUT) | P72 | P76 | P106 | P118 | P130 | T4 | P152 | B15 | B19 | 484 |
| CCLK | P73 | P77 | P107 | P119 | P131 | V1 | P153 | C13 | A20 | - |
| VCC | P74 | P78 | P108 | P120 | P132 | VCC* | P154 | VCC* | VCC* | - |
| O, TDO | P75 | P79 | P109 | P121 | P133 | U2 | P159 | A15 | A19 | 0 |
| GND | P76 | P80 | P110 | P122 | P134 | GND* | P160 | GND* | GND* | - |
| I/O (A0, WS) | P77 | P81 | P111 | P123 | P135 | T3 | P161 | A14 | B18 | 2 |
| I/O, PGCK4 †, GCK7 †† (A1) | P78 | P82 | P112 | P124 | P136 | U1 | P162 | B13 | B17 | 5 |
| I/O | - | - | P113 | P125 | P137 | P3 | P163 | E11 | C17 | 8 |
| I/O | - | - | P114 | P126 | P138 | R2 | P164 | C12 | D16 | 11 |
| I/O (CS1, A2) | P79 | P83 | P115 | P127 | P139 | T2 | P165 | A13 | A18 | 14 |
| I/O (A3) | P80 | P84 | P116 | P128 | P140 | N3 | P166 | B12 | A17 | 17 |
| I/O | - | - | P117 | P129 | P141 | P2 | P167 | A12 | A16 | 20 |
| I/O | - | - | - | P130 | P142 | T1 | P168 | C11 | C15 | 23 |
| I/O | - | - | - | - | - | R1 | P169 | B11 | B15 | 26 |
| I/O | - | - | - | - | - | N2 | P170 | E10 | A15 | 29 |
| GND | - | - | P118 | P131 | P143 | GND* | P171 | GND* | GND* | - |
| I/O | - | - | P119 | P132 | P144 | P1 | P172 | A11 | B14 | 32 |
| I/O | - | - | P120 | P133 | P145 | N1 | P173 | D10 | A14 | 35 |
| VCC | - | - | - | - | - | VCC* | - | VCC* | VCC* | - |
| I/O (A4) | P81 | P85 | P121 | P134 | P146 | M2 | P174 | A10 | C12 | 38 |
| I/O (A5) | P82 | P86 | P122 | P135 | P147 | M1 | P175 | D9 | B12 | 41 |
| I/O | - | - | - | - | P148 | L3 | P176 | C9 | A12 | 44 |
| I/O | - | - | - | P136 | P149 | L2 | P177 | B9 | B11 | 47 |
| I/O (A21)†† | - | P87 | P123 | P137 | P150 | L1 | P178 | A9 | C11 | 50 |
| I/O (A20)†† | - | P88 | P124 | P138 | P151 | K1 | P179 | E9 | A11 | 53 |
| I/O (A6) | P83 | P89 | P125 | P139 | P152 | K2 | P180 | C8 | A10 | 56 |
| I/O (A7) | P84 | P90 | P126 | P140 | P153 | K3 | P181 | B8 | B10 | 59 |

| XC4010E/XL Pad Name | PC 84 | PQ 100†† | TQ 144†† | PQ 160 | TQ 176†† | PG 191† | PQ/ HQ 208 | BG 225† | BG 256†† | Bndry Scan |
|---|---|---|---|---|---|---|---|---|---|---|
| GND | P1 | P91 | P127 | P141 | P154 | GND* | P182 | GND* | GND* | - |

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\* Pads labelled GND\* or VCC\* are internally bonded to Ground or VCC planes within the package. They have no direct connection to any specific package pin.

† = E only

†† = XL only

## Additional XC4010E/XL Package Pins

### PQ/HQ208

| N.C. Pins | | | | | | |
|---|---|---|---|---|---|---|
| P1 | P3 | P51 | P52 | P53 | P54 | P102 |
| P104 | P105 | P107 | P155 | P156 | P157 | P158 |
| P206 | P207 | P208 | - | - | - | - |

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### PG191

| VCC Pins | | | | | | |
|---|---|---|---|---|---|---|
| D3 | D10 | D16 | J4 | J15 | R4 | R10 |
| R15 | - | - | - | - | - | - |
| **GND Pins** | | | | | | |
| C7 | C12 | D4 | D9 | D15 | G3 | G16 |
| K4 | K15 | M3 | M16 | R3 | R9 | R16 |
| T7 | T12 | - | - | - | - | - |

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### BG225

| VCC Pins | | | | | | |
|---|---|---|---|---|---|---|
| B2 | B14 | D8 | H1 | H15 | R1 | R8 |
| R15 | - | - | - | - | - | - |
| **GND Pins** | | | | | | |
| A1 | A8 | D12 | F8 | G7 | G8 | G9 |
| H2 | H6 | H7 | H8 | H9 | H10 | J7 |
| J8 | J9 | K8 | M8 | - | - | - |
| **N.C. Pins** | | | | | | |
| A3 | B10 | C4 | C6 | C10 | D11 | E2 |
| E3 | E14 | E15 | F1 | F2 | F7 | F9 |
| F12 | G10 | J5 | K1 | K4 | K12 | L2 |
| L6 | L15 | M10 | M14 | N7 | N11 | N15 |
| P5 | P7 | P10 | R10 | - | - | - |

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### BG256

| VCC Pins | | | | | | |
|---|---|---|---|---|---|---|
| C14 | D6 | D7 | D11 | D14 | D15 | E20 |
| F1 | F4 | F17 | G4 | G17 | K4 | L17 |
| P4 | P17 | P19 | R2 | R4 | R17 | U6 |
| U7 | U10 | U14 | U15 | V7 | W20 | - |
| **GND Pins** | | | | | | |
| A1 | B7 | D4 | D8 | D13 | D17 | G20 |
| H4 | H17 | N3 | N4 | N17 | U4 | U8 |
| U13 | U17 | W14 | - | - | - | - |
| **N.C. Pins** | | | | | | |
| A6 | A7 | A13 | B13 | B16 | C4 | C7 |
| C8 | C13 | C16 | D5 | D12 | E19 | F2 |
| F3 | F18 | F19 | G18 | H1 | H2 | H20 |
| J3 | J4 | M4 | M19 | N1 | N2 | N18 |
| P20 | R3 | T1 | T18 | U20 | V9 | V13 |
| V15 | W6 | W9 | W10 | W13 | W16 | Y6 |
| Y9 | Y13 | Y14 | - | - | - | - |

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## Pin Locations for XC4013E/XL Devices

The following table may contain pinout information for unsupported device/package combinations. Please see the availability charts elsewhere in the XC4000 Series data sheet for availability information.

| XC4013E /XL Pad Name | HT 144†† | PQ 160 | HT 176†† | PQ/HQ 208 | PG 223† | BG 225† | PQ/ HQ 240 | BG 256†† | Bndry Scan |
|---|---|---|---|---|---|---|---|---|---|
| VCC | P128 | P142 | P155 | P183 | VCC* | VCC* | P212 | VCC* | - |
| I/O (A8) | P129 | P143 | P156 | P184 | J3 | E8 | P213 | C10 | 74 |
| I/O (A9) | P130 | P144 | P157 | P185 | J2 | B7 | P214 | D10 | 77 |
| I/O (A19) †† | P131 | P145 | P158 | P186 | J1 | A7 | P215 | A9 | 80 |
| I/O (A18) †† | P132 | P146 | P159 | P187 | H1 | C7 | P216 | B9 | 83 |
| I/O | - | - | P160 | P188 | H2 | D7 | P217 | C9 | 86 |
| I/O | - | - | P161 | P189 | H3 | E7 | P218 | D9 | 89 |
| I/O (A10) | P133 | P147 | P162 | P190 | G1 | A6 | P220 | A8 | 92 |
| I/O (A11) | P134 | P148 | P163 | P191 | G2 | B6 | P221 | B8 | 95 |
| VCC | - | - | - | - | VCC* | VCC* | P222 | VCC* | - |
| I/O | - | - | - | - | H4 | C6 | P223 | A6 | 98 |
| I/O | - | - | - | - | G4 | F7 | P224 | C7 | 101 |
| I/O | P135 | P149 | P164 | P192 | F1 | A5 | P225 | B6 | 104 |
| I/O | P136 | P150 | P165 | P193 | E1 | B5 | P226 | A5 | 107 |
| GND | P137 | P151 | P166 | P194 | GND* | GND* | P227 | GND* | - |
| I/O | - | - | - | P195 | F2 | D6 | P228 | C6 | 110 |
| I/O | - | - | P167 | P196 | D1 | C5 | P229 | B5 | 113 |
| I/O | - | P152 | P168 | P197 | C1 | A4 | P230 | A4 | 116 |
| I/O | - | P153 | P169 | P198 | E2 | E6 | P231 | C5 | 119 |
| I/O (A12) | P138 | P154 | P170 | P199 | F3 | B4 | P232 | B4 | 122 |
| I/O (A13) | P139 | P155 | P171 | P200 | D2 | D5 | P233 | A3 | 125 |
| I/O | - | - | - | - | F4 | A3 | P234 | D5 | 128 |
| I/O | - | - | - | - | E4 | C4 | P235 | C4 | 131 |
| I/O | P140 | P156 | P172 | P201 | B1 | B3 | P236 | B3 | 134 |
| I/O | P141 | P157 | P173 | P202 | E3 | F6 | P237 | B2 | 137 |

| XC4013E /XL Pad Name | HT 144†† | PQ 160 | HT 176†† | PQ/HQ 208 | PG 223† | BG 225† | PQ/ HQ 240 | BG 256†† | Bndry Scan |
|---|---|---|---|---|---|---|---|---|---|
| I/O (A14) | P142 | P158 | P174 | P203 | C2 | A2 | P238 | A2 | 140 |
| I/O, SGCK1 †, GCK8 †† (A15) | P143 | P159 | P175 | P204 | B2 | C3 | P239 | C3 | 143 |
| VCC | P144 | P160 | P176 | P205 | VCC* | VCC* | P240 | VCC* | - |
| GND | P1 | P1 | P1 | P2 | GND* | GND* | P1 | GND* | - |
| I/O, PGCK1 †, GCK1 †† (A16) | P2 | P2 | P2 | P4 | C3 | D4 | P2 | B1 | 146 |
| I/O (A17) | P3 | P3 | P3 | P5 | C4 | B1 | P3 | C2 | 149 |
| I/O | P4 | P4 | P4 | P6 | B3 | C2 | P4 | D2 | 152 |
| I/O | P5 | P5 | P5 | P7 | C5 | E5 | P5 | D3 | 155 |
| I/O, TDI | P6 | P6 | P6 | P8 | A2 | D3 | P6 | E4 | 158 |
| I/O, TCK | P7 | P7 | P7 | P9 | B4 | C1 | P7 | C1 | 161 |
| I/O | - | P8 | P8 | P10 | C6 | D2 | P8 | D1 | 164 |
| I/O | - | P9 | P9 | P11 | A3 | G6 | P9 | E3 | 167 |
| I/O | - | - | - | P12 | B5 | E4 | P10 | E2 | 170 |
| I/O | - | - | - | P13 | B6 | D1 | P11 | E1 | 173 |
| I/O | - | - | - | - | D5 | E3 | P12 | F3 | 176 |
| I/O | - | - | - | - | D6 | E2 | P13 | F2 | 179 |
| GND | P8 | P10 | P10 | P14 | GND* | GND* | P14 | GND* | - |
| I/O | P9 | P11 | P11 | P15 | A4 | F5 | P15 | G3 | 182 |
| I/O | P10 | P12 | P12 | P16 | A5 | E1 | P16 | G2 | 185 |
| I/O, TMS | P11 | P13 | P13 | P17 | B7 | F4 | P17 | G1 | 188 |
| I/O | P12 | P14 | P14 | P18 | A6 | F3 | P18 | H3 | 191 |
| VCC | - | - | - | - | VCC* | VCC* | P19 | VCC* | - |

| XC4013E/XL Pad Name | HT 144†† | PQ 160 | HT 176†† | PQ/HQ 208 | PG 223† | BG 225† | PQ/HQ 240 | BG 256†† | Bndry Scan |
|---|---|---|---|---|---|---|---|---|---|
| I/O | - | - | - | - | D7 | F2 | P20 | H2 | 194 |
| I/O | - | - | - | - | D8 | F1 | P21 | H1 | 197 |
| I/O | - | - | P15 | P19 | C8 | G4 | P23 | J2 | 200 |
| I/O | - | - | P16 | P20 | A7 | G3 | P24 | J1 | 203 |
| I/O | P13 | P15 | P17 | P21 | B8 | G2 | P25 | K2 | 206 |
| I/O | P14 | P16 | P18 | P22 | A8 | G1 | P26 | K3 | 209 |
| I/O | P15 | P17 | P19 | P23 | B9 | G5 | P27 | K1 | 212 |
| I/O | P16 | P18 | P20 | P24 | C9 | H3 | P28 | L1 | 215 |
| GND | P17 | P19 | P21 | P25 | GND* | GND* | P29 | GND* | - |
| VCC | P18 | P20 | P22 | P26 | VCC* | VCC* | P30 | VCC* | - |
| I/O | P19 | P21 | P23 | P27 | C10 | H4 | P31 | L2 | 218 |
| I/O | P20 | P22 | P24 | P28 | B10 | H5 | P32 | L3 | 221 |
| I/O | P21 | P23 | P25 | P29 | A9 | J2 | P33 | L4 | 224 |
| I/O | P22 | P24 | P26 | P30 | A10 | J1 | P34 | M1 | 227 |
| I/O | - | - | P27 | P31 | A11 | J3 | P35 | M2 | 230 |
| I/O | - | - | P28 | P32 | C11 | J4 | P36 | M3 | 233 |
| I/O | - | - | - | - | D11 | J5 | P38 | N1 | 236 |
| I/O | - | - | - | - | D12 | K1 | P39 | N2 | 239 |
| VCC | - | - | - | - | VCC* | VCC* | P40 | VCC* | - |
| I/O | P23 | P25 | P29 | P33 | B11 | K2 | P41 | P1 | 242 |
| I/O | P24 | P26 | P30 | P34 | A12 | K3 | P42 | P2 | 245 |
| I/O | P25 | P27 | P31 | P35 | B12 | J6 | P43 | R1 | 248 |
| I/O | P26 | P28 | P32 | P36 | A13 | L1 | P44 | P3 | 251 |
| GND | P27 | P29 | P33 | P37 | GND* | GND* | P45 | GND* | - |
| I/O | - | - | - | - | D13 | L2 | P46 | T1 | 254 |
| I/O | - | - | - | - | D14 | K4 | P47 | R3 | 257 |
| I/O | - | - | - | P38 | B13 | L3 | P48 | T2 | 260 |
| I/O | - | - | - | P39 | A14 | M1 | P49 | U1 | 263 |
| I/O | - | P30 | P34 | P40 | A15 | K5 | P50 | T3 | 266 |
| I/O | - | P31 | P35 | P41 | C13 | M2 | P51 | U2 | 269 |
| I/O | P28 | P32 | P36 | P42 | B14 | L4 | P52 | V1 | 272 |
| I/O | P29 | P33 | P37 | P43 | A16 | N1 | P53 | T4 | 275 |
| I/O | P30 | P34 | P38 | P44 | B15 | M3 | P54 | U3 | 278 |
| I/O | P31 | P35 | P39 | P45 | C14 | N2 | P55 | V2 | 281 |
| I/O | P32 | P36 | P40 | P46 | A17 | K6 | P56 | W1 | 284 |
| I/O, SGCK2 †, GCK2 †† | P33 | P37 | P41 | P47 | B16 | P1 | P57 | V3 | 287 |
| O (M1) | P34 | P38 | P42 | P48 | C15 | N3 | P58 | W2 | 290 |
| GND | P35 | P39 | P43 | P49 | GND* | GND* | P59 | GND* | - |
| I (M0) | P36 | P40 | P44 | P50 | A18 | P2 | P60 | Y1 | 293 |
| VCC | P37 | P41 | P45 | P55 | VCC* | VCC* | P61 | VCC* | - |
| I (M2) | P38 | P42 | P46 | P56 | C16 | M4 | P62 | W3 | 294 |
| I/O, PGCK2 †, GCK3 †† | P39 | P43 | P47 | P57 | B17 | R2 | P63 | Y2 | 295 |
| I/O (HDC) | P40 | P44 | P48 | P58 | E16 | P3 | P64 | W4 | 298 |
| I/O | P41 | P45 | P49 | P59 | C17 | L5 | P65 | V4 | 301 |
| I/O | P42 | P46 | P50 | P60 | D17 | N4 | P66 | U5 | 304 |
| I/O | P43 | P47 | P51 | P61 | B18 | R3 | P67 | Y3 | 307 |
| I/O (LDC) | P44 | P48 | P52 | P62 | E17 | P4 | P68 | Y4 | 310 |
| I/O | - | P49 | P53 | P63 | F16 | K7 | P69 | V5 | 313 |
| I/O | - | P50 | P54 | P64 | C18 | M5 | P70 | W5 | 316 |
| I/O | - | - | - | P65 | D18 | R4 | P71 | Y5 | 319 |
| I/O | - | - | - | P66 | F17 | N5 | P72 | V6 | 322 |
| I/O | - | - | - | - | E15 | P5 | P73 | W6 | 325 |
| I/O | - | - | - | - | F15 | L6 | P74 | Y6 | 328 |
| GND | P45 | P51 | P55 | P67 | GND* | GND* | P75 | GND* | - |
| I/O | P46 | P52 | P56 | P68 | E18 | R5 | P76 | W7 | 331 |
| I/O | P47 | P53 | P57 | P69 | F18 | M6 | P77 | Y7 | 334 |
| I/O | P48 | P54 | P58 | P70 | G17 | N6 | P78 | V8 | 337 |
| I/O | P49 | P55 | P59 | P71 | G18 | P6 | P79 | W8 | 340 |
| VCC | - | - | - | - | VCC* | VCC* | P80 | VCC* | - |
| I/O | - | - | P60 | P72 | H16 | R6 | P81 | Y8 | 343 |
| I/O | - | - | P61 | P73 | H17 | M7 | P82 | U9 | 346 |
| I/O | - | - | - | - | G15 | N7 | P84 | Y9 | 349 |
| I/O | - | - | - | - | H15 | P7 | P85 | W10 | 352 |
| I/O | P50 | P56 | P62 | P74 | H18 | R7 | P86 | V10 | 355 |
| I/O | P51 | P57 | P63 | P75 | J18 | L7 | P87 | Y10 | 358 |
| I/O | P52 | P58 | P64 | P76 | J17 | N8 | P88 | Y11 | 361 |
| I/O (INIT) | P53 | P59 | P65 | P77 | J16 | P8 | P89 | W11 | 364 |
| VCC | P54 | P60 | P66 | P78 | VCC* | VCC* | P90 | VCC* | - |
| GND | P55 | P61 | P67 | P79 | GND* | GND* | P91 | GND* | - |
| I/O | P56 | P62 | P68 | P80 | K16 | L8 | P92 | V11 | 367 |
| I/O | P57 | P63 | P69 | P81 | K17 | P9 | P93 | U11 | 370 |
| I/O | P58 | P64 | P70 | P82 | K18 | R9 | P94 | Y12 | 373 |
| I/O | P59 | P65 | P71 | P83 | L18 | N9 | P95 | W12 | 376 |
| I/O | - | - | P72 | P84 | L17 | M9 | P96 | V12 | 379 |
| I/O | - | - | P73 | P85 | L16 | L9 | P97 | U12 | 382 |
| I/O | - | - | - | - | L15 | R10 | P99 | V13 | 385 |
| I/O | - | - | - | - | M15 | P10 | P100 | Y14 | 388 |
| VCC | - | - | - | - | VCC* | VCC* | P101 | VCC* | - |
| I/O | P60 | P66 | P74 | P86 | M18 | N10 | P102 | Y15 | 391 |
| I/O | P61 | P67 | P75 | P87 | M17 | K9 | P103 | V14 | 394 |
| I/O | P62 | P68 | P76 | P88 | N18 | R11 | P104 | W15 | 397 |
| I/O | P63 | P69 | P77 | P89 | P18 | P11 | P105 | Y16 | 400 |
| GND | P64 | P70 | P78 | P90 | GND* | GND* | P106 | GND* | - |
| I/O | - | - | - | - | N15 | M10 | P107 | V15 | 403 |
| I/O | - | - | - | - | P15 | N11 | P108 | W16 | 406 |
| I/O | - | - | - | P91 | N17 | R12 | P109 | V16 | 409 |
| I/O | - | - | - | P92 | R18 | L10 | P110 | V16 | 412 |
| I/O | - | P71 | P79 | P93 | T18 | P12 | P111 | W17 | 415 |
| I/O | - | P72 | P80 | P94 | P17 | M11 | P112 | Y18 | 418 |
| I/O | P65 | P73 | P81 | P95 | N16 | R13 | P113 | U16 | 421 |
| I/O | P66 | P74 | P82 | P96 | T17 | N12 | P114 | V17 | 424 |
| I/O | P67 | P75 | P83 | P97 | R17 | P13 | P115 | W18 | 427 |
| I/O | P68 | P76 | P84 | P98 | P16 | K10 | P116 | Y19 | 430 |
| I/O | P69 | P77 | P85 | P99 | U18 | R14 | P117 | V18 | 433 |
| I/O, SGCK3 †, GCK4 †† | P70 | P78 | P86 | P100 | T16 | N13 | P118 | W19 | 436 |
| GND | P71 | P79 | P87 | P101 | GND* | GND* | P119 | GND* | - |
| DONE | P72 | P80 | P88 | P103 | U17 | P14 | P120 | Y20 | - |
| VCC | P73 | P81 | P89 | P106 | VCC* | VCC* | P121 | VCC* | - |
| PRO-GRAM | P74 | P82 | P90 | P108 | V18 | M12 | P122 | V19 | - |
| I/O (D7) | P75 | P83 | P91 | P109 | T15 | P15 | P123 | U19 | 439 |
| I/O, PGCK3 †, GCK5 †† | P76 | P84 | P92 | P110 | U16 | N14 | P124 | U18 | 442 |
| I/O | P77 | P85 | P93 | P111 | T14 | L11 | P125 | T17 | 445 |
| I/O | P78 | P86 | P94 | P112 | U15 | M13 | P126 | V20 | 448 |
| I/O | - | - | - | - | R14 | N15 | P127 | U20 | 451 |
| I/O | - | - | - | - | R13 | M14 | P128 | T18 | 454 |
| I/O (D6) | P79 | P87 | P95 | P113 | V17 | J10 | P129 | T19 | 457 |
| I/O | P80 | P88 | P96 | P114 | V16 | L12 | P130 | T20 | 460 |
| I/O | - | P89 | P97 | P115 | T13 | M15 | P131 | R18 | 463 |
| I/O | - | P90 | P98 | P116 | U14 | L13 | P132 | R19 | 466 |
| I/O | - | - | - | P117 | V15 | L14 | P133 | R20 | 469 |
| I/O | - | - | - | P118 | V14 | K11 | P134 | P18 | 472 |
| GND | P81 | P91 | P99 | P119 | GND* | GND* | P135 | GND* | - |
| I/O | - | - | - | - | R12 | L15 | P136 | P20 | 475 |
| I/O | - | - | - | - | R11 | K12 | P137 | N18 | 478 |
| I/O | P82 | P92 | P100 | P120 | U13 | K13 | P138 | N19 | 481 |
| I/O | P83 | P93 | P101 | P121 | V13 | K14 | P139 | N20 | 484 |
| VCC | - | - | - | - | VCC* | VCC* | P140 | VCC* | - |
| I/O (D5) | P84 | P94 | P102 | P122 | U12 | K15 | P141 | M17 | 487 |
| I/O (CS0) | P85 | P95 | P103 | P123 | V12 | J12 | P142 | M18 | 490 |
| I/O | - | - | P104 | P124 | T11 | J13 | P144 | M20 | 493 |
| I/O | - | - | P105 | P125 | U11 | J14 | P145 | L19 | 496 |
| I/O | P86 | P96 | P106 | P126 | V11 | J15 | P146 | L18 | 499 |
| I/O | P87 | P97 | P107 | P127 | V10 | J11 | P147 | L20 | 502 |
| I/O (D4) | P88 | P98 | P108 | P128 | U10 | H13 | P148 | K20 | 505 |
| I/O | P89 | P99 | P109 | P129 | T10 | H14 | P149 | K19 | 508 |
| VCC | P90 | P100 | P110 | P130 | VCC* | VCC* | P150 | VCC* | - |
| GND | P91 | P101 | P111 | P131 | GND* | GND* | P151 | GND* | - |
| I/O (D3) | P92 | P102 | P112 | P132 | T9 | H12 | P152 | K18 | 511 |
| I/O (RS) | P93 | P103 | P113 | P133 | U9 | H11 | P153 | K17 | 514 |
| I/O | P94 | P104 | P114 | P134 | V9 | G14 | P154 | J20 | 517 |
| I/O | P95 | P105 | P115 | P135 | V8 | G15 | P155 | J19 | 520 |
| I/O | - | - | P116 | P136 | U8 | G13 | P156 | J18 | 523 |
| I/O | - | - | P117 | P137 | T8 | G12 | P157 | J17 | 526 |
| I/O (D2) | P96 | P106 | P118 | P138 | V7 | G11 | P159 | H19 | 529 |
| I/O | P97 | P107 | P119 | P139 | U7 | F15 | P160 | H18 | 532 |
| VCC | - | - | - | - | VCC* | VCC* | P161 | VCC* | - |
| I/O | P98 | P108 | P120 | P140 | V6 | F14 | P162 | G19 | 535 |
| I/O | P99 | P109 | P121 | P141 | U6 | F13 | P163 | F20 | 538 |
| I/O | - | - | - | - | R8 | G10 | P164 | G18 | 541 |

| XC4013E /XL Pad Name | HT 144†† | PQ 160 | HT 176†† | PQ/HQ 208 | PG 223† | BG 225† | PQ/ HQ 240 | BG 256†† | Bndry Scan |
|---|---|---|---|---|---|---|---|---|---|
| I/O | - | - | - | - | R7 | E15 | P165 | F19 | 544 |
| GND | P100 | P110 | P122 | P142 | GND* | GND* | P166 | GND* | - |
| I/O | - | - | - | - | R6 | E14 | P167 | F18 | 547 |
| I/O | - | - | - | - | R5 | F12 | P168 | E19 | 550 |
| I/O | - | - | - | P143 | V5 | E13 | P169 | D20 | 553 |
| I/O | - | - | - | P144 | V4 | D15 | P170 | E18 | 556 |
| I/O | - | P111 | P123 | P145 | U5 | F11 | P171 | D19 | 559 |
| I/O | - | P112 | P124 | P146 | T6 | D14 | P172 | C20 | 562 |
| I/O (D1) | P101 | P113 | P125 | P147 | V3 | E12 | P173 | E17 | 565 |
| I/O (RCLK, RDY/ BUSY) | P102 | P114 | P126 | P148 | V2 | C15 | P174 | D18 | 568 |
| I/O | P103 | P115 | P127 | P149 | U4 | D13 | P175 | C19 | 571 |
| I/O | P104 | P116 | P128 | P150 | T5 | C14 | P176 | B20 | 574 |
| I/O (D0, DIN) | P105 | P117 | P129 | P151 | U3 | F10 | P177 | C18 | 577 |
| I/O, SGCK4 †, GCK6 †† (DOUT) | P106 | P118 | P130 | P152 | T4 | B15 | P178 | B19 | 580 |
| CCLK | P107 | P119 | P131 | P153 | V1 | C13 | P179 | A20 | - |
| VCC | P108 | P120 | P132 | P154 | VCC* | VCC* | P180 | VCC* | - |
| O, TDO | P109 | P121 | P133 | P159 | U2 | A15 | P181 | A19 | 0 |
| GND | P110 | P122 | P134 | P160 | GND* | GND* | P182 | GND* | - |
| I/O (A0, WS) | P111 | P123 | P135 | P161 | T3 | A14 | P183 | B18 | 2 |
| I/O, PGCK4 †, GCK7 †† (A1) | P112 | P124 | P136 | P162 | U1 | B13 | P184 | B17 | 5 |
| I/O | P113 | P125 | P137 | P163 | P3 | E11 | P185 | C17 | 8 |
| I/O | P114 | P126 | P138 | P164 | R2 | C12 | P186 | D16 | 11 |
| I/O (CS1, A2) | P115 | P127 | P139 | P165 | T2 | A13 | P187 | A18 | 14 |
| I/O (A3) | P116 | P128 | P140 | P166 | N3 | B12 | P188 | A17 | 17 |
| I/O | - | - | - | - | P4 | F9 | P189 | C16 | 20 |
| I/O | - | - | - | - | N4 | D11 | P190 | B16 | 23 |
| I/O | P117 | P129 | P141 | P167 | P2 | A12 | P191 | A16 | 26 |
| I/O | - | P130 | P142 | P168 | T1 | C11 | P192 | C15 | 29 |
| I/O | - | - | - | P169 | R1 | B11 | P193 | B15 | 32 |
| I/O | - | - | - | P170 | N2 | E10 | P194 | A15 | 35 |
| GND | P118 | P131 | P143 | P171 | GND* | GND* | P196 | GND* | - |
| I/O | P119 | P132 | P144 | P172 | P1 | A11 | P197 | B14 | 38 |
| I/O | P120 | P133 | P145 | P173 | N1 | D10 | P198 | A14 | 41 |
| I/O | - | - | - | - | M4 | C10 | P199 | C13 | 44 |
| I/O | - | - | - | - | L4 | B10 | P200 | B13 | 47 |
| VCC | - | - | - | - | VCC* | VCC* | P201 | VCC* | - |
| I/O (A4) | P121 | P134 | P146 | P174 | M2 | A10 | P202 | C12 | 50 |
| I/O (A5) | P122 | P135 | P147 | P175 | M1 | D9 | P203 | B12 | 53 |
| I/O | - | - | P148 | P176 | L3 | C9 | P205 | A12 | 56 |
| I/O | - | P136 | P149 | P177 | L2 | B9 | P206 | B11 | 59 |
| I/O (A21) †† | P123 | P137 | P150 | P178 | L1 | A9 | P207 | C11 | 62 |
| I/O (A20) †† | P124 | P138 | P151 | P179 | K1 | E9 | P208 | A11 | 65 |
| I/O (A6) | P125 | P139 | P152 | P180 | K2 | C8 | P209 | A10 | 68 |
| I/O (A7) | P126 | P140 | P153 | P181 | K3 | B8 | P210 | B10 | 71 |
| GND | P127 | P141 | P154 | P182 | GND* | GND* | P211 | GND* | - |

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\* Pads labelled GND* or VCC* are internally bonded to Ground or VCC planes within the package. They have no direct connection to any specific package pin.

† = E only, †† = XL only

## Additional XC4013E/XL Package Pins

**PQ/HQ208**

| N.C. Pins | | | | | |
|---|---|---|---|---|---|
| P1 | P3 | P51 | P52 | P53 | P54 |
| P102 | P104 | P105 | P107 | P155 | P156 |
| P157 | P158 | P206 | P207 | P208 | - |

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**PG223**

| VCC Pins | | | | | |
|---|---|---|---|---|---|
| D3 | D10 | D16 | J4 | J15 | R4 |
| R10 | R15 | - | - | - | - |
| **GND Pins** | | | | | |
| C7 | C12 | D4 | D9 | D15 | G3 |
| G16 | K4 | K15 | M3 | M16 | R3 |
| R9 | R16 | T7 | T12 | - | - |

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**BG225**

| VCC Pins | | | | |
|---|---|---|---|---|
| B2 | B14 | D8 | H1 | H15 |
| R1 | R8 | R15 | - | - |
| **GND Pins** | | | | |
| A1 | A8 | D12 | F8 | G7 |
| G8 | G9 | H2 | H6 | H7 |
| H8 | H9 | H10 | J7 | J8 |
| J9 | K8 | M8 | - | - |

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The BG225 package pins in this table are bonded to an internal Ground plane on the XC4013E die. They must all be externally connected to Ground.

**PQ/HQ240**

| GND Pins | | | | | |
|---|---|---|---|---|---|
| P22‡ | P37‡ | P83‡ | P98‡ | P143‡ | P158‡ |
| P204‡ | P219‡ | - | - | - | - |
| **N.C. Pins** | | | | | |
| P195 | - | - | - | - | - |

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‡ Pins marked with this symbol are used for Ground connections on some revisions of the device. These pins may not physically connect to anything on the current device revision. However, they should be externally connected to Ground, if possible.

**BG256**

| VCC Pins | | | | | |
|---|---|---|---|---|---|
| C14 | D6 | D7 | D11 | D14 | D15 |
| E20 | F1 | F4 | F17 | G4 | G17 |
| K4 | L17 | P4 | P17 | P19 | R2 |
| R4 | R17 | U6 | U7 | U10 | U14 |
| U15 | V7 | W20 | - | - | - |
| **GND Pins** | | | | | |
| A1 | B7 | D4 | D8 | D13 | D17 |
| G20 | H4 | H17 | N3 | N4 | N17 |
| U4 | U8 | U13 | U17 | W14 | - |
| **N.C. Pins** | | | | | |
| A7 | A13 | C8 | D12 | H20 | J3 |
| J4 | M4 | M19 | V9 | W9 | W13 |
| Y13 | - | - | - | - | - |

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# Pin Locations for XC4020E/XL Devices

The following table may contain pinout information for unsupported device/package combinations. Please see the availability charts elsewhere in the XC4000 Series data sheet for availability information.

| XC4020E/XL Pad Name | HT 144†† | PQ 160†† | HT 176†† | HQ208† PQ208†† | PG 223† | HQ240† PQ240†† | BG 256†† | Bndry Scan |
|---|---|---|---|---|---|---|---|---|
| VCC | P128 | P142 | P155 | P183 | VCC* | P212 | VCC* | - |
| I/O (A8) | P129 | P143 | P156 | P184 | J3 | P213 | C10 | 86 |
| I/O (A9) | P130 | P144 | P157 | P185 | J2 | P214 | D10 | 89 |
| I/O (A19) †† | P131 | P145 | P158 | P186 | J1 | P215 | A9 | 92 |
| I/O (A18) †† | P132 | P146 | P159 | P187 | H1 | P216 | B9 | 95 |
| I/O | - | - | P160 | P188 | H2 | P217 | C9 | 98 |
| I/O | - | - | P161 | P189 | H3 | P218 | D9 | 101 |
| I/O (A10) | P133 | P147 | P162 | P190 | G1 | P220 | A8 | 104 |
| I/O (A11) | P134 | P148 | P163 | P191 | G2 | P221 | B8 | 107 |
| I/O | - | - | - | - | - | - | C8 | 110 |
| I/O | - | - | - | - | - | - | A7 | 113 |
| VCC | - | - | - | - | VCC* | P222 | VCC* | - |
| I/O | - | - | - | - | H4 | P223 | A6 | 116 |
| I/O | - | - | - | - | G4 | P224 | C7 | 119 |
| I/O | P135 | P149 | P164 | P192 | F1 | P225 | B6 | 122 |
| I/O | P136 | P150 | P165 | P193 | E1 | P226 | A5 | 125 |
| GND | P137 | P151 | P166 | P194 | GND* | P227 | GND* | - |
| I/O | - | - | - | P195 | F2 | P228 | C6 | 128 |
| I/O | - | - | P167 | P196 | D1 | P229 | B5 | 131 |
| I/O | - | P152 | P168 | P197 | C1 | P230 | A4 | 134 |
| I/O | - | P153 | P169 | P198 | E2 | P231 | C5 | 137 |
| I/O (A12) | P138 | P154 | P170 | P199 | F3 | P232 | B4 | 140 |
| I/O (A13) | P139 | P155 | P171 | P200 | D2 | P233 | A3 | 143 |
| I/O | - | - | - | - | F4 | P234 | D5 | 152 |
| I/O | - | - | - | - | E4 | P235 | C4 | 155 |
| I/O | P140 | P156 | P172 | P201 | B1 | P236 | B3 | 158 |
| I/O | P141 | P157 | P173 | P202 | E3 | P237 | B2 | 161 |
| I/O (A14) | P142 | P158 | P174 | P203 | C2 | P238 | A2 | 164 |
| I/O, SGCK1 †, GCK8 †† (A15) | P143 | P159 | P175 | P204 | B2 | P239 | C3 | 167 |
| VCC | P144 | P160 | P176 | P205 | VCC* | P240 | VCC* | - |
| GND | P1 | P1 | P1 | P2 | GND* | P1 | GND* | - |
| I/O, PGCK1 †, GCK1 †† (A16) | P2 | P2 | P2 | P4 | C3 | P2 | B1 | 170 |
| I/O (A17) | P3 | P3 | P3 | P5 | C4 | P3 | C2 | 173 |
| I/O | P4 | P4 | P4 | P6 | B3 | P4 | D2 | 176 |
| I/O | P5 | P5 | P5 | P7 | C5 | P5 | D3 | 179 |
| I/O, TDI | P6 | P6 | P6 | P8 | A2 | P6 | E4 | 182 |
| I/O, TCK | P7 | P7 | P7 | P9 | B4 | P7 | C1 | 185 |
| I/O | - | P8 | P8 | P10 | C6 | P8 | D1 | 194 |
| I/O | - | P9 | P9 | P11 | A3 | P9 | E3 | 197 |
| I/O | - | - | - | P12 | B5 | P10 | E2 | 200 |
| I/O | - | - | - | P13 | B6 | P11 | E1 | 203 |
| I/O | - | - | - | - | D5 | P12 | F3 | 206 |
| I/O | - | - | - | - | D6 | P13 | F2 | 209 |
| GND | P8 | P10 | P10 | P14 | GND* | P14 | GND* | - |
| I/O | P9 | P11 | P11 | P15 | A4 | P15 | G3 | 212 |
| I/O | P10 | P12 | P12 | P16 | A5 | P16 | G2 | 215 |
| I/O, TMS | P11 | P13 | P13 | P17 | B7 | P17 | G1 | 218 |
| I/O | P12 | P14 | P14 | P18 | A6 | P18 | H3 | 221 |
| VCC | - | - | - | - | VCC* | P19 | VCC* | - |
| I/O | - | - | - | - | D7 | P20 | H2 | 224 |
| I/O | - | - | - | - | D8 | P21 | H1 | 227 |
| I/O | - | - | - | - | - | - | J4 | 230 |
| I/O | - | - | - | - | - | - | J3 | 233 |
| I/O | - | - | P15 | P19 | C8 | P23 | J2 | 236 |
| I/O | - | - | P16 | P20 | A7 | P24 | J1 | 239 |
| I/O | P13 | P15 | P17 | P21 | B8 | P25 | K2 | 242 |
| I/O | P14 | P16 | P18 | P22 | A8 | P26 | K3 | 245 |
| I/O | P15 | P17 | P19 | P23 | B9 | P27 | K1 | 248 |
| I/O | P16 | P18 | P20 | P24 | C9 | P28 | L1 | 251 |
| GND | P17 | P19 | P21 | P25 | GND* | P29 | GND* | - |
| VCC | P18 | P20 | P22 | P26 | VCC* | P30 | VCC* | - |
| I/O | P19 | P21 | P23 | P27 | C10 | P31 | L2 | 254 |
| I/O | P20 | P22 | P24 | P28 | B10 | P32 | L3 | 257 |
| I/O | P21 | P23 | P25 | P29 | A9 | P33 | L4 | 260 |
| I/O | P22 | P24 | P26 | P30 | A10 | P34 | M1 | 263 |
| I/O | - | - | P27 | P31 | A11 | P35 | M2 | 266 |
| I/O | - | - | P28 | P32 | C11 | P36 | M3 | 269 |
| I/O | - | - | - | - | - | - | M4 | 272 |
| I/O | - | - | - | - | D11 | P38 | N1 | 278 |
| I/O | - | - | - | - | D12 | P39 | N2 | 281 |
| VCC | - | - | - | - | VCC* | P40 | VCC* | - |
| I/O | P23 | P25 | P29 | P33 | B11 | P41 | P1 | 284 |

| XC4020E/XL Pad Name | HT 144†† | PQ 160†† | HT 176†† | HQ208† PQ208†† | PG 223† | HQ240† PQ240†† | BG 256†† | Bndry Scan |
|---|---|---|---|---|---|---|---|---|
| I/O | P24 | P26 | P30 | P34 | A12 | P42 | P2 | 287 |
| I/O | P25 | P27 | P31 | P35 | B12 | P43 | R1 | 290 |
| I/O | P26 | P28 | P32 | P36 | A13 | P44 | P3 | 293 |
| GND | P27 | P29 | P33 | P37 | GND* | P45 | GND* | - |
| I/O | - | - | - | - | D13 | P46 | T1 | 296 |
| I/O | - | - | - | - | D14 | P47 | R3 | 299 |
| I/O | - | - | - | P38 | B13 | P48 | T2 | 302 |
| I/O | - | - | - | P39 | A14 | P49 | U1 | 305 |
| I/O | - | P30 | P34 | P40 | A15 | P50 | T3 | 308 |
| I/O | - | P31 | P35 | P41 | C13 | P51 | U2 | 311 |
| I/O | P28 | P32 | P36 | P42 | B14 | P52 | V1 | 320 |
| I/O | P29 | P33 | P37 | P43 | A16 | P53 | T4 | 323 |
| I/O | P30 | P34 | P38 | P44 | B15 | P54 | U3 | 326 |
| I/O | P31 | P35 | P39 | P45 | C14 | P55 | V2 | 329 |
| I/O | P32 | P36 | P40 | P46 | A17 | P56 | W1 | 332 |
| I/O, SGCK2 †, GCK2 †† | P33 | P37 | P41 | P47 | B16 | P57 | V3 | 335 |
| O (M1) | P34 | P38 | P42 | P48 | C15 | P58 | W2 | 338 |
| GND | P35 | P39 | P43 | P49 | GND* | P59 | GND* | - |
| I (M0) | P36 | P40 | P44 | P50 | A18 | P60 | Y1 | 341 |
| VCC | P37 | P41 | P45 | P55 | VCC* | P61 | VCC* | - |
| I (M2) | P38 | P42 | P46 | P56 | C16 | P62 | W3 | 342 |
| I/O PGCK2 †, GCK3 †† | P39 | P43 | P47 | P57 | B17 | P63 | Y2 | 343 |
| I/O (HDC) | P40 | P44 | P48 | P58 | E16 | P64 | W4 | 346 |
| I/O | P41 | P45 | P49 | P59 | C17 | P65 | V4 | 349 |
| I/O | P42 | P46 | P50 | P60 | D17 | P66 | U5 | 352 |
| I/O | P43 | P47 | P51 | P61 | B18 | P67 | Y3 | 355 |
| I/O (LDC) | P44 | P48 | P52 | P62 | E17 | P68 | Y4 | 358 |
| I/O | - | P49 | P53 | P63 | F16 | P69 | V5 | 367 |
| I/O | - | P50 | P54 | P64 | C18 | P70 | W5 | 370 |
| I/O | - | - | - | P65 | D18 | P71 | Y5 | 373 |
| I/O | - | - | - | P66 | F17 | P72 | V6 | 376 |
| I/O | - | - | - | - | E15 | P73 | W6 | 379 |
| I/O | - | - | - | - | F15 | P74 | Y6 | 382 |
| GND | P45 | P51 | P55 | P67 | GND* | P75 | GND* | - |
| I/O | P46 | P52 | P56 | P68 | E18 | P76 | W7 | 385 |
| I/O | P47 | P53 | P57 | P69 | F18 | P77 | Y7 | 388 |
| I/O | P48 | P54 | P58 | P70 | G17 | P78 | V8 | 391 |
| I/O | P49 | P55 | P59 | P71 | G18 | P79 | W8 | 394 |
| VCC | - | - | - | - | VCC* | P80 | VCC* | - |
| I/O | - | - | P60 | P72 | H16 | P81 | Y8 | 397 |
| I/O | - | - | P61 | P73 | H17 | P82 | U9 | 400 |
| I/O | - | - | - | - | - | - | V9 | 403 |
| I/O | - | - | - | - | - | - | W9 | 406 |
| I/O | - | - | - | - | G15 | P84 | Y9 | 409 |
| I/O | - | - | - | - | H15 | P85 | W10 | 412 |
| I/O | P50 | P56 | P62 | P74 | H18 | P86 | V10 | 415 |
| I/O | P51 | P57 | P63 | P75 | J18 | P87 | Y10 | 418 |
| I/O | P52 | P58 | P64 | P76 | J17 | P88 | Y11 | 421 |
| I/O (INIT) | P53 | P59 | P65 | P77 | J16 | P89 | W11 | 424 |
| VCC | P54 | P60 | P66 | P78 | VCC* | P90 | VCC* | - |
| GND | P55 | P61 | P67 | P79 | GND* | P91 | GND* | - |
| I/O | P56 | P62 | P68 | P80 | K16 | P92 | V11 | 427 |
| I/O | P57 | P63 | P69 | P81 | K17 | P93 | U11 | 430 |
| I/O | P58 | P64 | P70 | P82 | K18 | P94 | Y12 | 433 |
| I/O | P59 | P65 | P71 | P83 | L18 | P95 | W12 | 436 |
| I/O | - | - | P72 | P84 | L17 | P96 | V12 | 439 |
| I/O | - | - | P73 | P85 | L16 | P97 | U12 | 442 |
| I/O | - | - | - | - | - | - | Y13 | 445 |
| I/O | - | - | - | - | - | - | W13 | 448 |
| I/O | - | - | - | - | L15 | P99 | V13 | 451 |
| I/O | - | - | - | - | M15 | P100 | Y14 | 454 |
| VCC | - | - | - | - | VCC* | P101 | VCC* | - |
| I/O | P60 | P66 | P74 | P86 | M18 | P102 | Y15 | 457 |
| I/O | P61 | P67 | P75 | P87 | M17 | P103 | V14 | 460 |
| I/O | P62 | P68 | P76 | P88 | N18 | P104 | W15 | 463 |
| I/O | P63 | P69 | P77 | P89 | P18 | P105 | Y16 | 466 |
| GND | P64 | P70 | P78 | P90 | GND* | P106 | GND* | - |
| I/O | - | - | - | - | N15 | P107 | V15 | 469 |
| I/O | - | - | - | - | P15 | P108 | W16 | 472 |
| I/O | - | - | - | P91 | N17 | P109 | Y17 | 475 |
| I/O | - | - | - | P92 | R18 | P110 | V16 | 478 |
| I/O | - | P71 | P79 | P93 | T18 | P111 | W17 | 481 |
| I/O | - | P72 | P80 | P94 | P17 | P112 | Y18 | 484 |

| XC4020E/XL Pad Name | HT 144†† | PQ 160†† | HT 176†† | HQ208† PQ208†† | PG 223† | HQ240† PQ240†† | BG 256†† | Bndry Scan |
|---|---|---|---|---|---|---|---|---|
| I/O | P65 | P73 | P81 | P95 | N16 | P113 | U16 | 493 |
| I/O | P66 | P74 | P82 | P96 | T17 | P114 | V17 | 496 |
| I/O | P67 | P75 | P83 | P97 | R17 | P115 | W18 | 499 |
| I/O | P68 | P76 | P84 | P98 | P16 | P116 | Y19 | 502 |
| I/O | P69 | P77 | P85 | P99 | U18 | P117 | V18 | 505 |
| I/O, SGCK3 †, GCK4 †† | P70 | P78 | P86 | P100 | T16 | P118 | W19 | 508 |
| GND | P71 | P79 | P87 | P101 | GND* | P119 | GND* | - |
| DONE | P72 | P80 | P88 | P103 | U17 | P120 | Y20 | - |
| VCC | P73 | P81 | P89 | P106 | VCC* | P121 | VCC* | - |
| PROGRAM | P74 | P82 | P90 | P108 | V18 | P122 | V19 | - |
| I/O (D7) | P75 | P83 | P91 | P109 | T15 | P123 | U19 | 511 |
| I/O, PGCK3 †, GCK5 †† | P76 | P84 | P92 | P110 | U16 | P124 | U18 | 514 |
| I/O | P77 | P85 | P93 | P111 | T14 | P125 | T17 | 517 |
| I/O | P78 | P86 | P94 | P112 | U15 | P126 | V20 | 520 |
| I/O | - | - | - | - | R14 | P127 | U20 | 523 |
| I/O | - | - | - | - | R13 | P128 | T18 | 526 |
| I/O (D6) | P79 | P87 | P95 | P113 | V17 | P129 | T19 | 535 |
| I/O | P80 | P88 | P96 | P114 | V16 | P130 | T20 | 538 |
| I/O | - | P89 | P97 | P115 | T13 | P131 | R18 | 541 |
| I/O | - | P90 | P98 | P116 | U14 | P132 | R19 | 544 |
| I/O | - | - | - | P117 | V15 | P133 | R20 | 547 |
| I/O | - | - | - | P118 | V14 | P134 | P18 | 550 |
| GND | P81 | P91 | P99 | P119 | GND* | P135 | GND* | - |
| I/O | - | - | - | - | R12 | P136 | P20 | 553 |
| I/O | - | - | - | - | R11 | P137 | N18 | 556 |
| I/O | P82 | P92 | P100 | P120 | U13 | P138 | N19 | 559 |
| I/O | P83 | P93 | P101 | P121 | V13 | P139 | N20 | 562 |
| VCC | - | - | - | - | VCC* | P140 | VCC* | - |
| I/O (D5) | P84 | P94 | P102 | P122 | U12 | P141 | M17 | 565 |
| I/O (CS0) | P85 | P95 | P103 | P123 | V12 | P142 | M18 | 568 |
| I/O | - | - | - | - | - | - | M19 | 574 |
| I/O | - | - | P104 | P124 | T11 | P144 | M20 | 577 |
| I/O | - | - | P105 | P125 | U11 | P145 | L19 | 580 |
| I/O | P86 | P96 | P106 | P126 | V11 | P146 | L18 | 583 |
| I/O | P87 | P97 | P107 | P127 | V10 | P147 | L20 | 586 |
| I/O (D4) | P88 | P98 | P108 | P128 | U10 | P148 | K20 | 589 |
| I/O | P89 | P99 | P109 | P129 | T10 | P149 | K19 | 592 |
| VCC | P90 | P100 | P110 | P130 | VCC* | P150 | VCC* | - |
| GND | P91 | P101 | P111 | P131 | GND* | P151 | GND* | - |
| I/O (D3) | P92 | P102 | P112 | P132 | T9 | P152 | K18 | 595 |
| I/O (RS) | P93 | P103 | P113 | P133 | U9 | P153 | K17 | 598 |
| I/O | P94 | P104 | P114 | P134 | V9 | P154 | J20 | 601 |
| I/O | P95 | P105 | P115 | P135 | V8 | P155 | J19 | 604 |
| I/O | - | - | P116 | P136 | U8 | P156 | J18 | 607 |
| I/O | - | - | P117 | P137 | T8 | P157 | J17 | 610 |
| I/O | - | - | - | - | - | - | H20 | 613 |
| I/O (D2) | P96 | P106 | P118 | P138 | V7 | P159 | H19 | 619 |
| I/O | P97 | P107 | P119 | P139 | U7 | P160 | H18 | 622 |
| VCC | - | - | - | - | VCC* | P161 | VCC* | - |
| I/O | P98 | P108 | P120 | P140 | V6 | P162 | G19 | 625 |
| I/O | P99 | P109 | P121 | P141 | U6 | P163 | F20 | 628 |
| I/O | - | - | - | - | R8 | P164 | G18 | 631 |
| I/O | - | - | - | - | R7 | P165 | F19 | 634 |
| GND | P100 | P110 | P122 | P142 | GND* | P166 | GND* | - |
| I/O | - | - | - | - | R6 | P167 | F18 | 637 |
| I/O | - | - | - | - | R5 | P168 | E19 | 640 |
| I/O | - | - | - | P143 | V5 | P169 | D20 | 643 |
| I/O | - | - | - | P144 | V4 | P170 | E18 | 646 |
| I/O | - | P111 | P123 | P145 | U5 | P171 | D19 | 649 |
| I/O | - | P112 | P124 | P146 | T6 | P172 | C20 | 652 |
| I/O (D1) | P101 | P113 | P125 | P147 | V3 | P173 | E17 | 655 |
| I/O (RCLK, RDY/BUSY) | P102 | P114 | P126 | P148 | V2 | P174 | D18 | 658 |
| I/O | P103 | P115 | P127 | P149 | U4 | P175 | C19 | 667 |
| I/O (D0, DIN) | P104 | P116 | P128 | P150 | T5 | P176 | B20 | 670 |
| I/O (D0, DIN) | P105 | P117 | P129 | P151 | U3 | P177 | C18 | 673 |
| I/O, SGCK4 †, GCK6 †† (DOUT) | P106 | P118 | P130 | P152 | T4 | P178 | B19 | 676 |
| CCLK | P107 | P119 | P131 | P153 | V1 | P179 | A20 | - |
| VCC | P108 | P120 | P132 | P154 | VCC* | P180 | VCC* | - |
| O, TDO | P109 | P121 | P133 | P159 | U2 | P181 | A19 | 0 |
| GND | P110 | P122 | P134 | P160 | GND* | P182 | GND* | - |
| I/O (A0, WS) | P111 | P123 | P135 | P161 | T3 | P183 | B18 | 2 |
| I/O, PGCK4 †, GCK7 †† (A1) | P112 | P124 | P136 | P162 | U1 | P184 | B17 | 5 |
| I/O | P113 | P125 | P137 | P163 | P3 | P185 | C17 | 8 |
| I/O | P114 | P126 | P138 | P164 | R2 | P186 | D16 | 11 |
| I/O (CS1, A2) | P115 | P127 | P139 | P165 | T2 | P187 | A18 | 14 |
| I/O (A3) | P116 | P128 | P140 | P166 | N3 | P188 | A17 | 17 |

| XC4020E/XL Pad Name | HT 144†† | PQ 160†† | HT 176†† | HQ208† PQ208†† | PG 223† | HQ240† PQ240†† | BG 256†† | Bndry Scan |
|---|---|---|---|---|---|---|---|---|
| I/O | - | - | - | - | P4 | P189 | C16 | 26 |
| I/O | - | - | - | - | N4 | P190 | B16 | 29 |
| I/O | P117 | P129 | P141 | P167 | P2 | P191 | A16 | 32 |
| I/O | - | P130 | P142 | P168 | T1 | P192 | C15 | 35 |
| I/O | - | - | - | P169 | R1 | P193 | B15 | 38 |
| I/O | - | - | - | P170 | N2 | P194 | A15 | 41 |
| GND | P118 | P131 | P143 | P171 | GND* | P196 | GND* | - |
| I/O | P119 | P132 | P144 | P172 | P1 | P197 | B14 | 44 |
| I/O | P120 | P133 | P145 | P173 | N1 | P198 | A14 | 47 |
| I/O | - | - | - | - | M4 | P199 | C13 | 50 |
| I/O | - | - | - | - | L4 | P200 | B13 | 53 |
| VCC | - | - | - | - | VCC* | P201 | VCC* | - |
| I/O | - | - | - | - | - | - | A13 | 56 |
| I/O | - | - | - | - | - | - | D12 | 59 |
| I/O (A4) | P121 | P134 | P146 | P174 | M2 | P202 | C12 | 62 |
| I/O (A5) | P122 | P135 | P147 | P175 | M1 | P203 | B12 | 65 |
| I/O | - | - | P148 | P176 | L3 | P205 | A12 | 68 |
| I/O | - | P136 | P149 | P177 | L2 | P206 | B11 | 71 |
| I/O (A21) †† | P123 | P137 | P150 | P178 | L1 | P207 | C11 | 74 |
| I/O (A20) †† | P124 | P138 | P151 | P179 | K1 | P208 | A11 | 77 |
| I/O (A6) | P125 | P139 | P152 | P180 | K2 | P209 | A10 | 80 |
| I/O (A7) | P126 | P140 | P153 | P181 | K3 | P210 | B10 | 83 |
| GND | P127 | P141 | P154 | P182 | GND* | P211 | GND* | - |

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† = E only
†† = XL only

## Additional XC4020E/XL Package Pins

### PQ/HQ208

| N.C. Pins | | | | | |
|---|---|---|---|---|---|
| P1 | P3 | P51 | P52 | P53 | P54 |
| P102 | P104 | P105 | P107 | P155 | P156 |
| P157 | P158 | P206 | P207 | P208 | - |

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### PG223

| VCC Pins | | | | | |
|---|---|---|---|---|---|
| D3 | D10 | D16 | J4 | J15 | R4 |
| R10 | R15 | - | - | - | - |
| **GND Pins** | | | | | |
| C7 | C12 | D4 | D9 | D15 | G3 |
| G16 | K4 | K15 | M3 | M16 | R3 |
| R9 | R16 | T7 | T12 | - | - |

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### PQ/HQ240

| GND Pins | | | | | |
|---|---|---|---|---|---|
| P22‡ | P37‡ | P83‡ | P98‡ | P143‡ | P158‡ |
| P204‡ | P219‡ | - | - | - | - |
| **N.C. Pins** | | | | | |
| P195 | - | - | - | - | - |

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‡ Pins marked with this symbol are used for Ground connections on some revisions of the device. These pins may not physically connect to anything on the current device revision. However, they should be externally connected to Ground, if possible.

### BG256

| VCC Pins | | | | | |
|---|---|---|---|---|---|
| C14 | D6 | D7 | D11 | D14 | D15 |
| E20 | F1 | F4 | F17 | G4 | G17 |
| K4 | L17 | P4 | P17 | P19 | R2 |
| R4 | R17 | U6 | U7 | U10 | U14 |
| U15 | V7 | W20 | - | - | - |
| **GND Pins** | | | | | |
| A1 | B7 | D4 | D8 | D13 | D17 |
| G20 | H4 | H17 | N3 | N4 | N17 |
| U4 | U8 | U13 | U17 | W14 | - |

6/17/97

# Pin Locations for XC4025E, XC4028EX/XL Devices

The following table may contain pinout information for unsupported device/package combinations. Please see the availability charts elsewhere in the XC4000 Series data sheet for availability information.

| XC4025E, XC4028 EX/XL Pad Name | HQ 160†† | HQ 208‡ | PG 223† | HQ 240 | BG 256†† | PG 299 | HQ 304 | BG 352‡ | Bndry Scan |
|---|---|---|---|---|---|---|---|---|---|
| VCC | P142 | P183 | VCC* | P212 | VCC* | VCC* | P38 | VCC* | - |
| I/O (A8) | P143 | P184 | J3 | P213 | C10 | K2 | P37 | D14 | 98 |
| I/O (A9) | P144 | P185 | J2 | P214 | D10 | K3 | P36 | C14 | 101 |
| I/O (A19) ‡ | P145 | P186 | J1 | P215 | A9 | K5 | P35 | A15 | 104 |
| I/O (A18) ‡ | P146 | P187 | H1 | P216 | B9 | K4 | P34 | B15 | 107 |
| I/O | - | P188 | H2 | P217 | C9 | J1 | P33 | C15 | 110 |
| I/O | - | P189 | H3 | P218 | D9 | J2 | P32 | D15 | 113 |
| I/O (A10) | P147 | P190 | G1 | P220 | A8 | H1 | P31 | A16 | 116 |
| I/O (A11) | P148 | P191 | G2 | P221 | B8 | J3 | P30 | B16 | 119 |
| GND | - | - | - | - | GND* | GND* | - | GND* | - |
| I/O | - | - | - | - | - | J4 | P29 | C16 | 122 |
| I/O | - | - | - | - | - | J5 | P28 | B17 | 125 |
| I/O | - | - | - | - | C8 | H2 | P27 | C17 | 128 |
| I/O | - | - | - | - | A7 | G1 | P26 | B18 | 131 |
| VCC | - | - | VCC* | P222 | VCC* | VCC* | P25 | VCC* | - |
| I/O | - | - | H4 | P223 | A6 | H3 | P23 | C18 | 134 |
| I/O | - | - | G4 | P224 | C7 | G2 | P22 | D17 | 137 |
| I/O | P149 | P192 | F1 | P225 | B6 | H4 | P21 | A20 | 140 |
| I/O | P150 | P193 | E1 | P226 | A5 | F2 | P20 | B19 | 143 |
| GND | P151 | P194 | GND* | P227 | GND* | GND* | P19 | GND* | - |
| I/O | - | - | - | - | - | H5 | P18 | C19 | 146 |
| I/O | - | - | - | - | - | G3 | P17 | D18 | 149 |
| I/O | - | P195 | F2 | P228 | C6 | D1 | P16 | A21 | 152 |
| I/O | - | P196 | D1 | P229 | B5 | G4 | P15 | B20 | 155 |
| I/O | P152 | P197 | C1 | P230 | A4 | E2 | P14 | C20 | 158 |
| I/O | P153 | P198 | E2 | P231 | C5 | F3 | P13 | B21 | 161 |
| I/O (A12) | P154 | P199 | F3 | P232 | B4 | G5 | P12 | B22 | 164 |
| I/O (A13) | P155 | P200 | D2 | P233 | A3 | C1 | P10 | C21 | 167 |
| GND | - | - | - | - | GND* | GND* | - | GND* | - |
| VCC | - | - | - | - | VCC* | VCC* | - | VCC* | - |
| I/O | - | - | - | - | - | F4 | P9 | D20 | 170 |
| I/O | - | - | - | - | - | E3 | P8 | A23 | 173 |
| I/O | - | - | F4 | P234 | D5 | D2 | P7 | D21 | 176 |
| I/O | - | - | E4 | P235 | C4 | C2 | P6 | C22 | 179 |
| I/O | P156 | P201 | B1 | P236 | B3 | F5 | P5 | B24 | 182 |
| I/O | P157 | P202 | E3 | P237 | B2 | E4 | P4 | C23 | 185 |
| I/O (A14) | P158 | P203 | C2 | P238 | A2 | D3 | P3 | D22 | 188 |
| I/O, SGCK1 †, GCK8 ‡ (A15) | P159 | P204 | B2 | P239 | C3 | C3 | P2 | C24 | 191 |
| VCC | P160 | P205 | VCC* | P240 | VCC* | VCC* | P1 | VCC* | - |
| GND | P1 | P2 | GND* | P1 | GND* | GND* | P304 | GND* | - |
| I/O, PGCK1 †, GCK1 ‡ (A16) | P2 | P4 | C3 | P2 | B1 | D4 | P303 | D23 | 194 |
| I/O (A17) | P3 | P5 | C4 | P3 | C2 | B2 | P302 | C25 | 197 |
| I/O | P4 | P6 | B3 | P4 | D2 | B3 | P301 | D24 | 200 |
| I/O | P5 | P7 | C5 | P5 | D3 | E6 | P300 | E23 | 203 |
| I/O, TDI | P6 | P8 | A2 | P6 | E4 | D5 | P299 | C26 | 206 |
| I/O, TCK | P7 | P9 | B4 | P7 | C1 | C4 | P298 | E24 | 209 |
| I/O | - | - | - | - | - | A3 | P297 | F24 | 212 |
| I/O | - | - | - | - | - | D6 | P296 | E25 | 215 |
| VCC | - | - | - | - | VCC* | VCC* | - | VCC* | - |
| GND | - | - | - | - | GND* | GND* | - | GND* | - |
| I/O | P8 | P10 | C6 | P8 | D1 | E7 | P295 | D26 | 218 |
| I/O | P9 | P11 | A3 | P9 | E3 | B4 | P294 | G24 | 221 |
| I/O | - | P12 | B5 | P10 | E2 | C5 | P293 | F25 | 224 |
| I/O | - | P13 | B6 | P11 | E1 | A4 | P292 | F26 | 227 |
| I/O | - | - | D5 | P12 | F3 | D7 | P291 | H23 | 230 |
| I/O | - | - | D6 | P13 | F2 | C6 | P290 | H24 | 233 |
| I/O | - | - | - | - | - | E8 | P289 | G25 | 236 |

| XC4025E, XC4028 EX/XL Pad Name | HQ 160†† | HQ 208‡ | PG 223† | HQ 240 | BG 256†† | PG 299 | HQ 304 | BG 352‡ | Bndry Scan |
|---|---|---|---|---|---|---|---|---|---|
| I/O | - | - | - | - | - | B5 | P288 | G26 | 239 |
| GND | P10 | P14 | GND* | P14 | GND* | GND* | P287 | GND* | - |
| I/O | P11 | P15 | A4 | P15 | G3 | B6 | P286 | J23 | 242 |
| I/O | P12 | P16 | A5 | P16 | G2 | D8 | P285 | J24 | 245 |
| I/O, TMS | P13 | P17 | B7 | P17 | G1 | C7 | P284 | H25 | 248 |
| I/O | P14 | P18 | A6 | P18 | H3 | B7 | P283 | K23 | 251 |
| VCC | - | - | VCC* | P19 | VCC* | VCC* | P282 | VCC* | - |
| I/O | - | - | D7 | P20 | H2 | C8 | P280 | K24 | 254 |
| I/O | - | - | D8 | P21 | H1 | E9 | P279 | J25 | 257 |
| I/O | - | - | - | - | - | A7 | P278 | L24 | 260 |
| I/O | - | - | - | - | - | D9 | P277 | K25 | 263 |
| GND | - | - | - | P22 | GND* | GND* | - | GND* | - |
| I/O | - | - | - | - | J4 | B8 | P276 | L25 | 266 |
| I/O | - | - | - | - | J3 | A8 | P275 | L26 | 269 |
| I/O | - | P19 | C8 | P23 | J2 | C9 | P274 | M23 | 272 |
| I/O | - | P20 | A7 | P24 | J1 | B9 | P273 | M24 | 275 |
| I/O | P15 | P21 | B8 | P25 | K2 | E10 | P272 | M25 | 278 |
| I/O | P16 | P22 | A8 | P26 | K3 | A9 | P271 | M26 | 281 |
| I/O | P17 | P23 | B9 | P27 | K1 | D10 | P270 | N24 | 284 |
| I/O | P18 | P24 | C9 | P28 | L1 | C10 | P269 | N25 | 287 |
| GND | P19 | P25 | GND* | P29 | GND* | GND* | P268 | GND* | - |
| VCC | P20 | P26 | VCC* | P30 | VCC* | VCC* | P267 | VCC* | - |
| I/O | P21 | P27 | C10 | P31 | L2 | B10 | P266 | N26 | 290 |
| I/O | P22 | P28 | B10 | P32 | L3 | B11 | P265 | P25 | 293 |
| I/O | P23 | P29 | A9 | P33 | L4 | C11 | P264 | P23 | 296 |
| I/O | P24 | P30 | A10 | P34 | M1 | E11 | P263 | P24 | 299 |
| I/O | - | P31 | A11 | P35 | M2 | D11 | P262 | R26 | 302 |
| I/O | - | P32 | C11 | P36 | M3 | A12 | P261 | R25 | 305 |
| I/O | - | - | - | - | M4 | B12 | P260 | R24 | 308 |
| I/O | - | - | - | - | - | A13 | P259 | R23 | 311 |
| GND | - | - | - | P37 | GND* | GND* | - | GND* | - |
| I/O | - | - | - | - | - | C12 | P258 | T26 | 314 |
| I/O | - | - | - | - | - | D12 | P257 | T25 | 317 |
| I/O | - | - | D11 | P38 | N1 | E12 | P256 | T23 | 320 |
| I/O | - | - | D12 | P39 | N2 | B13 | P255 | V26 | 323 |
| VCC | - | - | VCC* | P40 | VCC* | VCC* | P253 | VCC* | - |
| I/O | P25 | P33 | B11 | P41 | P1 | A14 | P252 | U24 | 326 |
| I/O | P26 | P34 | A12 | P42 | P2 | C13 | P251 | V25 | 329 |
| I/O | P27 | P35 | B12 | P43 | R1 | B14 | P250 | V24 | 332 |
| I/O | P28 | P36 | A13 | P44 | P3 | D13 | P249 | U23 | 335 |
| GND | P29 | P37 | GND* | P45 | GND* | GND* | P248 | GND* | - |
| I/O | - | - | - | - | - | B15 | P247 | Y26 | 338 |
| I/O | - | - | - | - | - | E13 | P246 | W25 | 341 |
| I/O | - | - | D13 | P46 | T1 | C14 | P245 | W24 | 344 |
| I/O | - | - | D14 | P47 | R3 | A17 | P244 | V23 | 347 |
| I/O | - | P38 | B13 | P48 | T2 | D14 | P243 | AA26 | 350 |
| I/O | - | P39 | A14 | P49 | U1 | B16 | P242 | Y25 | 353 |
| I/O | P30 | P40 | A15 | P50 | T3 | C15 | P241 | Y24 | 356 |
| I/O | P31 | P41 | C13 | P51 | U2 | E14 | P240 | AA25 | 359 |
| GND | - | - | - | - | GND* | GND* | - | GND* | - |
| VCC | - | - | - | - | VCC* | VCC* | - | VCC* | - |
| I/O | - | - | - | - | - | A18 | P239 | AB25 | 362 |
| I/O | - | - | - | - | - | D15 | P238 | AA24 | 365 |
| I/O | P32 | P42 | B14 | P52 | V1 | C16 | P237 | Y23 | 368 |
| I/O | P33 | P43 | A16 | P53 | T4 | B17 | P236 | AC26 | 371 |
| I/O | P34 | P44 | B15 | P54 | U3 | B18 | P235 | AA23 | 374 |
| I/O | P35 | P45 | C14 | P55 | V2 | E15 | P234 | AB24 | 377 |
| I/O | P36 | P46 | A17 | P56 | W1 | D16 | P233 | AD25 | 380 |
| I/O, SGCK2 †, GCK2 ‡ | P37 | P47 | B16 | P57 | V3 | C17 | P232 | AC24 | 383 |
| O (M1) | P38 | P48 | C15 | P58 | W2 | A20 | P231 | AB23 | 386 |
| GND | P39 | P49 | GND* | P59 | GND* | GND* | P230 | GND* | - |

| XC4025E, XC4028 EX/XL Pad Name | HQ 160†† | HQ 208‡ | PG 223† | HQ 240 | BG 256†† | PG 299 | HQ 304 | BG 352‡ | Bndry Scan |
|---|---|---|---|---|---|---|---|---|---|
| I (M0) | P40 | P50 | A18 | P60 | Y1 | C18 | P229 | AD24 | 389 |
| VCC | P41 | P55 | VCC* | P61 | VCC* | VCC* | P228 | VCC* | - |
| I (M2) | P42 | P56 | C16 | P62 | W3 | D17 | P227 | AC23 | 390 |
| I/O, PGCK2 †, GCK3 ‡ | P43 | P57 | B17 | P63 | Y2 | B19 | P226 | AE24 | 391 |
| I/O (HDC) | P44 | P58 | E16 | P64 | W4 | C19 | P225 | AD23 | 394 |
| I/O | P45 | P59 | C17 | P65 | V4 | F16 | P224 | AC22 | 397 |
| I/O | P46 | P60 | D17 | P66 | U5 | E17 | P223 | AF24 | 400 |
| I/O | P47 | P61 | B18 | P67 | Y3 | D18 | P222 | AD22 | 403 |
| I/O (LDC) | P48 | P62 | E17 | P68 | Y4 | C20 | P221 | AE23 | 406 |
| I/O | - | - | - | - | - | F17 | P220 | AE22 | 409 |
| I/O | - | - | - | - | - | G16 | P219 | AF23 | 412 |
| VCC | - | - | - | - | VCC* | VCC* | - | VCC* | - |
| GND | - | - | - | - | GND* | GND* | - | GND* | - |
| I/O | P49 | P63 | F16 | P69 | V5 | D19 | P218 | AD20 | 415 |
| I/O | P50 | P64 | C18 | P70 | W5 | E18 | P217 | AE21 | 418 |
| I/O | - | P65 | D18 | P71 | Y5 | D20 | P216 | AF21 | 421 |
| I/O | - | P66 | F17 | P72 | V6 | G17 | P215 | AC19 | 424 |
| I/O | - | - | E15 | P73 | W6 | F18 | P214 | AD19 | 427 |
| I/O | - | - | F15 | P74 | Y6 | H16 | P213 | AE20 | 430 |
| I/O | - | - | - | - | - | E19 | P212 | AF20 | 433 |
| I/O | - | - | - | - | - | F19 | P211 | AC18 | 436 |
| GND | P51 | P67 | GND* | P75 | GND* | GND* | P210 | GND* | - |
| I/O | P52 | P68 | E18 | P76 | W7 | H17 | P209 | AD18 | 439 |
| I/O | P53 | P69 | F18 | P77 | Y7 | G18 | P208 | AE19 | 442 |
| I/O | P54 | P70 | G17 | P78 | V8 | G19 | P207 | AC17 | 445 |
| I/O | P55 | P71 | G18 | P79 | W8 | H18 | P206 | AD17 | 448 |
| VCC | - | - | VCC* | P80 | VCC* | VCC* | P204 | VCC* | - |
| I/O | - | P72 | H16 | P81 | Y8 | J16 | P203 | AE18 | 451 |
| I/O | - | P73 | H17 | P82 | U9 | G20 | P202 | AF18 | 454 |
| I/O | - | - | - | - | - | J17 | P201 | AE17 | 457 |
| I/O | - | - | - | - | - | H19 | P200 | AE16 | 460 |
| GND | - | - | - | P83 | GND* | GND* | - | GND* | - |
| I/O | - | - | - | - | V9 | H20 | P199 | AF16 | 463 |
| I/O | - | - | - | - | W9 | J18 | P198 | AC15 | 466 |
| I/O | - | - | G15 | P84 | Y9 | J19 | P197 | AD15 | 469 |
| I/O | - | - | H15 | P85 | W10 | K16 | P196 | AE15 | 472 |
| I/O | P56 | P74 | H18 | P86 | V10 | J20 | P195 | AF15 | 475 |
| I/O | P57 | P75 | J18 | P87 | Y10 | K17 | P194 | AD14 | 478 |
| I/O | P58 | P76 | J17 | P88 | Y11 | K18 | P193 | AE14 | 481 |
| I/O (INIT) | P59 | P77 | J16 | P89 | W11 | K19 | P192 | AF14 | 484 |
| VCC | P60 | P78 | VCC* | P90 | VCC* | VCC* | P191 | VCC* | - |
| GND | P61 | P79 | GND* | P91 | GND* | GND* | P190 | GND* | - |
| I/O | P62 | P80 | K16 | P92 | V11 | L19 | P189 | AE13 | 487 |
| I/O | P63 | P81 | K17 | P93 | U11 | L18 | P188 | AC13 | 490 |
| I/O | P64 | P82 | K18 | P94 | Y12 | L16 | P187 | AD13 | 493 |
| I/O | P65 | P83 | L18 | P95 | W12 | L17 | P186 | AF12 | 496 |
| I/O | - | P84 | L17 | P96 | V12 | M20 | P185 | AE12 | 499 |
| I/O | - | P85 | L16 | P97 | U12 | M19 | P184 | AD12 | 502 |
| I/O | - | - | - | - | Y13 | N20 | P183 | AC12 | 505 |
| I/O | - | - | - | - | W13 | M18 | P182 | AF11 | 508 |
| GND | - | - | - | P98 | GND* | GND* | - | GND* | - |
| I/O | - | - | - | - | - | M17 | P181 | AE11 | 511 |
| I/O | - | - | - | - | - | M16 | P180 | AD11 | 514 |
| I/O | - | - | L15 | P99 | V13 | N19 | P179 | AF9 | 517 |
| I/O | - | - | M15 | P100 | Y14 | P20 | P178 | AD10 | 520 |
| VCC | - | - | VCC* | P101 | VCC* | VCC* | P177 | VCC* | - |
| I/O | P66 | P86 | M18 | P102 | Y15 | N18 | P175 | AE9 | 523 |
| I/O | P67 | P87 | M17 | P103 | V14 | P19 | P174 | AD9 | 526 |
| I/O | P68 | P88 | N18 | P104 | W15 | N17 | P173 | AC10 | 529 |
| I/O | P69 | P89 | P18 | P105 | Y16 | R19 | P172 | AF7 | 532 |
| GND | P70 | P90 | GND* | P106 | GND* | GND* | P171 | GND* | - |
| I/O | - | - | - | - | - | N16 | P170 | AE8 | 535 |
| I/O | - | - | - | - | - | P18 | P169 | AD8 | 538 |
| I/O | - | - | N15 | P107 | V15 | U20 | P168 | AC9 | 541 |
| I/O | - | - | P15 | P108 | W16 | P17 | P167 | AF6 | 544 |
| I/O | - | P91 | N17 | P109 | Y17 | T19 | P166 | AE7 | 547 |

| XC4025E, XC4028 EX/XL Pad Name | HQ 160†† | HQ 208‡ | PG 223† | HQ 240 | BG 256†† | PG 299 | HQ 304 | BG 352‡ | Bndry Scan |
|---|---|---|---|---|---|---|---|---|---|
| I/O | - | P92 | R18 | P110 | V16 | R18 | P165 | AD7 | 550 |
| I/O | P71 | P93 | T18 | P111 | W17 | P16 | P164 | AE6 | 553 |
| I/O | P72 | P94 | P17 | P112 | Y18 | V20 | P163 | AE5 | 556 |
| GND | - | - | - | - | GND* | GND* | - | GND* | - |
| VCC | - | - | - | - | VCC* | VCC* | - | VCC* | - |
| I/O | - | - | - | - | - | R17 | P162 | AD6 | 559 |
| I/O | - | - | - | - | - | T18 | P161 | AC7 | 562 |
| I/O | P73 | P95 | N16 | P113 | U16 | U19 | P160 | AF4 | 565 |
| I/O | P74 | P96 | T17 | P114 | V17 | V19 | P159 | AF3 | 568 |
| I/O | P75 | P97 | R17 | P115 | W18 | R16 | P158 | AD5 | 571 |
| I/O | P76 | P98 | P16 | P116 | Y19 | T17 | P157 | AE3 | 574 |
| I/O | P77 | P99 | U18 | P117 | V18 | U18 | P156 | AD4 | 577 |
| I/O, SGCK3 †, GCK4 ‡ | P78 | P100 | T16 | P118 | W19 | X20 | P155 | AC5 | 580 |
| GND | P79 | P101 | GND* | P119 | GND* | GND* | P154 | GND* | - |
| DONE | P80 | P103 | U17 | P120 | Y20 | V18 | P153 | AD3 | - |
| VCC | P81 | P106 | VCC* | P121 | VCC* | VCC* | P152 | VCC* | - |
| PROGRAM | P82 | P108 | V18 | P122 | V19 | U17 | P151 | AC4 | - |
| I/O (D7) | P83 | P109 | T15 | P123 | U19 | W19 | P150 | AD2 | 583 |
| I/O, PGCK3 †, GCK5 ‡ | P84 | P110 | U16 | P124 | U18 | W18 | P149 | AC3 | 586 |
| I/O | P85 | P111 | T14 | P125 | T17 | T15 | P148 | AB4 | 589 |
| I/O | P86 | P112 | U15 | P126 | V20 | U16 | P147 | AD1 | 592 |
| I/O | - | - | R14 | P127 | U20 | V17 | P146 | AA4 | 595 |
| I/O | - | - | R13 | P128 | T18 | X18 | P145 | AA3 | 598 |
| I/O | - | - | - | - | - | U15 | P144 | AB2 | 601 |
| I/O | - | - | - | - | - | T14 | P143 | AC1 | 604 |
| VCC | - | - | - | - | VCC* | VCC* | - | VCC* | - |
| GND | - | - | - | - | GND* | GND* | - | GND* | - |
| I/O (D6) | P87 | P113 | V17 | P129 | T19 | W17 | P142 | Y3 | 607 |
| I/O | P88 | P114 | V16 | P130 | T20 | W16 | P141 | AA2 | 610 |
| I/O | P89 | P115 | T13 | P131 | R18 | X17 | P140 | AA1 | 613 |
| I/O | P90 | P116 | U14 | P132 | R19 | U14 | P139 | W4 | 616 |
| I/O | - | P117 | V15 | P133 | R20 | V15 | P138 | W3 | 619 |
| I/O | - | P118 | V14 | P134 | P18 | T13 | P137 | Y2 | 622 |
| I/O | - | - | - | - | - | W16 | P136 | Y1 | 625 |
| I/O | - | - | - | - | - | W15 | P135 | V4 | 628 |
| GND | P91 | P119 | GND* | P135 | GND* | GND* | P134 | GND* | - |
| I/O | - | - | R12 | P136 | P20 | U13 | P133 | V3 | 631 |
| I/O | - | - | R11 | P137 | N18 | V14 | P132 | W2 | 634 |
| I/O | P92 | P120 | U13 | P138 | N19 | W14 | P131 | U4 | 637 |
| I/O | P93 | P121 | V13 | P139 | N20 | V13 | P130 | U3 | 640 |
| VCC | - | - | VCC* | P140 | VCC* | VCC* | P129 | VCC* | - |
| I/O (D5) | P94 | P122 | U12 | P141 | M17 | T12 | P127 | V2 | 643 |
| I/O (CS0) | P95 | P123 | V12 | P142 | M18 | X14 | P126 | V1 | 646 |
| I/O | - | - | - | - | - | U12 | P125 | U2 | 649 |
| I/O | - | - | - | - | - | W13 | P124 | T2 | 652 |
| GND | - | - | - | P143 | GND* | GND* | - | GND* | - |
| I/O | - | - | - | - | - | X13 | P123 | T1 | 655 |
| I/O | - | - | - | - | - | M19 | P122 | R4 | 658 |
| I/O | - | P124 | T11 | P144 | M20 | W12 | P121 | R3 | 661 |
| I/O | - | P125 | U11 | P145 | L19 | T11 | P120 | R2 | 664 |
| I/O | P96 | P126 | V11 | P146 | L18 | X12 | P119 | R1 | 667 |
| I/O | P97 | P127 | V10 | P147 | L20 | U11 | P118 | P3 | 670 |
| I/O (D4) | P98 | P128 | U10 | P148 | K20 | V11 | P117 | P2 | 673 |
| I/O | P99 | P129 | T10 | P149 | K19 | W11 | P116 | P1 | 676 |
| VCC | P100 | P130 | VCC* | P150 | VCC* | VCC* | P115 | VCC* | - |
| GND | P101 | P131 | GND* | P151 | GND* | GND* | P114 | GND* | - |
| I/O (D3) | P102 | P132 | T9 | P152 | K18 | W10 | P113 | N2 | 679 |
| I/O (RS) | P103 | P133 | U9 | P153 | K17 | V10 | P112 | N4 | 682 |
| I/O | P104 | P134 | V9 | P154 | J20 | T10 | P111 | N3 | 685 |
| I/O | P105 | P135 | V8 | P155 | J19 | U10 | P110 | M1 | 688 |
| I/O | - | P136 | U8 | P156 | J18 | X9 | P109 | M2 | 691 |
| I/O | - | P137 | T8 | P157 | J17 | W9 | P108 | M3 | 694 |
| I/O | - | - | - | - | H20 | X8 | P107 | M4 | 697 |

| XC4025E, XC4028 EX/XL Pad Name | HQ 160†† | HQ 208‡ | PG 223† | HQ 240 | BG 256†† | PG 299 | HQ 304 | BG 352‡ | Bndry Scan |
|---|---|---|---|---|---|---|---|---|---|
| I/O | - | - | - | - | - | V9 | P106 | L1 | 700 |
| GND | - | - | - | P158 | GND* | GND* | - | GND* | - |
| I/O | - | - | - | - | - | U9 | P105 | L2 | 703 |
| I/O | - | - | - | - | - | T9 | P104 | L3 | 706 |
| I/O (D2) | P106 | P138 | V7 | P159 | H19 | W8 | P103 | J1 | 709 |
| I/O | P107 | P139 | U7 | P160 | H18 | X7 | P102 | K3 | 712 |
| VCC | - | - | VCC* | P161 | VCC* | VCC* | P101 | VCC* | - |
| I/O | P108 | P140 | V6 | P162 | G19 | V8 | P99 | J2 | 715 |
| I/O | P109 | P141 | U6 | P163 | F20 | W7 | P98 | J3 | 718 |
| I/O | - | - | R8 | P164 | G18 | U8 | P97 | K4 | 721 |
| I/O | - | - | R7 | P165 | F19 | W6 | P96 | G1 | 724 |
| GND | P110 | P142 | GND* | P166 | GND* | GND* | P95 | GND* | - |
| I/O | - | - | - | - | - | T8 | P94 | H2 | 727 |
| I/O | - | - | - | - | - | V7 | P93 | H3 | 730 |
| I/O | - | - | R6 | P167 | F18 | X4 | P92 | J4 | 733 |
| I/O | - | - | R5 | P168 | E19 | U7 | P91 | F1 | 736 |
| I/O | - | P143 | V5 | P169 | D20 | W5 | P90 | G2 | 739 |
| I/O | - | P144 | V4 | P170 | E18 | V6 | P89 | G3 | 742 |
| I/O | P111 | P145 | U5 | P171 | D19 | T7 | P88 | F2 | 745 |
| I/O | P112 | P146 | T6 | P172 | C20 | X3 | P87 | E2 | 748 |
| GND | - | - | - | - | GND* | GND* | - | GND* | - |
| VCC | - | - | - | - | VCC* | VCC* | - | VCC* | - |
| I/O (D1) | P113 | P147 | V3 | P173 | E17 | U6 | P86 | F3 | 751 |
| I/O (RCLK, RDY/BUSY) | P114 | P148 | V2 | P174 | D18 | V5 | P85 | G4 | 754 |
| I/O | - | - | - | - | - | W4 | P84 | D2 | 757 |
| I/O | - | - | - | - | - | W3 | P83 | F4 | 760 |
| I/O | P115 | P149 | U4 | P175 | C19 | T6 | P82 | E3 | 763 |
| I/O | P116 | P150 | T5 | P176 | B20 | U5 | P81 | C2 | 766 |
| I/O (D0, DIN) | P117 | P151 | U3 | P177 | C18 | V4 | P80 | D3 | 769 |
| I/O, SGCK4 †, GCK6 ‡ (DOUT) | P118 | P152 | T4 | P178 | B19 | X1 | P79 | E4 | 772 |
| CCLK | P119 | P153 | V1 | P179 | A20 | V3 | P78 | C3 | - |
| VCC | P120 | P154 | VCC* | P180 | VCC* | VCC* | P77 | VCC* | - |
| O, TDO | P121 | P159 | U2 | P181 | A19 | U4 | P76 | D4 | 0 |
| GND | P122 | P160 | GND* | P182 | GND* | GND* | P75 | GND* | - |
| I/O (A0, WS) | P123 | P161 | T3 | P183 | B18 | W2 | P74 | B3 | 2 |
| I/O, PGCK4 †, GCK7 ‡ (A1) | P124 | P162 | U1 | P184 | B17 | V2 | P73 | C4 | 5 |
| I/O | P125 | P163 | P3 | P185 | C17 | R5 | P72 | D5 | 8 |
| I/O | P126 | P164 | R2 | P186 | D16 | T4 | P71 | A3 | 11 |
| I/O (CS1, A2) | P127 | P165 | T2 | P187 | A18 | U3 | P70 | D6 | 14 |
| I/O (A3) | P128 | P166 | N3 | P188 | A17 | V1 | P69 | C6 | 17 |
| I/O | - | - | - | - | - | R4 | P68 | B5 | 20 |
| I/O | - | - | - | - | - | P5 | P67 | A4 | 23 |
| VCC | - | - | - | - | VCC* | VCC* | - | VCC* | - |
| GND | - | - | - | - | GND* | GND* | - | GND* | - |
| I/O | - | - | P4 | P189 | C16 | U2 | P66 | C7 | 26 |
| I/O | - | - | N4 | P190 | B16 | T3 | P65 | B6 | 29 |
| I/O | P129 | P167 | P2 | P191 | A16 | U1 | P64 | A6 | 32 |
| I/O | P130 | P168 | T1 | P192 | C15 | P4 | P63 | D8 | 35 |
| I/O | - | P169 | R1 | P193 | B15 | R3 | P62 | B7 | 38 |
| I/O | - | P170 | N2 | P194 | A15 | N5 | P61 | A7 | 41 |
| I/O | - | - | - | P195 | - | T2 | P60 | D9 | 44 |
| I/O | - | - | - | - | - | R2 | P59 | C9 | 47 |
| GND | P131 | P171 | GND* | P196 | GND* | GND* | P58 | GND* | - |
| I/O | P132 | P172 | P1 | P197 | B14 | N4 | P57 | B8 | 50 |
| I/O | P133 | P173 | N1 | P198 | A14 | P3 | P56 | D10 | 53 |
| I/O | - | - | M4 | P199 | C13 | P2 | P55 | C10 | 56 |
| I/O | - | - | L4 | P200 | B13 | N3 | P54 | B9 | 59 |
| VCC | - | - | VCC* | P201 | VCC* | VCC* | P52 | VCC* | - |

| XC4025E, XC4028 EX/XL Pad Name | HQ 160†† | HQ 208‡ | PG 223† | HQ 240 | BG 256†† | PG 299 | HQ 304 | BG 352‡ | Bndry Scan |
|---|---|---|---|---|---|---|---|---|---|
| I/O | - | - | - | - | A13 | M5 | P51 | A9 | 62 |
| I/O | - | - | - | - | D12 | P1 | P50 | D11 | 65 |
| I/O | - | - | - | - | - | M4 | P49 | B11 | 68 |
| I/O | - | - | - | - | - | N2 | P48 | A11 | 71 |
| GND | - | - | - | - | GND* | GND* | - | GND* | - |
| I/O (A4) | P134 | P174 | M2 | P202 | C12 | N1 | P47 | D12 | 74 |
| I/O (A5) | P135 | P175 | M1 | P203 | B12 | M3 | P46 | C12 | 77 |
| I/O | - | P176 | L3 | P205 | A12 | M2 | P45 | B12 | 80 |
| I/O | P136 | P177 | L2 | P206 | B11 | L5 | P44 | A12 | 83 |
| I/O (A21) ‡ | P137 | P178 | L1 | P207 | C11 | M1 | P43 | C13 | 86 |
| I/O (A20) ‡ | P138 | P179 | K1 | P208 | A11 | L4 | P42 | B13 | 89 |
| I/O (A6) | P139 | P180 | K2 | P209 | A10 | L3 | P41 | A13 | 92 |
| I/O (A7) | P140 | P181 | K3 | P210 | B10 | L2 | P40 | B14 | 95 |
| GND | P141 | P182 | GND* | P211 | GND* | GND* | P39 | GND* | - |

6/19/97

* Pads labelled GND* or VCC* are internally bonded to Ground or VCC planes within the associated package. They have no direct connection to any specific package pin.

† = E only
†† = XL only
‡ = EX, XL only

## Additional XC4025E, XC4028EX/XL Package Pins

### HQ208

| N.C. Pins | | | | | |
|---|---|---|---|---|---|
| P1 | P52 | P102 | P107 | P157 | P207 |
| P3 | P53 | P104 | P155 | P158 | P208 |
| P51 | P54 | P105 | P156 | P206 | |

5/9/97

### PG223

| VCC Pins | | | |
|---|---|---|---|
| D3 | D10 | D16 | J4 |
| J15 | R4 | R10 | R15 |
| GND Pins | | | |
| C7 | C12 | D4 | D9 |
| D15 | G3 | G16 | K4 |
| K15 | M3 | M16 | R3 |
| R9 | R16 | T7 | T12 |

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### HQ240

| GND Pins | |
|---|---|
| P204 | P219 |

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Note: These pins may be N.C. for this device revision, however for compatability with other devices in this package, these pins should be tied to GND.

**BG256**

| VCC Pins | | | |
|---|---|---|---|
| C14 | D6 | D7 | D11 |
| D14 | D15 | E20 | F1 |
| F4 | F17 | G4 | G17 |
| K4 | L17 | P4 | P17 |
| P19 | R2 | R4 | R17 |
| U6 | U7 | U10 | U14 |
| U15 | V7 | W20 | - |
| **GND Pins** | | | |
| A1 | B7 | D4 | D8 |
| D13 | D17 | G20 | H4 |
| H17 | N3 | N4 | N17 |
| U4 | U8 | U13 | U17 |
| W14 | - | - | - |

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**PG299**

| VCC Pins | | | |
|---|---|---|---|
| A2 | A6 | A11 | A16 |
| B20 | E1 | E5 | F20 |
| K1 | L20 | R1 | T16 |
| T20 | W1 | X5 | X10 |
| X15 | X19 | - | - |
| **GND Pins** | | | |
| A5 | A10 | A15 | A19 |
| B1 | E16 | E20 | F1 |
| K20 | L1 | R20 | T1 |
| T5 | W20 | X2 | X6 |
| X11 | X16 | - | - |

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**HQ304**

| N.C. Pins | | | | |
|---|---|---|---|---|
| P11 | P53 | P128 | P205 | P281 |
| P24 | P100 | P176 | P254 | - |

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Note: In XC4025 (no extension) devices in the HQ304 package, P101 is a No Connect (N.C.) pin. P101 is Vcc in XC4025E and XC4028EX/XL devices. Where necessary for compatibility, this pin can be left unconnected.

**BG352**

| VCC Pins | | | | | |
|---|---|---|---|---|---|
| A10 | A17 | B2 | B25 | D7 | D13 |
| D19 | G23 | H4 | K1 | K26 | N23 |
| P4 | U1 | U26 | W23 | Y4 | AC8 |
| AC14 | AC20 | AE2 | AE25 | AF10 | AF17 |
| **GND Pins** | | | | | |
| A1 | A2 | A5 | A8 | A14 | A19 |
| A22 | A25 | A26 | B1 | B26 | E1 |
| E26 | H1 | H26 | N1 | P26 | W1 |
| W26 | AB1 | AB26 | AE1 | AE26 | AF1 |
| AF2 | AF5 | AF8 | AF13 | AF19 | AF22 |
| AF25 | AF26 | - | - | - | - |
| **N.C. Pins** | | | | | |
| A18 | A24 | B4 | B10 | B23 | C1 |
| C5 | C8 | C11 | D1 | D16 | D25 |
| F23 | J26 | K2 | L4 | L23 | T3 |
| T4 | T24 | U25 | AB3 | AC2 | AC6 |
| AC11 | AC16 | AC21 | AC25 | AD16 | AD21 |
| AD26 | AE4 | AE10 | - | - | - |

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# Pin Locations for XC4036EX/XL

The following table may contain pinout information for unsupported device/package combinations. Please see the availability charts elsewhere in the XC4000 Series data sheet for availability information.

| XC4036EX/XL Pad Name | PQ 160†† | HQ 208†† | HQ 240 | HQ 304 | BG 352 | PG 411 | BG 432 | Bndry Scan |
|---|---|---|---|---|---|---|---|---|
| VCC | P142 | P183 | P212 | P38 | VCC* | VCC* | VCC* | - |
| I/O (A8) | P143 | P184 | P213 | P37 | D14 | W3 | D17 | 110 |
| I/O (A9) | P144 | P185 | P214 | P36 | C14 | Y2 | A17 | 113 |
| I/O (A19) | P145 | P186 | P215 | P35 | A15 | V4 | C18 | 116 |
| I/O (A18) | P146 | P187 | P216 | P34 | B15 | T2 | D18 | 119 |
| I/O | - | P188 | P217 | P33 | C15 | U1 | B18 | 122 |
| I/O | - | P189 | P218 | P32 | D15 | V6 | A19 | 125 |
| I/O (A10) | P147 | P190 | P220 | P31 | A16 | U3 | B19 | 128 |
| I/O (A11) | P148 | P191 | P221 | P30 | B16 | R1 | C19 | 131 |
| VCC | - | - | - | - | VCC* | VCC* | VCC* | - |
| GND | - | - | - | - | GND* | GND* | GND* | - |
| I/O | - | - | - | P29 | C16 | U5 | D19 | 134 |
| I/O | - | - | - | P28 | B17 | T4 | A20 | 137 |
| I/O | - | - | - | - | D16 | P2 | B20 | 140 |
| I/O | - | - | - | - | A18 | N1 | C20 | 143 |
| I/O | - | - | - | P27 | C17 | R5 | C21 | 146 |
| I/O | - | - | - | P26 | B18 | M2 | A22 | 149 |
| VCC | - | - | P222 | P25 | VCC* | VCC* | VCC* | - |
| I/O | - | - | P223 | P23 | C18 | L3 | B22 | 152 |
| I/O | - | - | P224 | P22 | D17 | T6 | C22 | 155 |
| I/O | P149 | P192 | P225 | P21 | A20 | N5 | B23 | 158 |
| I/O | P150 | P193 | P226 | P20 | B19 | M4 | A24 | 161 |
| GND | P151 | P194 | P227 | P19 | GND* | GND* | GND* | - |
| I/O | - | - | - | P18 | C19 | K2 | D22 | 164 |
| I/O | - | - | - | P17 | D18 | K4 | C23 | 167 |
| I/O | - | P195 | P228 | P16 | A21 | P6 | B24 | 170 |
| I/O | - | P196 | P229 | P15 | B20 | M6 | C24 | 173 |
| I/O | P152 | P197 | P230 | P14 | C20 | J3 | A26 | 176 |
| I/O | P153 | P198 | P231 | P13 | B21 | H2 | C25 | 179 |
| I/O (A12) | P154 | P199 | P232 | P12 | B22 | H4 | D24 | 182 |

| XC4036EX/XL Pad Name | PQ 160†† | HQ 208†† | HQ 240 | HQ 304 | BG 352 | PG 411 | BG 432 | Bndry Scan |
|---|---|---|---|---|---|---|---|---|
| I/O (A13) | P155 | P200 | P233 | P10 | C21 | G3 | B26 | 185 |
| GND | - | - | - | - | GND* | GND* | GND* | - |
| VCC | - | - | - | - | VCC* | VCC* | VCC* | - |
| I/O | - | - | - | P9 | D20 | K6 | A27 | 188 |
| I/O | - | - | - | P8 | A23 | G1 | D25 | 191 |
| I/O | - | - | - | - | A24 | E1 | C26 | 194 |
| I/O | - | - | - | - | B23 | E3 | B27 | 197 |
| I/O | - | - | P234 | P7 | D21 | J7 | C27 | 200 |
| I/O | - | - | P235 | P6 | C22 | H6 | B28 | 203 |
| I/O | P156 | P201 | P236 | P5 | B24 | C3 | D27 | 206 |
| I/O | P157 | P202 | P237 | P4 | C23 | D2 | B29 | 209 |
| I/O (A14) | P158 | P203 | P238 | P3 | D22 | E5 | C28 | 212 |
| I/O, GCK8 (A15) | P159 | P204 | P239 | P2 | C24 | G7 | D28 | 215 |
| VCC | P160 | P205 | P240 | P1 | VCC* | VCC* | VCC* | - |
| GND | P1 | P2 | P1 | P304 | GND* | GND* | GND* | - |
| I/O, GCK1 (A16) | P2 | P4 | P2 | P303 | D23 | H8 | D29 | 218 |
| I/O (A17) | P3 | P5 | P3 | P302 | C25 | F6 | C30 | 221 |
| I/O | P4 | P6 | P4 | P301 | D24 | B4 | E28 | 224 |
| I/O | P5 | P7 | P5 | P300 | E23 | D4 | E29 | 227 |
| I/O, TDI | P6 | P8 | P6 | P299 | C26 | B2 | D30 | 230 |
| I/O, TCK | P7 | P9 | P7 | P298 | E24 | G9 | D31 | 233 |
| I/O | - | - | - | - | D25 | F8 | E30 | 236 |
| I/O | - | - | - | - | F23 | C5 | E31 | 239 |
| I/O | - | - | - | P297 | F24 | A7 | G28 | 242 |
| I/O | - | - | - | P296 | E25 | A5 | G29 | 245 |
| VCC | - | - | - | - | VCC* | VCC* | VCC* | - |
| GND | - | - | - | - | GND* | GND* | GND* | - |
| I/O | P8 | P10 | P8 | P295 | D26 | B8 | H28 | 248 |
| I/O | P9 | P11 | P9 | P294 | G24 | C9 | H29 | 251 |
| I/O | - | P12 | P10 | P293 | F25 | E9 | G30 | 254 |

| XC4036EX/XL Pad Name | PQ 160†† | HQ 208†† | HQ 240 | HQ 304 | BG 352 | PG 411 | BG 432 | Bndry Scan |
|---|---|---|---|---|---|---|---|---|
| I/O | - | P13 | P11 | P292 | F26 | F12 | H30 | 257 |
| I/O | - | - | P12 | P291 | H23 | D10 | J28 | 260 |
| I/O | - | - | P13 | P290 | H24 | B10 | J29 | 263 |
| I/O | - | - | - | P289 | G25 | F10 | H31 | 266 |
| I/O | - | - | - | P288 | G26 | F14 | J30 | 269 |
| GND | P10 | P14 | P14 | P287 | GND* | GND* | GND* | - |
| I/O | P11 | P15 | P15 | P286 | J23 | C11 | K28 | 272 |
| I/O | P12 | P16 | P16 | P285 | J24 | B12 | K29 | 275 |
| I/O, TMS | P13 | P17 | P17 | P284 | H25 | E11 | K30 | 278 |
| I/O | P14 | P18 | P18 | P283 | K23 | E15 | K31 | 281 |
| VCC | - | - | P19 | P282 | VCC* | VCC* | VCC* | - |
| I/O | - | - | P20 | P280 | K24 | F16 | L29 | 284 |
| I/O | - | - | P21 | P279 | J25 | C13 | L30 | 287 |
| I/O | - | - | - | - | J26 | B14 | M29 | 290 |
| I/O | - | - | - | - | L23 | E17 | M31 | 293 |
| I/O | - | - | - | P278 | L24 | E13 | N31 | 296 |
| I/O | - | - | - | P277 | K25 | A15 | N28 | 299 |
| GND | - | - | P22 | - | GND* | GND* | GND* | - |
| VCC | - | - | - | - | VCC* | VCC* | VCC* | - |
| I/O | - | - | - | P276 | L25 | B16 | P30 | 302 |
| I/O | - | - | - | P275 | L26 | D16 | P28 | 305 |
| I/O | - | P19 | P23 | P274 | M23 | D18 | P29 | 308 |
| I/O | - | P20 | P24 | P273 | M24 | A17 | R31 | 311 |
| I/O | P15 | P21 | P25 | P272 | M25 | E19 | R30 | 314 |
| I/O | P16 | P22 | P26 | P271 | M26 | B18 | R28 | 317 |
| I/O | P17 | P23 | P27 | P270 | N24 | C17 | R29 | 320 |
| I/O | P18 | P24 | P28 | P269 | N25 | C19 | T31 | 323 |
| GND | P19 | P25 | P29 | P268 | GND* | GND* | GND* | - |
| VCC | P20 | P26 | P30 | P267 | VCC* | VCC* | VCC* | - |
| I/O | P21 | P27 | P31 | P266 | N26 | F20 | T30 | 326 |
| I/O | P22 | P28 | P32 | P265 | P25 | B20 | T29 | 329 |
| I/O | P23 | P29 | P33 | P264 | P23 | C21 | U31 | 332 |
| I/O | P24 | P30 | P34 | P263 | P24 | B22 | U30 | 335 |
| I/O | - | P31 | P35 | P262 | R26 | E21 | U28 | 338 |
| I/O | - | P32 | P36 | P261 | R25 | D22 | U29 | 341 |
| I/O | - | - | - | P260 | R24 | A23 | V30 | 344 |
| I/O | - | - | - | P259 | R23 | B24 | V29 | 347 |
| VCC | - | - | - | - | VCC* | VCC* | VCC* | - |
| GND | - | - | P37 | - | GND* | GND* | GND* | - |
| I/O | - | - | - | P258 | T26 | A25 | W30 | 350 |
| I/O | - | - | - | P257 | T25 | D24 | W29 | 353 |
| I/O | - | - | - | - | T24 | B26 | Y30 | 356 |
| I/O | - | - | - | - | U25 | A27 | Y29 | 359 |
| I/O | - | - | P38 | P256 | T23 | C27 | Y28 | 362 |
| I/O | - | - | P39 | P255 | V26 | F24 | AA30 | 365 |
| VCC | - | - | P40 | P253 | VCC* | VCC* | VCC* | - |
| I/O | P25 | P33 | P41 | P252 | U24 | E25 | AA29 | 368 |
| I/O | P26 | P34 | P42 | P251 | V25 | E27 | AB31 | 371 |
| I/O | P27 | P35 | P43 | P250 | V24 | B28 | AB30 | 374 |
| I/O | P28 | P36 | P44 | P249 | U23 | C29 | AB29 | 377 |
| GND | P29 | P37 | P45 | P248 | GND* | GND* | GND* | - |
| I/O | - | - | - | P247 | Y26 | F26 | AB28 | 380 |
| I/O | - | - | - | P246 | W25 | D28 | AC30 | 383 |
| I/O | - | - | P46 | P245 | W24 | B30 | AC29 | 386 |
| I/O | - | - | P47 | P244 | V23 | E29 | AC28 | 389 |
| I/O | - | P38 | P48 | P243 | AA26 | F28 | AD29 | 392 |
| I/O | - | P39 | P49 | P242 | Y25 | F30 | AD28 | 395 |
| I/O | P30 | P40 | P50 | P241 | Y24 | C31 | AE30 | 398 |
| I/O | P31 | P41 | P51 | P240 | AA25 | E31 | AE29 | 401 |
| GND | - | - | - | - | GND* | GND* | GND* | - |
| VCC | - | - | - | - | VCC* | VCC* | VCC* | - |
| I/O | - | - | - | P239 | AB25 | B32 | AF31 | 404 |
| I/O | - | - | - | P238 | AA24 | A33 | AE28 | 407 |
| I/O | P32 | P42 | P52 | P237 | Y23 | A35 | AG31 | 410 |
| I/O | P33 | P43 | P53 | P236 | AC26 | F32 | AF28 | 413 |
| I/O | - | - | - | - | AD26 | C35 | AG30 | 416 |
| I/O | - | - | - | - | AC25 | B38 | AG29 | 419 |
| I/O | P34 | P44 | P54 | P235 | AA23 | E33 | AH31 | 422 |
| I/O | P35 | P45 | P55 | P234 | AB24 | G31 | AG28 | 425 |
| I/O | P36 | P46 | P56 | P233 | AD25 | H32 | AH30 | 428 |
| I/O, GCK2 | P37 | P47 | P57 | P232 | AC24 | B36 | AJ30 | 431 |
| O (M1) | P38 | P48 | P58 | P231 | AB23 | A39 | AH29 | 434 |
| GND | P39 | P49 | P59 | P230 | GND* | GND* | GND* | - |
| I (M0) | P40 | P50 | P60 | P229 | AD24 | E35 | AH28 | 437 |
| VCC | P41 | P55 | P61 | P228 | VCC* | VCC* | VCC* | - |

| XC4036EX/XL Pad Name | PQ 160†† | HQ 208†† | HQ 240 | HQ 304 | BG 352 | PG 411 | BG 432 | Bndry Scan |
|---|---|---|---|---|---|---|---|---|
| I (M2) | P42 | P56 | P62 | P227 | AC23 | G33 | AJ28 | 438 |
| I/O, GCK3 | P43 | P57 | P63 | P226 | AE24 | D36 | AK29 | 439 |
| I/O (HDC) | P44 | P58 | P64 | P225 | AD23 | C37 | AH27 | 442 |
| I/O | P45 | P59 | P65 | P224 | AC22 | F34 | AK28 | 445 |
| I/O | P46 | P60 | P66 | P223 | AF24 | J33 | AJ27 | 448 |
| I/O | P47 | P61 | P67 | P222 | AD22 | D38 | AL28 | 451 |
| I/O (LDC) | P48 | P62 | P68 | P221 | AE23 | G35 | AH26 | 454 |
| I/O | - | - | - | - | AC21 | E39 | AL27 | 457 |
| I/O | - | - | - | - | AD21 | K34 | AH25 | 460 |
| I/O | - | - | - | P220 | AE22 | F38 | AK26 | 463 |
| I/O | - | - | - | P219 | AF23 | G37 | AL26 | 466 |
| VCC | - | - | - | - | VCC* | VCC* | VCC* | - |
| GND | - | - | - | - | GND* | GND* | GND* | - |
| I/O | P49 | P63 | P69 | P218 | AD20 | H38 | AH24 | 469 |
| I/O | P50 | P64 | P70 | P217 | AE21 | J37 | AJ25 | 472 |
| I/O | - | P65 | P71 | P216 | AF21 | G39 | AK25 | 475 |
| I/O | - | P66 | P72 | P215 | AC19 | M34 | AJ24 | 478 |
| I/O | - | - | P73 | P214 | AD19 | N35 | AL24 | 481 |
| I/O | - | - | P74 | P213 | AE20 | P34 | AH22 | 484 |
| I/O | - | - | - | P212 | AF20 | J35 | AJ23 | 487 |
| I/O | - | - | - | P211 | AC18 | L37 | AK23 | 490 |
| GND | P51 | P67 | P75 | P210 | GND* | GND* | GND* | - |
| I/O | P52 | P68 | P76 | P209 | AD18 | M38 | AJ22 | 493 |
| I/O | P53 | P69 | P77 | P208 | AE19 | R35 | AK22 | 496 |
| I/O | P54 | P70 | P78 | P207 | AC17 | H36 | AL22 | 499 |
| I/O | P55 | P71 | P79 | P206 | AD17 | T34 | AJ21 | 502 |
| VCC | - | - | P80 | P204 | VCC* | VCC* | VCC* | - |
| I/O | - | P72 | P81 | P203 | AE18 | N37 | AH20 | 505 |
| I/O | - | P73 | P82 | P202 | AF18 | N39 | AK21 | 508 |
| I/O | - | - | - | - | AC16 | U35 | AK20 | 511 |
| I/O | - | - | - | - | AD16 | R39 | AJ19 | 514 |
| I/O | - | - | - | P201 | AE17 | M36 | AL20 | 517 |
| I/O | - | - | - | P200 | AE16 | V34 | AH18 | 520 |
| GND | - | - | P83 | - | GND* | GND* | GND* | - |
| VCC | - | - | - | - | VCC* | VCC* | VCC* | - |
| I/O | - | - | - | P199 | AF16 | R37 | AK19 | 523 |
| I/O | - | - | - | P198 | AC15 | T38 | AJ18 | 526 |
| I/O | - | - | P84 | P197 | AD15 | T36 | AL19 | 529 |
| I/O | - | - | P85 | P196 | AE15 | V36 | AK18 | 532 |
| I/O | P56 | P74 | P86 | P195 | AF15 | U37 | AH17 | 535 |
| I/O | P57 | P75 | P87 | P194 | AD14 | U39 | AJ17 | 538 |
| I/O | P58 | P76 | P88 | P193 | AE14 | V38 | AJ16 | 541 |
| I/O (INIT) | P59 | P77 | P89 | P192 | AF14 | W37 | AK16 | 544 |
| VCC | P60 | P78 | P90 | P191 | VCC* | VCC* | VCC* | - |
| GND | P61 | P79 | P91 | P190 | GND* | GND* | GND* | - |
| I/O | P62 | P80 | P92 | P189 | AE13 | Y34 | AL16 | 547 |
| I/O | P63 | P81 | P93 | P188 | AC13 | AC37 | AH15 | 550 |
| I/O | P64 | P82 | P94 | P187 | AD13 | AB38 | AK15 | 553 |
| I/O | P65 | P83 | P95 | P186 | AF12 | AD36 | AJ14 | 556 |
| I/O | - | P84 | P96 | P185 | AE12 | AA35 | AH14 | 559 |
| I/O | - | P85 | P97 | P184 | AD12 | AE37 | AK14 | 562 |
| I/O | - | - | - | P183 | AC12 | AB36 | AL13 | 565 |
| I/O | - | - | - | P182 | AF11 | AD38 | AK13 | 568 |
| VCC | - | - | - | - | VCC* | VCC* | VCC* | - |
| GND | - | - | P98 | - | GND* | GND* | GND* | - |
| I/O | - | - | - | P181 | AE11 | AB34 | AJ13 | 571 |
| I/O | - | - | - | P180 | AD11 | AE39 | AH13 | 574 |
| I/O | - | - | - | - | AE10 | AM36 | AL12 | 577 |
| I/O | - | - | - | - | AC11 | AC35 | AK12 | 580 |
| I/O | - | - | P99 | P179 | AF9 | AG39 | AH12 | 583 |
| I/O | - | - | P100 | P178 | AD10 | AG37 | AJ11 | 586 |
| VCC | - | - | P101 | P177 | VCC* | VCC* | VCC* | - |
| I/O | P66 | P86 | P102 | P175 | AE9 | AD34 | AL10 | 589 |
| I/O | P67 | P87 | P103 | P174 | AD9 | AN39 | AK10 | 592 |
| I/O | P68 | P88 | P104 | P173 | AC10 | AE35 | AJ10 | 595 |
| I/O | P69 | P89 | P105 | P172 | AF7 | AH38 | AK9 | 598 |
| GND | P70 | P90 | P106 | P171 | GND* | GND* | GND* | - |
| I/O | - | - | - | P170 | AE8 | AJ37 | AL8 | 601 |
| I/O | - | - | - | P169 | AD8 | AG35 | AH10 | 604 |
| I/O | - | - | P107 | P168 | AC9 | AF34 | AJ9 | 607 |
| I/O | - | - | P108 | P167 | AF6 | AH36 | AK8 | 610 |
| I/O | - | P91 | P109 | P166 | AE7 | AK36 | AK7 | 613 |
| I/O | - | P92 | P110 | P165 | AD7 | AM34 | AL6 | 616 |
| I/O | P71 | P93 | P111 | P164 | AE6 | AH34 | AJ7 | 619 |
| I/O | P72 | P94 | P112 | P163 | AE5 | AJ35 | AH8 | 622 |

| XC4036EX/XL Pad Name | PQ 160†† | HQ 208†† | HQ 240 | HQ 304 | BG 352 | PG 411 | BG 432 | Bndry Scan |
|---|---|---|---|---|---|---|---|---|
| GND | - | - | - | - | GND* | GND* | GND* | - |
| VCC | - | - | - | - | VCC* | VCC* | VCC* | - |
| I/O | - | - | - | P162 | AD6 | AL37 | AK6 | 625 |
| I/O | - | - | - | P161 | AC7 | AT38 | AL5 | 628 |
| I/O | P73 | P95 | P113 | P160 | AF4 | AM38 | AH7 | 631 |
| I/O | P74 | P96 | P114 | P159 | AF3 | AN37 | AJ6 | 634 |
| I/O | - | - | - | - | AE4 | AK34 | AK5 | 637 |
| I/O | - | - | - | - | AC6 | AR39 | AL4 | 640 |
| I/O | P75 | P97 | P115 | P158 | AD5 | AN35 | AK4 | 643 |
| I/O | P76 | P98 | P116 | P157 | AE3 | AL33 | AH5 | 646 |
| I/O | P77 | P99 | P117 | P156 | AD4 | AV38 | AK3 | 649 |
| I/O, GCK4 | P78 | P100 | P118 | P155 | AC5 | AT36 | AJ4 | 652 |
| GND | P79 | P101 | P119 | P154 | GND* | GND* | GND* | - |
| DONE | P80 | P103 | P120 | P153 | AD3 | AR35 | AH4 | - |
| VCC | P81 | P106 | P121 | P152 | VCC* | VCC* | VCC* | - |
| PROGRAM | P82 | P108 | P122 | P151 | AC4 | AN33 | AH3 | - |
| I/O (D7) | P83 | P109 | P123 | P150 | AD2 | AM32 | AJ2 | 655 |
| I/O, GCK5 | P84 | P110 | P124 | P149 | AC3 | AP34 | AG4 | 658 |
| I/O | P85 | P111 | P125 | P148 | AB4 | AW39 | AG3 | 661 |
| I/O | P86 | P112 | P126 | P147 | AD1 | AN31 | AH2 | 664 |
| I/O | - | - | - | - | AB3 | AV36 | AH1 | 667 |
| I/O | - | - | - | - | AC2 | AR33 | AF4 | 670 |
| I/O | - | - | P127 | P146 | AA4 | AP32 | AF3 | 673 |
| I/O | - | - | P128 | P145 | AA3 | AU35 | AG2 | 676 |
| I/O | - | - | - | P144 | AB2 | AW33 | AE3 | 679 |
| I/O | - | - | - | P143 | AC1 | AU33 | AF2 | 682 |
| VCC | - | - | - | - | VCC* | VCC* | VCC* | - |
| GND | - | - | - | - | GND* | GND* | GND* | - |
| I/O (D6) | P87 | P113 | P129 | P142 | Y3 | AV32 | AF1 | 685 |
| I/O | P88 | P114 | P130 | P141 | AA2 | AU31 | AD4 | 688 |
| I/O | P89 | P115 | P131 | P140 | AA1 | AR31 | AD3 | 691 |
| I/O | P90 | P116 | P132 | P139 | W4 | AP28 | AE2 | 694 |
| I/O | - | P117 | P133 | P138 | W3 | AT32 | AC3 | 697 |
| I/O | - | P118 | P134 | P137 | Y2 | AV30 | AD1 | 700 |
| I/O | - | - | - | P136 | Y1 | AR29 | AC2 | 703 |
| I/O | - | - | - | P135 | V4 | AP26 | AB4 | 706 |
| GND | P91 | P119 | P135 | P134 | GND* | GND* | GND* | - |
| I/O | - | - | P136 | P133 | V3 | AU29 | AB3 | 709 |
| I/O | - | - | P137 | P132 | W2 | AV28 | AB2 | 712 |
| I/O | P92 | P120 | P138 | P131 | U4 | AT28 | AB1 | 715 |
| I/O | P93 | P121 | P139 | P130 | U3 | AR25 | AA3 | 718 |
| VCC | - | - | P140 | P129 | VCC* | VCC* | VCC* | - |
| I/O (D5) | P94 | P122 | P141 | P127 | V2 | AP24 | AA2 | 721 |
| I/O (CS0) | P95 | P123 | P142 | P126 | V1 | AU27 | Y2 | 724 |
| I/O | - | - | - | - | T4 | AR27 | Y4 | 727 |
| I/O | - | - | - | - | T3 | AW27 | Y3 | 730 |
| I/O | - | - | - | P125 | U2 | AT24 | W4 | 733 |
| I/O | - | - | - | P124 | T2 | AR23 | W3 | 736 |
| GND | - | - | P143 | - | GND* | GND* | GND* | - |
| VCC | - | - | - | - | VCC* | VCC* | VCC* | - |
| I/O | - | - | - | P123 | T1 | AP22 | V4 | 739 |
| I/O | - | - | - | P122 | R4 | AV24 | V3 | 742 |
| I/O | - | P124 | P144 | P121 | R3 | AU23 | U1 | 745 |
| I/O | - | P125 | P145 | P120 | R2 | AT22 | U2 | 748 |
| I/O | P96 | P126 | P146 | P119 | R1 | AR21 | U4 | 751 |
| I/O | P97 | P127 | P147 | P118 | P3 | AV22 | U3 | 754 |
| I/O (D4) | P98 | P128 | P148 | P117 | P2 | AP20 | T1 | 757 |
| I/O | P99 | P129 | P149 | P116 | P1 | AU21 | T2 | 760 |
| VCC | P100 | P130 | P150 | P115 | VCC* | VCC* | VCC* | - |
| GND | P101 | P131 | P151 | P114 | GND* | GND* | GND* | - |
| I/O (D3) | P102 | P132 | P152 | P113 | N2 | AU19 | T3 | 763 |
| I/O (RS) | P103 | P133 | P153 | P112 | N4 | AV20 | R1 | 766 |
| I/O | P104 | P134 | P154 | P111 | N3 | AV18 | R2 | 769 |
| I/O | P105 | P135 | P155 | P110 | M1 | AR19 | R4 | 772 |
| I/O | - | P136 | P156 | P109 | M2 | AT18 | R3 | 775 |
| I/O | - | P137 | P157 | P108 | M3 | AW17 | P2 | 778 |
| I/O | - | - | - | P107 | M4 | AV16 | P3 | 781 |
| I/O | - | - | - | P106 | L1 | AP18 | P4 | 784 |
| VCC | - | - | - | - | VCC* | VCC* | VCC* | - |
| GND | - | - | P158 | - | GND* | GND* | GND* | - |
| I/O | - | - | - | P105 | L2 | AR17 | N3 | 787 |
| I/O | - | - | - | P104 | L3 | AT16 | N4 | 790 |
| I/O | - | - | - | - | K2 | AV14 | M1 | 793 |
| I/O | - | - | - | - | L4 | AW13 | M2 | 796 |
| I/O (D2) | P106 | P138 | P159 | P103 | J1 | AR15 | L2 | 799 |

| XC4036EX/XL Pad Name | PQ 160†† | HQ 208†† | HQ 240 | HQ 304 | BG 352 | PG 411 | BG 432 | Bndry Scan |
|---|---|---|---|---|---|---|---|---|
| I/O | P107 | P139 | P160 | P102 | K3 | AP16 | L3 | 802 |
| VCC | - | - | P161 | P101 | VCC* | VCC* | VCC* | - |
| I/O | P108 | P140 | P162 | P99 | J2 | AV12 | K1 | 805 |
| I/O | P109 | P141 | P163 | P98 | J3 | AR13 | K2 | 808 |
| I/O | - | - | P164 | P97 | K4 | AU11 | K3 | 811 |
| I/O | - | - | P165 | P96 | G1 | AT12 | K4 | 814 |
| GND | P110 | P142 | P166 | P95 | GND* | GND* | GND* | - |
| I/O | - | - | - | P94 | H2 | AP14 | J2 | 817 |
| I/O | - | - | - | P93 | H3 | AR11 | J3 | 820 |
| I/O | - | - | P167 | P92 | J4 | AV10 | J4 | 823 |
| I/O | - | - | P168 | P91 | F1 | AT8 | H1 | 826 |
| I/O | - | P143 | P169 | P90 | G2 | AT10 | H2 | 829 |
| I/O | - | P144 | P170 | P89 | G3 | AP10 | H3 | 832 |
| I/O | P111 | P145 | P171 | P88 | F2 | AP12 | H4 | 835 |
| I/O | P112 | P146 | P172 | P87 | E2 | AR9 | G2 | 838 |
| GND | - | - | - | - | GND* | GND* | GND* | - |
| VCC | - | - | - | - | VCC* | VCC* | VCC* | - |
| I/O (D1) | P113 | P147 | P173 | P86 | F3 | AU7 | G4 | 841 |
| I/O (RCLK, RDY/BUSY) | P114 | P148 | P174 | P85 | G4 | AW7 | F2 | 844 |
| I/O | - | - | - | - | D1 | AW5 | F3 | 847 |
| I/O | - | - | - | - | C1 | AV6 | E1 | 850 |
| I/O | - | - | - | P84 | D2 | AR7 | E3 | 853 |
| I/O | - | - | - | P83 | F4 | AV4 | D1 | 856 |
| I/O | P115 | P149 | P175 | P82 | E3 | AN9 | E4 | 859 |
| I/O | P116 | P150 | P176 | P81 | C2 | AW1 | D2 | 862 |
| I/O (D0, DIN) | P117 | P151 | P177 | P80 | D3 | AP6 | C2 | 865 |
| I/O, GCK6 (DOUT) | P118 | P152 | P178 | P79 | E4 | AU3 | D3 | 868 |
| CCLK | P119 | P153 | P179 | P78 | C3 | AR5 | D4 | - |
| VCC | P120 | P154 | P180 | P77 | VCC* | VCC* | VCC* | - |
| O, TDO | P121 | P159 | P181 | P76 | D4 | AN7 | C4 | 0 |
| GND | P122 | P160 | P182 | P75 | GND* | GND* | GND* | - |
| I/O (A0, WS) | P123 | P161 | P183 | P74 | B3 | AT4 | B3 | 2 |
| I/O, GCK7 (A1) | P124 | P162 | P184 | P73 | C4 | AV2 | D5 | 5 |
| I/O | P125 | P163 | P185 | P72 | D5 | AM8 | B4 | 8 |
| I/O | P126 | P164 | P186 | P71 | A3 | AL7 | C5 | 11 |
| I/O | - | - | - | - | C5 | AR3 | B5 | 14 |
| I/O | - | - | - | - | B4 | AR1 | C6 | 17 |
| I/O (CS1, A2) | P127 | P165 | P187 | P70 | D6 | AK6 | A5 | 20 |
| I/O (A3) | P128 | P166 | P188 | P69 | C6 | AN3 | D7 | 23 |
| I/O | - | - | - | P68 | B5 | AM6 | B6 | 26 |
| I/O | - | - | - | P67 | A4 | AM2 | A6 | 29 |
| VCC | - | - | - | - | VCC* | VCC* | VCC* | - |
| GND | - | - | - | - | GND* | GND* | GND* | - |
| I/O | - | - | P189 | P66 | C7 | AL3 | D8 | 32 |
| I/O | - | - | P190 | P65 | B6 | AH6 | C7 | 35 |
| I/O | P129 | P167 | P191 | P64 | A6 | AP2 | B7 | 38 |
| I/O | P130 | P168 | P192 | P63 | D8 | AK4 | D9 | 41 |
| I/O | - | P169 | P193 | P62 | B7 | AG5 | D10 | 44 |
| I/O | - | P170 | P194 | P61 | A7 | AF6 | C9 | 47 |
| I/O | - | - | P195 | P60 | D9 | AL5 | B9 | 50 |
| I/O | - | - | - | P59 | C9 | AJ3 | C10 | 53 |
| GND | P131 | P171 | P196 | P58 | GND* | GND* | GND* | - |
| I/O | P132 | P172 | P197 | P57 | B8 | AH2 | B10 | 56 |
| I/O | P133 | P173 | P198 | P56 | D10 | AE5 | A10 | 59 |
| I/O | - | - | P199 | P55 | C10 | AM4 | C11 | 62 |
| I/O | - | - | P200 | P54 | B9 | AD6 | D12 | 65 |
| VCC | - | - | P201 | P52 | VCC* | VCC* | VCC* | - |
| I/O | - | - | - | P51 | A9 | AG3 | B11 | 68 |
| I/O | - | - | - | P50 | D11 | AG1 | C12 | 71 |
| I/O | - | - | - | - | C11 | AC5 | C13 | 74 |
| I/O | - | - | - | - | B10 | AE1 | A12 | 77 |
| I/O | - | - | - | P49 | B11 | AH4 | D14 | 80 |
| I/O | - | - | - | P48 | A11 | AB6 | B13 | 83 |
| GND | - | - | - | - | GND* | GND* | GND* | - |
| VCC | - | - | - | - | VCC* | VCC* | VCC* | - |
| I/O (A4) | P134 | P174 | P202 | P47 | D12 | AD2 | C14 | 86 |
| I/O (A5) | P135 | P175 | P203 | P46 | C12 | AB4 | A13 | 89 |
| I/O | - | P176 | P205 | P45 | B12 | AE3 | B14 | 92 |
| I/O | P136 | P177 | P206 | P44 | A12 | AC1 | D15 | 95 |
| I/O (A21) | P137 | P178 | P207 | P43 | C13 | AD4 | C15 | 98 |
| I/O (A20) | P138 | P179 | P208 | P42 | B13 | AA5 | B15 | 101 |
| I/O (A6) | P139 | P180 | P209 | P41 | A13 | AA3 | B16 | 104 |
| I/O (A7) | P140 | P181 | P210 | P40 | B14 | Y6 | A16 | 107 |

| XC4036EX/XL Pad Name | PQ 160†† | HQ 208†† | HQ 240 | HQ 304 | BG 352 | PG 411 | BG 432 | Bndry Scan |
|---|---|---|---|---|---|---|---|---|
| GND | P141 | P182 | P211 | P39 | GND* | GND* | GND* | - |

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\* Pads labelled GND* or VCC* are internally bonded to Ground or VCC planes within the associated package. They have no direct connection to any specific package pin.

†† = XL only

## Additional XC4036EX/XL Package Pins

**HQ208**

| N.C. Pins | | | | |
|---|---|---|---|---|
| P1 | P3 | P51 | P52 | P53 |
| P54 | P102 | P104 | P105 | P107 |
| P155 | P156 | P157 | P158 | P206 |
| P207 | P208 | - | - | - |

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**HQ240**

| GND Pins | | | | |
|---|---|---|---|---|
| P204 | P219 | - | - | - |

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The Ground (GND) package pins in the above table should be externally connected to Ground if possible; however, they can be left unconnected if necessary for compatibility with other devices.

**HQ304**

| N.C. Pins | | | | |
|---|---|---|---|---|
| P11 | P24 | P53 | P100 | P128 |
| P176 | P205 | P254 | P281 | - |

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**BG352**

| VCC Pins | | | | | |
|---|---|---|---|---|---|
| A10 | A17 | B2 | B25 | D7 | D13 |
| D19 | G23 | H4 | K1 | K26 | N23 |
| P4 | U1 | U26 | W23 | Y4 | AC8 |
| AC14 | AC20 | AE2 | AE25 | AF10 | AF17 |
| **GND Pins** | | | | | |
| A1 | A2 | A5 | A8 | A14 | A19 |
| A22 | A25 | A26 | B1 | B26 | E1 |
| E26 | H1 | H26 | N1 | P26 | W1 |
| W26 | AB1 | AB26 | AE1 | AE26 | AF1 |
| AF2 | AF5 | AF8 | AF13 | AF19 | AF22 |
| AF25 | AF26 | - | - | - | - |
| **N.C. Pins** | | | | | |
| C8 | - | - | - | - | |

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**PG411**

| VCC Pins | | | | | |
|---|---|---|---|---|---|
| A3 | A11 | A21 | A31 | C39 | D6 |
| F36 | J1 | L39 | W1 | AA39 | AJ1 |
| AL39 | AP4 | AT34 | AU1 | AW9 | AW19 |
| AW29 | AW37 | - | - | - | - |
| **GND Pins** | | | | | |
| A9 | A19 | A29 | A37 | C1 | D14 |
| D20 | D26 | D34 | F4 | J39 | L1 |
| P4 | P36 | W39 | Y4 | Y36 | AA1 |
| AF4 | AF36 | AJ39 | AL1 | AP36 | AT6 |
| AT14 | AT20 | AT26 | AU39 | AW3 | AW11 |
| AW21 | AW31 | - | - | - | - |
| **N.C. Pins** | | | | | |
| A13 | B6 | B34 | C7 | C15 | C23 |
| C25 | C33 | D8 | D12 | D30 | D32 |
| E7 | E23 | E37 | F2 | F18 | F22 |
| G5 | H34 | J5 | K36 | K38 | L5 |
| L35 | N3 | P38 | R3 | V2 | W5 |
| W35 | Y38 | AA37 | AB2 | AC3 | AC39 |
| AF2 | AF38 | AJ5 | AK2 | AK38 | AL35 |
| AN1 | AN5 | AP8 | AP30 | AP38 | AR37 |
| AT2 | AT30 | AU5 | AU9 | AU13 | AU15 |
| AU17 | AU25 | AU37 | AV8 | AV26 | AV34 |
| AW15 | AW23 | AW25 | AW35 | - | - |

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**BG432**

| VCC Pins | | | | | |
|---|---|---|---|---|---|
| A1 | A11 | A21 | A31 | C3 | C29 |
| D11 | D21 | L1 | L4 | L28 | L31 |
| AA1 | AA4 | AA28 | AA31 | AH11 | AH21 |
| AJ3 | AJ29 | AL1 | AL11 | AL21 | AL31 |
| **GND Pins** | | | | | |
| A2 | A3 | A7 | A9 | A14 | A18 |
| A23 | A25 | A29 | A30 | B1 | B2 |
| B30 | B31 | C1 | C31 | D16 | G1 |
| G31 | J1 | J31 | P1 | P31 | T4 |
| T28 | V1 | V31 | AC1 | AC31 | AE1 |
| AE31 | AH16 | AJ1 | AJ31 | AK1 | AK2 |
| AK30 | AK31 | AL2 | AL3 | AL7 | AL9 |
| AL14 | AL18 | AL23 | AL25 | AL29 | AL30 |
| **N.C. Pins** | | | | | |
| A4 | A8 | A15 | A28 | B8 | B12 |
| B17 | B21 | B25 | C8 | C16 | C17 |
| D6 | D13 | D20 | D23 | D26 | E2 |
| F1 | F4 | F28 | F29 | F30 | F31 |
| G3 | M3 | M4 | M28 | M30 | N1 |
| N2 | N29 | N30 | V2 | V28 | W1 |
| W2 | W28 | W31 | Y1 | Y31 | AC4 |
| AD2 | AD30 | AD31 | AE4 | AF29 | AF30 |
| AG1 | AH6 | AH9 | AH19 | AH23 | AJ5 |
| AJ8 | AJ12 | AJ15 | AJ20 | AJ26 | AK11 |
| AK17 | AK24 | AK27 | AL15 | AL17 | - |

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## Pin Locations for XC4044XL Devices

(Note: XC4044XL is also available in the HQ304 package. The pinout is identical to the XC4036XL in the HQ304. )

| XC4044XL Pad Name | HQ 160 | HQ 208 | HQ 240 | BG 352 | PG 411 | BG 432 |
|---|---|---|---|---|---|---|
| VCC | P142 | P183 | P212 | VCC* | VCC* | VCC* |
| I/O (A8) | P143 | P184 | P213 | D14 | W3 | D17 |
| I/O (A9) | P144 | P185 | P214 | C14 | Y2 | A17 |
| I/O | - | - | - | - | V2 | C17 |
| I/O | - | - | - | - | W5 | B17 |
| I/O (A19) | P145 | P186 | P215 | A15 | V4 | C18 |
| I/O (A18) | P146 | P187 | P216 | B15 | T2 | D18 |
| I/O | - | P188 | P217 | C15 | U1 | B18 |
| I/O | - | P189 | P218 | D15 | V6 | A19 |
| I/O (A10) | P147 | P190 | P220 | A16 | U3 | B19 |
| I/O (A11) | P148 | P191 | P221 | B16 | R1 | C19 |
| VCC | - | - | - | VCC* | VCC* | VCC* |
| GND | - | - | - | GND* | GND* | GND* |
| I/O | - | - | - | C16 | U5 | D19 |
| I/O | - | - | - | B17 | T4 | A20 |

| XC4044XL Pad Name | HQ 160 | HQ 208 | HQ 240 | BG 352 | PG 411 | BG 432 | | XC4044XL Pad Name | HQ 160 | HQ 208 | HQ 240 | BG 352 | PG 411 | BG 432 |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| I/O | - | - | - | D16 | P2 | B20 | | I/O | - | P20 | P24 | M24 | A17 | R31 |
| I/O | - | - | - | A18 | N1 | C20 | | I/O | P15 | P21 | P25 | M25 | E19 | R30 |
| I/O | - | - | - | C17 | R5 | C21 | | I/O | P16 | P22 | P26 | M26 | B18 | R28 |
| I/O | - | - | - | B18 | M2 | A22 | | I/O | P17 | P23 | P27 | N24 | C17 | R29 |
| VCC | - | - | P222 | VCC* | VCC* | VCC* | | I/O | P18 | P24 | P28 | N25 | C19 | T31 |
| I/O | - | - | P223 | C18 | L3 | B22 | | GND | P19 | P25 | P29 | GND* | GND* | GND* |
| I/O | - | - | P224 | D17 | T6 | C22 | | VCC | P20 | P26 | P30 | VCC* | VCC* | VCC* |
| I/O | P149 | P192 | P225 | A20 | N5 | B23 | | I/O | P21 | P27 | P31 | N26 | F20 | T30 |
| I/O | P150 | P193 | P226 | B19 | M4 | A24 | | I/O | P22 | P28 | P32 | P25 | B20 | T29 |
| GND | P151 | P194 | P227 | GND* | GND* | GND* | | I/O | P23 | P29 | P33 | P23 | C21 | U31 |
| I/O | - | - | - | C19 | K2 | D22 | | I/O | P24 | P30 | P34 | P24 | B22 | U30 |
| I/O | - | - | - | D18 | K4 | C23 | | I/O | - | P31 | P35 | R26 | E21 | U28 |
| I/O | - | P195 | P228 | A21 | P6 | B24 | | I/O | - | P32 | P36 | R25 | D22 | U29 |
| I/O | - | P196 | P229 | B20 | M6 | C24 | | I/O | - | - | - | R24 | A23 | V30 |
| I/O | - | - | - | - | L5 | D23 | | I/O | - | - | - | R23 | B24 | V29 |
| I/O | - | - | - | - | J5 | B25 | | I/O | - | - | - | - | C23 | V28 |
| I/O | P152 | P197 | P230 | C20 | J3 | A26 | | I/O | - | - | - | - | F22 | W31 |
| I/O | P153 | P198 | P231 | B21 | H2 | C25 | | VCC | - | - | - | VCC* | VCC* | VCC* |
| I/O (A12) | P154 | P199 | P232 | B22 | H4 | D24 | | GND | - | - | P37 | GND* | GND* | GND* |
| I/O (A13) | P155 | P200 | P233 | C21 | G3 | B26 | | I/O | - | - | - | T26 | A25 | W30 |
| GND | - | - | - | GND* | GND* | GND* | | I/O | - | - | - | T25 | D24 | W29 |
| VCC | - | - | - | VCC* | VCC* | VCC* | | I/O | - | - | - | T24 | B26 | Y30 |
| I/O | - | - | - | D20 | K6 | A27 | | I/O | - | - | - | U25 | A27 | Y29 |
| I/O | - | - | - | A23 | G1 | D25 | | I/O | - | - | P38 | T23 | C27 | Y28 |
| I/O | - | - | - | A24 | E1 | C26 | | I/O | - | - | P39 | V26 | F24 | AA30 |
| I/O | - | - | - | B23 | E3 | B27 | | VCC | - | - | P40 | VCC* | VCC* | VCC* |
| I/O | - | - | P234 | D21 | J7 | C27 | | I/O | P25 | P33 | P41 | U24 | E25 | AA29 |
| I/O | - | - | P235 | C22 | H6 | B28 | | I/O | P26 | P34 | P42 | V25 | E27 | AB31 |
| I/O | P156 | P201 | P236 | B24 | C3 | D27 | | I/O | P27 | P35 | P43 | V24 | B28 | AB30 |
| I/O | P157 | P202 | P237 | C23 | D2 | B29 | | I/O | P28 | P36 | P44 | U23 | C29 | AB29 |
| I/O (A14) | P158 | P203 | P238 | D22 | E5 | C28 | | GND | P29 | P37 | P45 | GND* | GND* | GND* |
| I/O, GCK8 (A15) | P159 | P204 | P239 | C24 | G7 | D28 | | I/O | - | - | - | Y26 | F26 | AB28 |
| VCC | P160 | P205 | P240 | VCC* | VCC* | VCC* | | I/O | - | - | - | W25 | D28 | AC30 |
| GND | P1 | P2 | P1 | GND* | GND* | GND* | | I/O | - | - | P46 | W24 | B30 | AC29 |
| I/O, GCK1 (A16) | P2 | P4 | P2 | D23 | H8 | D29 | | I/O | - | - | P47 | V23 | E29 | AC28 |
| I/O (A17) | P3 | P5 | P3 | C25 | F6 | C30 | | I/O | - | - | - | - | D30 | AD31 |
| I/O | P4 | P6 | P4 | D24 | B4 | E28 | | I/O | - | - | - | - | D32 | AD30 |
| I/O | P5 | P7 | P5 | E23 | D4 | E29 | | I/O | - | P38 | P48 | AA26 | F28 | AD29 |
| I/O, TDI | P6 | P8 | P6 | C26 | B2 | D30 | | I/O | - | P39 | P49 | Y25 | F30 | AD28 |
| I/O, TCK | P7 | P9 | P7 | E24 | G9 | D31 | | I/O | P30 | P40 | P50 | Y24 | C31 | AE30 |
| I/O | - | - | - | D25 | F8 | E30 | | I/O | P31 | P41 | P51 | AA25 | E31 | AE29 |
| I/O | - | - | - | F23 | C5 | E31 | | GND | - | - | - | GND* | GND* | GND* |
| I/O | - | - | - | F24 | A7 | G28 | | VCC | - | - | - | VCC* | VCC* | VCC* |
| I/O | - | - | - | E25 | A5 | G29 | | I/O | - | - | - | AB25 | B32 | AF31 |
| VCC | - | - | - | VCC* | VCC* | VCC* | | I/O | - | - | - | AA24 | A33 | AE28 |
| GND | - | - | - | GND* | GND* | GND* | | I/O | P32 | P42 | P52 | Y23 | A35 | AG31 |
| I/O | - | - | - | - | C7 | F30 | | I/O | P33 | P43 | P53 | AC26 | F32 | AF28 |
| I/O | - | - | - | - | D8 | F31 | | I/O | - | - | - | AD26 | C35 | AG30 |
| I/O | P8 | P10 | P8 | D26 | B8 | H28 | | I/O | - | - | - | AC25 | B38 | AG29 |
| I/O | P9 | P11 | P9 | G24 | C9 | H29 | | I/O | P34 | P44 | P54 | AA23 | E33 | AH31 |
| I/O | - | P12 | P10 | F25 | E9 | G30 | | I/O | P35 | P45 | P55 | AB24 | G31 | AG28 |
| I/O | - | P13 | P11 | F26 | F12 | H30 | | I/O | P36 | P46 | P56 | AD25 | H32 | AH30 |
| I/O | - | - | P12 | H23 | D10 | J28 | | I/O, GCK2 | P37 | P47 | P57 | AC24 | B36 | AJ30 |
| I/O | - | - | P13 | H24 | B10 | J29 | | O (M1) | P38 | P48 | P58 | AB23 | A39 | AH29 |
| I/O | - | - | - | G25 | F10 | H31 | | GND | P39 | P49 | P59 | GND* | GND* | GND* |
| I/O | - | - | - | G26 | F14 | J30 | | I (M0) | P40 | P50 | P60 | AD24 | E35 | AH28 |
| GND | P10 | P14 | P14 | GND* | GND* | GND* | | VCC | P41 | P55 | P61 | VCC* | VCC* | VCC* |
| I/O | P11 | P15 | P15 | J23 | C11 | K28 | | I (M2) | P42 | P56 | P62 | AC23 | G33 | AJ28 |
| I/O | P12 | P16 | P16 | J24 | B12 | K29 | | I/O, GCK3 | P43 | P57 | P63 | AE24 | D36 | AK29 |
| I/O, TMS | P13 | P17 | P17 | H25 | E11 | K30 | | I/O (HDC) | P44 | P58 | P64 | AD23 | C37 | AH27 |
| I/O | P14 | P18 | P18 | K23 | E15 | K31 | | I/O | P45 | P59 | P65 | AC22 | F34 | AK28 |
| VCC | - | - | P19 | VCC* | VCC* | VCC* | | I/O | P46 | P60 | P66 | AF24 | J33 | AJ27 |
| I/O | - | - | P20 | K24 | F16 | L29 | | I/O | P47 | P61 | P67 | AD22 | D38 | AL28 |
| I/O | - | - | P21 | J25 | C13 | L30 | | I/O (LDC) | P48 | P62 | P68 | AE23 | G35 | AH26 |
| I/O | - | - | - | J26 | B14 | M29 | | I/O | - | - | - | AC21 | E39 | AL27 |
| I/O | - | - | - | L23 | E17 | M31 | | I/O | - | - | - | AD21 | K34 | AH25 |
| I/O | - | - | - | L24 | E13 | N31 | | I/O | - | - | - | AE22 | F38 | AK26 |
| I/O | - | - | - | K25 | A15 | N28 | | I/O | - | - | - | AF23 | G37 | AL26 |
| GND | - | - | P22 | GND* | GND* | GND* | | VCC | - | - | - | VCC* | VCC* | VCC* |
| VCC | - | - | - | VCC* | VCC* | VCC* | | GND | - | - | - | GND* | GND* | GND* |
| I/O | - | - | - | - | F18 | N29 | | I/O | P49 | P63 | P69 | AD20 | H38 | AH24 |
| I/O | - | - | - | - | C15 | N30 | | I/O | P50 | P64 | P70 | AE21 | J37 | AJ25 |
| I/O | - | - | - | L25 | B16 | P30 | | I/O | - | P65 | P71 | AF21 | G39 | AK25 |
| I/O | - | - | - | L26 | D16 | P28 | | I/O | - | P66 | P72 | AC19 | M34 | AJ24 |
| I/O | - | P19 | P23 | M23 | D18 | P29 | | I/O | - | - | - | - | K36 | AH23 |

| XC4044XL Pad Name | HQ 160 | HQ 208 | HQ 240 | BG 352 | PG 411 | BG 432 |
|---|---|---|---|---|---|---|
| I/O | - | - | - | - | K38 | AK24 |
| I/O | - | - | P73 | AD19 | N35 | AL24 |
| I/O | - | - | P74 | AE20 | P34 | AH22 |
| I/O | - | - | - | AF20 | J35 | AJ23 |
| I/O | - | - | - | AC18 | L37 | AK23 |
| GND | P51 | P67 | P75 | GND* | GND* | GND* |
| I/O | P52 | P68 | P76 | AD18 | M38 | AJ22 |
| I/O | P53 | P69 | P77 | AE19 | R35 | AK22 |
| I/O | P54 | P70 | P78 | AC17 | H36 | AL22 |
| I/O | P55 | P71 | P79 | AD17 | T34 | AJ21 |
| VCC | - | - | P80 | VCC* | VCC* | VCC* |
| I/O | - | P72 | P81 | AE18 | N37 | AH20 |
| I/O | - | P73 | P82 | AF18 | N39 | AK21 |
| I/O | - | - | - | AC16 | U35 | AK20 |
| I/O | - | - | - | AD16 | R39 | AJ19 |
| I/O | - | - | - | AE17 | M36 | AL20 |
| I/O | - | - | - | AE16 | V34 | AH18 |
| GND | - | - | P83 | GND* | GND* | GND* |
| VCC | - | - | - | VCC* | VCC* | VCC* |
| I/O | - | - | - | AF16 | R37 | AK19 |
| I/O | - | - | - | AC15 | T38 | AJ18 |
| I/O | - | - | P84 | AD15 | T36 | AL19 |
| I/O | - | - | P85 | AE15 | V36 | AK18 |
| I/O | P56 | P74 | P86 | AF15 | U37 | AH17 |
| I/O | P57 | P75 | P87 | AD14 | U39 | AJ17 |
| I/O | - | - | - | - | W35 | AK17 |
| I/O | - | - | - | - | AC39 | AL17 |
| I/O | P58 | P76 | P88 | AE14 | V38 | AJ16 |
| I/O (INIT) | P59 | P77 | P89 | AF14 | W37 | AK16 |
| VCC | P60 | P78 | P90 | VCC* | VCC* | VCC* |
| GND | P61 | P79 | P91 | GND* | GND* | GND* |
| I/O | P62 | P80 | P92 | AE13 | Y34 | AL16 |
| I/O | P63 | P81 | P93 | AC13 | AC37 | AH15 |
| I/O | - | - | - | - | Y38 | AL15 |
| I/O | - | - | - | - | AA37 | AJ15 |
| I/O | P64 | P82 | P94 | AD13 | AB38 | AK15 |
| I/O | P65 | P83 | P95 | AF12 | AD36 | AJ14 |
| I/O | - | P84 | P96 | AE12 | AA35 | AH14 |
| I/O | - | P85 | P97 | AD12 | AE37 | AK14 |
| I/O | - | - | - | AC12 | AB36 | AL13 |
| I/O | - | - | - | AF11 | AD38 | AK13 |
| VCC | - | - | - | VCC* | VCC* | VCC* |
| GND | - | - | P98 | GND* | GND* | GND* |
| I/O | - | - | - | AE11 | AB34 | AJ13 |
| I/O | - | - | - | AD11 | AE39 | AH13 |
| I/O | - | - | - | AE10 | AM36 | AL12 |
| I/O | - | - | - | AC11 | AC35 | AK12 |
| I/O | - | - | P99 | AF9 | AG39 | AH12 |
| I/O | - | - | P100 | AD10 | AG37 | AJ11 |
| VCC | - | - | P101 | VCC* | VCC* | VCC* |
| I/O | P66 | P86 | P102 | AE9 | AD34 | AL10 |
| I/O | P67 | P87 | P103 | AD9 | AN39 | AK10 |
| I/O | P68 | P88 | P104 | AC10 | AE35 | AJ10 |
| I/O | P69 | P89 | P105 | AF7 | AH38 | AK9 |
| GND | P70 | P90 | P106 | GND* | GND* | GND* |
| I/O | - | - | - | AE8 | AJ37 | AL8 |
| I/O | - | - | - | AD8 | AG35 | AH10 |
| I/O | - | - | P107 | AC9 | AF34 | AJ9 |
| I/O | - | - | P108 | AF6 | AH36 | AK8 |
| I/O | - | - | - | - | AK38 | AJ8 |
| I/O | - | - | - | - | AP38 | AH9 |
| I/O | - | P91 | P109 | AE7 | AK36 | AK7 |
| I/O | - | P92 | P110 | AD7 | AM34 | AL6 |
| I/O | P71 | P93 | P111 | AE6 | AH34 | AJ7 |
| I/O | P72 | P94 | P112 | AE5 | AJ35 | AH8 |
| GND | - | - | - | GND* | GND* | GND* |
| VCC | - | - | - | VCC* | VCC* | VCC* |
| I/O | - | - | - | AD6 | AL37 | AK6 |
| I/O | - | - | - | AC7 | AT38 | AL5 |
| I/O | P73 | P95 | P113 | AF4 | AM38 | AH7 |
| I/O | P74 | P96 | P114 | AF3 | AN37 | AJ6 |
| I/O | - | - | - | AE4 | AK34 | AK5 |
| I/O | - | - | - | AC6 | AR39 | AL4 |
| I/O | P75 | P97 | P115 | AD5 | AN35 | AK4 |
| I/O | P76 | P98 | P116 | AE3 | AL33 | AH5 |

| XC4044XL Pad Name | HQ 160 | HQ 208 | HQ 240 | BG 352 | PG 411 | BG 432 |
|---|---|---|---|---|---|---|
| I/O | P77 | P99 | P117 | AD4 | AV38 | AK3 |
| I/O, GCK4 | P78 | P100 | P118 | AC5 | AT36 | AJ4 |
| GND | P79 | P101 | P119 | GND* | GND* | GND* |
| DONE | P80 | P103 | P120 | AD3 | AR35 | AH4 |
| VCC | P81 | P106 | P121 | VCC* | VCC* | VCC* |
| PROGRAM | P82 | P108 | P122 | AC4 | AN33 | AH3 |
| I/O (D7) | P83 | P109 | P123 | AD2 | AM32 | AJ2 |
| I/O, GCK5 | P84 | P110 | P124 | AC3 | AP34 | AG4 |
| I/O | P85 | P111 | P125 | AB4 | AW39 | AG3 |
| I/O | P86 | P112 | P126 | AD1 | AN31 | AH2 |
| I/O | - | - | - | AB3 | AV36 | AH1 |
| I/O | - | - | - | AC2 | AR33 | AF4 |
| I/O | - | - | P127 | AA4 | AP32 | AF3 |
| I/O | - | - | P128 | AA3 | AU35 | AG2 |
| I/O | - | - | - | AB2 | AW33 | AE3 |
| I/O | - | - | - | AC1 | AU33 | AF2 |
| VCC | - | - | - | VCC* | VCC* | VCC* |
| GND | - | - | - | GND* | GND* | GND* |
| I/O (D6) | P87 | P113 | P129 | Y3 | AV32 | AF1 |
| I/O | P88 | P114 | P130 | AA2 | AU31 | AD4 |
| I/O | P89 | P115 | P131 | AA1 | AR31 | AD3 |
| I/O | P90 | P116 | P132 | W4 | AP28 | AE2 |
| I/O | - | - | - | - | AP30 | AD2 |
| I/O | - | - | - | - | AT30 | AC4 |
| I/O | - | P117 | P133 | W3 | AT32 | AC3 |
| I/O | - | P118 | P134 | Y2 | AV30 | AD1 |
| I/O | - | - | - | Y1 | AR29 | AC2 |
| I/O | - | - | - | V4 | AP26 | AB4 |
| GND | P91 | P119 | P135 | GND* | GND* | GND* |
| I/O | - | - | P136 | V3 | AU29 | AB3 |
| I/O | - | - | P137 | W2 | AV28 | AB2 |
| I/O | P92 | P120 | P138 | U4 | AT28 | AB1 |
| I/O | P93 | P121 | P139 | U3 | AR25 | AA3 |
| VCC | - | - | P140 | VCC* | VCC* | VCC* |
| I/O (D5) | P94 | P122 | P141 | V2 | AP24 | AA2 |
| I/O (CS0) | P95 | P123 | P142 | V1 | AU27 | Y2 |
| I/O | - | - | - | T4 | AR27 | Y4 |
| I/O | - | - | - | T3 | AW27 | Y3 |
| I/O | - | - | - | U2 | AT24 | W4 |
| I/O | - | - | - | T2 | AR23 | W3 |
| GND | - | - | P143 | GND* | GND* | GND* |
| VCC | - | - | - | VCC* | VCC* | VCC* |
| I/O | - | - | - | - | AW25 | W2 |
| I/O | - | - | - | - | AW23 | V2 |
| I/O | - | - | - | T1 | AP22 | V4 |
| I/O | - | - | - | R4 | AV24 | V3 |
| I/O | - | P124 | P144 | R3 | AU23 | U1 |
| I/O | - | P125 | P145 | R2 | AT22 | U2 |
| I/O | P96 | P126 | P146 | R1 | AR21 | U4 |
| I/O | P97 | P127 | P147 | P3 | AV22 | U3 |
| I/O (D4) | P98 | P128 | P148 | P2 | AP20 | T1 |
| I/O | P99 | P129 | P149 | P1 | AU21 | T2 |
| VCC | P100 | P130 | P150 | VCC* | VCC* | VCC* |
| GND | P101 | P131 | P151 | GND* | GND* | GND* |
| I/O (D3) | P102 | P132 | P152 | N2 | AU19 | T3 |
| I/O (RS) | P103 | P133 | P153 | N4 | AV20 | R1 |
| I/O | P104 | P134 | P154 | N3 | AV18 | R2 |
| I/O | P105 | P135 | P155 | M1 | AR19 | R4 |
| I/O | - | P136 | P156 | M2 | AT18 | R3 |
| I/O | - | P137 | P157 | M3 | AW17 | P2 |
| I/O | - | - | - | M4 | AV16 | P3 |
| I/O | - | - | - | L1 | AP18 | P4 |
| I/O | - | - | - | - | AU17 | N1 |
| I/O | - | - | - | - | AW15 | N2 |
| VCC | - | - | - | VCC* | VCC* | VCC* |
| GND | - | - | P158 | GND* | GND* | GND* |
| I/O | - | - | - | L2 | AR17 | N3 |
| I/O | - | - | - | L3 | AT16 | N4 |
| I/O | - | - | - | K2 | AV14 | M1 |
| I/O | - | - | - | L4 | AW13 | M2 |
| I/O (D2) | P106 | P138 | P159 | J1 | AR15 | L2 |
| I/O | P107 | P139 | P160 | K3 | AP16 | L3 |
| VCC | - | - | P161 | VCC* | VCC* | VCC* |
| I/O | P108 | P140 | P162 | J2 | AV12 | K1 |
| I/O | P109 | P141 | P163 | J3 | AR13 | K2 |

| XC4044XL Pad Name | HQ 160 | HQ 208 | HQ 240 | BG 352 | PG 411 | BG 432 |
|---|---|---|---|---|---|---|
| I/O | - | - | P164 | K4 | AU11 | K3 |
| I/O | - | - | P165 | G1 | AT12 | K4 |
| GND | P110 | P142 | P166 | GND* | GND* | GND* |
| I/O | - | - | - | H2 | AP14 | J2 |
| I/O | - | - | - | H3 | AR11 | J3 |
| I/O | - | - | P167 | J4 | AV10 | J4 |
| I/O | - | - | P168 | F1 | AT8 | H1 |
| I/O | - | P143 | P169 | G2 | AT10 | H2 |
| I/O | - | P144 | P170 | G3 | AP10 | H3 |
| I/O | P111 | P145 | P171 | F2 | AP12 | H4 |
| I/O | P112 | P146 | P172 | E2 | AR9 | G2 |
| I/O | - | - | - | - | AU9 | G3 |
| I/O | - | - | - | - | AV8 | F1 |
| GND | - | - | - | GND* | GND* | GND* |
| VCC | - | - | - | VCC* | VCC* | VCC* |
| I/O (D1) | P113 | P147 | P173 | F3 | AU7 | G4 |
| I/O (RCLK, RDY/BUSY) | P114 | P148 | P174 | G4 | AW7 | F2 |
| I/O | - | - | - | D1 | AW5 | F3 |
| I/O | - | - | - | C1 | AV6 | E1 |
| I/O | - | - | - | D2 | AR7 | E3 |
| I/O | - | - | - | F4 | AV4 | D1 |
| I/O | P115 | P149 | P175 | E3 | AN9 | E4 |
| I/O | P116 | P150 | P176 | C2 | AW1 | D2 |
| I/O (D0, DIN) | P117 | P151 | P177 | D3 | AP6 | C2 |
| I/O, GCK6 (DOUT) | P118 | P152 | P178 | E4 | AU3 | D3 |
| CCLK | P119 | P153 | P179 | C3 | AR5 | D4 |
| VCC | P120 | P154 | P180 | VCC* | VCC* | VCC* |
| O, TDO | P121 | P159 | P181 | D4 | AN7 | C4 |
| GND | P122 | P160 | P182 | GND* | GND* | GND* |
| I/O (A0, WS) | P123 | P161 | P183 | B3 | AT4 | B3 |
| I/O, GCK7 (A1) | P124 | P162 | P184 | C4 | AV2 | D5 |
| I/O | P125 | P163 | P185 | D5 | AM8 | B4 |
| I/O | P126 | P164 | P186 | A3 | AL7 | C5 |
| I/O | - | - | - | C5 | AR3 | B5 |
| I/O | - | - | - | B4 | AR1 | C6 |
| I/O (CS1,A2) | P127 | P165 | P187 | D6 | AK6 | A5 |
| I/O (A3) | P128 | P166 | P188 | C6 | AN3 | D7 |
| I/O | - | - | - | B5 | AM6 | B6 |
| I/O | - | - | - | A4 | AM2 | A6 |
| VCC | - | - | - | VCC* | VCC* | VCC* |
| GND | - | - | - | GND* | GND* | GND* |
| I/O | - | - | P189 | C7 | AL3 | D8 |
| I/O | - | - | P190 | B6 | AH6 | C7 |
| I/O | P129 | P167 | P191 | A6 | AP2 | B7 |
| I/O | P130 | P168 | P192 | D8 | AK4 | D9 |
| I/O | - | - | - | C8 | AN1 | B8 |
| I/O | - | - | - | - | AK2 | A8 |
| I/O | - | P169 | P193 | B7 | AG5 | D10 |
| I/O | - | P170 | P194 | A7 | AF6 | C9 |
| I/O | - | - | P195 | D9 | AL5 | B9 |
| I/O | - | - | - | C9 | AJ3 | C10 |
| GND | P131 | P171 | P196 | GND* | GND* | GND* |
| I/O | P132 | P172 | P197 | B8 | AH2 | B10 |
| I/O | P133 | P173 | P198 | D10 | AE5 | A10 |
| I/O | - | - | P199 | C10 | AM4 | C11 |
| I/O | - | - | P200 | B9 | AD6 | D12 |
| VCC | - | - | P201 | VCC* | VCC* | VCC* |
| I/O | - | - | - | A9 | AG3 | B11 |
| I/O | - | - | - | D11 | AG1 | C12 |
| I/O | - | - | - | C11 | AC5 | C13 |
| I/O | - | - | - | B10 | AE1 | A12 |
| I/O | - | - | - | B11 | AH4 | D14 |
| I/O | - | - | - | A11 | AB6 | B13 |
| GND | - | - | - | GND* | GND* | GND* |
| VCC | - | - | - | VCC* | VCC* | VCC* |
| I/O (A4) | P134 | P174 | P202 | D12 | AD2 | C14 |
| I/O (A5) | P135 | P175 | P203 | C12 | AB4 | A13 |
| I/O | - | P176 | P205 | B12 | AE3 | B14 |
| I/O | P136 | P177 | P206 | A12 | AC1 | D15 |
| I/O (A21) | P137 | P178 | P207 | C13 | AD4 | C15 |
| I/O (A20) | P138 | P179 | P208 | B13 | AA5 | B15 |
| I/O | - | - | - | - | AB2 | A15 |
| I/O | - | - | - | - | AC3 | C16 |
| I/O (A6) | P139 | P180 | P209 | A13 | AA3 | B16 |
| I/O (A7) | P140 | P181 | P210 | B14 | Y6 | A16 |

| XC4044XL Pad Name | HQ 160 | HQ 208 | HQ 240 | BG 352 | PG 411 | BG 432 |
|---|---|---|---|---|---|---|
| GND | P141 | P182 | P211 | GND* | GND* | GND* |

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\* Pads labelled GND\* or VCC\* are internally bonded to Ground or VCC planes within the associated package. They have no direct connection to any specific package pin.

## Additional XC4044XL Package Pins

**HQ208**

| N.C. Pins | | | | | | |
|---|---|---|---|---|---|---|
| P1 | P3 | P51 | P52 | P53 | P54 | P102 |
| P104 | P105 | P107 | P155 | P156 | P157 | P158 |
| P206 | P207 | P208 | - | - | - | - |

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**HQ240**

| GND Pins | | | | | | |
|---|---|---|---|---|---|---|
| P204 | P219 | - | - | - | - | - |

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Note: These pins may be N.C. for this device revision, however for compatability with other devices in this package, these pins should be tied to GND.

**BG352**

| VCC Pins | | | | | | |
|---|---|---|---|---|---|---|
| A10 | A17 | B2 | B25 | D7 | D13 | D19 |
| G23 | H4 | K1 | K26 | N23 | P4 | U1 |
| U26 | W23 | Y4 | AC8 | AC14 | AC20 | AE2 |
| AE25 | AF10 | AF17 | - | - | - | - |

| GND Pins | | | | | | |
|---|---|---|---|---|---|---|
| A1 | A2 | A5 | A8 | A14 | A19 | A22 |
| A25 | A26 | B1 | B26 | E1 | E26 | H1 |
| H26 | N1 | P26 | W1 | W26 | AB1 | AB26 |
| AE1 | AE26 | AF1 | AF2 | AF5 | AF8 | AF13 |
| AF19 | AF22 | AF25 | AF26 | - | - | - |

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**PG411**

| VCC Pins | | | | | | |
|---|---|---|---|---|---|---|
| A3 | A11 | A21 | A31 | C39 | D6 | F36 |
| J1 | L39 | W1 | AA39 | AJ1 | AL39 | AP4 |
| AT34 | AU1 | AW9 | AW19 | AW29 | AW37 | - |

| GND Pins | | | | | | |
|---|---|---|---|---|---|---|
| A9 | A19 | A29 | A37 | C1 | D14 | D20 |
| D26 | D34 | F4 | J39 | L1 | P4 | P36 |
| W39 | Y4 | Y36 | AA1 | AF4 | AF36 | AJ39 |
| AL1 | AP36 | AT6 | AT14 | AT20 | AT26 | AU39 |
| AW3 | AW11 | AW21 | AW31 | - | - | - |

| N.C. Pins | | | | | | |
|---|---|---|---|---|---|---|
| A13 | B6 | B34 | C25 | C33 | D12 | E7 |
| E23 | E37 | F2 | G5 | H34 | L35 | N3 |
| P38 | R3 | AF2 | AF38 | AJ5 | AL35 | AN5 |
| AP8 | AR37 | AT2 | AU5 | AU13 | AU15 | AU25 |
| AU37 | AV26 | AV34 | AW35 | - | - | - |

6/2/97

**BG432**

| VCC Pins | | | | | | |
|------|------|------|------|------|------|------|
| A1 | A11 | A21 | A31 | C3 | C29 | D11 |
| D21 | L1 | L4 | L28 | L31 | AA1 | AA4 |
| AA28 | AA31 | AH11 | AH21 | AJ3 | AJ29 | AL1 |
| AL11 | AL21 | AL31 | - | - | - | - |
| **GND Pins** | | | | | | |
| A2 | A3 | A7 | A9 | A14 | A18 | A23 |
| A25 | A29 | A30 | B1 | B2 | B30 | B31 |
| C1 | C31 | D16 | G1 | G31 | J1 | J31 |
| P1 | P31 | T4 | T28 | V1 | V31 | AC1 |
| AC31 | AE1 | AE31 | AH16 | AJ1 | AJ31 | AK1 |
| AK2 | AK30 | AK31 | AL2 | AL3 | AL7 | AL9 |
| AL14 | AL18 | AL23 | AL25 | AL29 | AL30 | - |
| **N.C. Pins** | | | | | | |
| A4 | A28 | B12 | B21 | C8 | D6 | D13 |
| D20 | D26 | E2 | F4 | F28 | F29 | M3 |
| M4 | M28 | M30 | W1 | W28 | Y1 | Y31 |
| AE4 | AF29 | AF30 | AG1 | AH6 | AH19 | AJ5 |
| AJ12 | AJ20 | AJ26 | AK11 | AK27 | - | - |

5/29/97

## Pin Locations for XC4052XL Devices

(Note: XC4052XL is also available in the HQ304 package. The pinout is identical to the XC4036XL in HQ304.)

| XC4052XL Pad Name | HQ 240 | PG 411 | BG 432 | BG 560 |
|------|------|------|------|------|
| VCC | P212 | VCC* | VCC* | VCC* |
| I/O (A8) | P213 | W3 | D17 | A17 |
| I/O (A9) | P214 | Y2 | A17 | B18 |
| I/O | - | V2 | C17 | C18 |
| I/O | - | W5 | B17 | E18 |
| GND | - | GND* | GND* | GND* |
| I/O (A19) | P215 | V4 | C18 | C19 |
| I/O (A18) | P216 | T2 | D18 | D19 |
| I/O | P217 | U1 | B18 | E19 |
| I/O | P218 | V6 | A19 | B20 |
| I/O (A10) | P220 | U3 | B19 | C20 |
| I/O (A11) | P221 | R1 | C19 | D20 |
| VCC | - | VCC* | VCC* | VCC* |
| GND | - | GND* | GND* | GND* |
| I/O | - | U5 | D19 | A21 |
| I/O | - | T4 | A20 | E20 |
| I/O | - | P2 | B20 | B21 |
| I/O | - | N1 | C20 | C21 |
| I/O | - | R3 | B21 | D21 |
| I/O | - | N3 | D20 | B22 |
| GND | - | GND* | GND* | GND* |
| I/O | - | R5 | C21 | C23 |
| I/O | - | M2 | A22 | E22 |
| VCC | P222 | VCC* | VCC* | VCC* |
| I/O | P223 | L3 | B22 | B24 |
| I/O | P224 | T6 | C22 | D23 |
| I/O | P225 | N5 | B23 | C24 |
| I/O | P226 | M4 | A24 | A25 |
| GND | P227 | GND* | GND* | GND* |
| I/O | - | K2 | D22 | E23 |
| I/O | - | K4 | C23 | B25 |
| I/O | P228 | P6 | B24 | D24 |
| I/O | P229 | M6 | C24 | C25 |
| GND | - | GND* | GND* | GND* |
| I/O | - | L5 | D23 | E25 |
| I/O | - | J5 | B25 | C27 |
| I/O | P230 | J3 | A26 | D26 |
| I/O | P231 | H2 | C25 | B28 |
| I/O (A12) | P232 | H4 | D24 | B29 |
| I/O (A13) | P233 | G3 | B26 | E26 |

| XC4052XL Pad Name | HQ 240 | PG 411 | BG 432 | BG 560 |
|------|------|------|------|------|
| GND | - | GND* | GND* | GND* |
| VCC | - | VCC* | VCC* | VCC* |
| I/O | - | K6 | A27 | C28 |
| I/O | - | G1 | D25 | D27 |
| I/O | - | E1 | C26 | B30 |
| I/O | - | E3 | B27 | C29 |
| I/O | - | F2 | A28 | E27 |
| I/O | - | G5 | D26 | A31 |
| GND | - | GND* | GND* | GND* |
| I/O | P234 | J7 | C27 | D28 |
| I/O | P235 | H6 | B28 | C30 |
| I/O | P236 | C3 | D27 | D29 |
| I/O | P237 | D2 | B29 | E28 |
| I/O (A14) | P238 | E5 | C28 | D30 |
| I/O, GCK8 (A15) | P239 | G7 | D28 | E29 |
| VCC | P240 | VCC* | VCC* | VCC* |
| GND | P1 | GND* | GND* | GND* |
| I/O, GCK1 (A16) | P2 | H8 | D29 | B33 |
| I/O (A17) | P3 | F6 | C30 | F29 |
| I/O | P4 | B4 | E28 | E30 |
| I/O | P5 | D4 | E29 | D31 |
| I/O, TDI | P6 | B2 | D30 | F30 |
| I/O, TCK | P7 | G9 | D31 | C33 |
| GND | - | GND* | GND* | GND* |
| I/O | - | E7 | F28 | G29 |
| I/O | - | B6 | F29 | E31 |
| I/O | - | F8 | E30 | D32 |
| I/O | - | C5 | E31 | G30 |
| I/O | - | A7 | G28 | F31 |
| I/O | - | A5 | G29 | H29 |
| VCC | - | VCC* | VCC* | VCC* |
| GND | - | GND* | GND* | GND* |
| I/O | - | C7 | F30 | H30 |
| I/O | - | D8 | F31 | G31 |
| I/O | P8 | B8 | H28 | J29 |
| I/O | P9 | C9 | H29 | F33 |
| I/O | P10 | E9 | G30 | G32 |
| I/O | P11 | F12 | H30 | J30 |
| GND | - | GND* | GND* | GND* |
| I/O | P12 | D10 | J28 | K30 |
| I/O | P13 | B10 | J29 | H33 |
| I/O | - | F10 | H31 | L29 |
| I/O | - | F14 | J30 | K31 |
| GND | P14 | GND* | GND* | GND* |
| I/O | P15 | C11 | K28 | L30 |

| XC4052XL Pad Name | HQ 240 | PG 411 | BG 432 | BG 560 | XC4052XL Pad Name | HQ 240 | PG 411 | BG 432 | BG 560 |
|---|---|---|---|---|---|---|---|---|---|
| I/O | P16 | B12 | K29 | K32 | I/O | - | A33 | AE28 | AF29 |
| I/O, TMS | P17 | E11 | K30 | J33 | I/O | - | C33 | AF30 | AH31 |
| I/O | P18 | E15 | K31 | M29 | I/O | - | B34 | AF29 | AG30 |
| VCC | P19 | VCC* | VCC* | VCC* | I/O | P52 | A35 | AG31 | AK32 |
| I/O | P20 | F16 | L29 | L32 | I/O | P53 | F32 | AF28 | AJ31 |
| I/O | P21 | C13 | L30 | M31 | GND | - | GND* | GND* | GND* |
| GND | - | GND* | GND* | GND* | I/O | - | C35 | AG30 | AG29 |
| I/O | - | A13 | M30 | N29 | I/O | - | B38 | AG29 | AL33 |
| I/O | - | D12 | M28 | L33 | I/O | P54 | E33 | AH31 | AH30 |
| I/O | - | B14 | M29 | M32 | I/O | P55 | G31 | AG28 | AK31 |
| I/O | - | E17 | M31 | P29 | I/O | P56 | H32 | AH30 | AJ30 |
| I/O | - | E13 | N31 | P30 | I/O, GCK2 | P57 | B36 | AJ30 | AH29 |
| I/O | - | A15 | N28 | N33 | O (M1) | P58 | A39 | AH29 | AK30 |
| GND | P22 | GND* | GND* | GND* | GND | P59 | GND* | GND* | GND* |
| VCC | - | VCC* | VCC* | VCC* | I (M0) | P60 | E35 | AH28 | AJ29 |
| I/O | - | F18 | N29 | P31 | VCC | P61 | VCC* | VCC* | VCC* |
| I/O | - | C15 | N30 | P32 | I (M2) | P62 | G33 | AJ28 | AN32 |
| I/O | - | B16 | P30 | R29 | I/O, GCK3 | P63 | D36 | AK29 | AJ28 |
| I/O | - | D16 | P28 | R30 | I/O (HDC) | P64 | C37 | AH27 | AK29 |
| I/O | P23 | D18 | P29 | R31 | I/O | P65 | F34 | AK28 | AL30 |
| I/O | P24 | A17 | R31 | R33 | I/O | P66 | J33 | AJ27 | AK28 |
| GND | - | GND* | GND* | GND* | I/O | P67 | D38 | AL28 | AM31 |
| I/O | P25 | E19 | R30 | T31 | I/O (LDC) | P68 | G35 | AH26 | AJ27 |
| I/O | P26 | B18 | R28 | T29 | GND | - | GND* | GND* | GND* |
| I/O | P27 | C17 | R29 | U32 | I/O | - | E37 | AK27 | AN31 |
| I/O | P28 | C19 | T31 | U31 | I/O | - | H34 | AJ26 | AL29 |
| GND | P29 | GND* | GND* | GND* | I/O | - | E39 | AL27 | AK27 |
| VCC | P30 | VCC* | VCC* | VCC* | I/O | - | K34 | AH25 | AL28 |
| I/O | P31 | F20 | T30 | U29 | I/O | - | F38 | AK26 | AJ26 |
| I/O | P32 | B20 | T29 | U30 | I/O | - | G37 | AL26 | AM30 |
| I/O | P33 | C21 | U31 | V31 | VCC | - | VCC* | VCC* | VCC* |
| I/O | P34 | B22 | U30 | V29 | GND | - | GND* | GND* | GND* |
| GND | - | GND* | GND* | GND* | I/O | P69 | H38 | AH24 | AM29 |
| I/O | P35 | E21 | U28 | V30 | I/O | P70 | J37 | AJ25 | AK26 |
| I/O | P36 | D22 | U29 | W33 | I/O | P71 | G39 | AK25 | AL27 |
| I/O | - | A23 | V30 | W31 | I/O | P72 | M34 | AJ24 | AJ25 |
| I/O | - | B24 | V29 | W30 | I/O | - | K36 | AH23 | AN29 |
| I/O | - | C23 | V28 | W29 | I/O | - | K38 | AK24 | AN28 |
| I/O | - | F22 | W31 | Y32 | GND | - | GND* | GND* | GND* |
| VCC | - | VCC* | VCC* | VCC* | I/O | P73 | N35 | AL24 | AL25 |
| GND | P37 | GND* | GND* | GND* | I/O | P74 | P34 | AH22 | AJ23 |
| I/O | - | A25 | W30 | Y31 | I/O | - | J35 | AJ23 | AN26 |
| I/O | - | D24 | W29 | Y30 | I/O | - | L37 | AK23 | AL24 |
| I/O | - | E23 | W28 | AA32 | GND | P75 | GND* | GND* | GND* |
| I/O | - | C25 | Y31 | AA31 | I/O | P76 | M38 | AJ22 | AK23 |
| I/O | - | B26 | Y30 | AA30 | I/O | P77 | R35 | AK22 | AN25 |
| I/O | - | A27 | Y29 | AB32 | I/O | P78 | H36 | AL22 | AJ22 |
| GND | - | GND* | GND* | GND* | I/O | P79 | T34 | AJ21 | AL23 |
| I/O | P38 | C27 | Y28 | AA29 | VCC | P80 | VCC* | VCC* | VCC* |
| I/O | P39 | F24 | AA30 | AB31 | I/O | P81 | N37 | AH20 | AM24 |
| VCC | P40 | VCC* | VCC* | VCC* | I/O | P82 | N39 | AK21 | AK22 |
| I/O | P41 | E25 | AA29 | AC31 | GND | - | GND* | GND* | GND* |
| I/O | P42 | E27 | AB31 | AB29 | I/O | - | P38 | AJ20 | AK21 |
| I/O | P43 | B28 | AB30 | AD32 | I/O | - | L35 | AH19 | AM22 |
| I/O | P44 | C29 | AB29 | AC30 | I/O | - | U35 | AK20 | AJ20 |
| GND | P45 | GND* | GND* | GND* | I/O | - | R39 | AJ19 | AL21 |
| I/O | - | F26 | AB28 | AD31 | I/O | - | M36 | AL20 | AN21 |
| I/O | - | D28 | AC30 | AE33 | I/O | - | V34 | AH18 | AK20 |
| I/O | P46 | B30 | AC29 | AC29 | GND | P83 | GND* | GND* | GND* |
| I/O | P47 | E29 | AC28 | AE32 | VCC | - | VCC* | VCC* | VCC* |
| GND | - | GND* | GND* | GND* | I/O | - | R37 | AK19 | AL20 |
| I/O | - | D30 | AD31 | AG33 | I/O | - | T38 | AJ18 | AJ19 |
| I/O | - | D32 | AD30 | AH33 | I/O | P84 | T36 | AL19 | AM20 |
| I/O | P48 | F28 | AD29 | AE29 | I/O | P85 | V36 | AK18 | AK19 |
| I/O | P49 | F30 | AD28 | AG31 | I/O | P86 | U37 | AH17 | AL19 |
| I/O | P50 | C31 | AE30 | AF30 | I/O | P87 | U39 | AJ17 | AN19 |
| I/O | P51 | E31 | AE29 | AH32 | GND | - | GND* | GND* | GND* |
| GND | - | GND* | GND* | GND* | I/O | - | W35 | AK17 | AL18 |
| VCC | - | VCC* | VCC* | VCC* | I/O | - | AC39 | AL17 | AM18 |
| I/O | - | B32 | AF31 | AJ32 | I/O | P88 | V38 | AJ16 | AK17 |

| XC4052XL Pad Name | HQ 240 | PG 411 | BG 432 | BG 560 |
|---|---|---|---|---|
| I/O (INIT) | P89 | W37 | AK16 | AJ17 |
| VCC | P90 | VCC* | VCC* | VCC* |
| GND | P91 | GND* | GND* | GND* |
| I/O | P92 | Y34 | AL16 | AL17 |
| I/O | P93 | AC37 | AH15 | AM17 |
| I/O | - | Y38 | AL15 | AN17 |
| I/O | - | AA37 | AJ15 | AK16 |
| GND | - | GND* | GND* | GND* |
| I/O | P94 | AB38 | AK15 | AM16 |
| I/O | P95 | AD36 | AJ14 | AL15 |
| I/O | P96 | AA35 | AH14 | AK15 |
| I/O | P97 | AE37 | AK14 | AJ15 |
| I/O | - | AB36 | AL13 | AN15 |
| I/O | - | AD38 | AK13 | AM14 |
| VCC | - | VCC* | VCC* | VCC* |
| GND | P98 | GND* | GND* | GND* |
| I/O | - | AB34 | AJ13 | AL14 |
| I/O | - | AE39 | AH13 | AK14 |
| I/O | - | AM36 | AL12 | AJ14 |
| I/O | - | AC35 | AK12 | AN13 |
| I/O | - | AL35 | AJ12 | AM13 |
| I/O | - | AF38 | AK11 | AL13 |
| GND | - | GND* | GND* | GND* |
| I/O | P99 | AG39 | AH12 | AK12 |
| I/O | P100 | AG37 | AJ11 | AN11 |
| VCC | P101 | VCC* | VCC* | VCC* |
| I/O | P102 | AD34 | AL10 | AJ12 |
| I/O | P103 | AN39 | AK10 | AL11 |
| I/O | P104 | AE35 | AJ10 | AK11 |
| I/O | P105 | AH38 | AK9 | AM10 |
| GND | P106 | GND* | GND* | GND* |
| I/O | - | AJ37 | AL8 | AL10 |
| I/O | - | AG35 | AH10 | AJ11 |
| I/O | P107 | AF34 | AJ9 | AN9 |
| I/O | P108 | AH36 | AK8 | AK10 |
| GND | - | GND* | GND* | GND* |
| I/O | - | AK38 | AJ8 | AN7 |
| I/O | - | AP38 | AH9 | AJ9 |
| I/O | P109 | AK36 | AK7 | AL7 |
| I/O | P110 | AM34 | AL6 | AK8 |
| I/O | P111 | AH34 | AJ7 | AN6 |
| I/O | P112 | AJ35 | AH8 | AM6 |
| GND | - | GND* | GND* | GND* |
| VCC | - | VCC* | VCC* | VCC* |
| I/O | - | AL37 | AK6 | AJ8 |
| I/O | - | AT38 | AL5 | AL6 |
| I/O | P113 | AM38 | AH7 | AK7 |
| I/O | P114 | AN37 | AJ6 | AM5 |
| I/O | - | AK34 | AK5 | AM4 |
| I/O | - | AR39 | AL4 | AJ7 |
| GND | - | GND* | GND* | GND* |
| I/O | - | AR37 | AH6 | AL5 |
| I/O | - | AU37 | AJ5 | AK6 |
| I/O | P115 | AN35 | AK4 | AN3 |
| I/O | P116 | AL33 | AH5 | AK5 |
| I/O | P117 | AV38 | AK3 | AJ6 |
| I/O, GCK4 | P118 | AT36 | AJ4 | AL4 |
| GND | P119 | GND* | GND* | GND* |
| DONE | P120 | AR35 | AH4 | AJ5 |
| VCC | P121 | VCC* | VCC* | VCC* |
| PROGRAM | P122 | AN33 | AH3 | AM1 |
| I/O (D7) | P123 | AM32 | AJ2 | AH5 |
| I/O, GCK5 | P124 | AP34 | AG4 | AJ4 |
| I/O | P125 | AW39 | AG3 | AK3 |
| I/O | P126 | AN31 | AH2 | AH4 |
| I/O | - | AV36 | AH1 | AL1 |
| I/O | - | AR33 | AF4 | AG5 |
| GND | - | GND* | GND* | GND* |
| I/O | P127 | AP32 | AF3 | AJ3 |
| I/O | P128 | AU35 | AG2 | AK2 |

| XC4052XL Pad Name | HQ 240 | PG 411 | BG 432 | BG 560 |
|---|---|---|---|---|
| I/O | - | AV34 | AG1 | AG4 |
| I/O | - | AW35 | AE4 | AH3 |
| I/O | - | AW33 | AE3 | AF5 |
| I/O | - | AU33 | AF2 | AJ2 |
| VCC | - | VCC* | VCC* | VCC* |
| GND | - | GND* | GND* | GND* |
| I/O (D6) | P129 | AV32 | AF1 | AJ1 |
| I/O | P130 | AU31 | AD4 | AF4 |
| I/O | P131 | AR31 | AD3 | AG3 |
| I/O | P132 | AP28 | AE2 | AE5 |
| I/O | - | AP30 | AD2 | AH1 |
| I/O | - | AT30 | AC4 | AF3 |
| GND | - | GND* | GND* | GND* |
| I/O | P133 | AT32 | AC3 | AE3 |
| I/O | P134 | AV30 | AD1 | AC5 |
| I/O | - | AR29 | AC2 | AE1 |
| I/O | - | AP26 | AB4 | AD3 |
| GND | P135 | GND* | GND* | GND* |
| I/O | P136 | AU29 | AB3 | AC4 |
| I/O | P137 | AV28 | AB2 | AD2 |
| I/O | P138 | AT28 | AB1 | AB5 |
| I/O | P139 | AR25 | AA3 | AC3 |
| VCC | P140 | VCC* | VCC* | VCC* |
| I/O (D5) | P141 | AU24 | AA2 | AA5 |
| I/O (CS0) | P142 | AU27 | Y2 | AB3 |
| GND | - | GND* | GND* | GND* |
| I/O | - | AR27 | Y4 | AB2 |
| I/O | - | AW27 | Y3 | AA4 |
| I/O | - | AU25 | Y1 | AA3 |
| I/O | - | AV26 | W1 | Y5 |
| I/O | - | AT24 | W4 | Y3 |
| I/O | - | AR23 | W3 | Y2 |
| GND | P143 | GND* | GND* | GND* |
| VCC | - | VCC* | VCC* | VCC* |
| I/O | - | AW25 | W2 | W5 |
| I/O | - | AW23 | V2 | W4 |
| I/O | - | AP22 | V4 | W3 |
| I/O | - | AV24 | V3 | W1 |
| I/O | P144 | AU23 | U1 | V3 |
| I/O | P145 | AT22 | U2 | V5 |
| GND | - | GND* | GND* | GND* |
| I/O | P146 | AR21 | U4 | V4 |
| I/O | P147 | AV22 | U3 | V2 |
| I/O (D4) | P148 | AP20 | T1 | U5 |
| I/O | P149 | AU21 | T2 | U4 |
| VCC | P150 | VCC* | VCC* | VCC* |
| GND | P151 | GND* | GND* | GND* |
| I/O (D3) | P152 | AU19 | T3 | U3 |
| I/O (RS) | P153 | AV20 | R1 | T2 |
| I/O | P154 | AV18 | R2 | T4 |
| I/O | P155 | AR19 | R4 | R1 |
| GND | - | GND* | GND* | GND* |
| I/O | P156 | AT18 | R3 | R3 |
| I/O | P157 | AW17 | P2 | R4 |
| I/O | - | AV16 | P3 | R5 |
| I/O | - | AP18 | P4 | P2 |
| I/O | - | AU17 | N1 | P3 |
| I/O | - | AW15 | N2 | P4 |
| VCC | - | VCC* | VCC* | VCC* |
| GND | P158 | GND* | GND* | GND* |
| I/O | - | AR17 | N3 | N1 |
| I/O | - | AT16 | N4 | P5 |
| I/O | - | AV14 | M1 | N2 |
| I/O | - | AW13 | M2 | N3 |
| I/O | - | AU15 | M3 | N5 |
| I/O | - | AU13 | M4 | M3 |
| GND | - | GND* | GND* | GND* |
| I/O (D2) | P159 | AR15 | L2 | M4 |
| I/O | P160 | AP16 | L3 | L1 |
| VCC | P161 | VCC* | VCC* | VCC* |

| XC4052XL Pad Name | HQ 240 | PG 411 | BG 432 | BG 560 |
|---|---|---|---|---|
| I/O | P162 | AV12 | K1 | K2 |
| I/O | P163 | AR13 | K2 | L4 |
| I/O | P164 | AU11 | K3 | J1 |
| I/O | P165 | AT12 | K4 | K3 |
| GND | P166 | GND* | GND* | GND* |
| I/O | - | AP14 | J2 | L5 |
| I/O | - | AR11 | J3 | J2 |
| I/O | P167 | AV10 | J4 | K4 |
| I/O | P168 | AT8 | H1 | J3 |
| GND | - | GND* | GND* | GND* |
| I/O | P169 | AT10 | H2 | G1 |
| I/O | P170 | AP10 | H3 | F1 |
| I/O | P171 | AP12 | H4 | J5 |
| I/O | P172 | AR9 | G2 | G3 |
| I/O | - | AU9 | G3 | H4 |
| I/O | - | AV8 | F1 | F2 |
| GND | - | GND* | GND* | GND* |
| VCC | - | VCC* | VCC* | VCC* |
| I/O (D1) | P173 | AU7 | G4 | F3 |
| I/O (RCLK, RDY/BUSY) | P174 | AW7 | F2 | G4 |
| I/O | - | AW5 | F3 | D2 |
| I/O | - | AV6 | E1 | E3 |
| I/O | - | AU5 | F4 | G5 |
| I/O | - | AP8 | E2 | C1 |
| GND | - | GND* | GND* | GND* |
| I/O | - | AR7 | E3 | F4 |
| I/O | - | AV4 | D1 | D3 |
| I/O | P175 | AN9 | E4 | B3 |
| I/O | P176 | AW1 | D2 | F5 |
| I/O (D0, DIN) | P177 | AP6 | C2 | E4 |
| I/O, GCK6 (DOUT) | P178 | AU3 | D3 | D4 |
| CCLK | P179 | AR5 | D4 | C4 |
| VCC | P180 | VCC* | VCC* | VCC* |
| O, TDO | P181 | AN7 | C4 | E6 |
| GND | P182 | GND* | GND* | GND* |
| I/O (A0, WS) | P183 | AT4 | B3 | D5 |
| I/O, GCK7 (A1) | P184 | AV2 | D5 | A2 |
| I/O | P185 | AM8 | B4 | D6 |
| I/O | P186 | AL7 | C5 | A3 |
| I/O | - | AT2 | A4 | E7 |
| I/O | - | AN5 | D6 | C5 |
| GND | - | GND* | GND* | GND* |
| I/O | - | AR3 | B5 | B4 |
| I/O | - | AR1 | C6 | D7 |
| I/O (CS1, A2) | P187 | AK6 | A5 | C6 |
| I/O (A3) | P188 | AN3 | D7 | E8 |
| I/O | - | AM6 | B6 | B5 |
| I/O | - | AM2 | A6 | A5 |
| VCC | - | VCC* | VCC* | VCC* |
| GND | - | GND* | GND* | GND* |
| I/O | P189 | AL3 | D8 | D8 |
| I/O | P190 | AH6 | C7 | C7 |
| I/O | P191 | AP2 | B7 | E9 |
| I/O | P192 | AK4 | D9 | A6 |
| I/O | - | AN1 | B8 | B7 |
| I/O | - | AK2 | A8 | D9 |
| GND | - | GND* | GND* | GND* |
| I/O | P193 | AG5 | D10 | E11 |
| I/O | P194 | AF6 | C9 | A9 |
| I/O | P195 | AL5 | B9 | C10 |
| I/O | - | AJ3 | C10 | D11 |
| GND | P196 | GND* | GND* | GND* |
| I/O | P197 | AH2 | B10 | B10 |
| I/O | P198 | AE5 | A10 | E12 |
| I/O | P199 | AM4 | C11 | C11 |
| I/O | P200 | AD6 | D12 | B11 |
| VCC | P201 | VCC* | VCC* | VCC* |
| I/O | - | AG3 | B11 | D12 |
| I/O | - | AG1 | C12 | A11 |
| GND | - | GND* | GND* | GND* |

| XC4052XL Pad Name | HQ 240 | PG 411 | BG 432 | BG 560 |
|---|---|---|---|---|
| I/O | - | AF2 | D13 | C13 |
| I/O | - | AJ5 | B12 | E14 |
| I/O | - | AC5 | C13 | A13 |
| I/O | - | AE1 | A12 | D14 |
| I/O | - | AH4 | D14 | C14 |
| I/O | - | AB6 | B13 | B14 |
| GND | - | GND* | GND* | GND* |
| VCC | - | VCC* | VCC* | VCC* |
| I/O (A4) | P202 | AD2 | C14 | E15 |
| I/O (A5) | P203 | AB4 | A13 | D15 |
| I/O | P205 | AE3 | B14 | C15 |
| I/O | P206 | AC1 | D15 | A15 |
| I/O (A21) | P207 | AD4 | C15 | C16 |
| I/O (A20) | P208 | AA5 | B15 | E16 |
| GND | - | GND* | GND* | GND* |
| I/O | - | AB2 | A15 | B17 |
| I/O | - | AC3 | C16 | C17 |
| I/O (A6) | P209 | AA3 | B16 | E17 |
| I/O (A7) | P210 | Y6 | A16 | D17 |
| GND | P211 | GND* | GND* | GND* |

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* Pads labelled GND* or VCC* are internally bonded to Ground or VCC planes within the associated package. They have no direct connection to any specific package pin.

## Additional XC4052XL Package Pins

**HQ240**

| GND Pins | | | | | | |
|---|---|---|---|---|---|---|
| P204 | P219 | - | - | - | - | - |

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Note: These pins may be N.C. for this device revision, however for compatability with other devices in this package, these pins should be tied to GND.

**PG411**

| VCC Pins | | | | | | |
|---|---|---|---|---|---|---|
| A3 | A11 | A21 | A31 | C39 | D6 | F36 |
| J1 | L39 | W1 | AA39 | AJ1 | AL39 | AP4 |
| AT34 | AU1 | AW9 | AW19 | AW29 | AW37 | - |
| **GND Pins** | | | | | | |
| A9 | A19 | A29 | A37 | C1 | D14 | D20 |
| D26 | D34 | F4 | J39 | LI | P4 | P36 |
| W39 | Y4 | Y36 | AA1 | AF4 | AF36 | AJ39 |
| AL1 | AP36 | AT6 | AT14 | AT20 | AT26 | AU39 |
| AW3 | AW11 | AW21 | AW31 | - | - | - |

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**BG432**

| VCC Pins | | | | | | |
|---|---|---|---|---|---|---|
| A1 | A11 | A21 | A31 | C3 | C29 | D11 |
| D21 | L1 | L4 | L28 | L31 | AA1 | AA4 |
| AA28 | AA31 | AH11 | AH21 | AJ3 | AJ29 | AL1 |
| AL11 | AL21 | AL31 | - | - | - | - |
| **GND Pins** | | | | | | |
| A2 | A3 | A7 | A9 | A14 | A18 | A23 |
| A25 | A29 | A30 | B1 | B2 | B30 | B31 |
| C1 | C31 | D16 | G1 | G31 | J1 | J31 |
| P1 | P31 | T4 | T28 | V1 | V31 | AC1 |
| AC31 | AE1 | AE31 | AH16 | AJ1 | AJ31 | AK1 |
| AK2 | AK30 | AK31 | AL2 | AL3 | AL7 | AL9 |
| AL14 | AL18 | AL23 | AL25 | AL29 | AL30 | - |
| **N.C. Pins** | | | | | | |
| C8 | - | - | - | - | - | - |

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**PG560**

| VCC Pins | | | | | | |
|---|---|---|---|---|---|---|
| A4 | A10 | A16 | A22 | A26 | A30 | B2 |
| B13 | B19 | B32 | C3 | C31 | C32 | D1 |
| D33 | E5 | H1 | K33 | M1 | N32 | R2 |
| T33 | V1 | W32 | AA2 | AB33 | AD1 | AF33 |
| AK1 | AK4 | AK33 | AL2 | AL3 | AL31 | AM2 |
| AM15 | AM21 | AM32 | AN4 | AN8 | AN12 | AN18 |
| AN24 | AN30 | - | - | - | - | - |

| GND Pins | | | | | | |
|---|---|---|---|---|---|---|
| A7 | A12 | A14 | A18 | A20 | A24 | A29 |
| A32 | B1 | B6 | B9 | B15 | B23 | B27 |
| B31 | C2 | E1 | F32 | G2 | G33 | J32 |
| K1 | L2 | M33 | P1 | P33 | R32 | T1 |
| V33 | W2 | Y1 | Y33 | AB1 | AC32 | AD33 |
| AE2 | AG1 | AG32 | AH2 | AJ33 | AL32 | AM3 |
| AM7 | AM11 | AM19 | AM25 | AM28 | AM33 | AN2 |
| AN5 | AN10 | AN14 | AN16 | AN20 | AN22 | AN27 |

| N.C. Pins | | | | | | |
|---|---|---|---|---|---|---|
| A1 | A8 | A19 | A23 | A27 | A28 | A33 |
| B8 | B12 | B16 | B26 | C8 | C9 | C12 |
| C22 | C26 | D10 | D13 | D16 | D18 | D22 |
| D25 | E2 | E10 | E13 | E21 | E24 | E32 |
| E33 | H2 | H3 | H5 | H31 | H32 | J4 |
| J31 | K5 | K29 | L3 | L31 | M2 | M5 |
| M30 | N4 | N30 | N31 | T3 | T5 | T30 |
| T32 | U1 | U2 | U33 | V32 | Y4 | Y29 |
| AA1 | AA33 | AB4 | AB30 | AC1 | AC2 | AC33 |
| AD4 | AD5 | AD29 | AD30 | AE4 | AE30 | AE31 |
| AF1 | AF2 | AF31 | AF32 | AG2 | AJ10 | AJ13 |
| AJ16 | AJ18 | AJ21 | AJ24 | AK9 | AK13 | AK18 |
| AK24 | AK25 | AL8 | AL9 | AL12 | AL16 | AL22 |
| AL26 | AM8 | AM9 | AM12 | AM23 | AM26 | AM27 |
| AN1 | AN23 | AN33 | - | - | - | - |

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## Pin Locations for XC4062XL Devices

(Note: XC4062XL is also available in the HQ304 package. The pinout is identical to the XC4036XL in HQ304.)

| XC4062XL Pad Name | HQ240 | BG432 | PG475 | BG560 |
|---|---|---|---|---|
| VCC | P212 | VCC* | VCC* | VCC* |
| I/O (A8) | P213 | D17 | Y2 | A17 |
| I/O (A9) | P214 | A17 | Y4 | B18 |
| I/O | - | C17 | W5 | C18 |
| I/O | - | B17 | Y6 | E18 |
| I/O | - | - | U3 | D18 |
| I/O | - | - | W3 | A19 |
| GND | - | GND* | GND* | GND* |
| I/O (A19) | P215 | C18 | W1 | C19 |
| I/O (A18) | P216 | D18 | U5 | D19 |
| I/O | P217 | B18 | W7 | E19 |
| I/O | P218 | A19 | U7 | B20 |
| I/O (A10) | P220 | B19 | V2 | C20 |
| I/O (A11) | P221 | C19 | V4 | D20 |
| VCC | - | VCC* | VCC* | VCC* |
| GND | - | GND* | GND* | GND* |
| I/O | - | D19 | V6 | A21 |
| I/O | - | A20 | R1 | E20 |
| I/O | - | B20 | T6 | B21 |
| I/O | - | C20 | R3 | C21 |
| I/O | - | B21 | R5 | D21 |
| I/O | - | D20 | T4 | B22 |
| GND | - | GND* | GND* | GND* |
| I/O | - | C21 | P2 | C23 |
| I/O | - | A22 | N1 | E22 |
| VCC | P222 | VCC* | VCC* | VCC* |
| I/O | P223 | B22 | N3 | B24 |

| XC4062XL Pad Name | HQ240 | BG432 | PG475 | BG560 |
|---|---|---|---|---|
| I/O | P224 | C22 | P4 | D23 |
| I/O | P225 | B23 | R7 | C24 |
| I/O | P226 | A24 | M2 | A25 |
| GND | P227 | GND* | GND* | GND* |
| I/O | - | D22 | M4 | E23 |
| I/O | - | C23 | L3 | B25 |
| I/O | P228 | B24 | N5 | D24 |
| I/O | P229 | C24 | K2 | C25 |
| I/O | - | - | L5 | B26 |
| I/O | - | - | J1 | E24 |
| GND | - | GND* | GND* | GND* |
| I/O | - | D23 | M6 | E25 |
| I/O | - | B25 | K4 | C27 |
| I/O | P230 | A26 | J3 | D26 |
| I/O | P231 | C25 | J5 | B28 |
| I/O (A12) | P232 | D24 | H2 | B29 |
| I/O (A13) | P233 | B26 | G1 | E26 |
| GND | - | GND* | GND* | GND* |
| VCC | - | VCC* | VCC* | VCC* |
| I/O | - | A27 | L7 | C28 |
| I/O | - | D25 | K6 | D27 |
| I/O | - | C26 | E1 | B30 |
| I/O | - | B27 | H4 | C29 |
| I/O | - | A28 | G5 | E27 |
| I/O | - | D26 | F2 | A31 |
| GND | - | GND* | GND* | GND* |
| I/O | P234 | C27 | H6 | D28 |
| I/O | P235 | B28 | C3 | C30 |
| I/O | P236 | D27 | F4 | D29 |
| I/O | P237 | B29 | C5 | E28 |

| XC4062XL Pad Name | HQ240 | BG432 | PG475 | BG560 |
|---|---|---|---|---|
| I/O (A14) | P238 | C28 | E3 | D30 |
| I/O GCK8 (A15) | P239 | D28 | E5 | E29 |
| VCC | P240 | VCC* | VCC* | VCC* |
| GND | P1 | GND* | GND* | GND* |
| I/O, GCK1 (A16) | P2 | D29 | G7 | B33 |
| I/O (A17) | P3 | C30 | D4 | F29 |
| I/O | P4 | E28 | A5 | E30 |
| I/O | P5 | E29 | B4 | D31 |
| I/O, TDI | P6 | D30 | D6 | F30 |
| I/O, TCK | P7 | D31 | F8 | C33 |
| GND | - | GND* | GND* | GND* |
| I/O | - | F28 | B6 | G29 |
| I/O | - | F29 | E7 | E31 |
| I/O | - | E30 | D8 | D32 |
| I/O | - | E31 | G9 | G30 |
| I/O | - | G28 | E9 | F31 |
| I/O | - | G29 | A7 | H29 |
| VCC | - | VCC* | VCC* | VCC* |
| GND | - | GND* | GND* | GND* |
| I/O | - | F30 | B8 | H30 |
| I/O | - | F31 | C9 | G31 |
| I/O | P8 | H28 | G11 | J29 |
| I/O | P9 | H29 | D10 | F33 |
| I/O | P10 | G30 | E11 | G32 |
| I/O | P11 | H30 | A9 | J30 |
| GND | - | GND* | GND* | GND* |
| I/O | - | - | B10 | H32 |
| I/O | - | - | C11 | J31 |
| I/O | P12 | J28 | F12 | K30 |
| I/O | P13 | J29 | D12 | H33 |
| I/O | - | H31 | A11 | L29 |
| I/O | - | J30 | G15 | K31 |
| GND | P14 | GND* | GND* | GND* |
| I/O | P15 | K28 | B12 | L30 |
| I/O | P16 | K29 | E13 | K32 |
| I/O, TMS | P17 | K30 | C13 | J33 |
| I/O | P18 | K31 | A13 | M29 |
| VCC | P19 | VCC* | VCC* | VCC* |
| I/O | P20 | L29 | B14 | L32 |
| I/O | P21 | L30 | C15 | M31 |
| GND | - | GND* | GND* | GND* |
| I/O | - | M30 | G17 | N29 |
| I/O | - | M28 | F14 | L33 |
| I/O | - | M29 | D16 | M32 |
| I/O | - | M31 | D14 | P29 |
| I/O | - | N31 | A15 | P30 |
| I/O | - | N28 | C17 | N33 |
| GND | P22 | GND* | GND* | GND* |
| VCC | - | VCC* | VCC* | VCC* |
| I/O | - | N29 | D18 | P31 |
| I/O | - | N30 | B18 | P32 |
| I/O | - | P30 | F16 | R29 |
| I/O | - | P28 | G19 | R30 |
| I/O | P23 | P29 | E17 | R31 |
| I/O | P24 | R31 | E19 | R33 |
| GND | - | GND* | GND* | GND* |
| I/O | P25 | R30 | A19 | T31 |
| I/O | P26 | R28 | F18 | T29 |
| I/O | - | - | C19 | T30 |
| I/O | - | - | D20 | T32 |
| I/O | P27 | R29 | F20 | U32 |
| I/O | P28 | T31 | B20 | U31 |
| GND | P29 | GND* | GND* | GND* |
| VCC | P30 | VCC* | VCC* | VCC* |
| I/O | P31 | T30 | C21 | U29 |
| I/O | P32 | T29 | A21 | U30 |
| I/O | - | - | D22 | U33 |
| I/O | - | - | B22 | V32 |
| I/O | P33 | U31 | E23 | V31 |
| I/O | P34 | U30 | F22 | V29 |

| XC4062XL Pad Name | HQ240 | BG432 | PG475 | BG560 |
|---|---|---|---|---|
| GND | - | GND* | GND* | GND* |
| I/O | P35 | U28 | C23 | V30 |
| I/O | P36 | U29 | F24 | W33 |
| I/O | - | V30 | A23 | W31 |
| I/O | - | V29 | E25 | W30 |
| I/O | - | V28 | G23 | W29 |
| I/O | - | W31 | B24 | Y32 |
| VCC | - | VCC* | VCC* | VCC* |
| GND | P37 | GND* | GND* | GND* |
| I/O | - | W30 | D24 | Y31 |
| I/O | - | W29 | C25 | Y30 |
| I/O | - | W28 | D28 | AA32 |
| I/O | - | Y31 | A27 | AA31 |
| I/O | - | Y30 | E29 | AA30 |
| I/O | - | Y29 | C27 | AB32 |
| GND | - | GND* | GND* | GND* |
| I/O | P38 | Y28 | G25 | AA29 |
| I/O | P39 | AA30 | D26 | AB31 |
| VCC | P40 | VCC* | VCC* | VCC* |
| I/O | P41 | AA29 | F26 | AC31 |
| I/O | P42 | AB31 | B28 | AB29 |
| I/O | P43 | AB30 | D30 | AD32 |
| I/O | P44 | AB29 | A29 | AC30 |
| GND | P45 | GND* | GND* | GND* |
| I/O | - | AB28 | C29 | AD31 |
| I/O | - | AC30 | G27 | AE33 |
| I/O | P46 | AC29 | F30 | AC29 |
| I/O | P47 | AC28 | B30 | AE32 |
| I/O | - | - | E31 | AD30 |
| I/O | - | - | C31 | AE31 |
| GND | - | GND* | GND* | GND* |
| I/O | - | AD31 | F28 | AG33 |
| I/O | - | AD30 | D32 | AH33 |
| I/O | P48 | AD29 | B32 | AE29 |
| I/O | P49 | AD28 | G31 | AG31 |
| I/O | P50 | AE30 | A33 | AF30 |
| I/O | P51 | AE29 | C33 | AH32 |
| GND | - | GND* | GND* | GND* |
| VCC | - | VCC* | VCC* | VCC* |
| I/O | - | AF31 | B34 | AJ32 |
| I/O | - | AE28 | A35 | AF29 |
| I/O | - | AF30 | E33 | AH31 |
| I/O | - | AF29 | D34 | AG30 |
| I/O | P52 | AG31 | D36 | AK32 |
| I/O | P53 | AF28 | B36 | AJ31 |
| GND | - | GND* | GND* | GND* |
| I/O | - | AG30 | F34 | AG29 |
| I/O | - | AG29 | D38 | AL33 |
| I/O | P54 | AH31 | C37 | AH30 |
| I/O | P55 | AG28 | G37 | AK31 |
| I/O | P56 | AH30 | B38 | AJ30 |
| I/O, GCK2 | P57 | AJ30 | F38 | AH29 |
| O (M1) | P58 | AH29 | A39 | AK30 |
| GND | P59 | GND* | GND* | GND* |
| I (M0) | P60 | AH28 | E35 | AJ29 |
| VCC | P61 | VCC* | VCC* | VCC* |
| I (M2) | P62 | AJ28 | G33 | AN32 |
| I/O, GCK3 | P63 | AK29 | J37 | AJ28 |
| I/O (HDC) | P64 | AH27 | G35 | AK29 |
| I/O | P65 | AK28 | K36 | AL30 |
| I/O | P66 | AJ27 | C39 | AK28 |
| I/O | P67 | AL28 | K38 | AM31 |
| I/O (LDC) | P68 | AH26 | C41 | AJ27 |
| GND | - | GND* | GND* | GND* |
| I/O | - | AK27 | D40 | AN31 |
| I/O | - | AJ26 | L37 | AL29 |
| I/O | - | AL27 | H36 | AK27 |
| I/O | - | AH25 | M36 | AL28 |
| I/O | - | AK26 | J35 | AJ26 |
| I/O | - | AL26 | E41 | AM30 |

| XC4062XL Pad Name | HQ240 | BG432 | PG475 | BG560 |
|---|---|---|---|---|
| VCC | - | VCC* | VCC* | VCC* |
| GND | - | GND* | GND* | GND* |
| I/O | P69 | AH24 | F40 | AM29 |
| I/O | P70 | AJ25 | H38 | AK26 |
| I/O | P71 | AK25 | N37 | AL27 |
| I/O | P72 | AJ24 | L35 | AJ25 |
| I/O | - | AH23 | R35 | AN29 |
| I/O | - | AK24 | G41 | AN28 |
| GND | - | GND* | GND* | GND* |
| I/O | - | - | H40 | AM26 |
| I/O | - | - | P38 | AK24 |
| I/O | P73 | AL24 | J39 | AL25 |
| I/O | P74 | AH22 | R37 | AJ23 |
| I/O | - | AJ23 | J41 | AN26 |
| I/O | - | AK23 | K40 | AL24 |
| GND | P75 | GND* | GND* | GND* |
| I/O | P76 | AJ22 | L39 | AK23 |
| I/O | P77 | AK22 | M38 | AN25 |
| I/O | P78 | AL22 | T36 | AJ22 |
| I/O | P79 | AJ21 | M40 | AL23 |
| VCC | P80 | VCC* | VCC* | VCC* |
| I/O | P81 | AH20 | N39 | AM24 |
| I/O | P82 | AK21 | N41 | AK22 |
| GND | - | GND* | GND* | GND* |
| I/O | - | AJ20 | P40 | AK21 |
| I/O | - | AH19 | T38 | AM22 |
| I/O | - | AK20 | U35 | AJ20 |
| I/O | - | AJ19 | U37 | AL21 |
| I/O | - | AL20 | R39 | AN21 |
| I/O | - | AH18 | R41 | AK20 |
| GND | P83 | GND* | GND* | GND* |
| VCC | - | VCC* | VCC* | VCC* |
| I/O | - | AK19 | V36 | AL20 |
| I//O | - | AJ18 | U39 | AJ19 |
| I/O | P84 | AL19 | V38 | AM20 |
| I/O | P85 | AK18 | V40 | AK19 |
| I/O | P86 | AH17 | W37 | AL19 |
| I/O | P87 | AJ17 | W35 | AN19 |
| GND | - | GND* | GND* | GND* |
| I/O | - | - | W41 | AJ18 |
| I/O | - | - | Y36 | AK18 |
| I/O | - | AK17 | W39 | AL18 |
| I/O | - | AL17 | AB36 | AM18 |
| I/O | P88 | AJ16 | Y40 | AK17 |
| I/O (INIT) | P89 | AK16 | Y38 | AJ17 |
| VCC | P90 | VCC* | VCC* | VCC* |
| GND | P91 | GND* | GND* | GND* |
| I/O | P92 | AL16 | AA39 | AL17 |
| I/O | P93 | AH15 | AB38 | AM17 |
| I/O | - | AL15 | AB40 | AN17 |
| I/O | - | AJ15 | AC37 | AK16 |
| I/O | - | - | AC39 | AJ16 |
| I/O | - | - | AC41 | AL16 |
| GND | - | GND* | GND* | GND* |
| I/O | P94 | AK15 | AD36 | AM16 |
| I/O | P95 | AJ14 | AC35 | AL15 |
| I/O | P96 | AH14 | AE37 | AK15 |
| I/O | P97 | AK14 | AD40 | AJ15 |
| I/O | - | AL13 | AD38 | AN15 |
| I/O | - | AK13 | AE39 | AM14 |
| VCC | - | VCC* | VCC* | VCC* |
| GND | P98 | GND* | GND* | GND* |
| I/O | - | AJ13 | AG41 | AL14 |
| I/O | - | AH13 | AG39 | AK14 |
| I/O | - | AL12 | AG37 | AJ14 |
| I/O | - | AK12 | AE35 | AN13 |
| I/O | - | AJ12 | AH38 | AM13 |
| I/O | - | AK11 | AF38 | AL13 |
| GND | - | GND* | GND* | GND* |
| I/O | P99 | AH12 | AF36 | AK12 |

| XC4062XL Pad Name | HQ240 | BG432 | PG475 | BG560 |
|---|---|---|---|---|
| I/O | P100 | AJ11 | AH40 | AN11 |
| VCC | P101 | VCC* | VCC* | VCC* |
| I/O | P102 | AL10 | AJ41 | AJ12 |
| I/O | P103 | AK10 | AJ39 | AL11 |
| I/O | P104 | AJ10 | AJ37 | AK11 |
| I/O | P105 | AK9 | AG35 | AM10 |
| GND | P106 | GND* | GND* | GND* |
| I/O | - | AL8 | AK40 | AL10 |
| I/O | - | AH10 | AK38 | AJ11 |
| I/O | P107 | AJ9 | AL37 | AN9 |
| I/O | P108 | AK8 | AL39 | AK10 |
| I/O | - | - | AM38 | AM9 |
| I/O | - | - | AM40 | AL9 |
| GND | - | GND* | GND* | GND* |
| I/O | - | AJ8 | AN41 | AN7 |
| I/O | - | AH9 | AM36 | AJ9 |
| I/O | P109 | AK7 | AK36 | AL7 |
| I/O | P110 | AL6 | AU41 | AK8 |
| I/O | P111 | AJ7 | AN39 | AN6 |
| I/O | P112 | AH8 | AP40 | AM6 |
| GND | - | GND* | GND* | GND* |
| VCC | - | VCC* | VCC* | VCC* |
| I/O | - | AK6 | AR41 | AJ8 |
| I/O | - | AL5 | AL35 | AL6 |
| I/O | P113 | AH7 | AV40 | AK7 |
| I/O | P114 | AJ6 | AN37 | AM5 |
| I/O | - | AK5 | AT38 | AM4 |
| I/O | - | AL4 | AP38 | AJ7 |
| GND | - | GND* | GND* | GND* |
| I/O | - | AH6 | AT40 | AL5 |
| I/O | - | AJ5 | AW39 | AK6 |
| I/O | P115 | AK4 | AP36 | AN3 |
| I/O | P116 | AH5 | AU37 | AK5 |
| I/O | P117 | AK3 | AR37 | AJ6 |
| I/O, GCK4 | P118 | AJ4 | AU39 | AL4 |
| GND | P119 | GND* | GND* | GND* |
| DONE | P120 | AH4 | AR35 | AJ5 |
| VCC | P121 | VCC* | VCC* | VCC* |
| PROGRAM | P122 | AH3 | AN35 | AM1 |
| I/O (D7) | P123 | AJ2 | AU35 | AH5 |
| I/O, GCK5 | P124 | AG4 | AV38 | AJ4 |
| I/O | P125 | AG3 | AT34 | AK3 |
| I/O | P126 | AH2 | BA39 | AH4 |
| I/O | - | AH1 | AU33 | AL1 |
| I/O | - | AF4 | AY38 | AG5 |
| GND | - | GND* | GND* | GND* |
| I/O | P127 | AF3 | AV36 | AJ3 |
| I/O | P128 | AG2 | AR31 | AK2 |
| I/O | - | AG1 | AR33 | AG4 |
| I/O | - | AE4 | AV32 | AH3 |
| I/O | - | AE3 | BA37 | AF5 |
| I/O | - | AF2 | AY36 | AJ2 |
| VCC | - | VCC* | VCC* | VCC* |
| GND | - | GND* | GND* | GND* |
| I/O (D6) | P129 | AF1 | AV34 | AJ1 |
| I/O | P130 | AD4 | BA35 | AF4 |
| I/O | P131 | AD3 | AU31 | AG3 |
| I/O | P132 | AE2 | AY34 | AE5 |
| I/O | - | AD2 | AT30 | AH1 |
| I/O | - | AC4 | AW33 | AF3 |
| GND | - | GND* | GND* | GND* |
| I/O | - | - | BA33 | AF1 |
| I/O | - | - | AV30 | AD4 |
| I/O | P133 | AC3 | AY32 | AE3 |
| I/O | P134 | AD1 | AU29 | AC5 |
| I/O | - | AC2 | AW31 | AE1 |
| I/O | - | AB4 | BA31 | AD3 |
| GND | P135 | GND* | GND* | GND* |
| I/O | P136 | AB3 | AR27 | AC4 |
| I/O | P137 | AB2 | AT28 | AD2 |

| XC4062XL Pad Name | HQ240 | BG432 | PG475 | BG560 |
|---|---|---|---|---|
| I/O | P138 | AB1 | AY30 | AB5 |
| I/O | P139 | AA3 | AW29 | AC3 |
| VCC | P140 | VCC* | VCC* | VCC* |
| I/O (D5) | P141 | AA2 | BA29 | AA5 |
| I/O (CS0) | P142 | Y2 | AY28 | AB3 |
| GND | P143 | GND* | GND* | GND* |
| I/O | - | Y4 | AR25 | AB2 |
| I/O | - | Y3 | AV28 | AA4 |
| I/O | - | Y1 | AW27 | AA3 |
| I/O | - | W1 | AT26 | Y5 |
| I/O | - | W4 | AV26 | Y3 |
| I/O | - | W3 | BA27 | Y2 |
| GND | - | GND* | GND* | GND* |
| VCC | - | VCC* | VCC* | VCC* |
| I/O | - | W2 | AW25 | W5 |
| I/O | - | V2 | AV24 | W4 |
| I/O | - | V4 | AU25 | W3 |
| I/O | - | V3 | AR23 | W1 |
| I/O | P144 | U1 | AT24 | V3 |
| I/O | P145 | U2 | AY24 | V5 |
| GND | - | GND* | GND* | GND* |
| I/O | P146 | U4 | BA23 | V4 |
| I/O | P147 | U3 | AU23 | V2 |
| I/O | - | - | AW23 | U2 |
| I/O | - | - | AV20 | U1 |
| I/O (D4) | P148 | T1 | AY22 | U5 |
| I/O | P149 | T2 | AV22 | U4 |
| VCC | P150 | VCC* | VCC* | VCC* |
| GND | P151 | GND* | GND* | GND* |
| I/O (D3) | P152 | T3 | AW21 | U3 |
| I/O (RS) | P153 | R1 | BA21 | T2 |
| I/O | - | - | AU19 | T3 |
| I/O | - | - | AY20 | T5 |
| I/O | P154 | R2 | AU17 | T4 |
| I/O | P155 | R4 | AW19 | R1 |
| GND | - | GND* | GND* | GND* |
| I/O | P156 | R3 | BA19 | R3 |
| I/O | P157 | P2 | AT16 | R4 |
| I/O | - | P3 | AR19 | R5 |
| I/O | - | P4 | AV14 | P2 |
| I/O | - | N1 | AY18 | P3 |
| I/O | - | N2 | AV18 | P4 |
| VCC | - | VCC* | VCC* | VCC* |
| GND | P158 | GND* | GND* | GND* |
| I/O | - | N3 | AT18 | N1 |
| I/O | - | N4 | AW17 | P5 |
| I/O | - | M1 | AR15 | N2 |
| I/O | - | M2 | BA15 | N3 |
| I/O | - | M3 | AT14 | N5 |
| I/O | - | M4 | AR17 | M3 |
| GND | - | GND* | GND* | GND* |
| I/O (D2) | P159 | L2 | AW15 | M4 |
| I/O | P160 | L3 | AV16 | L1 |
| VCC | P161 | VCC* | VCC* | VCC* |
| I/O | P162 | K1 | AY14 | K2 |
| I/O | P163 | K2 | BA13 | L4 |
| I/O | P164 | K3 | AU13 | J1 |
| I/O | P165 | K4 | AW13 | K3 |
| GND | P166 | GND* | GND* | GND* |
| I/O | - | J2 | AY12 | L5 |
| I/O | - | J3 | BA11 | J2 |
| I/O | P167 | J4 | AV12 | K4 |
| I/O | P168 | H1 | AT12 | J3 |
| I/O | - | - | AW11 | H2 |
| I/O | - | - | AY10 | K5 |
| GND | - | GND* | GND* | GND* |
| I/O | P169 | H2 | BA9 | G1 |
| I/O | P170 | H3 | AU11 | F1 |
| I/O | P171 | H4 | AW9 | J5 |
| I/O | P172 | G2 | AV10 | G3 |

| XC4062XL Pad Name | HQ240 | BG432 | PG475 | BG560 |
|---|---|---|---|---|
| I/O | - | G3 | AY8 | H4 |
| I/O | - | F1 | BA7 | F2 |
| GND | - | GND* | GND* | GND* |
| VCC | - | VCC* | VCC* | VCC* |
| I/O (D1) | P173 | G4 | AV8 | F3 |
| I/O (RCLK, RDY/BUSY) | P174 | F2 | AY6 | G4 |
| I/O | - | F3 | AR11 | D2 |
| I/O | - | E1 | AT8 | E3 |
| I/O | - | F4 | AU9 | G5 |
| I/O | - | E2 | AW5 | C1 |
| GND | - | GND* | GND* | GND* |
| I/O | - | E3 | AY4 | F4 |
| I/O | - | D1 | BA5 | D3 |
| I/O | P175 | E4 | AV4 | B3 |
| I/O | P176 | D2 | AR9 | F5 |
| I/O (D0, DIN) | P177 | C2 | AU5 | E4 |
| I/O, GCK6 (DOUT) | P178 | D3 | AV6 | D4 |
| CCLK | P179 | D4 | AR5 | C4 |
| VCC | P180 | VCC* | VCC* | VCC* |
| O, TDO | P181 | C4 | AN7 | E6 |
| GND | P182 | GND* | GND* | GND* |
| I/O (A0, WS) | P183 | B3 | AR7 | D5 |
| I/O, GCK7 (A1) | P184 | D5 | AW3 | A2 |
| I/O | P185 | B4 | AU3 | D6 |
| I/O | P186 | C5 | AW1 | A3 |
| I/O | - | A4 | AP6 | E7 |
| I/O | - | D6 | AV2 | C5 |
| GND | - | GND* | GND* | GND* |
| I/O | - | B5 | AT4 | B4 |
| I/O | - | C6 | AN5 | D7 |
| I/O (CS1, A2) | P187 | A5 | AU1 | C6 |
| I/O (A3) | P188 | D7 | AM6 | E8 |
| I/O | - | B6 | AT2 | B5 |
| I/O | - | A6 | AL7 | A5 |
| VCC | - | VCC* | VCC* | VCC* |
| GND | - | GND* | GND* | GND* |
| I/O | P189 | D8 | AR1 | D8 |
| I/O | P190 | C7 | AP2 | C7 |
| I/O | P191 | B7 | AM4 | E9 |
| I/O | P192 | D9 | AN3 | A6 |
| I/O | - | B8 | AL5 | B7 |
| I/O | - | A8 | AK6 | D9 |
| GND | - | GND* | GND* | GND* |
| I/O | - | - | AN1 | D10 |
| I/O | - | - | AJ5 | C9 |
| I/O | P193 | D10 | AM2 | E11 |
| I/O | P194 | C9 | AH4 | A9 |
| I/O | P195 | B9 | AL3 | C10 |
| I/O | - | C10 | AK4 | D11 |
| GND | P196 | GND* | GND* | GND* |
| I/O | P197 | B10 | AG7 | B10 |
| I/O | P198 | A10 | AG5 | E12 |
| I/O | P199 | C11 | AK2 | C11 |
| I/O | P200 | D12 | AJ3 | B11 |
| VCC | P201 | VCC* | VCC* | VCC* |
| I/O | - | B11 | AJ1 | D12 |
| I/O | - | C12 | AF6 | A11 |
| GND | - | GND* | GND* | GND* |
| I/O | - | D13 | AH2 | C13 |
| I/O | - | B12 | AF4 | E14 |
| I/O | - | C13 | AE7 | A13 |
| I/O | - | A12 | AE5 | D14 |
| I/O | - | D14 | AG3 | C14 |
| I/O | - | B13 | AG1 | B14 |
| GND | - | GND* | GND* | GND* |
| VCC | - | VCC* | VCC* | VCC* |
| I/O (A4) | P202 | C14 | AD6 | E15 |
| I/O (A5) | P203 | A13 | AD4 | D15 |
| I/O | P205 | B14 | AE3 | C15 |
| I/O | P206 | D15 | AC5 | A15 |

| XC4062XL Pad Name | HQ240 | BG432 | PG475 | BG560 |
|---|---|---|---|---|
| I/O (A21) | P207 | C15 | AD2 | C16 |
| I/O (A20) | P208 | B15 | AC7 | E16 |
| GND | - | GND* | GND* | GND* |
| I/O | - | - | AC1 | D16 |
| I/O | - | - | AC3 | B16 |
| I/O | - | A15 | AB6 | B17 |
| I/O | - | C16 | AB2 | C17 |
| I/O (A6) | P209 | B16 | AB4 | E17 |
| I/O (A7) | P210 | A16 | AA3 | D17 |
| GND | P211 | GND* | GND* | GND* |

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* Pads labelled GND* or VCC* are internally bonded to Ground or VCC planes within the package. They have no direct connection to any specific package pin.

## Additional XC4062XL Package Pins

**HQ240**

| GND Pins | | | | | |
|---|---|---|---|---|---|
| P204 | P219 | - | - | - | - |

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Note: These pins may be N.C. for this device revision, however for compatability with other devices in this package, these pins should be tied to GND.

**BG432**

| VCC Pins | | | | | | |
|---|---|---|---|---|---|---|
| A1 | A11 | A21 | A31 | C3 | C29 | D11 |
| D21 | L1 | L4 | L28 | L31 | AA1 | AA4 |
| AA28 | AA31 | AH11 | AH21 | AJ3 | AJ29 | AL1 |
| AL11 | AL21 | AL31 | - | - | - | - |

| GND Pins | | | | | | |
|---|---|---|---|---|---|---|
| A2 | A3 | A7 | A9 | A14 | A18 | A23 |
| A25 | A29 | A30 | B1 | B2 | B30 | B31 |
| C1 | C31 | D16 | G1 | G31 | J1 | J31 |
| P1 | P31 | T4 | T28 | V1 | V31 | AC1 |
| AC31 | AE1 | AE31 | AH16 | AJ1 | AJ31 | AK1 |
| AK2 | AK30 | AK31 | AL2 | AL3 | AL7 | AL9 |
| AL14 | AL18 | AL23 | AL25 | AL29 | AL30 | - |

| N.C. Pins | | | | | | |
|---|---|---|---|---|---|---|
| C8 | - | - | - | - | - | - |

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**PG475**

| VCC Pins | | | | | |
|---|---|---|---|---|---|
| A37 | B2 | B16 | B26 | B40 | D2 |
| E21 | F6 | F36 | G13 | G29 | N7 |
| N35 | T2 | T40 | AA1 | AA5 | AA37 |
| AA41 | AF2 | AF40 | AJ7 | AJ35 | AR13 |
| AR29 | AT6 | AT22 | AT36 | AU21 | AW37 |
| AW41 | AY2 | AY16 | AY26 | AY40 | BA3 |

| GND Pins | | | | | |
|---|---|---|---|---|---|
| A3 | C1 | C7 | G3 | L1 | P6 |
| U1 | A17 | A25 | A41 | AA7 | AE1 |
| AH6 | AL1 | AR3 | AW7 | BA1 | C35 |
| E15 | E27 | F10 | F32 | G21 | G39 |
| L41 | P36 | U41 | AA35 | AE41 | AH36 |
| AL41 | AR21 | AR39 | AT10 | AT20 | AT32 |
| AU15 | AU27 | AW35 | BA17 | BA25 | BA41 |
| E37 | E39 | A31 | J7 | AP4 | AU7 |

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**BG560**

| VCC Pins | | | | | | |
|---|---|---|---|---|---|---|
| A4 | A10 | A16 | A22 | A26 | A30 | B2 |
| B13 | B19 | B32 | C3 | C31 | C32 | D1 |
| D33 | E5 | H1 | K33 | M1 | N32 | R2 |
| T33 | V1 | W32 | AA2 | AB33 | AD1 | AF33 |
| AK1 | AK4 | AK33 | AL2 | AL3 | AL31 | AM2 |
| AM15 | AM21 | AM32 | AN4 | AN8 | AN12 | AN18 |
| AN24 | AN30 | - | - | - | - | - |

| GND Pins | | | | | | |
|---|---|---|---|---|---|---|
| A7 | A12 | A14 | A18 | A20 | A24 | A29 |
| A32 | B1 | B6 | B9 | B15 | B23 | B27 |
| B31 | C2 | E1 | F32 | G2 | G33 | J32 |
| K1 | L2 | M33 | P1 | P33 | R32 | T1 |
| V33 | W2 | Y1 | Y33 | AB1 | AC32 | AD33 |
| AE2 | AG1 | AG32 | AH2 | AJ33 | AL32 | AM3 |
| AM11 | AM19 | AM25 | AM28 | AM33 | AM7 | AN2 |
| AN5 | AN10 | AN14 | AN16 | AN20 | AN22 | AN27 |

| N.C. Pins | | | | | | |
|---|---|---|---|---|---|---|
| A1 | A8 | A23 | A27 | A28 | A33 | B8 |
| B12 | C8 | C12 | C22 | C26 | D13 | D22 |
| D25 | E2 | E10 | E13 | E21 | E32 | E33 |
| H3 | H5 | H31 | J4 | K29 | L3 | L31 |
| M2 | M5 | M30 | N4 | N30 | N31 | Y4 |
| Y29 | AA1 | AA33 | AB4 | AB30 | AC1 | AC2 |
| AC33 | AD5 | AD29 | AE4 | AE30 | AF2 | AF31 |
| AF32 | AG2 | AJ10 | AJ13 | AJ21 | AJ24 | AK9 |
| AK13 | AK25 | AL8 | AL12 | AL22 | AL26 | AM8 |
| AM12 | AM23 | AM27 | AN1 | AN23 | AN33 | - |

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## Pin Locations for XC4085XL Devices

| XC4085XL Pad Name | BG560 | PG559 |
|---|---|---|
| VCC | VCC* | VCC* |
| I/O (A8) | A17 | AB6 |
| I/O (A9) | B18 | AB4 |
| I/O | C18 | AA7 |
| I/O | E18 | AC1 |
| I/O | D18 | AA5 |
| I/O | A19 | AA3 |
| GND | GND* | GND* |
| I/O (A19) | C19 | Y8 |
| I/O (A18) | D19 | AB2 |
| I/O | E19 | Y6 |
| I/O | B20 | AA1 |
| I/O (A10) | C20 | Y4 |
| I/O (A11) | D20 | W7 |
| VCC | VCC* | VCC* |

| XC4085XL Pad Name | BG560 | PG559 |
|---|---|---|
| GND | GND* | GND* |
| I/O | A21 | W5 |
| I/O | E20 | V6 |
| I/O | B21 | V4 |
| I/O | C21 | Y2 |
| I/O | D21 | U3 |
| I/O | B22 | U7 |
| I/O | E21 | V2 |
| I/O | C22 | U5 |
| GND | GND* | GND* |
| I/O | D22 | T4 |
| I/O | A23 | U1 |
| I/O | C23 | R3 |
| I/O | E22 | R5 |
| VCC | VCC* | VCC* |

| XC4085XL<br>Pad Name | BG560 | PG559 |
|---|---|---|
| I/O | B24 | T8 |
| I/O | D23 | T2 |
| I/O | C24 | P4 |
| I/O | A25 | R7 |
| GND | GND* | GND* |
| I/O | E23 | N3 |
| I/O | B25 | R1 |
| I/O | D24 | N5 |
| I/O | C25 | P2 |
| I/O | B26 | M4 |
| I/O | E24 | L1 |
| I/O | C26 | L3 |
| I/O | D25 | P8 |
| GND | GND* | GND* |
| VCC | VCC* | VCC* |
| I/O | A27 | N7 |
| I/O | A28 | K2 |
| I/O | E25 | M6 |
| I/O | C27 | J1 |
| I/O | D26 | L5 |
| I/O | B28 | H2 |
| I/O (A12) | B29 | K4 |
| I/O (A13) | E26 | J3 |
| GND | GND* | GND* |
| VCC | VCC* | VCC* |
| I/O | C28 | L7 |
| I/O | D27 | J5 |
| I/O | B30 | G1 |
| I/O | C29 | H4 |
| I/O | E27 | F2 |
| I/O | A31 | G5 |
| GND | GND* | GND* |
| I/O | D28 | H6 |
| I/O | C30 | K8 |
| I/O | D29 | D2 |
| I/O | E28 | J7 |
| I/O (A14) | D30 | F4 |
| I/O, GCK8 (A15) | E29 | E3 |
| VCC | VCC* | VCC* |
| GND | GND* | GND* |
| I/O, GCK1 (A16) | B33 | C1 |
| I/O (A17) | F29 | C3 |
| I/O | E30 | F6 |
| I/O | D31 | A3 |
| I/O (TDI) | F30 | H8 |
| I/O (TCK) | C33 | D4 |
| GND | GND* | GND* |
| I/O | G29 | D6 |
| I/O | E31 | C5 |
| I/O | D32 | E7 |
| I/O | G30 | B4 |
| I/O | F31 | H10 |
| I/O | H29 | G9 |
| VCC | VCC* | VCC* |
| GND | GND* | GND* |
| I/O | E32 | F8 |
| I/O | E33 | D8 |
| I/O | H30 | B6 |
| I/O | G31 | E9 |
| I/O | J29 | A7 |
| I/O | F33 | G11 |
| I/O | G32 | H14 |
| I/O | J30 | F12 |
| VCC | VCC* | VCC* |
| GND | GND* | GND* |
| I/O | H31 | G13 |
| I/O | K29 | E11 |
| I/O | H32 | B8 |
| I/O | J31 | D10 |
| I/O | K30 | A9 |

| XC4085XL<br>Pad Name | BG560 | PG559 |
|---|---|---|
| I/O | H33 | G15 |
| I/O | L29 | B10 |
| I/O | K31 | H16 |
| GND | GND* | GND* |
| I/O | L30 | C9 |
| I/O | K32 | E13 |
| I/O (TMS) | J33 | A11 |
| I/O | M29 | D12 |
| VCC | VCC* | VCC* |
| I/O | L31 | C11 |
| I/O | M30 | B14 |
| I/O | L32 | G17 |
| I/O | M31 | E15 |
| GND | GND* | GND* |
| I/O | N29 | D14 |
| I/O | L33 | A15 |
| I/O | N30 | C13 |
| I/O | N31 | B16 |
| I/O | M32 | E17 |
| I/O | P29 | F18 |
| I/O | P30 | A17 |
| I/O | N33 | G19 |
| GND | GND* | GND* |
| VCC | VCC* | VCC* |
| I/O | P31 | D16 |
| I/O | P32 | C15 |
| I/O | R29 | B18 |
| I/O | R30 | H20 |
| I/O | R31 | B20 |
| I/O | R33 | E19 |
| GND | GND* | GND* |
| I/O | T31 | D18 |
| I/O | T29 | F20 |
| I/O | T30 | G21 |
| I/O | T32 | C17 |
| I/O | U32 | D20 |
| I/O | U31 | E21 |
| GND | GND* | GND* |
| VCC | VCC* | VCC* |
| I/O | U29 | C21 |
| I/O | U30 | F22 |
| I/O | U33 | A21 |
| I/O | V32 | D22 |
| I/O | V31 | B22 |
| I/O | V29 | G23 |
| GND | GND* | GND* |
| I/O | V30 | E23 |
| I/O | W33 | C23 |
| I/O | W31 | A23 |
| I/O | W30 | D24 |
| I/O | W29 | B24 |
| I/O | Y32 | H24 |
| VCC | VCC* | VCC* |
| GND | GND* | GND* |
| I/O | Y31 | F24 |
| I/O | Y30 | E25 |
| I/O | AA33 | B26 |
| I/O | Y29 | D26 |
| I/O | AA32 | A27 |
| I/O | AA31 | G25 |
| I/O | AA30 | B28 |
| I/O | AB32 | C27 |
| GND | GND* | GND* |
| I/O | AA29 | F26 |
| I/O | AB31 | E27 |
| I/O | AB30 | A29 |
| I/O | AC33 | D28 |
| VCC | VCC* | VCC* |
| I/O | AC31 | G27 |
| I/O | AB29 | B30 |

| XC4085XL Pad Name | BG560 | PG559 |
|---|---|---|
| I/O | AD32 | C29 |
| I/O | AC30 | E29 |
| GND | GND* | GND* |
| I/O | AD31 | D30 |
| I/O | AE33 | A33 |
| I/O | AC29 | C31 |
| I/O | AE32 | B34 |
| I/O | AD30 | H28 |
| I/O | AE31 | A35 |
| I/O | AF32 | G29 |
| I/O | AD29 | E31 |
| GND | GND* | GND* |
| VCC | VCC* | VCC* |
| I/O | AF31 | D32 |
| I/O | AE30 | C35 |
| I/O | AG33 | C33 |
| I/O | AH33 | B36 |
| I/O | AE29 | H30 |
| I/O | AG31 | A37 |
| I/O | AF30 | G31 |
| I/O | AH32 | F32 |
| GND | GND* | GND* |
| VCC | VCC* | VCC* |
| I/O | AJ32 | E33 |
| I/O | AF29 | D34 |
| I/O | AH31 | B38 |
| I/O | AG30 | G33 |
| I/O | AK32 | A41 |
| I/O | AJ31 | E35 |
| GND | GND* | GND* |
| I/O | AG29 | D36 |
| I/O | AL33 | F36 |
| I/O | AH30 | G35 |
| I/O | AK31 | H34 |
| I/O | AJ30 | B40 |
| I/O, GCK2 | AH29 | E37 |
| O (M1) | AK30 | D38 |
| GND | GND* | GND* |
| I (M0) | AJ29 | C39 |
| VCC | VCC* | VCC* |
| I (M2) | AN32 | H36 |
| I/O, GCK3 | AJ28 | F38 |
| I/O (HDC) | AK29 | C41 |
| I/O | AL30 | D40 |
| I/O | AK28 | B42 |
| I/O | AM31 | J37 |
| I/O (LDC) | AJ27 | K36 |
| GND | GND* | GND* |
| I/O | AN31 | H38 |
| I/O | AL29 | D42 |
| I/O | AK27 | G39 |
| I/O | AL28 | C43 |
| I/O | AJ26 | F40 |
| I/O | AM30 | E41 |
| VCC | VCC* | VCC* |
| GND | GND* | GND* |
| I/O | AM29 | L37 |
| I/O | AK26 | J39 |
| I/O | AL27 | F42 |
| I/O | AJ25 | H40 |
| I/O | AN29 | G43 |
| I/O | AN28 | J41 |
| I/O | AK25 | H42 |
| I/O | AL26 | N37 |
| VCC | VCC* | VCC* |
| GND | GND* | GND* |
| I/O | AJ24 | P36 |
| I/O | AM27 | M38 |
| I/O | AM26 | J43 |
| I/O | AK24 | L39 |

| XC4085XL Pad Name | BG560 | PG559 |
|---|---|---|
| I/O | AL25 | K42 |
| I/O | AJ23 | K40 |
| I/O | AN26 | L43 |
| I/O | AL24 | L41 |
| GND | GND* | GND* |
| I/O | AK23 | R37 |
| I/O | AN25 | P42 |
| I/O | AJ22 | T36 |
| I/O | AL23 | N39 |
| VCC | VCC* | VCC* |
| I/O | AM24 | M40 |
| I/O | AK22 | R43 |
| I/O | AM23 | N41 |
| I/O | AJ21 | R39 |
| GND | GND* | GND* |
| I/O | AL22 | U37 |
| I/O | AN23 | T42 |
| I/O | AK21 | P40 |
| I/O | AM22 | U43 |
| I/O | AJ20 | R41 |
| I/O | AL21 | V42 |
| I/O | AN21 | U39 |
| I/O | AK20 | V38 |
| GND | GND* | GND* |
| VCC | VCC* | VCC* |
| I/O | AL20 | W37 |
| I/O | AJ19 | T40 |
| I/O | AM20 | Y42 |
| I/O | AK19 | U41 |
| I/O | AL19 | Y36 |
| I/O | AN19 | V40 |
| GND | GND* | GND* |
| I/O | AJ18 | W39 |
| I/O | AK18 | AA43 |
| I/O | AL18 | Y38 |
| I/O | AM18 | Y40 |
| I/O | AK17 | AA37 |
| I/O (INIT) | AJ17 | AA39 |
| VCC | VCC* | VCC* |
| GND | GND* | GND* |
| I/O | AL17 | AA41 |
| I/O | AM17 | AB38 |
| I/O | AN17 | AB42 |
| I/O | AK16 | AB40 |
| I/O | AJ16 | AC37 |
| I/O | AL16 | AC39 |
| GND | GND* | GND* |
| I/O | AM16 | AD36 |
| I/O | AL15 | AC41 |
| I/O | AK15 | AD38 |
| I/O | AJ15 | AC43 |
| I/O | AN15 | AD40 |
| I/O | AM14 | AE39 |
| VCC | VCC* | VCC* |
| GND | GND* | GND* |
| I/O | AL14 | AE37 |
| I/O | AK14 | AF40 |
| I/O | AJ14 | AD42 |
| I/O | AN13 | AF42 |
| I/O | AM13 | AF38 |
| I/O | AL13 | AG39 |
| I/O | AK13 | AG43 |
| I/O | AJ13 | AG37 |
| GND | GND* | GND* |
| I/O | AM12 | AH40 |
| I/O | AL12 | AJ41 |
| I/O | AK12 | AG41 |
| I/O | AN11 | AK40 |
| VCC | VCC* | VCC* |
| I/O | AJ12 | AJ39 |

| XC4085XL Pad Name | BG560 | PG559 | XC4085XL Pad Name | BG560 | PG559 |
|---|---|---|---|---|---|
| I/O | AL11 | AH42 | I/O | AE3 | AY34 |
| I/O | AK11 | AH36 | I/O | AC5 | BC33 |
| I/O | AM10 | AL39 | I/O | AE1 | AU29 |
| GND | GND* | GND* | I/O | AD3 | AT28 |
| I/O | AL10 | AJ37 | GND | GND* | GND* |
| I/O | AJ11 | AJ43 | I/O | AC4 | BA35 |
| I/O | AN9 | AM40 | I/O | AD2 | BB30 |
| I/O | AK10 | AK42 | I/O | AB5 | AW31 |
| I/O | AM9 | AN41 | I/O | AC3 | AY32 |
| I/O | AL9 | AL41 | VCC | VCC* | VCC* |
| I/O | AJ10 | AR41 | I/O | AB4 | BA33 |
| I/O | AM8 | AK36 | I/O | AC1 | AU27 |
| GND | GND* | GND* | I/O (D5) | AA5 | BC29 |
| VCC | VCC* | VCC* | I/O (CS0) | AB3 | AW29 |
| I/O | AK9 | AL37 | GND | GND* | GND* |
| I/O | AL8 | AN43 | I/O | AB2 | AY30 |
| I/O | AN7 | AM38 | I/O | AA4 | BA31 |
| I/O | AJ9 | AP42 | I/O | AA3 | BB28 |
| I/O | AL7 | AN39 | I/O | Y5 | AW27 |
| I/O | AK8 | AR43 | I/O | AA1 | BC27 |
| I/O | AN6 | AP40 | I/O | Y4 | AV26 |
| I/O | AM6 | AT40 | I/O | Y3 | AU25 |
| GND | GND* | GND* | I/O | Y2 | AY28 |
| VCC | VCC* | VCC* | GND | GND* | GND* |
| I/O | AJ8 | AN37 | VCC | VCC* | VCC* |
| I.O | AL6 | AR39 | I/O | W5 | BA29 |
| I/O | AK7 | AT42 | I/O | W4 | AT24 |
| I/O | AM5 | BA43 | I/O | W3 | BB26 |
| I/O | AM4 | AU43 | I/O | W1 | AW25 |
| I/O | AJ7 | AU39 | I/O | V3 | BB24 |
| GND | GND* | GND* | I/O | V5 | AY26 |
| I/O | AL5 | AT38 | GND | GND* | GND* |
| I/O | AK6 | AP36 | I/O | V4 | AV24 |
| I/O | AN3 | AR37 | I/O | V2 | AU23 |
| I/O | AK5 | AV42 | I/O | U2 | BA27 |
| I/O | AJ6 | AV40 | I/O | U1 | BC23 |
| I/O, GCK4 | AL4 | AW41 | I/O (D4) | U5 | AY24 |
| GND | GND* | GND* | I/O | U4 | AW23 |
| DONE | AJ5 | AY42 | VCC | VCC* | VCC* |
| VCC | VCC* | VCC* | GND | GND* | GND* |
| PROGRAM | AM1 | BB42 | I/O (D3) | U3 | BA23 |
| I/O (D7) | AH5 | BC41 | I/O (RS) | T2 | AV22 |
| I/O, GCK5 | AJ4 | AV38 | I/O | T3 | AY22 |
| I/O | AK3 | BA39 | I/O | T5 | BB22 |
| I/O | AH4 | AT36 | I/O | T4 | AU21 |
| I/O | AL1 | BB40 | I/O | R1 | AW21 |
| I/O | AG5 | AY40 | GND | GND* | GND* |
| GND | GND* | GND* | I/O | R3 | BA21 |
| I/O | AJ3 | BA41 | I/O | R4 | BC21 |
| I/O | AK2 | BB38 | I/O | R5 | AY20 |
| I/O | AG4 | AY38 | I/O | P2 | BB20 |
| I/O | AH3 | BC37 | I/O | P3 | AT20 |
| I/O | AF5 | AW37 | I/O | P4 | AV20 |
| I/O | AJ2 | AT34 | VCC | VCC* | VCC* |
| VCC | VCC* | VCC* | GND | GND* | GND* |
| GND | GND* | GND* | I/O | N1 | AW19 |
| I/O (D6) | AJ1 | AU35 | I/O | P5 | AY18 |
| I/O | AF4 | AV36 | I/O | N2 | BB18 |
| I/O | AG3 | BB36 | I/O | N3 | AU19 |
| I/O | AE5 | AY36 | I/O | N4 | BC17 |
| I/O | AH1 | BC35 | I/O | M2 | BA17 |
| I/O | AF3 | AW35 | I/O | N5 | AV18 |
| I/O | AE4 | AU33 | I/O | M3 | AW17 |
| I/O | AG2 | AT30 | GND | GND* | GND* |
| VCC | VCC* | VCC* | I/O (D2) | M4 | AY16 |
| GND | GND* | GND* | I/O | L1 | BB16 |
| I/O | AD5 | AV32 | I/O | L3 | AU17 |
| I/O | AF2 | AU31 | I/O | M5 | BA15 |
| I/O | AF1 | AW33 | VCC | VCC* | VCC* |
| I/O | AD4 | BB34 | I/O | K2 | AW15 |

| XC4085XL Pad Name | BG560 | PG559 |
|---|---|---|
| I/O | L4 | BC15 |
| I/O | J1 | AY14 |
| I/O | K3 | BA13 |
| GND | GND* | GND* |
| I/O | L5 | AT16 |
| I/O | J2 | BB14 |
| I/O | K4 | AU15 |
| I/O | J3 | BC11 |
| I/O | H2 | AW13 |
| I/O | K5 | BB10 |
| I/O | H3 | AY12 |
| I/O | J4 | BA11 |
| GND | GND* | GND* |
| VCC | VCC* | VCC* |
| I/O | G1 | AT14 |
| I/O | F1 | AU13 |
| I/O | J5 | AV12 |
| I/O | G3 | BC9 |
| I/O | H4 | AW11 |
| I/O | F2 | BB8 |
| I/O | E2 | AY10 |
| I/O | H5 | AU11 |
| GND | GND* | GND* |
| VCC | VCC* | VCC* |
| I/O (D1) | F3 | BA9 |
| I/O (RCLK RDY/BUSY) | G4 | AW9 |
| I/O | D2 | BC7 |
| I/O | E3 | AY8 |
| I/O | G5 | AV8 |
| I/O | C1 | AT10 |
| GND | GND* | GND* |
| I/O | F4 | AU9 |
| I/O | D3 | BB6 |
| I/O | B3 | AW7 |
| I/O | F5 | BC3 |
| I/O (D0, DIN) | E4 | AY6 |
| I/O, GCK6 (DOUT) | D4 | BB4 |
| CCLK | C4 | BA5 |
| VCC | VCC* | VCC* |
| O, TDO | E6 | BA3 |
| GND | GND* | GND* |
| I/O (A0, WS) | D5 | AT8 |
| I/O, GCK7 (A1) | A2 | AV6 |
| I/O | D6 | BB2 |
| I/O | A3 | AY4 |
| I/O | E7 | AR7 |
| I/O | C5 | AP8 |
| GND | GND* | GND* |
| I/O | B4 | AT6 |
| I/O | D7 | AY2 |
| I/O (CS1, A2) | C6 | AU5 |
| I/O (A3) | E8 | BA1 |
| I/O | B5 | AV4 |
| I/O | A5 | AW3 |
| VCC | VCC* | VCC* |
| GND | GND* | GND* |
| I/O | D8 | AN7 |
| I/O | C7 | AR5 |
| I/O | E9 | AV2 |
| I/O | A6 | AT4 |
| I/O | B7 | AU1 |
| I/O | D9 | AR3 |
| I/O | C8 | AT2 |
| I/O | E10 | AL7 |
| VCC | VCC* | VCC* |
| GND | GND* | GND* |
| I/O | B8 | AK8 |
| I/O | A8 | AM6 |
| I/O | D10 | AN5 |

| XC4085XL Pad Name | BG560 | PG559 |
|---|---|---|
| I/O | C9 | AR1 |
| I/O | E11 | AP4 |
| I/O | A9 | AN3 |
| I/O | C10 | AP2 |
| I/O | D11 | AJ7 |
| GND | GND* | GND* |
| I/O | B10 | AH8 |
| I/O | E12 | AL5 |
| I/O | C11 | AN1 |
| I/O | B11 | AM4 |
| VCC | VCC* | VCC* |
| I/O | D12 | AL3 |
| I/O | A11 | AJ5 |
| I/O | E13 | AK2 |
| I/O | C12 | AG7 |
| GND | GND* | GND* |
| I/O | B12 | AK4 |
| I/O | D13 | AJ3 |
| I/O | C13 | AG5 |
| I/O | E14 | AJ1 |
| I/O | A13 | AF6 |
| I/O | D14 | AH2 |
| I/O | C14 | AE7 |
| I/O | B14 | AH4 |
| GND | GND* | GND* |
| VCC | VCC* | VCC* |
| I/O (A4) | E15 | AG3 |
| I/O (A5) | D15 | AD8 |
| I/O | C15 | AG1 |
| I/O | A15 | AF4 |
| I/O (A21) | C16 | AE5 |
| I/O (A20) | E16 | AD6 |
| GND | GND* | GND* |
| I/O | D16 | AD4 |
| I/O | B16 | AF2 |
| I/O | B17 | AC7 |
| I/O | C17 | AD2 |
| I/O (A6) | E17 | AC5 |
| I/O (A7) | D17 | AC3 |
| GND | GND* | GND* |

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## Additional XC4085XL Package Pins

**BG560**

| VCC Pins | | | | | | |
|---|---|---|---|---|---|---|
| A4 | A10 | A16 | A22 | A26 | A30 | B2 |
| B13 | B19 | B32 | C3 | C31 | C32 | D1 |
| D33 | E5 | H1 | K33 | M1 | N32 | R2 |
| T33 | V1 | W32 | AA2 | AB33 | AD1 | AF33 |
| AK1 | AK4 | AK33 | AL2 | AL3 | AL31 | AM2 |
| AM15 | AM21 | AM32 | AN4 | AN8 | AN12 | AN18 |
| AN24 | AN30 | - | - | - | - | - |

| GND Pins | | | | | | |
|---|---|---|---|---|---|---|
| A7 | A12 | A14 | A18 | A20 | A24 | A29 |
| A32 | B1 | B6 | B9 | B15 | B23 | B27 |
| B31 | C2 | E1 | F32 | G2 | G33 | J32 |
| K1 | L2 | M33 | P1 | P33 | R32 | T1 |
| V33 | W2 | Y1 | Y33 | AB1 | AC32 | AD33 |
| AE2 | AG1 | AG32 | AH2 | AJ33 | AL32 | AM3 |
| AM11 | AM19 | AM25 | AM28 | AM33 | AM7 | AN2 |
| AN5 | AN10 | AN14 | AN16 | AN20 | AN22 | AN27 |

| N.C. Pins | | | | | | |
|---|---|---|---|---|---|---|
| A1 | A33 | AC2 | AN1 | AN33 | - | - |

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**PG559**

| VCC Pins | | | | | | |
|---|---|---|---|---|---|---|
| A13 | A31 | A43 | B2 | C7 | C19 | C25 |
| C37 | F14 | F30 | G3 | G7 | G37 | G41 |
| H12 | H18 | H26 | H32 | M8 | M36 | N1 |
| N43 | P6 | P38 | V8 | V36 | W3 | W41 |
| AE3 | AE41 | AF8 | AF36 | AK6 | AK38 | AL1 |
| AL43 | AM8 | AM36 | AT12 | AT18 | AT26 | AT32 |
| AU3 | AU7 | AU37 | AU41 | AV14 | AV30 | BA7 |
| BA19 | BA25 | BA37 | BC1 | BC13 | BC31 | BC43 |
| **GND Pins** | | | | | | |
| A5 | A19 | A25 | A39 | B12 | B32 | E1 |
| E5 | E39 | E43 | F10 | F16 | F28 | F34 |
| H22 | K6 | K38 | M2 | M42 | T6 | T38 |
| W1 | W43 | AB8 | AB36 | AE1 | AE43 | AH6 |
| AH38 | AM2 | AM42 | AP6 | AP38 | AT22 | AV10 |
| AV16 | AV28 | AV34 | AW1 | AW5 | AW39 | AW43 |
| BB12 | BB32 | BC5 | BC19 | BC25 | BC39 | - |

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* Pads labelled GND* or VCC* are internally bonded to Ground or VCC planes within the package.  They have no direct connection to any specific package pin.
† = E only, †† = XL only

# Product Availability

Table 24 - Table 26 show the planned packages and speed grades for XC4000-Series devices. Call your local sales office for the latest availability information, or see the Xilinx WEBLINX at http://www.xilinx.com for the latest revision of the specifications.

**Table 24: Component Availability Chart for XC4000XL FPGAs**

| Device | Speed | 84 Plast. PLCC PC84 | 100 Plast. PQFP PQ100 | 100 Plast. VQFP VQ100 | 144 Plast. TQFP TQ144 | 144 High-Perf. TQFP HT144 | 160 High-Perf. QFP HQ160 | 160 Plast. PQFP PQ160 | 176 Plast. TQFP TQ176 | 176 High-Perf. TQFP HT176 | 208 High-Perf. QFP HQ208 | 208 Plast. PQFP PQ208 | 240 High-Perf. QFP HQ240 | 240 Plast. PQFP PQ240 | 256 Plast. BGA BG256 | 299 Ceram. PGA PG299 | 304 High-Perf. QFP HQ304 | 352 Plast. BGA BG352 | 411 Ceram. PGA PG411 | 432 Plast. BGA BG432 | 475 Ceram. PGA PG475 | 599 Ceram. PGA PG599 | 560 Plast. BGA BG560 |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| **XC4005XL** | -3 | C I | C I | C I | C I |  |  | C I |  |  |  | C I |  |  |  |  |  |  |  |  |  |  |  |
|  | -2 | C | C | C | C |  |  | C |  |  |  | C |  |  |  |  |  |  |  |  |  |  |  |
|  | -1 | C | C | C | C |  |  | C |  |  |  | C |  |  |  |  |  |  |  |  |  |  |  |
| **XC4010XL** | -3 | C I | C I |  | C I |  |  | C I | C I |  |  | C I |  |  | C I |  |  |  |  |  |  |  |  |
|  | -2 | C | C |  | C |  |  | C | C |  |  | C |  |  | C |  |  |  |  |  |  |  |  |
|  | -1 | C | C |  | C |  |  | C | C |  |  | C |  |  | C |  |  |  |  |  |  |  |  |
| **XC4013XL** | -3 |  |  |  |  | C I |  | C I |  | C I |  | C I |  |  | C I | C I |  |  |  |  |  |  |  |
|  | -2 |  |  |  |  | C |  | C |  | C |  | C |  |  | C | C |  |  |  |  |  |  |  |
|  | -1 |  |  |  |  | C |  | C |  | C |  | C |  |  | C | C |  |  |  |  |  |  |  |
| **XC4020XL** | -3 |  |  |  |  | C I |  | C I |  | C I |  | C I |  |  | C I | C I |  |  |  |  |  |  |  |
|  | -2 |  |  |  |  | C |  | C |  | C |  | C |  |  | C | C |  |  |  |  |  |  |  |
|  | -1 |  |  |  |  | C |  | C |  | C |  | C |  |  | C | C |  |  |  |  |  |  |  |
| **XC4028XL** | -3 |  |  |  |  |  | C I |  |  |  | C I |  | C I |  | C I | C I | C I | C I |  |  |  |  |  |
|  | -2 |  |  |  |  |  | C |  |  |  | C |  | C |  | C | C | C | C |  |  |  |  |  |
|  | -1 |  |  |  |  |  | C |  |  |  | C |  | C |  | C | C | C | C |  |  |  |  |  |
| **XC4036XL** | -3 |  |  |  |  |  | C |  |  |  | C I |  | C I |  |  |  | C I | C I | C I | C I |  |  |  |
|  | -2 |  |  |  |  |  | C I |  |  |  | C |  | C |  |  |  | C | C | C | C |  |  |  |
|  | -1 |  |  |  |  |  | C |  |  |  | C |  | C |  |  |  | C | C | C | C |  |  |  |
| **XC4044XL** | -3 |  |  |  |  |  | C I |  |  |  | C I |  | C I |  |  |  | C I | C I | C I | C I |  |  |  |
|  | -2 |  |  |  |  |  | C |  |  |  | C |  | C |  |  |  | C | C | C | C |  |  |  |
|  | -1 |  |  |  |  |  | C |  |  |  | C |  | C |  |  |  | C | C | C | C |  |  |  |
| **XC4052XL** | -3 |  |  |  |  |  |  |  |  |  |  |  | C I |  |  |  | C I |  | C I | C I |  |  | C I |
|  | -2 |  |  |  |  |  |  |  |  |  |  |  | C |  |  |  | C |  | C | C |  |  | C |
|  | -1 |  |  |  |  |  |  |  |  |  |  |  | C |  |  |  | C |  | C | C |  |  | C |
| **XC4062XL** | -3 |  |  |  |  |  |  |  |  |  |  |  | C I |  |  |  | C I |  |  | C I | C I |  | C I |
|  | -2 |  |  |  |  |  |  |  |  |  |  |  | C |  |  |  | C |  |  | C | C |  | C |
|  | -1 |  |  |  |  |  |  |  |  |  |  |  | C |  |  |  | C |  |  | C | C |  | C |
| **XC4085XL** | -3 |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  | C I | C I |
|  | -2 |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  | C | C |
|  | -1 |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  | C | C |

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C = Commercial  $T_J = 0°$ to $+85°C$

I= Industrial  $T_J = -40°C$ to $+100°C$

### Table 25: Component Availability Chart for XC4000E FPGAs

| | | PINS 84 | 100 | 100 | 120 | 144 | 156 | 160 | 191 | 208 | 208 | 223 | 225 | 240 | 240 | 299 | 304 |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| | | Plast. PLCC | Plast. PQFP | Plast. VQFP | Ceram. PGA | Plast. TQFP | Ceram. PGA | Plast. PQFP | Ceram. PGA | High-Perf. QFP | Plast. PQFP | Ceram. PGA | Plast. BGA | High-Perf. QFP | Plast. PQFP | Ceram. PGA | High-Perf. QF |
| | | PC84 | PQ100 | VQ100 | PG120 | TQ144 | PG156 | PQ160 | PG191 | HQ208 | PQ208 | PG223 | BG225 | HQ240 | PQ240 | PG299 | HQ304 |
| **XC4003E** | -4 | C I | C I | C I | C I | | | | | | | | | | | | |
| | -3 | C | C | C | C | | | | | | | | | | | | |
| | -2 | C | C | C | C | | | | | | | | | | | | |
| | -1 | C | C | C | C | | | | | | | | | | | | |
| **XC4005E** | -4 | C I | C I | | | C I | C I | C I | | | C I | | | | | | |
| | -3 | C | C | | | C | C | C | | | C | | | | | | |
| | -2 | C | C | | | C | C | C | | | C | | | | | | |
| | -1 | C | C | | | C | C | C | | | C | | | | | | |
| **XC4006E** | -4 | C I | | | | C I | C I | C I | | | C I | | | | | | |
| | -3 | C | | | | C | C | C | | | C | | | | | | |
| | -2 | C | | | | C | C | C | | | C | | | | | | |
| | -1 | C | | | | C | C | C | | | C | | | | | | |
| **XC4008E** | -4 | C I | | | | | | C I | C I | | C I | | | | | | |
| | -3 | C | | | | | | C | C | | C | | | | | | |
| | -2 | C | | | | | | C | C | | C | | | | | | |
| | -1 | C | | | | | | C | C | | C | | | | | | |
| **XC4010E** | -4 | C I | | | | | | C I | C I | C I | C I | | | C I | | | |
| | -3 | C | | | | | | C | C | C | C | | | C | | | |
| | -2 | C | | | | | | C | C | C | C | | | C | | | |
| | -1 | C | | | | | | C | C | C | C | | | C | | | |
| **XC4013E** | -4 | | | | | | | C I | | C I | C I | C I | C I | C I | C I | | |
| | -3 | | | | | | | C | | C | C | C | C | C | C | | |
| | -2 | | | | | | | C | | C | C | C | C | C | C | | |
| | -1 | | | | | | | C | | C | C | C | C | C | C | | |
| **XC4020E** | -4 | | | | | | | | | C I | | C I | | C I | | | |
| | -3 | | | | | | | | | C | | C | | C | | | |
| | -2 | | | | | | | | | C | | C | | C | | | |
| | -1 | | | | | | | | | C | | C | | C | | | |
| **XC4025E** | -4 | | | | | | | | | C I | | C I | | C I | | C I | C I |
| | -3 | | | | | | | | | C | | C | | C | | C | C |
| | -2 | | | | | | | | | C | | C | | C | | C | C |

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C = Commercial $T_J$ = 0° to +85°C

I = Industrial $T_J$ = -40°C to +100°C

### Table 26: Component Availability Chart for XC4000EX FPGAs

| | | PINS 208 | 240 | 299 | 304 | 352 | 411 | 432 |
|---|---|---|---|---|---|---|---|---|
| | TYPE | High-Perf. QFP | High-Perf. QFP | Ceram. PGA | High-Perf. QFP | Plast. BGA | Ceram. PGA | Plast. BGA |
| | CODE | HQ208 | HQ240 | PG299 | HQ304 | BG352 | PG411 | BG432 |
| **XC4028EX** | -3 | C I | C I | C I | C I | C I | | |
| | -2 | C | C | C | C | C | | |
| | -1 | C | C | C | C | C | | |
| **XC4036EX** | -3 | | | | C I | | C I | C I |
| | -2 | | | | C | | C | C |
| | -1 | | | | C | | C | C |

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C = Commercial $T_J$ = 0° to +85°C

I = Industrial $T_J$ = -40°C to +100°C

# User I/O Per Package

Table 27 - Table 29 show the number of user I/Os available in each package for XC4000-Series devices. Call your local sales office for the latest availability information, or see the Xilinx WEBLINX at http://www.xilinx.com for the latest revision of the specifications.

## Table 27: User I/O Chart for XC4000XL FPGAs

| Device | Max I/O | PC84 | PQ100 | VQ100 | TQ144 | HT144 | HQ160 | PQ160 | TQ176 | HT176 | HQ208 | PQ208 | HQ240 | PQ240 | BG256 | PG299 | HQ304 | BG352 | PG411 | BG432 | PG475 | PG599 | BG560 |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| XC4005XL | 112 | 61 | 77 | 77 | 112 | | | 112 | | | | 112 | | | | | | | | | | | |
| XC4010XL | 160 | 61 | 77 | | 113 | | | 129 | 145 | | | 160 | | | 160 | | | | | | | | |
| XC4013XL | 192 | | | | | 113 | | 129 | | 145 | | 160 | | 192 | 192 | | | | | | | | |
| XC4020XL | 224 | | | | | 113 | | 129 | | 145 | | 160 | | 193 | 205 | | | | | | | | |
| XC4028XL | 256 | | | | | | 129 | | | | 160 | | 193 | | 205 | 256 | 256 | 256 | | | | | |
| XC4036XL | 288 | | | | | | 129 | | | | 160 | | 193 | | | 256 | 288 | 288 | 288 | | | | |
| XC4044XL | 320 | | | | | | 129 | | | | 160 | | 193 | | | 256 | 289 | 320 | 320 | | | | |
| XC4052XL | 352 | | | | | | | | | | | | 193 | | | 256 | | 352 | 352 | | | | 352 |
| XC4062XL | 384 | | | | | | | | | | | | 193 | | | 256 | | | 352 | 384 | | | 384 |
| XC4085XL | 448 | | | | | | | | | | | | | | | | | | | | | 448 | 448 |
| XC40125XV | 448 | | | | | | | | | | | | | | | | | | | | | 448 | 432 |

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## Table 28: User I/O Chart for XC4000E FPGAs

| Device | Max I/O | PC84 | PQ100 | VQ100 | PG120 | TQ144 | PG156 | PQ160 | PG191 | HQ208 | PQ208 | PG223 | BG225 | HQ240 | PQ240 | PG299 | HQ304 |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| XC4003E | 80 | 61 | 77 | 77 | 80 | | | | | | | | | | | | |
| XC4005E | 112 | 61 | 77 | | | 112 | 112 | 112 | | | 112 | | | | | | |
| XC4006E | 128 | 61 | | | | 113 | 125 | 128 | | | 128 | | | | | | |
| XC4008E | 144 | 61 | | | | | | 129 | 144 | | 144 | | | | | | |
| XC4010E | 160 | 61 | | | | | | 129 | 160 | 160 | 160 | | | 160 | | | |
| XC4013E | 192 | | | | | | | 129 | | 160 | 160 | 192 | 192 | 192 | 192 | | |
| XC4020E | 224 | | | | | | | | | 160 | | 192 | | 193 | | | |
| XC4025E | 256 | | | | | | | | | | | 192 | | 193 | | 256 | 256 |

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## Table 29: User I/O Chart for XC4000EX FPGAs

| Device | Max I/O | HQ208 | HQ240 | PG299 | HQ304 | BG352 | PG411 | BG432 |
|---|---|---|---|---|---|---|---|---|
| XC4028EX | 256 | 160 | 193 | 256 | 256 | 256 | | |
| XC4036EX | 288 | | 193 | | 256 | 288 | 288 | 288 |

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## Ordering Information

**Example:** **XC4013E-3HQ240C**

Device Type

Speed Grade
-6
-5
-4
-3
-2
-1

Package Type
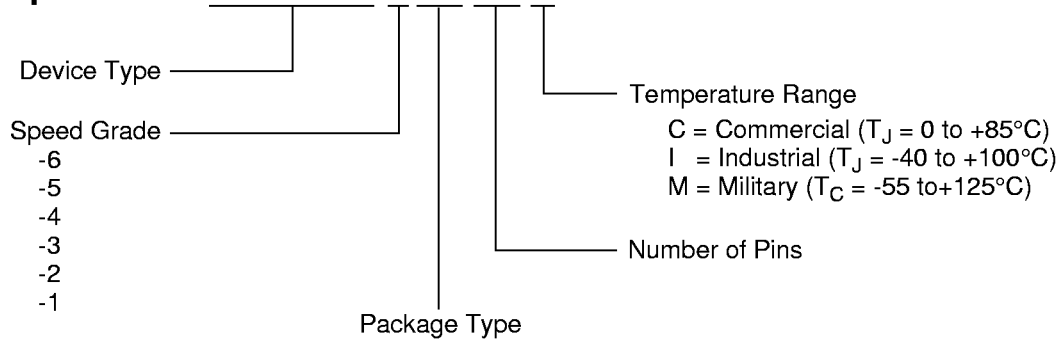
PC = Plastic Lead Chip Carrier
PQ = Plastic Quad Flat Pack
VQ = Very Thin Quad Flat Pack
TQ = Thin Quad Flat Pack

BG = Ball Grid Array
PG = Ceramic Pin Grid Array
HQ = High Heat Dissipation Quad Flat Pack
MQ = Metal Quad Flat Pack
CB = Top Brazed Ceramic Quad Flat Pack

Temperature Range
C = Commercial ($T_J$ = 0 to +85°C)
I  = Industrial ($T_J$ = -40 to +100°C)
M = Military ($T_C$ = -55 to +125°C)

Number of Pins

X9020

**Σ XILINX®** The Programmable Logic Company℠

**Headquarters**

Xilinx, Inc.
2100 Logic Drive
San Jose, CA 95124
U.S.A.

Tel: 1 (800) 255-7778
or 1 (408) 559-7778
Fax: 1 (800) 559-7114

Net: hotline@xilinx.com
Web: http://www.xilinx.com

**North America**

Irvine, California
(714) 727-0780

Englewood, Colorado
(303)220-7541

Sunnyvale, California
(408) 245-9850

Schaumburg, Illinois
(847) 605-1972

Nashua, New Hampshire
(603) 891-1098

Raleigh, North Carolina
(919) 846-3922

West Chester, Pennsylvania
(610) 430-3300

Dallas, Texas
(214) 960-1043

**Europe**

Xilinx Sarl
Jouy en Josas, France
Tel: (33) 1-34-63-01-01
Net: frhelp@xilinx.com

Xilinx GmbH
Aschheim, Germany
Tel: (49) 89-99-1549-01
Net: dlhelp@xilinx.com

Xilinx, Ltd.
Byfleet, United Kingdom
Tel: (44) 1-932-349401
Net: ukhelp@xilinx.com

**Japan**

Xilinx, K.K.
Tokyo, Japan
Tel: (03) 3297-9191

**Asia Pacific**

Xilinx Asia Pacific
Hong Kong
Tel: (852) 2424-5200
Net: hongkong@xilinx.com